## Linear Circuits <br> Data Acquisition and Conversion

## Linear Products Quick Reference Guide

| Data Book | Contents | Document No. |
| :---: | :---: | :---: |
| - Linear Circuits Vol 1 Amplifiers, Comparators, and Special Functions | Operational Amplifiers <br> Voltage Comparators <br> Video Amplifiers <br> Hall-Effect Devices <br> Timers and Current Mirrors <br> Magnetic-Memory Interface <br> Frequency-to-Voltage Converters <br> Sonar Ranging Circuits/Modules <br> Sound Generators | $\begin{gathered} \text { SLYDOO3 } \\ 1989 \end{gathered}$ |
| - Linear Circuits Vol 2 Data Acquisition and Conversion | A/D and D/A Converters <br> DSP Analog Interface <br> Analog Switches and Multiplexers Switched-Capacitor Filters | $\begin{gathered} \text { SLYDOO4 } \\ 1989 \end{gathered}$ |
| - Linear Circuits Vol 3 Voltage Regulators and Supervisors | Supervisor Functions <br> Series-Pass Voltage Regulators <br> Shunt Regulators <br> Voltage References <br> DC-to-DC Converters <br> PWM Controllers | $\begin{gathered} \text { SLYDOO5 } \\ 1989 \end{gathered}$ |
| - Telecommunications Circuits | Equipment Line Interfaces <br> Subscriber Line Interfaces <br> Modems and Receiver/Transmitters <br> Ringers, Detectors, Tone Encoders <br> PCM Interface <br> Transient Suppressors | $\begin{gathered} \text { SCTD001A } \\ 1988 / 89 \end{gathered}$ |
| - Optoelectronics and Image Sensors | Optocouplers <br> CCD Image Sensors and Support Phototransistors <br> IR-Emitting Diodes Hybrid Displays | $\begin{gathered} \text { SOYDOO2 } \\ 1987 \end{gathered}$ |
| - Interface Circuits | High-Voltage (Display) Drivers High-Power (Peripheral/Motor) Drivers Line Drivers, Receivers, Transceivers EIA RS-232, RS-422, RS-423, RS-485 IBM 360/370, IEEE 802.3, CCITT Military Memory Interface | $\begin{gathered} \text { SLYDOO2 } \\ 1987 \end{gathered}$ |
| - Speech System Manuals | TSP50C4X Family | $\begin{gathered} \text { SLPSO25 } \\ 1988 \end{gathered}$ |

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## Data Sheets

## Product Previews

Mechanical Data

# Linear Circuits Data Book 1989 

Volume 2<br>Data Acquisition and Conversion

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Information contained in this data book supersedes all data for this technology published by TI in the United States of America before January 1989

## INTRODUCTION

Texas Instruments offers an extensive line of industry-standard integrated circuits for peripheral support applications of microprocessor-based systems, DSP (digital signal processing) related analog interfaces, and other high-speed digitizing requirements that demand ADC and DAC conversion.

Tl data acquisition system circuits represent technologies from traditional bipolar through Advanced Low-Power Schottky (ALS), IMPACT ${ }^{\text {Im }}$, LinCMOS ${ }^{\text {m }}$, Advanced LinCMOS ${ }^{\text {'m }}$, and LinEPIC ${ }^{\text {Im }}$ processes. The ALS and IMPACT ${ }^{\text {m }}$ oxide-isolated technology provides the data acquisition family with improved speed-conversion characteristics.
 temperature stability. LinEPIC ${ }^{\text {M }}$ has both improved speed conversion and reduced power consumption.

This data book (Volume 2 of 3) provides information on the following types of products:

- Single-Slope and Dual-Slope Analog-to-Digital (ADC) Converters
- Successive-Approximation Semi-Flash, and Flash ADC Converters
- Current Multiplying and Video DAC Converters
- Color Palette Chips
- Analog Interface for Digital Signal Processors
- Analog Switches and Multiplexers
- Switched-Capacitor Filter Integrated Circuits

These products cover the requirements of consumer applications, industrial process controls, digital signal processing, microprocessor interface, electronic instrumentation, digital audio equipment, video work stations, and imaging. New surface-mount packages (8 to 28 leads) include both ceramic and plastic chip carriers, and the small-outline (D) plastic packages that optimize board density with minimum impact on power-dissipation capability. Test equipment with handlers and automated assembly bonders strengthen the production capabilities to provide a lower cost-toperformance ratio. Tl continues to enhance quality and reliability of integrated circuits by improving materials, processes, test methods, and test equipment. In addition, specifications and programs are continuously updated. Quality and performance are monitored throughout all phases of manufacturing.

The alphanumeric listing in this data book includes all devices in Volumes 1, 2, and 3. Products in this data book are shown in bold type. The alphanumeric index provides a method of quickly locating the correct device type. The selection guide includes a functional description of each device that provides key parameter information and packaging types. Ordering information and mechanical data are in the last section of the data book.

While this volume offers design and specification data for data acquisition circuit components only, complete technical data for any TI semiconductor product is available from your nearest TI Field Sales Office, local authorized TI distributor, or by writing directly to:

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We sincerely feel that the new 1989 Data Acquisition and Conversion data book will be a significant addition to your library of technical literature from Texas Instruments.

## General Information

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## Product Previews

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successive-approximation and semi-flash converters

| ADDRESS <br> AND <br> DATA I/O <br> FORMAT | SIGNAL INPUTS |  | RESOLUTION (BITS) | CONVERSION <br> SPEED <br> $(\mu \mathrm{S})^{\ddagger}$ | POWER DISSIPATION (mW TYP) | $\begin{aligned} & \text { UNADJUSTED } \\ & \text { ERROR } \\ & \text { (MAX) } \\ & \pm \text { LSB } \\ & \hline \end{aligned}$ | TYPE | PACKAGE | $\begin{aligned} & \text { PAGE } \\ & \text { NO. } \end{aligned}$ |
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|  | 1 | 0 | 13 | 10 | 45 | 1.0 | TLC1225A | J, N | 3.43 |
|  |  |  |  |  |  | 0.5 | TLC1225B |  |  |

[^0]
## data acouisition and conversion

 SELECTION GUIDEsuccessive-approximation converters

| ADDRESS AND DATA I/O FORMAT | SIGNAL INPUTS |  | $\begin{gathered} \text { RESOLU- } \\ \text { TION } \\ \text { (BITS) } \end{gathered}$ | CONVERSION SPEED $(\mu \mathrm{s})^{\ddagger}$ | POWER DISSIPATION (mW TYP) | $\begin{array}{\|c\|} \hline \text { UNADJUSTED } \\ \text { ERROR } \\ \text { (MAX) } \\ \pm \text { LSB } \\ \hline \end{array}$ | TYPE | PACKAGE | PAGE NO. |
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|  |  |  |  | TLC7533 | D, FN, N |  |

[^1]analog interface for digital signal processors

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## video converters

$\left.\begin{array}{|c|c|c|c|c|c|}\hline \begin{array}{c}\text { CONVERSION } \\ \text { FUNCTION }\end{array} & \begin{array}{c}\text { RESOLUTION } \\ \text { (BITS) }\end{array} & \begin{array}{c}\text { CONVERSION } \\ \text { FREQUENCY } \\ \text { (MHz) }\end{array} & \begin{array}{c}\text { POWER } \\ \text { DISSIPATION } \\ \text { (mW) }\end{array} & \text { TYPE } & \text { PACKAGE }\end{array} \begin{array}{c}\text { PAGE } \\ \text { NO. }\end{array}\right]$
analog switches and multiplexers

| FUNCTION | POWER SUPPLIES <br> (V) | VOLTAGE RANGE (V) | TYPICAL IMPEDANCE (OHMS) | TYPE | PACKAGE | PAGE NO. |
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[^2]Replacements are based on similarity of electrical and mechanical characteristics as shown in currently published data. Interchangeability in particular applications is not guaranteed. Before using a device as a substitute, the user should compare the specifications of the substitute device with the specifications of the original.

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## GLOSSARY <br> TERMS, DEFINITIONS AND LETTER SYMBOLS

## TERMS, DEFINITIONS, AND LETTER SYMBOLS FOR ANALOG-TO-DIGITAL AND DIGITAL-TO-ANALOG CONVERTERS

## INTRODUCTION

These terms, definitions, and letter symbols are in accordance with those currently approved by the JEDEC Council of the Electronic Industries Association (EIA) for use in the USA and by the International Electrotechnical Commission (IEC) for international use.

## 1. GENERAL TERMS

## Analog-to-Digital Converter (ADC)

A converter that uniquely represents all analog input values within a specified total input range by a limited number of digital output codes, each of which exclusively represents a fractional part of the total analog input range. (See Figure 1.)
NOTE: This quantization procedure introduces inherent errors of one-half LSB (least significant bit) in the representation since, within this fractional range, only one analog value can be represented free of error by a single digital output code.


FIGURE 1. ELEMENTS OF TRANSFER DIAGRAM FOR AN IDEAL LINEAR ADC

## GLOSSARY

## TERMS, DEFINITIONS AND LETTER SYMBOLS

## Analog-to-Digital Processor

An integrated circuit providing the analog part of an ADC; provision of external timing, counting, and arithmetic operations is necessary for implementing a full analog-to-digital converter.

## Companding DAC

A DAC whose transfer function complies with a compression or expansion law.
NOTE 1: The corresponding ADC normally consists of such a companding DAC and additional external circuitry.

NOTE 2: The compression or expansion law is usually a logarithmic function, e.g., A-law or $\mu$-law.

## Conversion Code (of an ADC or a DAC)

The set of correlations between each of the fractional parts of the total analog input range or each of the digital input codes, respectively, and the corresponding digital output codes or analog output values, respectively. (See Figures 1 and 2.)

NOTE: Examples of output code formats are straight binary, 2's complement, and binary-coded decimal.


FIGURE 2. ELEMENTS OF TRANSFER DIAGRAM FOR AN IDEAL LINEAR DAC

## Digital-to-Analog Converter (DAC)

A converter that represents a limited number of different digital input codes by a corresponding number of discrete analog output values. (See Figure 2.)
NOTE: Examples of input code formats are straight binary, 2's complement, and binary-coded decimal.

## Full Scale (of a unipolar ADC or DAC)

A term used to refer a characteristic to that step within the transfer diagram whose nominal midstep value or nominal step value has the highest absolute value. (See Figure 3 a for a linear unipolar ADC.)

NOTE 1: The subscript for the letter symbol of a characteristic at full scale is "FS".
NOTE 2: In place of a letter symbol, the abbreviation "FS" is in common use.
Full Scale, Negative (of a bipolar ADC or DAC) (See Figures 3b and 3c)
A term used to refer a characteristic to the negative end of the transfer diagram, that is, to the step whose nominal midstep value or nominal step value has the most-negative value.

NOTE 1: The subscript for the letter symbol of a characteristic at negative full scale is "FS-" (VFS-, IFS-).
NOTE 2: In place of a letter symbol, the abbreviation "FS-" is in common use.
Full Scale, Positive (of a bipolar ADC or DAC) (See Figure 3b and 3c)
A term used to refer a characteristic to the positive end of the transfer diagram, that is, to the step whose nominal midstep value or nominal step value has the most-positive value.
NOTE 1: The subscript for the letter symbol of a characteristic at positive full scale is "FS+" (VFS+, IFS + ).
NOTE 2: In place of a letter symbol, the abbreviation "FS+" is in common use.
Full-Scale Range, Nominal (of a linear ADC or DAC) (VFSRnom, IFSRnom) (See Figure 3)
The total range in analog values that can be coded with uniform accuracy by the total number of steps with this number rounded to the next higher power of 2 .
NOTE: In place of the letter symbols, the abbreviation "FSR(nom)" can be used.
Example: Using a straight binary $n$-bit code format, it follows:

- for an ADC: $\operatorname{FSR}($ nom $)=2^{n} \times$ (nominal value of step width)
- for a DAC: $F S R($ nom $)=2^{n} \times$ (nominal value of step height)


## Full-Scale Value, Nominal (VFSnom, IFSnom)

A value derived from the nominal full-scale range:

- for a unipolar converter: $V_{F S n o m}=V_{F S R}$ nom
- for a bipolar converter: VFSnom $=1 / 2$ VFSRnom (See Figure 3.)
NOTE 1: In a few data sheets, this analog value is used as a reference value for adjustment procedures or as a rounded value for the full-scale range(s).

NOTE 2: In place of letter symbols, the abbreviation "FS(nom)" is in common use.

a. UNIPOLAR ADC

b. BIPOLAR ADC WITH TRUE ZERO
c. BIPOLAR ADC WITH NO TRUE ZERO

Figure 3. ideal straight line, full-scale value and zero-scale value (SHOWN FOR IDEAL LINEAR ADCs)

## GLOSSARY TERMS, DEFINITIONS AND LETTER SYMBOLS

Full-Scale Range, (Practical) (of a linear ADC or DAC) (VFSR, IFSR) (VFSRpr, IFSRpr) (See Figure 3) The total range of analog values that correspond to the ideal straight line.
NOTE 1: The qualifying adjective "practical" can usually be deleted from this term provided that, in a very few critical cases, the term "nominal full-scale range" is not also shortened in the same way. This permits use of the shorter letter symbols or abbreviations. (See Note 2.)
NOTE 2: In place of the letter symbols, the abbreviations "FSR" and "FSR(pr)" are in common use.
NOTE 3: The (practical) full-scale range has only a nominal value because it is defined by the end points of the ideal straight line.

Example: Using a straight binary n-bit code format, it follows:

- for an ADC: FSR $=\left(2^{n}-1\right) \times$ (nominal value of step width)
- for a DAC: FSR $=\left(2^{n}-1\right) \times($ nominal value of step height $)$


## Gain Point (of an adjustable ADC or DAC)

The point in the transfer diagram corresponding to the midstep value (for an ADC) or the step value (for a DAC) of the step for which gain error is specified (usually full scale), and in reference to which the gain adjustment is performed. (See Figures 4 and 5.)

NOTE: Gain adjustment causes only a change of the slope of the transfer diagram, without changing the offset error.

## Ideal Straight Line (of a linear ADC or DAC)

In the transfer diagram, a straight line between the specified points for the most-positive (least-negative) and most-negative (least-positive) nominal midstep values or nominal step values, respectively. (See Figures 1, 2, and 3 .)

NOTE: The ideal straight line passes through all the points for nominal midstep values or nominal step values, respectively.

## Linear ADC

An ADC having steps ideally of equal width excluding the steps at the two ends of the total range of analog input values.
NOTE: Ideally, the width of each end steps is one half of the width of any other step. (See Figure 1.)

## Linear DAC

A DAC having steps ideally of equal height. (See Figure 2.)

## LSB, Abbreviation

The abbreviation for "Least Significant Bit", that is, for the bit that has the lowest positional weight in a natural binary numeral.

Example: In the natural binary numeral "1010", the rightmost bit "0" is the LSB.

## GLOSSARY

TERMS, DEFINITIONS AND LETTER SYMBOLS


b. AFTER OFFSET ADJUSTMENT
c. AFTER OFFSET AND GAIN ADJUSTMENTS

NOTE: In the above examples, the offset point is referred to the step with the digital code 000, and the gain point is referred to the step with the digital code 111.

FIGURE 4. ADJUSTMENT IN OFFSET POINT AND GAIN POINT FOR AN ADC

a. BEFORE ADJUSTMENT


NOTE: In the above examples, the offset point is referred to the step with the digital code 000 , and the gain point is referred to the step with the digital code 111.

FIGURE 5. ADJUSTMENT IN OFFSET AND GAIN POINT FOR A DAC

## GLOSSARY <br> TERMS, DEFINITIONS AND LETTER SYMBOLS

## LSB, Unit Symbol (for linear converters only)

The unit symbol for the magnitude of the analog resolution of a linear converter, which serves as a reference unit to express the magnitude of other analog quantities of that same converter, especially of analog errors, as multiples or submultiples of the magnitude of the analog resolution.

Example: " $1 / 2$ LSB" means an analog quantity equal to 0.5 times the analog resolution.
NOTE: The unit symbol LSB refers to the fact that, for a natural binary code, the analog resolution corresponds to the nominal positional weight attributed to the least significant bit of the binary numeral.

In this case, the identity:
$1 \mathrm{LSB}=$ analog resolution
leads, for an n-bit resolution, to:

$$
1 \text { LSB }=\frac{\text { FSR }}{2^{n}-1}=\frac{\text { FSR(nom) }}{2^{n}}
$$

## Midstep Value (of an ADC)

The analog value for the center of the step excluding the steps at the two ends of the total range of analog input values.

NOTE: For the end steps, the midstep value is defined as the analog value that results when the analog value for the transition to the adjacent step is reduced or enlarged, as appropriate, by half the nominal value of the step width. (See Figure 1.)

## Midstep Value, Nominal (of an ADC)

A specified analog value within a step that is ideally represented free of error by the corresponding digital output code. (See Figure 1.)

## Missing Code (of an ADC)

An intermediate code that is absent when the changing analog input to an ADC causes a multiple code change in the digital output. (See Figure 6.)

## Monotonicity (of an ADC or a DAC)

A property of the transfer function that ensures the consistent increase or decrease of the analog output of a DAC or the digital output of an ADC in response to a consistent increase or decrease of the digital or analog input, respectively. (Figure 7 illustrates nonmonotonic conversion.)

NOTE: An intermediate increment with the value of zero does not invalidate monotonicity.

## Multiplying DAC

A DAC having at least two inputs, at least one of which is digital, and whose analog output value is proportional to the product of the inputs:

## Nonlinear ADC or DAC

An ADC or a DAC with a specified nonlinear transfer function between the nominal midstep values or nominal step values, respectively, and the corresponding step widths or step heights, respectively.

NOTE: The function may be continuously nonlinear or piece-wise linear.

## Offset Point (of an adjustable ADC or DAC)

The point in the transfer diagram corresponding to the midstep value (for an ADC) or the step value (for a DAC) of the step about which the transfer diagram rotates when gain is adjusted. (See Figures 4 and 5.)

NOTE: Offset adjustment must be performed with respect to this point so that it causes only a parallel displacement of the transfer diagram, without changing its slope.

## GLOSSARY <br> TERMS, DEFINITIONS AND LETTER SYMBOLS



FIGURE 7. NONMONOTONIC CONVERSION OF AN ADC OR DAC

## Resolution (general term)

NOTE 1: Resolution as a capability can be expressed in different forms: (see "resolution, analog", "resolution, numerical", and "resolution, relative").

NOTE 2: Resolution is a design parameter and therefore has only a nominal value.
NOTE 3: The terms for these different forms may all be shortened to "resolution" if no ambiguity is likely to occur (for example, when the dimension of the term is also given).

## Resolution (of an ADC)

The degree to which nearly equal values of the analog input quantity can be discriminated.

## Resolution (of a DAC)

The degree to which nearly equal values of the analog output quantity can be produced.

## Resolution, Analog (of a linear or nonlinear ADC or DAC)

For an ADC: The nominal value of the step width.
For a DAC: The nominal value of the step height.
NOTE: For a linear ADC or DAC, the constant magnitude of the analog resolution is often used as the reference unit LṢB.

## Resolution, Numerical

The number ( n ) of digits in the chosen numbering system necessary to express the total number of steps.
NOTE 1: The numbering system is normally a binary or a decimal system.
NOTE 2: In the binary-coded-decimal numbering system, the term " $1 / 2$ digit" refers to an additional decimal digit with the highest positional value, but limited to the decimal figures "0" or "1" as it is represented by only a single bit. This additional digit serves to double the range of values covered by the other " n " digits.

## Resolution, Relative (of a linear ADC or DAC)

The ratio of the analog resolution to the full-scale range (practical or nominal).
NOTE: This ratio is normally expressed as a percentage of the full-scale range [\% of FSR, \% of FSR(nom)]. For high resolutions (high value of $n$ ), it is of little importance whether this ratio refers to the practical or nominal full-scale range.

## Step (of an analog-to-digital or digital-to-analog conversion)

In the conversion code: Any of the individual correlations.
In the transfer diagram: Any part of the diagram equating to an individual correlation.
For an ADC, a step represents both a fractional range of analog input values and the corresponding digital output code. (See Figure 1.)
For a DAC, a step represents both a digital input code and the corresponding discrete analog output value. (See Figure 2.)

## Step Height (Step Size) (of a DAC)

The absolute value of the difference in step value between two adjacent steps in the transfer diagram. (See Figure 2.)
NOTE: For companding DACs, the term "step size" is in general use.

## GLOSSARY

TERMS, DEFINITIONS AND LETTER SYMBOLS

## Step Value (of a DAC)

The value of the analog output representing a digital input code. (See Figure 2.)
Step Value, Nominal (of a DAC)
A specified step value that represents free of error the corresponding digital input code. (See Figure 2.)

## Step Width (of an ADC)

The absolute value of the difference between the two ends of the range of analog values corresponding to one step. (See Figure 1.)

## Temperature Coefficients of Analog Characteristics ( $\alpha$ )

NOTE 1: The letter symbol for the temperature coefficient of an analog characieristic consists of the letter symbol $\alpha$ with a subscript referring to the relevant characteristic.
Example: Temperature coefficient of the gain error: $\alpha E G$
NOTE 2: Temperature coefficients are usually specified in "parts per million (relative to the full-scale value) per degrees Celsius", that is, in "ppm/ ${ }^{\circ} \mathrm{C}^{\prime \prime}$.

Zero Scale (of an ADC or a DAC with true zero) (See Figures 3a and 3b)
A term used to refer a characteristic to the step whose nominal midstep value or nominal step value equals zero.
NOTE 1: The subscript for the letter symbol of a characteristic at zero scale is "ZS".
NOTE 2: In place of a letter symbol, the abbreviation " $Z$ " is in common use.
Zero Scale, Negative (of an ADC or a DAC with no true zero) (See Figure 3c)
A term used to refer a characteristic to the negative step closest to analog zero.
NOTE 1: The subscript for the letter symbol of a characteristic at negative zero scale is "ZS-" (VZS-, IZS-).
NOTE 2: In place of a letter symbol, the abbreviation "ZS-" is in common use.
Zero Scale, Positive (of an ADC or a DAC with no true zero) (See Figure 3c)
A term used to refer a characteristic to the positive step closest to analog zero.
NOTE 1: The subscript for the letter symbol of a characteristic at positive zero scale is "ZS + " ( $\mathrm{V} \mathrm{ZS}_{+}$, IZS + )
NOTE 2: In place of a letter symbol, the abbreviation " $\mathrm{ZS}+$ " is in common use.

## 2. STATIC PERFORMANCE

## Accuracy (see "Errors", Part 4)

Asymmetry, Full-Scale (of a DAC with a bipolar analog range) ( $\Delta \mathrm{I} F S S, \Delta V_{F S S}$ )
The difference between the absolute values of the two full-scale analog values.
Compliance, Current (of a DAC) (IO(op))
The permissible range of output current within which the specifications are valid.
Compliance, Voltage (of a DAC) (VO(op))
The permissible range of output voltage within which the specifications are valid.

## Errors (see Part 4)

## Supply Voltage Sensitivity, (of a DAC) (ksvS)

The change in full scale output current (or voltage) caused by a change in supply voltage.
NOTE: This sensitivity is usually expressed as the ratio of the percent change of full-scale current (or voltage) to the percent change of supply voltage.

## 3. DYNAMIC PERFORMANCE

Conversion Rate (of an externally controlled ADC) ( fc )
The number of conversions per unit time.
NOTE 1: The maximum conversion rate should be specified for full resolution.
NOTE 2: The conversion rate is usually expressed as the number of conversions per second.
NOTE 3: Due to additionally needed settling or recovery times, the maximum specified conversion rate is smaller than the reciprocal of the worst-case conversion time.

## Conversion Time (of an ADC) ( $\mathrm{t}_{\mathrm{c}}$ )

The time elapsed between the command to perform a conversion and the appearance at the converter output of the complete digital representation of the analog input value.

Delay Time, (Digital) (of a linear or a multiplying DAC) ( $\mathrm{t}_{\mathrm{d}}, \mathrm{t}_{\mathrm{dd}}$ )
The time interval between the instant when the digital input changes and the instant when the analog output passes a specified value that is close to its initial value, ignoring glitches. (See Figure 8.)
NOTE: For a multiplying DAC, the full term and the additional subscript d must be used to distinguish between the digital and the delay time.

Delay Time, Reference (of a multiplying DAC) ( tdr )
The time interval between the instant when a step change of the reference voltage occurs and the instant when the analog output passes a specified value that is close to its initial value.

## Feedthrough Capacitance ( $\mathrm{C}_{\mathrm{F}}$ )

The value of the capacitance for a specified value of $R$ in an equivalent circuit for the calculation of the feedthrough error.
NOTE: The equivalent circuit consists of a high-pass R-C filter between the reference input and the analog output.

Feedthrough Error (see Part 4)

## Glitch (of a DAC)

A short, undesirable transient in the analog output occurring following a code change at the digital input. (See Figure 8.)

## Glitch Area (of a DAC)

The time integral of the analog value of the glitch transient.
NOTE 1: Usually, the maximum specified glitch area refers to a specified worst-case code change.
NOTE 2: Instead of a letter symbol, the abbreviation "GA" is in use.

## Glitch Energy (of a DAC)

The time integral of the electrical power of the glitch transient.
NOTE 1: Usually, the maximum specified glitch energy refers to a specified worst-case code change.
NOTE 2: Instead of a letter symbol, the abbreviation "GE" is in use.


FIGURE 8. OUTPUT CHARACTERISTICS OF A LINEAR OR A MULTIPLYING DAC FOR A STEP CHANGE IN THE DIGITAL INPUT CODE

Pedestal (Error) (Ep) (see Part 4)
Ramp Delay, Steady-State (of a multiplying DAC) (td(ramp))
The time separation between the actual curve of the analog output and the theoretical curve (with no delay) for a ramp in reference voltage, after the settling time to steady-state ramp has elapsed. (See Figure 9.)

## Settling Time, Analog (of a DAC) ( $t_{s a}$ )

The time interval between the instant when the analog output passes a specified value and the instant when the analog output enters for the last time a specified error band about its final value. (See Figures 8 and 10.)

Settling Time, (Digital) (of a linear or a multiplying DAC) ( $\mathbf{t}_{\mathbf{s}}, \mathrm{t}_{\mathbf{s}} \mathrm{d}$ )
The time interval between the instant when the digital input changes and the instant when the analog output value enters for the last time a specified error band about its final value. (See Figure 8.)

NOTE: For a multiplying DAC, the full term and the additional subscript $d$ must be used to distinguish between the digital and the settling time.

## Settling Time, Reference (of a multiplying DAC) ( $\mathbf{t s r}_{\text {sr }}$ )

The time interval between the instant when a step change of the reference voltage occurs and the instant when the analog output enters for the last time a specified error band about its final value. (See Figure 10.)

NOTE: Specifications for the reference settling time are usually given for the highest allowed step change in reference voltage.


FIGURE 9. OUTPUT CHARACTERISTICS FOR A RAMP IN REFERENCE VOLTAGE OF A MULTIPLYING DAC

$t_{d r}=$ Reference Delay Time
$t_{\text {sr }}=$ Reference Settling Time
$\mathbf{S}_{\mathrm{OMR}}=$ Reference Slew Rate
$\mathrm{t}_{\mathrm{sa}}=$ Analog Settling Time

FIGURE 10. OUTPUT CHARACTERISTICS FOR A STEP CHANGE IN REFERENCE VOLTAGE OF A MULTIPLYING DAC

## GLOSSARY <br> TERMS, DEFINITIONS AND LETTER SYMBOLS

## Setting Time to Steady-State Ramp (of a multiplying DAC) ( $\mathbf{t}_{\mathbf{s} \text { (ramp) }}$ )

The time interval between the instant a ramp in the reference voltage starts and the instant when the analog output value enters for the last time a specified error band about the final ramp in the output. (See Figure 9.)

## Skewing Time, Internal (of a DAC)

The difference in internal delay between the individual output transitions for a given change of digital input.
NOTE: The internal (and external) skew has a major influence on the settling time for critical changes in the digital input, for example, for a 1 -LSB change from $011 \ldots 111$ to $100 \ldots 000$, and is an important source of commutation noise.

Slew Rate, (Digital) (of a linear or a multiplying DAC) (SOM, SOMD)
The maximum rate of change of the analog output value when a change of the digital input code causes a large step change of the analog output value. (See Figure 8.)
NOTE 1: For a multiplying DAC, the full term and the additional subscript $D$ must be used to distinguish between the digital and the slew rate.

NOTE 2: The abbreviations "SR" and "SR(dig)" are also used.

## Slew Rate, Reference (of a multiplying DAC) (SOMR)

The maximum rate of change of the analog output following a large step change of the reference voltage. (See Figure 10.)
NOTE: The abbreviation "SR(ref)" is also used.

## 4. ERRORS, ACCURACY

The definitions in this section describe the errors as the difference between the actual value and the nominal value of the analog quantity. As such they may be expressed in conventional units (for example, millivolts) or as multiples or submultiples of 1 LSB. An error can also be expressed as a relative value, for example, in "\% of FSR". In this case, it is common practice to use the same term as for the analog value.

## Absolute Accuracy Error

Synonym for total error.

## Feedthrough Error (of a multiplying DAC) ( $\mathrm{E}_{\mathrm{F}}$ )

An error in analog output due to variation in the reference voltage that appears as an offset error and is proportional to frequency and amplitude of the reference signal.
NOTE 1: The specification for the feedthrough error is given for the digital input for which the offset error is specified, and for a reference signal of specified frequency and amplitude.
NOTE 2: This error may also be expressed as a peak-to-peak analog value.
Full-Scale Error (of a linear ADC or DAC) (EFS)
The difference between the actual midstep value or step value and the nominal midstep value or step value, respectively, at specified full scale.

NOTE: Normally, this error specification is applied to converters that have no arrangement for an external adjustment of offset error and gain error.

## GLOSSARY

TERMS, DEFINITIONS AND LETTER SYMBOLS

Gain Error (of a linear ADC or DAC) (EG)
For an ADC: The difference between the actual midstep value and the nominal midstep value in the transfer diagram at the specified gain point after the offset error has been adjusted to zero. (See Figure 11a.)

For a DAC: The difference between the actual step value and the nominal step value in the transfer diagram at the specified gain point after the offset error has been adjusted to zero. (See Figure 11b.)
NOTE: See Notes 1 and 2 under "Offset Error".


FIGURE 11. GAIN ERROR OF A LINEAR 3-BIT NATURAL BINARY CODE CONVERTER (SPECIFIED AT STEP 111), AFTER CORRECTION OF THE OFFSET ERROR

Instability, Long-Term (Accuracy) ( $\Delta \mathrm{E}(\Delta \mathrm{t}), \Delta \mathrm{E}(\mathrm{t})$ )
The additional error caused by the aging of the components and specified for a longer period in time.

## Linearity Error, Best-Straight-Line (of a linear and adjustable ADC) (EL(adj))

The difference between the actual analog value at the transition between any two adjacent steps and its ideal value after offset error and gain error have been adjusted to minimize the magnitude of the extreme values of this difference. (See Figure 12a.)
NOTE 1: The inherent quantization error is not included in the best-straight-line linearity error of an ADC. The ideal value for the transition corresponds to the nominal midstep value $\pm 1 / 2$ LSB.

NOTE 2: For a uniformly curved transfer diagram, the extreme values will be very close to half of the magnitude of the end-point linearity error. (See Figure 12a.)


FIGURE 12. BEST-STRAIGHT-LINE LINEARITY ERROR OF A LINEAR 3-BIT NATURAL BINARY-CODED CONVERTER (VALUES BETWEEN $\pm 1 / 4$ LSB)

Linearity Error, Best-Straight-Line (of a linear and adjustable DAC) (EL(adj))
The difference between the actual step value and the nominal step value after offset error and gain error have been adjusted to minimize the magnitude of the extreme values of this difference. (See Figure 12b.)
NOTE: For a uniformly curved transfer diagram, the extreme values will be very close to half of the magnitude of the end-point linearity error. (See Figure 12b.)

Linearity Error, Differential (of a linear ADC or DAC) (ED)
The difference between the actual step width or step height and the ideal value (1 LSB). (See Figure 13.)
NOTE: A differential linearity error greater than 1 LSB can lead to missing codes in an ADC or to nonmonotonicity of an ADC or a DAC. (See Figures 6 and 7.)

Linearity Error, End-Point (of a linear and adjustable ADC) ( $E_{L}$ )
The difference between the actual analog value at the transition between any two adjacent steps and its ideal value after offset error and gain error have been adjusted to zero. (See Figure 14a.)

NOTE 1: The short term "linearity error" is in common use and is sufficient if no ambiguity with the "best-straight-line linearity error" is likely to occur.
NOTE 2: The inherent quantization error is not included in the linearity error of an ADC. The ideal value for the transition corresponds to the nominal midstep value $\pm 1 / 2$ LSB.

TERMS, DEFINITIONS AND LETTER SYMBOLS


b. DAC

FIGURE 13. DIFFERENTIAL LINEARITY ERROR OF A LINEAR ADC OR DAC

## GLOSSARY TERMS, DEFINITIONS AND LETTER SYMBOLS



FIGURE 14. END-POINT LINEARITY ERROR OF A LINEAR 3-BIT NATURAL BINARY-CODED ADC OR DAC (OFFSET ERROR AND GAIN ERROR ARE ADJUSTED TO THE VALUE ZERO)

## Linearity Error, End-point (of a linear and adjustable DAC) (EL)

The difference between the actual step value and the nominal step value after offset error and gain error have been adjusted to zero. (See Figure 14b.)
NOTE: The short term "linearity error" is in common use and is sufficient if no ambiguity with the "best-straightline linearity error" is likely to occur.

## Offset Error (of a linear ADC or DAC) (EO)

For an ADC: The difference between the actual midstep value and the nominal midstep value at the offset point. (See Figure 15a.)
For a DAC: The difference between the actual step value and the nominal step value at the offset point. (See Figure 15b.)
NOTE 1: Usually, the specified steps for the specification of offset error and gain error are the steps at the ends of the practical full-scale range. For an ADC, the midstep value of these steps is defined as the value for a point 1/2 LSB apart from the adjacent transition. (See Figures 11 and 15.)

NOTE 2: The terms "offset error" and "gain error" should be used only for errors that can be adjusted to zero. Otherwise, the terms "zero-scale error" and "full-scale error" should be used.

## Pedestal (Error) (Ep)

A dynamic offset error produced in the commutation process.

## GLOSSARY

TERMS, DEFINITIONS AND LETTER SYMBOLS
(

FIGURE 15. OFFSET ERROR OF A LINEAR 3-BIT NATURAL BINARY CODE CONVERTER (SPECIFIED AT STEP 000)

## Quantization Error, Inherent (of an ideal ADC)

Within a step, the maximum (positive or negative) possible deviation of the actual analog input value from the nominal midstep value.

NOTE 1: This error follows necessarily from the quantization procedure. For a linear ADC, its value equals $\pm 1 / 2$ LSB. (See Figure 1.)

NOTE 2: The term "resolution error" for the "inherent quantization error" is deprecated, because "resolution" as a design parameter has only a nominal value.

Rollover Error (of an ADC with decimal output and auto-polarity) (ERO)
The difference in output readings with the analog input switched between positive and negative values of the same magnitude (close to full scale).

Total Error (of a linear ADC) ( $\mathrm{E}_{\mathrm{T}}$ )
The maximum difference (positive or negative) between an analog value and the nominal midstep value within any step. (See Figure 16a.)
NOTE 1: If this error is expressed as a relative value, the term "relative accuracy error" should be used instead of "absolute accuracy error".
NOTE 2: This error includes contributions from offset error, gain error, linearity error, and the inherent quantization error.


FIGURE 16. ABSOLUTE ACCURACY ERROR, TOTAL ERROR OF A LINEAR ADC OR DAC
Total Error (of a linear DAC) (ET)
The difference (positive or negative) between the actual step value and the nominal step value for any step. (See Figure 16b.)

NOTE 1: If this error is expressed as a relative value, the term "relative accuracy error" should be used instead of "absolute accuracy error".
NOTE 2: This error includes contributions from offset error, gain error, and linearity error.
Zero-Scale Error (of a linear ADC or DAC) (EZS)
The difference between the actual midstep value or step value and the nominal midstep value or step value, respectively, at specified zero scale.
NOTE: Normally, this error specification is applied to converters that have no arrangement for an external adjustment of offset error and gain error.

## Data Sheets

## Product Previews

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- Advanced LinCMOS ${ }^{T M}$ Silicon-Gate Technology
- Easily Interfaced to Microprocessors
- On-Chip Data Latches
- Monotonicity Over Entire A/D Conversion Range
- Segmented High-Order Bits Ensure LowGlitch Output
- Designed to be Interchangeable with Analog Devices AD7524, PMI PM-7524, and Micro Power Systems MP7524
- Fast Control Signaling for Digital Signal Processor Applications Including Interface with TMS320

| KEY PERFORMANCE SPECIFICATIONS |  |
| :---: | :---: |
| Resolution | 8 Bits |
| Linearity error | $1 / 2$ LSB Max |
| Power dissipation at $V_{D D}=5 \mathrm{~V}$ | 5 mW Max |
| Settling time | 100 ns Max |
| Propagation delay | 80 ns Max |

## description

The AD7524 is an Advanced LinCMOS ${ }^{\text {m }} 8$-bit digital-to-analog converter (DAC) designed for easy interface to most popular microprocessors.

The AD7524 is an 8-bit multiplying DAC with input latches and with a load cycle similar to the "write" cycle of a random access memory. Segmenting the high-order bits minimizes glitches during changes in the most-significant bits, which produce the highest glitch impulse. The AD7524 provides accuracy to $1 / 2$ LSB without the need for thin-film resistors or laser trimming, while dissipating less than 5 mW typically.

Featuring operation from a $5-\mathrm{V}$ to $15-\mathrm{V}$ single supply, the AD7524 interfaces easily to most microprocessor buses or output ports. Excellent multiplying (2 or 4 quadrant) makes the AD7524 an ideal choice for many microprocessor-controlled gain-setting and signal-control applications.
The AD7524A is characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the AD7524J is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

AVAILABLE OPTIONS

| SYMBOLIZATION |  | OPERATING <br> TEMPERATURE |
| :---: | :---: | :---: |
| DEVICE | PACKAGE <br> SUFFIXES |  |
| AD7524A | N | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7524J | $\mathrm{N}, \mathrm{FN}$ | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |

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AD7524
Advanced LinCMOS ${ }^{\text {TM }}$ 8-BIT MULTIPLYING
DIGITAL-TO-ANALOG CONVERTER

## functional block diagram


operating sequence

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VDD | -0.3 V to 17 V |
| :---: | :---: |
| Voltage between RFB and GND | $\pm 25 \mathrm{~V}$ |
| Digital input voltage, $\mathrm{V}_{1}$ | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ | $\pm 25 \mathrm{~V}$ |
| Peak digital input current, II | $10 \mu \mathrm{~A}$ |
| Operating free-air temperature range: AD7524A | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7524J | . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN package | $260^{\circ} \mathrm{C}$ |
| ead temperature $1,6 \mathrm{~mm}$ (1/16 inch) from |  |

recommended operating conditions

|  |  |  | D $=$ |  |  | $D=1$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| Supply voltage, VDD |  | 4.75 | 5 | 5.25 | 14.5 | 15 | 15.5 | V |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ |  |  | $\pm 10$ |  |  | $\pm 10$ |  | V |
| High-level input voltage, $\mathrm{V}_{1}$ |  | 2.4 |  |  | 13.5 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 |  |  | 1.5 | V |
| $\overline{\mathrm{CS}}$ setup time, $\mathrm{t}_{\text {su( }}$ (CS) |  | 40 |  |  | 40 |  |  | ns |
| $\overline{\mathrm{CS}}$ hold time, th(CS) |  | 0 |  |  | 0 |  |  | ns |
| Data bus input setup time, $\mathrm{t}_{\text {SU }}(\mathrm{D})$ |  | 25 |  |  | 25 |  |  | ns |
| Data bus input hold time, $\mathrm{th}_{\mathrm{h}}(\mathrm{D})$ |  | 10 |  |  | 10 |  |  | ns |
| Pulse duration, $\overline{W R}$ low, $\mathrm{t}_{\mathrm{W}}(\mathrm{WR})$ |  | 40 |  |  | 40 |  |  | ns |
| Operating free-air tem | AD7524A | -25 |  | 85 | -25 |  | 85 |  |
| A | AD7524J | 0 |  | 70 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $V_{\text {DD }}=15 \mathrm{~V}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN MAX |  |
| Linearity error |  |  | $\pm 0.2$ | $\pm 0.2$ | \%FSR |
| Gain error | See Note 1 | Full range | $\pm 1.4$ | $\pm 0.6$ | \%FSR |
|  |  | $25^{\circ} \mathrm{C}$ | $\pm 1$ | $\pm 0.5$ |  |
| Settling time (to 1/2 LSB) | See Note 2 |  | 100 | 100 | ns |
| Propagation delay from digital input to $90 \%$ of final analog output current | See Note 2 |  | 80 | 80 | ns |
| Feedthrough at OUT1 or OUT2 | $V_{\mathrm{ref}}= \pm 10 \mathrm{~V}(100 \mathrm{kHz}$ <br> sinewave), $\overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 , DBO-DB7 at 0 | Full range | 0.5 | 0.5 | \%FSR |
|  |  | $25^{\circ} \mathrm{C}$ | 0.25 | 0.25 |  |
| Temperature coefficient of gain | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ to $\mathrm{t}_{\min }$ or $\mathrm{t}_{\max }$ |  | $\pm 0.004$ | $\pm 0.001$ | \%FSR $/{ }^{\circ} \mathrm{C}$ |

NOTES: 1. Gain error is measured using the internal feedback resistor. Nominal Full Scale Range (FSR) $=V_{\text {ref }}-1$ LSB.
2. OUT1 load $=100 \Omega, C_{e x t}=13 \mathrm{pF}, \overline{\mathrm{WR}}$ at $0 \mathrm{~V}, \overline{\mathrm{CS}}$ at $0 \mathrm{~V}, \mathrm{DBO}-\mathrm{DB7}$ at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .

## PRINCIPLES OF OPERATION

The AD7524 is an 8-bit multiplying D/A converter consisting of an inverted R-2R ladder, analog switches, and data input latches. Binary weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state. The high-order bits are decoded and these decoded bits, through a modification in the R-2R ladder, control three equally weighted current sources. Most applications only require the addition of an external operational amplifier and a voltage reference.

The equivalent circuit for all digital inputs low is seen in Figure 1. With all digital inputs low, the entire reference current, Iref, is switched to OUT2. The current source I/256 represents the constant current flowing through the termination resistor of the R-2R ladder, while the current source l/kg represents leakage currents to the substrate. The capacitances appearing at OUT1 and OUT2 are dependent upon the digital input code. With all digital inputs high, the off-state switch capacitance ( 30 pF maximum) appears at OUT2 and the on-state switch capacitance ( 120 pF maximum) appears at OUT1. With all digital inputs low, the situation is reversed as shown in Figure 1. Analysis of the circuit for all digital inputs high is similar to Figure 1; however, in this case, Iref would be switched to OUT1.
Interfacing the AD7524 D/A converter to a microprocessor is accomplished via the data bus and the $\overline{C S}$ and $\overline{\mathrm{WR}}$ control signals. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ are both low, the AD7524 analog output responds to the data activity on the DBO-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the $\overline{\mathrm{CS}}$ signal or $\overline{\mathrm{WR}}$ signal goes high, the data on the DBO-DB7 inputs are latched until the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled regardless of the state of the $\overline{W R}$ signal.
The AD7524 is capable of performing 2 -quadrant or full 4 -quadrant multiplication. Circuit configurations for 2-quadrant or 4-quadrant multiplication are shown in Figures 2 and 3. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.

PRINCIPLES OF OPERATION


FIGURE 1. AD7524 EQUIVALENT CIRCUIT WITH ALL DIGITAL INPUTS LOW


FIGURE 2. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)


FIGURE 3. BIPOLAR OPERATION (4-QUADRANT OPERATION)

NOTES: 3. $R_{A}$ and $R_{B}$ used only if gain adjustment is required.
4. C phase compensation ( $10-15 \mathrm{pF}$ ) is required when using high-speed amplifiers to prevent ringing or oscillation.

Advanced LinCMOS ${ }^{\text {™ }}$ 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

PRINCIPLES OF OPERATION

Table 1. Unipolar Binary Code

| DIGITAL INPUT <br> (SEE NOTE 5) | ANALOG OUTPUT |
| :--- | :--- |
| MSB LSB |  |
| 11111111 | $-V_{\text {ref }}(255 / 256)$ |
| 10000001 | $-V_{\text {ref }}(129 / 256)$ |
| 10000000 | $-V_{\text {ref }}(128 / 256)=-V_{\text {ref }} / 2$ |
| 01111111 | $-V_{\text {ref }}(127 / 256)$ |
| 00000001 | $-V_{\text {ref }}(1 / 256)$ |
| 00000000 | 0 |

Table 2. Bipolar (Offset Binary) Code

| DIGITAL INPUT <br> (SEE NOTE 6) | ANALOG OUTPUT |
| :--- | :--- |
| MSB LSB |  |
| 11111111 | $\mathrm{~V}_{\text {ref }}(127 / 128)$ |
| 10000001 | $\mathrm{~V}_{\text {ref }}(1 / 128)$ |
| 10000000 | 0 |
| 01111111 | $-\mathrm{V}_{\text {ref }}(1 / 128)$ |
| 00000001 | $-\mathrm{V}_{\text {ref }}(127 / 128)$ |
| 00000000 | $-\mathrm{V}_{\text {ref }}$ |

NOTES: $\quad 5 . \operatorname{LSB}=1 / 256\left(V_{\text {ref }}\right)$.
6. $L S B=1 / 128\left(V_{\text {ref }}\right)$.
microprocessor interfaces


FIGURE 4. AD7524-Z-80A INTERFACE


FIGURE 5. AD7524-6800 INTERFACE
microprocessor interfaces (continued)


FIGURE 6. AD7524-8051 INTERFACE

- Advanced LinCMOS ${ }^{m}$ Silicon-Gate Technology
- Easily Interfaced to Microprocessors
- On-Chip Data Latches
- Monotonic Over the Entire A/D Conversion Range
- Designed to be Interchangeable with Analog Devices AD7528 and PMI PM-7528
- Fast Control Signaling for Digital Signal Processor Applications Including Interface with TMS320

| KEY PERFORMANCE SPECIFICATIONS |  |
| :--- | :---: |
| Resolution | 8 bits |
| Linearity Error | $1 / 2 \mathrm{LSB}$ |
| Power Dissipation at $V_{D D}=5 \mathrm{~V}$ | 5 mW |
| Settling Time at $V_{D D}=5 \mathrm{~V}$ | 100 ns |
| Propagation Delay at $V_{D D}=5 \mathrm{~V}$ | 80 ns |

## description

The AD7528 is a dual 8 -bit digital-to-analog converter designed with separate on-chip data latches and featuring excellent DAC-to-DAC matching. Data is transferred to either of the two DAC data latches via a common 8-bit input port. Control input $\overline{D A C A} / D A C B$ determines which DAC is to be loaded. The "load" cycle of the
AD7528 is similar to the "write" cycle of a random-access memory, allowing easy interface to most popular microprocessor busses and output ports. Segmenting the high-order bits minimizes glitches during changes in the most significant bits, where glitch impulse is typically the strongest.

The AD7528 operates from a $5-\mathrm{V}$ to $15-\mathrm{V}$ power supply and dissipates less than 15 mW (typical). Excellent 2- or 4-quadrant multiplying makes the AD7528 a sound choice for many microprocessor-controlled gainsetting and signal-control applications.
The AD7528B is characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The $A D 7528 \mathrm{~K}$ is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

AVAILABLE OPTIONS

| SYMBOLIZATION |  | OPERATING <br> TEMPERATURE <br> DEVICE |
| :---: | :---: | :---: |
| PACKAGE <br> SUFFIX | RANGE |  |
| AD7528B | FN, N | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7528K | FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |

AD7528
Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER
functional block diagram

operating sequence

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VDD (to AGND or DGND) | -0.3 V to 17 V |
| :---: | :---: |
| Voltage between AGND and DGND | $\pm V_{\text {DD }}$ |
| Input voltage, $\mathrm{V}_{\text {I }}$ (to DGND) | -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ or $\mathrm{V}_{\text {refB }}$ (to AGND) | $\pm 25 \mathrm{~V}$ |
| Feedback voltage, VRFBA or $\mathrm{V}_{\text {RFBB }}$ (to AGND) | $\pm 25 \mathrm{~V}$ |
| Output voltage, $\mathrm{V}_{\mathrm{OA}}$ or $\mathrm{V}_{\text {OB }}$ (to AGND) | $\pm 25 \mathrm{~V}$ |
| Peak input current | . $10 \mu \mathrm{~A}$ |
| Operating free-air temperature range: AD7528B | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7528K | . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN package. | $260^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case | $260^{\circ} \mathrm{C}$ |

recommended operating conditions


AD7528

## Advanced LinCMOS ${ }^{T w}$ DUAL 8-BIT MULTIPLYING

DIGITAL-TO-ANALOG CONVERTER
electrical characteristics over recommended operating temperature range, $\mathrm{V}_{\text {ref }}=\mathrm{V}_{\text {refB }}=10 \mathrm{~V}$, $V_{O A}$ and $V_{O B}$ at 0 V (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN MAX |  |
| ${ }^{\prime} \mathrm{IH}$ | High-level input current |  |  |  | $V_{I}=V_{D D}$ | Full Range | 10 | 10 | $\mu \mathrm{A}$ |
|  |  |  | $25^{\circ} \mathrm{C}$ | 1 |  | 1 |  |  |
| IIL. | Low-level input current |  | $V_{1}=0$ | Full Range | -10 | -10 | $\mu \mathrm{A}$ |  |
|  |  |  | $25^{\circ} \mathrm{C}$ | -1 | -1 |  |  |
|  | Reference input impedance (Pin 15 to GND) |  |  |  |  | 815 | 815 | $\mathrm{k} \Omega$ |  |
| I/kg | Output leakage current | OUTA | DAC data latch loaded with $00000000, V_{\text {refA }}= \pm 10 \mathrm{~V}$ | Full Range | $\pm 400$ | $\pm 200$ | nA |  |
|  |  |  |  | $25^{\circ} \mathrm{C}$ | $\pm 50$ | $\pm 50$ |  |  |
|  |  | OUTB | DAC data latch loaded with $00000000, V_{\text {refB }}= \pm 10 \mathrm{~V}$ | Full Range | $\pm 400$ | $\pm 200$ |  |  |
|  |  |  |  | $25^{\circ} \mathrm{C}$ | $\pm 50$ | $\pm 50$ |  |  |
| Input resistance match (REFA to REFB) |  |  |  |  | $\pm 1 \%$ | $\pm 1 \%$ |  |  |
| DC supply sensitivity $\Delta$ gain $/ \Delta V_{D D}$ |  |  | $V_{D D}= \pm 10 \%$ | Full Range | 0.04 | 0.02 | \%/\% |  |
|  |  |  | $25^{\circ} \mathrm{C}$ | 0.02 | 0.01 |  |  |
| ${ }^{\text {I D D }}$ | Supply current | Quiescent |  | DB0-DB7 at $\mathrm{V}_{\text {IH }}$ min or $\mathrm{V}_{\text {IL }}$ max |  | 1 | 1 | mA |  |
|  |  | Standby | DB0-DB7 at 0 V or $\mathrm{V}_{\mathrm{DD}}$ | Full Range | 0.5 | 0.5 |  |  |  |
|  |  |  |  | $25^{\circ} \mathrm{C}$ | 0.1 | 0.1 |  |  |  |
| $\mathrm{C}_{i}$ | Input capacitance | DB0-DB7 | $V_{1}=0$ or $V_{D D}$ |  | 10 | 10 | pF |  |  |
|  |  | $\overline{\mathrm{WR}}, \overline{\mathrm{CS}}$, $\overline{\mathrm{DACA}} / \mathrm{DACB}$ |  |  | 15 | 15 |  |  |  |
| $C_{0}$ | Output capacitance (OUTA, OUTB) |  | DAC Data latches loaded with 00000000 |  | 50 | 50 | pF |  |  |
|  |  |  | DAC Data latches loaded with 11111111 |  | 120 | 120 |  |  |  |

## AD7528 <br> Advanced LinCMOS ${ }^{\text {Tw }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

## operating characteristics over recommended operating free-air temperature range, <br> $\mathrm{V}_{\text {ref }}=\mathrm{V}_{\text {refB }}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{OA}}$ and $\mathrm{V}_{\mathrm{OB}}$ at 0 V (unless otherwise noted)



NOTES: 1. OUTA, OUTB load $=100 \Omega, C_{\text {ext }}=13 \mathrm{pF} ; \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V ; DBO-DB7 at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V
2. Gain error is measured using an internal feedback resistor. Nominal Full Scale Range (FSR) $=V_{\text {ref }}-1$ LSB.
3. $V_{\text {ref }}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; DAC data latches loaded with 0000000 .
4. $V_{\text {refA }}=V_{\text {refB }}=10 \mathrm{~V}$; OUTA/OUTB load $=100 \Omega, C_{e x t}=13 \mathrm{pF} ; \overline{W R}$ and $\overline{C S}$ at 0 V ; DBO-DB7 at 0 V to $V_{D D}$ or $V_{D D}$ to $0 V$.
5. Both DAC latches loaded with $11111111 ; V_{\text {refA }}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; $\mathrm{V}_{\text {refB }}=0$.
6. Both DAC latches loaded with $11111111 ; V_{\text {refB }}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; $V_{\text {ref }}=0$.

## principles of operation

The AD7528 contains two identical 8-bit multiplying D/A converters, DACA and DACB. Each DAC consists of an inverted R-2R ladder, analog switches, and input data latches. Binary-weighted currents are switched between DAC output and AGND, thus maintaining a constant current in each ladder leg independent of the switch state. Most applications require only the addition of an external operational amplifier and voltage reference. A simplified D/A circuit for DACA with all digital inputs low is shown in Figure 1.
Figure 2 shows the DACA equivalent circuit. A similar equivalent circuit can be drawn for DACB. Both DACs share the analog ground pin 1 (AGND). With all digital inputs high, the entire reference current flows to OUTA. A small leakage current ( 1 Ikg ) flows across internal junctions, and as with most semiconductor devices, doubles every $10^{\circ} \mathrm{C} . \mathrm{C}_{0}$ is due to the parallel combination of the NMOS switches and has a value that depends on the number of switches connected to the output. The range of $C_{0}$ is 50 pF to 120 pF maximum. The equivalent output resistance $r_{0}$ varies with the input code from $0.8 R$ to $3 R$ where $R$ is the nominal value of the ladder resistor in the R-2R network.
Interfacing the AD7528 to a microprocessor is accomplished via the data bus, $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}$, and $\overline{\mathrm{DACA}} / \mathrm{DACB}$ control signals. When $\overline{C S}$ and $\overline{W R}$ are both low, the AD7528 analog output, specified by the $\overline{\text { DACA }} / D A C B$ control line, responds to the activity on the DBO-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the $\overline{\mathrm{CS}}$ signal or $\overline{\mathrm{WR}}$ signal goes high, the data on the DBO-DB7 inputs is latched until the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled regardless of the state of the $\overline{\mathrm{WR}}$ signal.
The digital inputs of the AD7528 provide TTL compatibility when operated from a supply voltage of 5 V . The AD7528 may be operated with any supply voltage in the range from 5 V to 15 V , however, input logic levels are not TTL compatible above 5 V .

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FIGURE 1. SIMPLIFIED FUNCTIONAL CIRCUIT FOR DACA


FIGURE 2. AD7528 EQUIVALENT CIRCUIT, DACA LATCH LOADED WITH 11111111.
mode selection table

| $\overline{\text { DACA }}$ <br> DACB | $\overline{\mathbf{C S}}$ | $\overline{\text { WR }}$ | DACA | DACB |
| :---: | :---: | :---: | :---: | :---: |
| L | L | L | WRITE | HOLD |
| H | L | L | HOLD | WRITE |
| $X$ | $H$ | $X$ | HOLD | HOLD |
| $X$ | $X$ | H | HOLD | HOLD |

$\mathrm{L}=$ low level, $\mathrm{H}=$ high level, $\mathrm{X}=$ don't care

## TYPICAL APPLICATION DATA

The AD7528 is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2 -quadrant and 4-quadrant multiplication are shown in Figures 3 and 4. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.


NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Make gain adjustment with digital input of 255 .
2. C 1 and C 2 phase compensation capacitors ( 10 pF to 15 pF ) are required when using high-speed amplifiers to prevent ringing or oscillation.

FIGURE 3. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)

## TYPICAL APPLICATION DATA



NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table in Figure 3 for recommended values. Adjust R1 for $\mathrm{V}_{\mathrm{OA}}=0 \mathrm{~V}$ with code 10000000 in DACA latch. Adjust R 3 for $\mathrm{V}_{\mathrm{OB}}=0 \mathrm{~V}$ with 10000000 in DACB latch.
2. Matching and tracking are essential for resistor pairs R6, R7, R9, and R10.
3. C1 and C2 phase compensation capacitors ( 10 pF to 15 pF ) may be required if A 1 and A 3 are high-speed amplifiers.

FIGURE 4. BIPOLAR OPERATION (4-QUADRANT OPERATION)

TABLE 1. UNIPOLAR BINARY CODE

| DAC LATCH CONTENTS <br> MSB LSB $^{\dagger}$ | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $-\mathrm{V}_{\mathrm{i}}(255 / 256)$ |
| 10000001 | $-\mathrm{V}_{\mathrm{i}}(129 / 256)$ |
| 10000000 | $-\mathrm{V}_{\mathrm{i}}(128 / 256)=-\mathrm{V}_{\mathrm{i}} / 2$ |
| 01111111 | $-\mathrm{V}_{\mathrm{i}}(127 / 256)$ |
| 00000001 | $-\mathrm{V}_{\mathrm{i}}(1 / 256)$ |
| 00000000 | $-\mathrm{V}_{\mathrm{i}}(0 / 256)=0$ |

[^3]TABLE 2. BIPOLAR (OFFSET BINARY) CODE

| DAC LATCH CONTENTS <br> MSB $\quad$ LSB $^{\ddagger}$ | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $\mathrm{~V}_{\mathrm{i}}(127 / 128)$ |
| 10000001 | $\mathrm{~V}_{\mathrm{i}}(1 / 128)$ |
| 10000000 | 0 V |
| 01111111 | $-\mathrm{V}_{\mathrm{i}}(1 / 128)$ |
| 00000001 | $-\mathrm{V}_{\mathrm{i}}(127 / 128)$ |
| 00000000 | $-\mathrm{V}_{\mathrm{i}}(128 / 128)$ |

$\ddagger 1 \mathrm{LSB}=\left(2^{-7}\right) \mathrm{V}_{\mathrm{i}}$

## TYPICAL APPLICATION DATA

microprocessor interface information


NOTE: $\quad \mathrm{A}=$ decoded address for AD7528 DACA.
A $+1=$ decoded address for AD7528 DACB.
FIGURE 5. AD7528 - INTEL 8051 INTERFACE


NOTE: $\quad A=$ decoded address for AD7528 DACA.
$A+1=$ decoded address for AD7528 DACB.
FIGURE 6. AD7528-6800 INTERFACE

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TYPICAL APPLICATION DATA


NOTE: $\quad A=$ decoded address for AD7528 DACA.
$A+1=$ decoded address for AD7528 DACB.
FIGURE 7. AD7528 TO Z-80A INTERFACE
programmable window detector
The programmable window comparator shown in Figure 8 will determine if voltage applied to the DAC feedback resistors are within the limits programmed into the AD7528 data latches. Input signal range depends on the reference and polarity, that is, the test input range is 0 to $-V_{\text {ref }}$. The DACA and DACB data latches are programmed with the upper and lower test limits. A signal within the programmed limits will drive the output high.


FIGURE 8. DIGITALLY PROGRAMMABLE WINDOW COMPARATOR (UPPER• AND LOWER-LIMIT TESTER)

## TYPICAL APPLICATION DATA

## digitally controlled signal attenuator

Figure 9 shows the AD7528 configured as a two-channel programmable attenuator. Applications include stereo audio and telephone signal level control. Table 3 shows input codes vs attenuation for a 0 to 15.5 dB range.

Attenuation $\mathrm{db}=-20 \log _{10} \mathrm{D} / 256, \mathrm{D}=$ digital ilnput code


FIGURE 9. DIGITALLY CONTROLLED DUAL TELEPHONE ATTENUATOR
TABLE 3. ATTENUATION vs DACA, DACB CODE

| ATTN(dB) | DAC INPUT CODE | CODE IN <br> DECIMAL | ATTN(dB) | DAC INPUT CODE | CODE IN <br> DECIMAL |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 11111111 | 255 | 8.0 | 01100110 | 102 |
| 0.5 | 11110010 | 242 | 8.5 | 01100000 | 96 |
| 1.0 | 11100100 | 228 | 9.0 | 01011011 | 91 |
| 1.5 | 11010111 | 215 | 9.5 | 01010110 | 86 |
| 2.0 | 11001011 | 203 | 10.0 | 01010001 | 81 |
| 2.5 | 11000000 | 192 | 10.5 | 01001100 | 76 |
| 3.0 | 10110101 | 181 | 11.0 | 01001000 | 72 |
| 3.5 | 10101011 | 171 | 11.5 | 01000100 | 68 |
| 4.0 | 10100010 | 162 | 12.0 | 01000000 | 64 |
| 4.5 | 10011000 | 152 | 12.5 | 00111101 | 61 |
| 5.0 | 10010000 | 144 | 13.0 | 00111001 | 57 |
| 5.5 | 10001000 | 136 | 13.5 | 00110110 | 54 |
| 6.0 | 10000000 | 128 | 14.0 | 00110011 | 51 |
| 6.5 | 01111001 | 121 | 14.5 | 00110000 | 48 |
| 7.0 | 01110010 | 114 | 15.0 | 00101110 | 46 |
| 7.5 | 01101100 | 108 | 15.5 | 00101011 | 43 |

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## TYPICAL APPLICATION DATA

programmable state-variable filter
This programmable state-variable or universal filter configuration provides low-pass, high-pass, and bandpass outputs, and is suitable for applications in which microprocessor control of filter parameters is required.
As shown in Figure 10, DACA1 and DACB1 control the gain and $Q$ of the filter while DACA2 and DACB2 control the cutoff frequency. Both halves of the DACA2 and DACB2 must track accurately in order for the cutoff-frequency equation to be true. With the AD7528, this is easily achieved.

$$
f_{C}=\frac{1}{2 \pi R 1 C 1}
$$

The programmable range for the cutoff or center frequency is 0 to 15 kHz with a Q ranging from 0.3 to 4.5 . This defines the limits of the component values.


FIGURE 10. DIGITALLY CONTROLLED STATE-VARIABLE FILTER

## - 8-Bit Resolution

## - Ratiometric Conversion

- 100- $\boldsymbol{\mu}$ s Conversion Time
- 135-ns Access Time
- Guaranteed Monotonicity
- High Reference Ladder Impedance . . $8 \mathrm{k} \Omega$ Typical
- No Zero Adjust Requirement
- On-Chip Clock Generator
- Single 5-V Power Supply
- Operates with Microprocessor or as Stand-Alone
- Designed to be Interchangeable with National Semiconductor and Signetics ADC0803 and ADC0805


## description

The ADC0803 and ADC0805 are CMOS 8-bit, successive-approximation, analog-to-digital converters that use a modified potentiometric (256R) ladder. These devices are designed to operate from common microprocessor control buses with the three-state output latches driving the data bus. The devices can be made to appear to the microprocessor as a memory location or an I/O port. Detailed information on interfacing to most popular microprocessors is readily available from the factory.
A differential analog voltage input allows increased common-mode rejection and offset of the zero-input analog voltage value. Although a reference input (REF/2) is available to allow 8-bit conversion over smaller analog voltage spans or to make use of an external reference, ratiometric conversion is possible with the REF/2 input open. Without an external reference, the conversion takes place over a span from VCC to analog ground (ANLG GND). The devices can operate with an external clock signal or, with an additional resistor and capacitor, using an on-chip clock generator.
The ADC0803I and ADC0805I are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The ADC0803C and ADC0805C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## ADC0803, ADC0805

## 8-BIT ANALOG-TO-DIGITAL CONVERTERS

WITH DIFFERENTIAL INPUTS
functional block diagram (positive logic)


## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)



NOTE 1: All voltage values are with respect to digital ground (DGTL GND) with DGTL GND and ANLG GND connected together unless otherwise noted.
recommended operating conditions


NOTES: 2. When the differential input voltage $\left(V_{1}+-V_{1-}\right)$ is less than or equal to 0 V , the output code is 00000000 .
3. The internal reference voltage is equal to the voltage applied to REF/2 or approximately equal to one-half of the $V_{C C}$ when REF/2 is left open. The voltage at REF/2 should be one-half the full-scale differential input voltage between the analog inputs. Thus, the differential input voltage range when REF/2 is open and $V_{C C}=5 \mathrm{~V}$ is 0 V to 5 V . $\mathrm{V}_{\mathrm{REF}}$ /2 for an input voltage range from 0.5 V to 3.5 V (full-scale differential voltage of 3 V ) is 1.5 V .
4. These values are with respect to DGTL GND.
5. Total unadjusted error is specified only at an $f_{\text {clock }}$ of 640 kHz with a duty cycle of $40 \%$ to $60 \%$ (pulse duration 625 ns to 937 ns ). For frequencies above this limit or pulse duration below 625 ns , error may increase. The duty cycle limits should be observed for an flock greater than 640 kHz . Below 640 kHz , this duty cycle limit can be exceeded provided $\mathrm{t}_{\mathrm{w}}$ (CLK) remains within limits.

## ADC0803, ADC0805 <br> 8-BIT ANALOG-TO-DIGITAL CONVERTERS <br> WITH DIFFERENTIAL INPUTS

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$,
$\mathrm{f}_{\text {clock }}=640 \mathrm{kHz}, \mathrm{V}_{\mathrm{REF}} / 2=2.5 \mathrm{~V}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VOH | High-level output voltage | All outputs | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}^{\mathrm{OH}}=-360 \mu \mathrm{~A}$ | 2.4 |  |  | V |
|  |  | DB and INTR | $\mathrm{V}_{\text {CC }}=4.75 \mathrm{~V}$, | $\mathrm{IOH}^{\prime}=-10 \mu \mathrm{~A}$ | 4.5 |  |  |  |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | Data outputs | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{IOL}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |
|  |  | INTR output | $\mathrm{V}_{\text {CC }}=4.75 \mathrm{~V}$, | $1 \mathrm{OL}=1 \mathrm{~mA}$ |  |  | 0.4 |  |
|  |  | CLK OUT | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{IOL}=360 \mu \mathrm{~A}$ |  |  | 0.4 |  |
| $\mathrm{V}_{\mathrm{T}+}$ | Clock positive-going threshold voltage |  |  |  | 2.7 | 3.1 | 3.5 | V |
| $\mathrm{V}_{\mathrm{T} \text { - }}$ | Clock negative-going threshold voltage |  |  |  | 1.5 | 1.8 | 2.1 | V |
| $\mathrm{V}_{T+}-\mathrm{V}_{T-}$ | Clock input hysteresis |  |  |  | 0.6 | 1.3 | 2 | V |
| ${ }^{\text {IIH }}$ | High-level input current |  |  |  |  | 0.005 | 1 | $\mu \mathrm{A}$ |
| ILL | Low-level input current |  |  |  |  | -0.005 | -1 | $\mu \mathrm{A}$ |
| IOZ | Off-state output current |  | $\mathrm{V}_{\mathrm{O}}=0$ |  |  |  | -3 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{0}=5 \mathrm{~V}$ |  |  |  | 3 |  |
| IOHS | Short-current output current | Output high | $\mathrm{V}_{\mathrm{O}}=0$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | -4.5 | -6 |  | mA |
| IOLS | Short-circuit output current | Output low | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V}$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 9 | 16 |  | mA |
| ICC | Supply current plus reference current |  | $\begin{aligned} & \mathrm{V}_{\text {REF/2 }}=\text { open, } \\ & \overline{\mathrm{CS}}=5 \mathrm{~V} \end{aligned}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C},$ |  | 1.1 | 1.8 | mA |
| RREF/2 | Input resistance to reference ladder |  | See Note 6 |  | 2.5 | 8 |  | k $\Omega$ |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance (control) |  |  |  |  | 5 | 7.5 | pF |
| $\mathrm{C}_{0}$ | Output capacitance (DB) |  |  |  |  | 5 | 7.5 | pF |

NOTE 6: Resistance is calculated from the current drawn from a $5-V$ supply applied to pins 8 and 9.
operating characteristics over recommended operating free-air temperature, $\mathrm{VCC}=5 \mathrm{~V}$, $\mathrm{V}_{\text {REF/2 }}=2.5 \mathrm{~V}, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply-voltage-variation error |  |  | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V , | See Note 7 |  | $\pm 1 / 16$ | $\pm 1 / 8$ | LSB |
| Total adjusted error |  | ADC0803 | With full-scale adjust, See Notes 7 and 8 |  |  |  | $\pm 1 / 4$ |  |
|  |  |  |  |  |  | $\pm 1 / 2$ | LSB |
|  | Total unadjusted error |  | ADC0805 | $\mathrm{V}_{\mathrm{REF} / 2}=2.5 \mathrm{~V}$, | See Notes 7 and 8 |  |  | $\pm 1 / 2$ | LSB |
|  |  | $V_{\text {REF/2 }}$ open, |  | See Notes 7 and 8 |  |  | $\pm 1$ |  |
|  | DC common-mode error |  | See Notes 7 and 8 |  |  | $\pm 1 / 16$ | $\pm 1 / 8$ | LSB |  |
| ten | Output enable time |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  | 135 | 200 | ns |  |
| $\mathrm{t}_{\text {dis }}$ | Output disable time |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{C}_{\mathrm{L}}=10 \mathrm{p}$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | 125 | 200 | ns |  |
| $t_{\text {d }}$ (INTR) | Delay time to reset $\overline{\text { NTR }}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 300 | 450 | ns |  |
| tconv | Conversion cycle time |  | $\begin{aligned} & f_{\text {clock }}=100 \mathrm{kHz} \text { to } 1.4 \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \end{aligned}$ | $\overline{\mathrm{VHz}} \text {, }$ <br> See Note 9 | 66 |  | 73 | clock cycles |  |
| CR | Free-running conversion rate |  | $\overline{\text { INTR }}$ connected to $\overline{W R}$, | $\overline{\mathrm{CS}}$ at 0 V |  |  | 8770 | conv/s |  |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 7. These parameters are specified over the recommended analog input voltage range.
8. All errors are measured with reference to an ideal straight line through the end-points of the analog-to-digital transfer characteristic.
9. Although internal conversion is completed in 64 clock periods, a $\overline{C S}$ or $\overline{W R}$ low-to-high transition is followed by 1 to 8 clock periods before conversion starts. After conversion is complete, part of another clock period is required before a high-to-low transition of $\overline{\mathrm{NTR}}$ completes the cycle.

ADC0803, ADC0805

## PARAMETER MEASUREMENT INFORMATION



## PRINCIPLES OF OPERATION

The ADC0803 and ADC0805 each contain a circuit equivalent to a 256 -resistor network. Analog switches are sequenced by successive-approximation logic to match an analog differential input voltage ( $\mathrm{V}_{\text {in }}+-\mathrm{V}_{\text {in }}$ ) to a corresponding tap on the 256R network. The most significant bit (MSB) is tested first. After eight comparisons ( 64 clock periods), an eight-bit binary code (1111 $1111=$ full scale) is transferred to an output latch and the interrupt (INTR) output goes low. The device can be operated in a free-running mode by connecting the $\overline{\mathrm{NTR}}$ output to the write $(\overline{\mathrm{WR}}$ ) input and holding the conversion start ( $\overline{\mathrm{CS}}$ ) input at a low level. To ensure start-up under all conditions, a low-level $\overline{W R}$ input is required during the power-up cycle. Taking $\overline{\mathrm{CS}}$ low any time after that will interrupt a conversion in process.

When the $\overline{W R}$ input goes low, the internal successive approximation register (SAR) and 8-bit shift register are reset. As long as both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ remain low, the analog-to-digital converter remains in a reset state. One to eight clock periods after $\overline{\mathrm{CS}}$ or $\overline{\mathrm{WR}}$ makes a low-to-high transition, conversion starts.
When the $\overline{\mathrm{CS}}$ and $\overline{W R}$ inputs are low, the start flip-flop is set and the interrupt flip-flop and 8-bit register are reset. The next clock pulse transfers a logic high to the output of the start flip-flop. The logic high is ANDed with the next clock pulse, placing a logic high on the reset input of the start flip-flop. If either $\overline{\mathrm{CS}}$ or $\overline{\mathrm{WR}}$ have gone high, the set signal to the start flip-flop is removed, causing it to be reset. A logic high is placed on the $D$ input of the eight-bit shift register and the conversion process is started. If the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ inputs are still low, the start flip-flop, the 8 -bit shift register, and the SAR remain reset. This action allows for wide $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ inputs, with conversion starting from one to eight clock periods after one of the inputs goes high.

When the logic high input has been clocked through the 8 -bit shift register, which completes the SAR search, it is applied to an AND gate controlling the output latches and to the D input of a flip-flop. On the next clock pulse, the digital word is transferred to the 3-state output latches and the interrupt flip-flop is set. The output of the interrupt flip-flop is inverted to provide an INTR output that is high during conversion and low when the conversion is complete.
When a low is at both the $\overline{C S}$ and $\overline{R D}$ inputs, an output is applied to the DBO through DB7 outputs and the interrupt flip-flop is reset. When either the $\overline{C S}$ or $\overline{R D}$ inputs return to a high state, the DBO through DB7 outputs are disabled (returned to the high-impedance state). The interrupt flip-flop remains reset.

## - 8-Bit Resolution

- Ratiometric Conversion
- 100- $\mu$ s Conversion Time
- 135-ns Access Time
- No Zero Adjust Requirement
- On-Chip Clock Generator
- Single 5-V Power Supply
- Operates with Microprocessor or as Stand-Alone
- Designed to be Interchangeable with National Semiconductor and Signetics ADC0804


## description

The ADC0804 is a CMOS 8-bit successive-approximation analog-to-digital converter that uses a modified potentiometric (256R) ladder. The ADC0804 is designed to operate from common microprocessor control buses, with the three-state output latches driving the data bus. The ADC0804 can be made to appear to the microprocessor as a memory location or an I/O port. Detailed information on interfacing to most popular microprocessors is readily available from the factory.
A differential analog voltage input allows increased common-mode rejection and offset of the zero-input analog voltage value. Although a reference input (REF/2) is available to allow 8-bit conversion over smaller analog voltage spans or to make use of an external reference, ratiometric conversion is possible with the REF/2 input open. Without an external reference, the conversion takes place over a span from VCC to analog ground (ANLG GND). The ADC0804 can operate with an external clock signal or, with an additional resistor and capacitor, can operate using an on-chip clock generator.
The ADC08041 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The ADC0804C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## ADC0804I, ADC0804C

## 8-BIT ANALOG-TO-DIGITAL CONVERTER WITH DIFFERENTIAL INPUTS

functional block diagram (positive logic)


## ADC0804I, ADC0804C 8-BIT ANALOG-TO-DIGITAL CONVERTER WITH DIFFERENTIAL INPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)


NOTE 1: All voltage values are with respect to digital ground (DGTL GND) with DGTL GND and ANLG GND connected together (unless otherwise noted).

## recommended operating conditions



NOTES: 2. The internal reference voltage is equal to the voltage applied to REF/2, or approximately equal to one-half of the $V_{C C}$ when REF/2 is left open. The voltage at REF/2 should be one-half the full-scale differential input voltage between the analog inputs. Thus, the differential input voltage when REF/2 is open and $V_{C C}=5 \mathrm{~V}$ is 0 to 5 V . VREF/2 for an input voltage range from 0.5 V to 3.5 V (full-scale differential voltage of 3 V ) is 1.5 V .
3. These values are with respect to DGTL GND.
4. When the differential input voltage $\left(V_{I N}+-V_{i n-}\right)$ is less than or equal to 0 V , the output code is 00000000.
5. Total unadjusted error is specified only at an $f_{\text {clock of }} 640 \mathrm{kHz}$ with a duty cycle of $40 \%$ to $60 \%$ (pulse duration 625 ns to 937 ns ). For frequencies above this limit or pulse duration below 625 ns , error may increase. The duty cycle limits should be observed for an $f_{\text {clock }}$ greater than 640 kHz . Below 640 kHz , this duty cycle limit can be exceeded provided $\mathrm{t}_{\mathrm{w}}$ (CLK) remains within limits.

## ADC0804I, ADC0804C <br> 8-BIT ANALOG-TO-DIGITAL CONVERTER WITH DIFFERENTIAL INPUTS

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, $\mathbf{f}_{\text {clock }}=\mathbf{6 4 0} \mathbf{k H z}, \mathrm{REF} / \mathbf{2}=\mathbf{2 . 5} \mathrm{V}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | All outputs | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}^{\text {OH }}=-360 \mu \mathrm{~A}$ | 2.4 |  |  |  |
|  |  | DB and INTR | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, 1 \mathrm{OH}=-10 \mu \mathrm{~A}$ | 4.5 |  |  | v |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | Data outputs $\overline{\text { INTR }}$ output CLK OUT | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{l}^{\mathrm{OL}}=1 \mathrm{~mA}$ |  |  | 0.4 |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=360 \mu \mathrm{~A}$ |  |  | 0.4 |  |
| $\mathrm{V}_{\mathrm{T}+}$ | Clock positive-going threshold voltage |  |  | 2.7 | 3.1 | 3.5 | V |
| $\mathrm{V}_{\mathrm{T} \text { - }}$ | Clock negative-going threshold voltage |  |  | 1.5 | 1.8 | 2.1 | V |
| $\mathrm{V}_{T+}-\mathrm{V}_{\mathbf{T}-}$ | Clock input hysteresis |  |  | 0.6 | 1.3 | 2 | V |
| ${ }^{1} \mathrm{IH}$ | High-level input current |  |  |  | 0.005 | 1 | $\mu \mathrm{A}$ |
| IIL | Low-level input current |  |  |  | -0.005 | -1 | $\mu \mathrm{A}$ |
| Ioz | Off-state output current |  | $\mathrm{V}_{0}=0$ |  |  | -3 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{0}=5 \mathrm{~V}$ |  |  | 3 |  |
| IOHS | Short-circuit output current | Output high | $\mathrm{V}_{0}=0, \quad \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | -4.5 | -6 |  | mA |
| IOLS | Short-circuit output current | Output low | $\mathrm{V}_{0}=5 \mathrm{~V}, \quad \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 9 | 16 |  | mA |
| ICC | Supply current plus reference current |  | $\begin{array}{ll} \hline \text { REF/2 open, } & \overline{\mathrm{CS}} \text { at } 5 \mathrm{~V}, \\ \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} & \\ \hline \end{array}$ |  | 1.9 | 2.5 | mA |
| RREF/2 | Input resistance to reference ladder |  | See Note 6 | 1 | 1.3 |  | k $\Omega$ |
| $\mathrm{C}_{i}$ | Input capacitance (control) |  |  |  | 5 | 7.5 | pF |
| $\mathrm{C}_{0}$ | Output capacitance (DB) |  |  |  | 5 | 7.5 | pF |

operating characteristics over recommended operating free-air temperature range, $\mathrm{VCC}=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{REF} / 2}=\mathbf{2 . 5} \mathrm{V}, \mathrm{f}_{\text {clock }}=\mathbf{6 4 0} \mathbf{~ k H z}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Supply-voltage-variation error (See Notes 2 and 7) | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V |  | $\pm 1 / 16$ | $\pm 1 / 8$ | LSB |
|  | Total unadjusted error (See Notes 7 and 8) | $\mathrm{V}_{\mathrm{REF} / 2}=2.5 \mathrm{~V}$ |  |  | $\pm 1$ | LSB |
|  | DC common-mode error (See Note 8) |  |  | $\pm 1 / 16$ | $\pm 1 / 8$ | LSB |
| $t_{\text {en }}$ | Output enable time | $C_{L}=100 \mathrm{pF}$ |  | 135 | 200 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \quad \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | 125 | 200 | ns |
| $\mathrm{t}_{\mathrm{d}}$ (INTR) | Delay time to reset INTR |  |  | 300 | 450 | ns |
| $\mathrm{t}_{\text {conv }}$ | Conversion cycle time (See Note 9) | $\mathrm{f}_{\text {clock }}=100 \mathrm{kHz}$ to 1.46 MHz | $65^{1 / 2}$ |  | $721 / 2$ | clock cycles |
|  | Conversion time |  | 103 |  | 114 | $\mu \mathrm{s}$ |
| CR | Free-running conversion rate | $\overline{\mathrm{NT} T \mathrm{R}}$ connected to $\overline{\mathrm{WR}}$, $\overline{\mathrm{CS}}$ at 0 V |  |  | 8827 | conv/s |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 2. The internal reference voltage is equal to the voltage applied to REF/2, or approximately equal to one-half of the $V_{C C}$ when REF/2 is left open. The voltage at REF/2 should be one-half the full-scale differential input voltage between the analog inputs. Thus, the differential input voltage when REF/2 is open and $V_{C C}=5 \mathrm{~V}$ is 0 to 5 V . $\mathrm{V}_{\mathrm{REF} / 2}$ for an input voltage range from 0.5 V to 3.5 V (full-scale differential voltage of 3 V ) is 1.5 V .
6. The resistance is calculated from the current drawn from a $5-\mathrm{V}$ supply applied to pins 8 and 9 .
7. These parameters are specified for the recommended analog input voltage range.
8. All errors are measured with reference to an ideal straight line through the end-points of the analog-to-digital transfer characteristic.
9. Although internal conversion is completed in 64 clock periods, a $\overline{C S}$ or $\overline{W R}$ low-to-high transition is followed by 1 to 8 clock periods before conversion starts. After conversion is completed, part of another clock period is required before a high-to-low transition of $\overline{\text { INTR }}$ completes the cycle.

ADC08041, ADC0804C
8-BIT ANALOG-TO-DIGITAL CONVERTER WITH DIFFERENTIAL INPUTS
timing diagrams


WRITE OPERATION TIMING DIAGRAM

## PRINCIPLES OF OPERATION

The ADC0804 contains a circuit equivalent to a 256 -resistor network. Analog switches are sequenced by successive approximation logic to match an analog differential input voltage ( $\mathrm{V}_{\text {in }}+-\mathrm{V}_{\text {in }}$ ) to a corresponding tap on the 256 -resistor network. The most-significant bit (MSB) is tested first. After eight comparisons ( 64 clock periods), an 8 -bit binary code ( $11111111=$ full scale) is transferred to an output latch and the interrupt ( $\overline{\mathrm{INTR}}$ ) output goes low. The device can be operated in a free-running mode by connecting the $\overline{\text { INTR }}$ output to the write $(\overline{\mathrm{WR}})$ input and holding the conversion start $(\overline{\mathrm{CS}})$ input at a low level. To ensure start-up under all conditions, a low-level $\overline{W R}$ input is required during the power-up cycle. Taking $\overline{\mathrm{CS}}$ low anytime after that will interrupt a conversion in process.
When the $\overline{W R}$ input goes low, the ADC0804 successive approximation register (SAR) and 8-bit shift register are reset. As long as both $\overline{\mathrm{CS}}$ and $\overline{W R}$ remain low, the ADC0804 remains in a reset state. One to eight clock periods after $\overline{\mathrm{CS}}$ or $\overline{W R}$ makes a low-to-high transition, conversion starts.
When the $\overline{C S}$ and $\overline{W R}$ inputs are low, the start flip-flop is set and the interrupt flip-flop and 8-bit register are reset. The next clock pulse transfers a logic high to the output of the start flip-flop. The logic high is ANDed with the next clock pulse, placing a logic high on the reset input of the start flip-flop. If either $\overline{\mathrm{CS}}$ or $\overline{\mathrm{WR}}$ have gone high, the set signal to the start flip-flop is removed, causing it to be reset. A logic high is placed on the $D$ input of the 8 -bit shift register and the conversion process is started. If the $\overline{C S}$ and $\overline{W R}$ inputs are still low, the start flip-flop, the 8 -bit shift register, and the SAR remain reset. This action allows for wide $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ inputs with conversion starting from one to eight clock periods after one of the inputs goes high.

When the logic high input has been clocked through the 8-bit shift register, completing the SAR search, it is applied to an AND gate controlling the output latches and to the D input of a flip-flop. On the next clock pulse, the digital word is transferred to the three-state output latches and the interrupt flip-flop is set. The output of the interrupt flip-flop is inverted to provide an INTR output that is high during conversion and low when the conversion is completed.
When a low is at both the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ inputs, an output is applied to the DBO through DB7 outputs and the interrupt flip-flop is reset. When either the $\overline{\mathrm{CS}}$ or $\overline{\mathrm{RD}}$ inputs return to a high state, the DBO through DB7 outputs are disabled (returned to the high-impedance state). The interrupt flip-flop remains reset.

- Total Unadjusted Error . . . $\pm 0.75$ LSB Max for ADC0808 and $\pm 1.25$ LSB Max for ADC0809
- Resolution of 8 Bits
- $100 \mu \mathrm{~s}$ Conversion Time
- Ratiometric Conversion
- Monotonicity Over the Entire A/D Conversion Range
- No Missing Codes
- Easy Interface with Microprocessors
- Latched 3-State Outputs
- Latched Address Inputs
- Single 5-V Supply
- Low Power Consumption
- Designed to be Interchangeable with National Semiconductor ADC0808, ADC0809


## description

The ADC0808 and ADC0809 are monolithic CMOS devices with an 8-channel multiplexer, an 8-bit anaiog-to-digital (A/D) converter, and microprocessor-compatible control logic. The 8 -channel multiplexer can be controlled by a microprocessor through a 3-bit address decoder with address load to select any one of eight single-ended analog switches connected directly to the comparator. The 8-bit A/D converter uses the successive-approximation conversion technique featuring a high-impedance threshold detector, a switched-capacitor array, a sample-and-hold, and a successive-approximation register (SAR). Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The comparison and converting methods used eliminate the possibility of missing codes, nonmonotonicity, and the need for zero or full-scale adjustment. Also featured are latched 3-state outputs from the SAR and latched inputs to the multiplexer address decoder. The single $5-\mathrm{V}$ supply and low power requirements make the ADC0808 and ADC0809 especially useful for a wide variety of applications. Ratiometric conversion is made possible by access to the reference voltage input terminals.
The ADC0808 and ADC0809 are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## ADC0808, ADC0809

## CMOS ANALOG-TO-DIGITAL CONVERTERS

WITH 8.CHANNEL MULTIPLEXERS

## functional block diagram (positive logic)



MULTIPLEXER FUNCTION TABLE

| INPUTS |  |  |  | SELECTED |
| :---: | :---: | :---: | :---: | :---: |
| ADDRESS |  |  | ADDRESS |  |
| C | B | A | STROBE | CHANNEL |
| L | L | L | $\uparrow$ | 0 |
| L | L | $H$ | $\uparrow$ | 1 |
| L | $H$ | L | $\uparrow$ | 2 |
| L | $H$ | $H$ | $\uparrow$ | 3 |
| $H$ | L | L | $\uparrow$ | 4 |
| $H$ | L | $H$ | $\uparrow$ | 5 |
| $H$ | $H$ | L | $\uparrow$ | 6 |
| $H$ | $H$ | $H$ | $\uparrow$ | 7 |

$H=$ high level, $L=$ low level
$\uparrow=$ low-to-high transition
operating sequence


## ADC0808, ADC0809 <br> CMOS ANALOG-TO-DIGITAL CONVERTERS WITH 8.CHANNEL MULTIPLEXERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Input voltage range:control inputs ................................................. . . . 0.3 to 15 V
all other inputs ................................ . -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Operating free-air temperature range ............................................ . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage temperature range ....................... . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: N package ............. $260^{\circ} \mathrm{C}$
NOTE 1: All voltage values are with respect to network ground terminal.
recommended operating conditions

|  | MIN | NOM |
| :--- | :---: | :---: |
| Supply voltage, $V_{C C}$ | MAX | UNIT |
| Positive reference voltage, $\mathrm{V}_{\text {ref }}+$ (see Note 2) | 4.5 | 5 |
| Negative reference voltage, $\mathrm{V}_{\text {ref }}$ | 6 | V |
| Differential reference voltage, $\mathrm{V}_{\text {ref }}+-\mathrm{V}_{\text {ref }}-$ | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ |
| V | 0 | -0.1 |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$ | V |  |
| Low-level input voltage, $\mathrm{V}_{\mathrm{IL}}$ | 5 | V |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | $\mathrm{V}_{\mathrm{CC}}-1.5$ | V |

NOTE 2: Care must be taken that this rating is observed even during power-up.
electrical characteristics over recommended operating free-air temperature range. $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V (unless otherwise noted)
total device

| PARAMETER |  |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | ${ }^{1} \mathrm{O}=-360 \mu \mathrm{~A}$ | $V_{\text {CC }}-0.4$ |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | Data outputs | $\mathrm{I}_{0}=1.6 \mathrm{~mA}$ |  | 0.45 | V |
|  |  | End of conversion | $1_{0}=1.2 \mathrm{~mA}$ |  | 0.45 |  |
| ${ }^{\prime} \mathrm{OZ}$ | Off-state (high-impedance-state) output current |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{C}}$ |  | 3 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  | -3 |  |
| 1 | Control input current at maximum input voltage |  | $\mathrm{V}_{1}=15 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
| IIL | Low-level control input current |  | $V_{1}=0$ |  | -1 | $\mu \mathrm{A}$ |
| ${ }^{\text {I CC }}$ | Supply current |  | $\mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ | 0.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, control inputs |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 10 | 15 | pF |
| $\mathrm{C}_{0}$ | Output capacitance, data outputs |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 10 | 15 | pF |
|  | Resistance from pin 12 to pin 16 |  |  | 1000 |  | $\mathrm{k} \Omega$ |

analog multiplexer

| PARAMETER | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Channel on-state current (see Note 3) | $\mathrm{V}_{1}=\mathrm{V}_{\text {CC }}$, | $\mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ |  | 2 | $\mu \mathrm{A}$ |
|  | $\mathrm{V}_{1}=0.1 \mathrm{~V}, \quad \dagger_{\text {clock }}=640 \mathrm{kHz}$ |  |  | -2 |  |
| Channel off-state current | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  | $10 \quad 200$ | nA |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $V_{1}=0$ |  | -10-200 |  |
|  | $V_{C C}=5 \mathrm{~V}$ | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{1}=0$ |  | -1 |  |

${ }^{\dagger} T_{y p i c a l}$ values are at $V_{C C}=5 \mathrm{~V}$ and $T_{A}=25^{\circ} \mathrm{C}$.
NOTE 3: Channel on-state current is primarily due to the bias current into or out of the threshold detector, and it varies directly with clock frequency.

ADC0808, ADC0809 CMOS ANALOG-TO-DIGITAL CONVERTERS WITH 8.CHANNEL MULTIPLEXERS
timing requirements, $\mathrm{VCC}_{\mathrm{C}}=\mathrm{V}_{\mathrm{ref}+}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }-}=0 \mathrm{~V}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | 10 | 640 | 1280 | kHz |
| $\mathrm{t}_{\text {conv }}$ | Conversion time | See Note 4 | 90 | 100 | 116 | $\mu \mathrm{S}$ |
| $t_{w}(\mathrm{~s})$ | Pulse duration, START |  | 200 |  |  | ns |
| $t_{w}$ (ALE) | Pulse duration, ALE |  | 200 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, ADDRESS |  | 50 |  |  | ns |
| $t_{\text {h }}$ | Hold time, ADDRESS |  | 50 |  |  | ns |
| $\mathrm{t}_{\mathrm{d}}$ | Delay time, EOC | See Notes 4 and 5 | 0 |  | 14.5 | $\mu \mathrm{s}$ |

operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }+}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }-}=0 \mathrm{~V}, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | ADC0808 |  |  | ADC0809 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\text { }}$ | MAX | MIN | TYP ${ }^{\text { }}$ | MAX |  |
| kSVS | Supply voltage sensitivity |  | $\begin{aligned} & V_{C C}=V_{\text {ref }+}=4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V}, \\ & T_{A}=-40^{\circ} \mathrm{C} \text { to } 85^{\circ} \mathrm{C} \text {, See Note } 6 \end{aligned}$ | $\pm 0.05$ |  |  | $\pm 0.05$ |  |  | \%/V |
|  | Linearity error (see Note 7) |  | $\pm 0.25$ |  |  | $\pm 0.5$ |  |  | LSB |
|  | Zero error (see Note 8) |  | $\pm 0.25$ |  |  |  | $\pm 0.25$ |  | LSB |
|  | Total unadjusted error (See Note 9) | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $\pm 0.25 \pm 0.5$ |  | $\pm 0.5$ |  |  | LSB |
|  |  | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $\pm 0.75$ |  |  | $\pm 1.25$ |  |  |  |
|  |  | $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |  |  |  | $\pm 1$ |  |  |  |
| ten | Output enable time | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 80 |  | 250 |  | 80 | 250 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time | $C_{L}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 105250 |  |  |  | 105 | 250 | ns |

${ }^{\dagger}$ Typical values for all except supply voltage sensitivity are at $V_{C C}=5 \mathrm{~V}$, and all are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 4. Refer to the operating sequence diagram.
5. For clock frequencies other than $640 \mathrm{kHz}, \mathrm{t}_{\mathrm{d}(\mathrm{EOC})}$ maximum is 8 clock periods plus $2 \mu \mathrm{~s}$.
6. Supply voltage sensitivity relates to the ability of an analog-to-digital converter to maintain accuracy as the supply voltage varies. The supply and $V_{r e f}+$ are varied together and the change in accuracy is measured with respect to full-scale.
7. Linearity error is the maximum deviation from a straight line through the end points of the A/D transfer characteristic.
8. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
9. Total unadjusted error is the maximum sum of linearity error, zero error, and full-scale error.

## PRINCIPLES OF OPERATION

The ADC0808 and ADC0809 each consists of an analog signal multiplexer, an 8-bit successiveapproximation converter, and related control and output circuitry.

## multiplexer

The analog multiplexer selects 1 of 8 single-ended input channels as determined by the address decoder. Address load control loads the address code into the decoder on a low-to-high transition. The output latch is reset by the positive-going edge of the start pulse. Sampling also starts with the positive-going edge of the start pulse and lasts for 32 clock periods. The conversion process may be interrupted by a new start pulse before the end of 64 clock periods. The previous data will be lost if a new start of conversion occurs before the 64th clock pulse. Continuous conversion may be accomplished by connecting the End-of-Conversion output to the start input. If used in this mode an external pulse should be applied after power up to assure start up.

## converter

The CMOS threshold detector in the successive-approximation conversion system determines each bit by examining the charge on a series of binary-weighted capacitors (Figure 1). In the first phase of the conversion process, the analog input is sampled by closing switch $\mathrm{S}_{\mathrm{C}}$ and all $\mathrm{S}_{\mathrm{T}}$ switches, and by simultaneously charging all the capacitors to the input voltage.

In the next phase of the conversion process, $a l l \mathrm{~S}_{\mathrm{T}}$ and $\mathrm{S}_{\mathrm{C}}$ switches are opened and the threshold detector begins identifying bits by identifying the charge (voltage) on each capacitor relative to the reference voltage. In the switching sequence, all eight capacitors are examined separately until all 8 bits are identified, and then the charge-convert sequence is repeated. In the first step of the conversion phase, the threshold detector looks at the first capacitor (weight $=128$ ). Node 128 of this capacitor is switched to the reference voltage, and the equivalent nodes of all the other capacitors on the ladder are switched to REF - . If the voltage at the summing node is greater than the trip-point of the threshold detector (approximately onehalf the $V_{C C}$ voltage), a bit is placed in the output register, and the 128 -weight capacitor is switched to REF - . If the voltage at the summing node is less than the trip point of the threshold detector, this 128 -weight capacitor remains connected to REF + through the remainder of the capacitor-sampling (bitcounting) process. The process is repeated for the 64 -weight capacitor, the 32 -weight capacitor, and so forth down the line, until all bits are counted.

With each step of the capacitor-sampling process, the initial charge is redistributed among the capacitors. The conversion process is successive approximation, but relies on charge redistribution rather than a successive-approximation register (and reference DAC) to count and weigh the bits from MSB to LSB.


FIGURE 1. SIMPLIFIED MODEL OF THE SUCCESSIVE-APPROXIMATION SYSTEM

- Total Unadjusted Error . . . $\pm 0.75$ LSB Max
- Resolution of 8 Bits
- $100 \mu$ s Conversion Time
- Ratiometric Conversion
- Monotonous Over the Entire A/D Conversion Range
- No Missing Codes
- Easy Interface with Microprocessors
- Latched 3-State Outputs
- Latched Address Inputs
- Single 5-Volt Supply
- Low Power Consumption
- Designed to be Interchangeable with National Semiconductor ADC0808CJ


## description

The ADC0808M is a monolithic CMOS device with an 8-channel multiplexer, an 8-bit analog-to-digital (A/D) converter, and microprocessorcompatible control logic. The 8 -channel multiplexer can be controlled by a microprocessor through a 3-bit address decoder with address load to select any one of eight singleended analog switches connected directly to the comparator. The 8-bit A/D converter uses the successive-approximation conversion technique featuring a high-impedance threshold detector, a switched capacitor array, a sample-and-hold, and a successive-approximation register (SAR). Detailed information on interfacing to most popular microprocessors is readily available from the factory.
The comparison and converting methods used eliminate the possibility of missing codes, nonmonotonicity, and the need for zero or full-scale adjustment. Also featured are latched 3 -state outputs from the SAR and latched inputs to the multiplexer address decoder. The single 5 -volt supply and low power requirements make the ADC0808M especially useful for a wide variety of applications. Ratiometric conversion is made possible by access to the reference voltage input terminals.

The ADC0808M is characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
functional block diagram (positive logic)


MULTIPLEXER FUNCTION TABLE

| INPUTS |  |  |  | SELECTED <br> ANALOG <br> CHANNEL |
| :---: | :---: | :---: | :---: | :---: |
| ADDRESS |  |  | ADDRESS STROBE |  |
| C | B | A |  |  |
| L | L | L | $\uparrow$ | 0 |
| L | L | H | $\uparrow$ | 1 |
| L | H | L | $\uparrow$ | 2 |
| L | H | H | $\dagger$ | 3 |
| H | L | L | $\uparrow$ | 4 |
| H | L | H | $\uparrow$ | 5 |
| H | H | L | $\uparrow$ | 6 |
| H | H | H | $\uparrow$ | 7 |

[^4]
## operating sequence



## ADC0808M <br> CMOS ANALOG-TO-DIGITAL CONVERTER <br> WITH 8-CHANNEL MULTIPLEXER

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VCC (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Input voltage range: control inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0.3 to 15 V
all other inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 60 seconds: FK package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 60 seconds: J package .............. $300^{\circ} \mathrm{C}$
NOTE 1: All voltage values are with respect to network ground terminal.
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ | 4.5 | 5 | 6 | V |
| Positive reference voltage, $\mathrm{V}_{\text {ref }}$ ( (see Note 2) |  | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {ref }}$ - |  | 0 | -0.1 | V |
| Differential reference voltage, $\mathrm{V}_{\text {ref }+}-\mathrm{V}_{\text {ref }}$ - |  | 5 |  | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{CC}}-1.5$ |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  | 1.5 | V |
| Start pulse duration, $\mathrm{t}_{\mathrm{w}}(\mathrm{S})$ | 200 |  |  | ns |
| Address load control pulse duration, $\mathrm{t}_{\mathrm{w}}(\mathrm{ALC})$ | 200 |  |  | ns |
| Address setup time, $\mathrm{t}_{\text {su }}$ | 50 |  |  | ns |
| Address hold time, $\mathrm{th}^{\text {l }}$ | 50 |  |  | ns |
| Clock frequency, $f_{\text {clock }}$ | 10 | 640 | 1280 | kHz |
| Operating free-air temperature, $\mathrm{T}_{\text {A }}$ | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |

NOTE 2: Care must be taken that this rating is observed even during power-up.

## ADC0808M CMOS ANALOG-TO-DIGITAL CONVERTER WITH 8-CHANNEL MULTIPLEXER

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ to 5.5 V (unless otherwise noted)
total device

| PARAMETER |  |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{I}_{\mathrm{O}}=-360 \mu \mathrm{~A}$ | $\mathrm{V}_{\text {CC- }} 0.4$ |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | Data outputs | $1_{0}=1.6 \mathrm{~mA}$ |  | 0.45 | V |
|  |  | End of conversion | $\mathrm{I}_{\mathrm{O}}=1.2 \mathrm{~mA}$ |  | 0.45 |  |
| Ioz | Off-state (high-impedance-state) output current |  | $V_{O}=V_{C C}$ |  | 3 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  | -3 |  |
| 11 | Control input current at maximum input voltage |  | $\mathrm{V}_{1}=15 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
| IIL | Low-level control input current |  | $V_{1}=0$ |  | -1 | $\mu \mathrm{A}$ |
| ${ }^{\text {I CC }}$ | Supply current |  | $\mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ | 0.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, control inputs |  | $\mathrm{T}_{\text {A }}=25^{\circ} \mathrm{C}$ | 10 |  | pF |
| $\mathrm{C}_{0}$ | Output capacitance, data outputs |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 10 |  | pF |
|  | Resistance from pin 12 to pin 16 |  |  | 1000 |  | $\mathrm{k} \Omega$ |

analog multiplexer

| PARAMETER | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Channel on-state current (see Note 3) | $\begin{array}{ll} V_{1}=V_{\text {CC }}, & f_{\text {clock }}=640 \mathrm{kHz} \\ \hline V_{1}=0, & f_{\text {clock }}=640 \mathrm{kHz} \\ \hline \end{array}$ |  |  |  | 2 | $\mu \mathrm{A}$ |
|  |  |  |  |  | -2 |  |
| loff Channel off-state current | $\begin{aligned} & \mathrm{V}_{C C}=5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  | 10 | 200 | nA |
|  |  | $V_{1}=0$ |  | -10 | -200 |  |
|  | $V_{C C}=5 \mathrm{~V}$ | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  |  | 1 | A |
|  |  | $V_{1}=0$ |  |  | -1 |  |

${ }^{\dagger}$ Typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTE 3: Channel on-state current is primarily due to the bias current into or out of the threshold detector, and it varies directly with clock frequency.
timing characteristics, $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }}+=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | 10 | 640 | 1280 | kHz |
| $\mathrm{t}_{\text {conv }}$ | Conversion time | See Notes 4 and 5 and Figure 1 | 90 | 100 | 116 | $\mu \mathrm{s}$ |
| tent | Enable time, high | See Figure 1 |  | 150 | 360 | ns |
| $\mathrm{t}_{\text {enL }}$ | Enable time, low | See Figure 1 |  | 90 | 250 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time | See Figure 1 |  | 200 | 405 | ns |
| $\mathrm{t}_{\mathrm{w} \text { (s) }}$ | Pulse duration, START |  | 200 |  |  | ns |
| $\mathrm{t}_{\mathrm{w}}$ (ALE) | Pulse duration, ALE |  | 200 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, ADDRESS |  | 50 |  |  | ns |
| $t_{n}$ | Hold time, ADDRESS |  | 50 |  |  | ns |
| $\mathrm{t}_{\mathrm{d}(\mathrm{EOC})}$ | Delay time, EOC | See Notes 4 and 6 and Figure 1 | 0 |  | 14.5 | $\mu \mathrm{s}$ |

NOTES: 4. Refer to the operating sequence diagram.
5. For clock frequencies other than $640 \mathrm{kHz}, \mathrm{t}_{\text {conv }}$ is 57 clock cycles minimum and 74 clock cycles maximum.
6. For clock frequencies other than $640 \mathrm{kHz}, \mathrm{t}_{\mathrm{d}}(\mathrm{EOC})$ maximum is 8 clock cycles plus $2 \mu \mathrm{~s}$.

## ADC0808M

CMOS ANALOG-TO-DIGITAL CONVERTER
WITH 8.CHANNEL MULTIPLEXER
operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }+}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }-}=0 \mathrm{~V}, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| kSVS | Supply voltage sensitivity | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }+}=4.5 \mathrm{~V} \text { to } 5.5 \mathrm{~V}, \\ & \mathrm{~T}_{\mathrm{A}}=-55^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C}, \quad \text { See Note } 7 \end{aligned}$ |  | $\pm 0.05$ |  | \%/V |
|  | Linearity error (see Note 8) |  |  | $\pm 0.25$ |  | LSB |
|  | Zero error (see Note 9) |  |  | $\pm 0.25$ |  | LSB |
| Total unadjusted error (see Note 10) |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $\pm 0.25$ | $\pm 0.5$ | LSB |
|  |  | $\mathrm{T}_{\mathrm{A}}=-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | $\pm 0.75$ |  |  |  |

${ }^{\dagger}$ Typical values for all except supply voltage sensitivity are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, and all are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 7. Supply voltage sensitivity relates to the ability of an analog-to-digital converter to maintain accuracy as the supply voltage varies. The supply and $V_{r e f}+$ are varied together and the change in accuracy is measured with respect to full-scale.
8. Linearity error is the maximum deviation from a straight line through the end points of the A/D transfer characteristic.
9. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
10. Total unadjusted error is the maximum sum of linearity error, zero error, and full-scale error.

## PARAMETER MEASUREMENT INFORMATION



FIGURE 1. TEST CIRCUIT

## ADCO808M CMOS ANALOG-TO-DIGITAL CONVERTER WITH 8-CHANNEL MULTIPLEXER

## PRINCIPLES OF OPERATION

The ADC0808M consists of an analog signal multiplexer, an 8-bit successive-approximation converter, and related control and output circuitry.

## multiplexer

The analog multiplexer selects 1 of 8 single-ended input channels as determined by the address decoder. Address load control loads the address code into the decoder on a low-to-high transition. The output latch is reset by the positive-going edge of the start pulse. Sampling also starts with the positive-going edge of the start pulse and lasts for 32 clock periods. The conversion process may be interrupted by a new start pulse before the end of 64 clock periods. The previous data will be lost if a new start of conversion occurs before the 64th clock pulse. Continuous conversion may be accomplished by connecting the End-of-Conversion output to the start input. If used in this mode an external pulse should be applied after power up to assure start up.

## converter

The CMOS threshold detector in the successive-approximation conversion system determines each bit by examining the charge on a series of binary-weighted capacitors (Figure 2). In the first phase of the conversion process, the analog input is sampled by closing switch $\mathrm{S}_{\mathrm{C}}$ and all $\mathrm{S}_{\mathrm{T}}$ switches, and by simultaneously charging all the capacitors to the input voltage.

In the next phase of the conversion process, all $\mathrm{S}_{\mathrm{T}}$ and $\mathrm{S}_{\mathrm{C}}$ switches are opened and the threshold detector begins identifying bits by identifying the charge (voltage) on each capacitor relative to the reference voltage. In the switching sequence, all eight capacitors are examined separately until all 8 bits are identified, and then the charge-convert sequence is repeated. In the first step of the conversion phase, the threshold detector looks at the first capacitor (weight $=128$ ). Node 128 of this capacitor is switched to the reference voltage, and the equivalent nodes of all the other capacitors on the ladder are switched to REF - . If the voltage at the summing node is greater than the trip-point of the threshold detector (approximately onehalf the VCC voltage), a bit is placed in the output register, and the 128 -weight capacitor is switched to REF - . If the voltage at the summing node is less than the trip point of the threshold detector, this 128 -weight capacitor remains connected to REF + through the remainder of the capacitor-sampling (bitcounting) process. The process is repeated for the 64 -weight capacitor, the 32 -weight capacitor, and so forth down the line, until all bits are counted.
With each step of the capacitor-sampling process, the initial charge is redistributed among the capacitors. The conversion process is successive approximation, but relies on charge redistribution rather than a successive-approximation register (and reference DAC) to count and weigh the bits from MSB to LSB.


FIGURE 2. SIMPLIFIED MODEL OF THE SUCCESSIVE-APPROXIMATION SYSTEM

## - 8-Bit Resolution

- Easy Microprocessor Interface or StandAlone Operation
- Operates Ratiometrically or with 5-V Reference
- Single Channel or Multiplexed Twin Channels with Single-Ended or Differential Input Options
- Input Range 0 to 5 V with Single 5-V Supply
- Inputs and Outputs are Compatible with TTL and MOS
- Conversion Time of $32 \mu \mathrm{~s}$ at CLK $=250$ kHz
- Designed to be Interchangeable with National Semiconductor ADC0831 and ADC0832

| DEVICE | TOTAL UNADJUSTED ERROR |  |
| :---: | :---: | :---: |
|  | A-SUFFIX | B-SUFFIX |
| ADC0831 | $\pm 1 \mathrm{LSB}$ | $\pm 1 / 2 \mathrm{LSB}$ |
| ADC0832 | $\pm 1 \mathrm{LSB}$ | $\pm 1 / 2 \mathrm{LSB}$ |

ADC0831 . . . P DUAL-IN-LINE PACKAGE (TOP VIEW)


ADC0832 . . P DUAL-IN-LINE PACKAGE (TOP VIEW)


## description

These devices are 8-bit successive-approximation analog-to-digital converters. The ADC0831A and ADC0831B have single input channels; the ADC0832A and ADC0832B have multiplexed twin input channels. The serial output is configured to interface with standard shift registers or microprocessors. Detailed information on interfacing to most popular microprocessors is readily available from the factory.
The ADC0832 multiplexer is software configured for single-ended or differential inputs. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

The operation of the ADC0831 and ADC0832 devices is very similar to the more complex ADC0834 and ADC0838 devices. Ratiometric conversion can be attained by setting the REF input equal to the maximum analog input signal value, which gives the highest possible conversion resolution. Typically, REF is set equal to $V_{C C}$ (done internally on the ADC0832). For more detail on the operation of the ADC0831 and ADC0832 devices, refer to the ADC0834/ADC0838 data sheet.

The ADC0831AI, ADC0831BI, ADC0832AI, and ADC0832BI are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The ADC0831AC, ADC0831BC, ADC0832AC, and ADC0832BC are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

ADC0831A, ADC0832A, ADC0831B, ADC0832B A/D PERIPHERALS WITH SERIAL CONTROL

## functional block diagram


sequence of operation


## ADC0831A, ADC0832A, ADC0831B, ADC0832B A/D PERIPHERALS WITH SERIAL CONTROL

## absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC $_{\text {C }}$ (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Input voltage range: Logic . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to 15 V
Analog . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to VCC +0.3 V
Input current. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 5 \mathrm{~mA}$
Total input current for package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 20 \mathrm{~mA}$
Operating free-air temperature range: I-suffix . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
C-suffix . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from case for 10 seconds . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
NOTE 1: All voltage values, except differential voltages, are with respect to the network ground terminal.
recommended operating conditions

|  |  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply voltage |  | 4.5 | 5 | 6.3 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 2 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  |  | 0.8 | V |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency |  | 10 |  | 400 | kHz |
|  | Clock duty cycle (see Note 2) |  | 40 |  | 60 | \% |
| $\mathrm{t}_{\mathrm{wH}}$ (CS) | Pulse duration, $\overline{\mathrm{CS}}$ high |  | 220 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, $\overline{\mathrm{CS}}$ low or ADC0832 data valid before clock $\uparrow$ |  | 350 |  |  | ns |
| $t_{h}$ | Hold time, ADC0832 data valid after clock $\uparrow$ |  | 90 |  |  | ns |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature | 1-suffix | -40 |  | 85 | C |
|  |  | C-suffix | 0 |  | 70 | C |

NOTE 2: The clock duty cycle range ensures proper operation at all clock frequencies. If a clock frequency is used outside the recommended duty cycle range, the minimum pulse duration (high or low) is $1 \mu \mathrm{~s}$.
electrical characteristics over recommended range of operating free-air temperature, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, $\mathbf{f}_{\text {clock }}=\mathbf{2 5 0} \mathbf{~ k H z}$ (unless otherwise noted)
digital section

| PARAMETER |  | TEST CONDITIONS ${ }^{\dagger}$ |  | I SUFFIX |  |  | C SUFFIX |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\ddagger}$ | MAX | MIN | TYP ${ }^{\ddagger}$ | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}^{\mathrm{OH}}=-360 \mu \mathrm{~A}$ | 2.4 |  |  | 2.8 |  |  | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OH}}=-10 \mu \mathrm{~A}$ | 4.5 |  |  | 4.6 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{V}_{C C}=4.75 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ | 0.4 |  |  | 0.34 |  |  | V |  |
| IIH | High-level input current | $\mathrm{V}_{\mathrm{IH}}=5 \mathrm{~V}$ |  | 0.005 |  | 1 | 0.005 |  | 1 | $\mu \mathrm{A}$ |  |
| IIL | Low-level input current | $\mathrm{V}_{\mathrm{IL}}=0$ |  | -0.005 |  | -1 | -0.005 |  | -1 | $\mu \mathrm{A}$ |  |
| ${ }^{\mathrm{I} O H}$ | High-level output (source) current | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{O}}$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $-6.5$ | -14 |  | -6.5 | - 14 |  | mA |  |
| IOL | Low-level output (sink) current | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\mathrm{CC}}$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 8 | 16 |  | 8 | 16 |  | mA |  |
| ${ }^{\text {IOZ }}$ | High-impedance- <br> state output <br> current (DO) | $\mathrm{V}_{0}=5 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 0.01 | 3 |  | 0.01 | 3 | $\mu \mathrm{A}$ |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=0$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -0.01 | -3 |  | -0.01 | -3 |  |  |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  |  | 5 |  |  | 5 |  |  | pF |  |
| $\mathrm{C}_{0}$ | Output capacitance |  |  | 5 |  |  | 5 |  |  | pF |  |

[^5]electrical characteristics over recommended range of operating free-air temperature, $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$, $f_{\text {clock }}=250 \mathbf{k H z}$ (unless otherwise noted)

## analog and converter section

| PARAMETER |  |  | TEST CONDITIONS ${ }^{\dagger}$ | MIN | TYP ${ }^{\ddagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VICR Common-mode input voltage range |  |  | See Note 3 | $\begin{gathered} -0.05 \\ \text { to } \\ \mathrm{V}_{\mathrm{CC}}+0 . \end{gathered}$ |  |  | V |
| I/(stdby) | Standby input current (see Note 4) | On-channel | $\mathrm{V}_{1}=5 \mathrm{~V}$ at on-channel, |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | Off-channel | $V_{1}=0$ at off-channe! |  |  | -1 |  |
|  |  | On-channel | $\mathrm{V}_{1}=0$ at on-channel, |  |  | -1 |  |
|  |  | Off-channel | $\mathrm{V}_{1}=5 \mathrm{~V}$ at off-channel |  |  | 1 |  |
| ri(REF) | Input resistance to reference ladder |  |  | 1.3 | 2.4 | 5.9 | k $\Omega$ |

## total device

| PARAMETER |  |  | TEST CONDITIONS ${ }^{\dagger}$ | MIN | TYP ${ }^{\ddagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{1} \mathrm{CC}$ | Supply current | ADC0831 |  |  | 1 | 2.5 | mA |
|  |  | ADC0832 |  |  | 3 | 5.2 |  |

${ }^{\dagger}$ All parameters are measured under open-loop conditions with zero common-mode input voltage.
${ }^{\ddagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 3. If channel IN - is more positive than channel IN +, the digital output code will be 00000000 . Connected to each analog input are two on-chip diodes that will conduct forward current for analog input voltages one diode drop above $\mathrm{V}_{\mathrm{CC}}$. Care must be taken during testing at low $\mathrm{V}_{\mathrm{CC}}$ levels ( 4.5 V ) because high-level analog input voltage ( 5 V ) can, especially at high temperatures, cause this input diode to conduct and cause errors for analog inputs that are near full-scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV , the output code will be correct. To achieve an absolute $\mathrm{O} V$ to 5 V input voltage range requires a minimum $\mathrm{V}_{\mathrm{CC}}$ of 4.95 V for all variations of temperature and load.
4. Standby input currents are currents going into or out of the on or off channels when the $A / D$ converter is not performing conversion and the clock is in a high or low steady-state condition.
operating characteristics $\mathrm{V}_{\mathrm{CC}}=\mathrm{REF}=5 \mathrm{~V}, \mathrm{f}_{\text {clock }}=250 \mathrm{kHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=20 \mathrm{~ns}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS ${ }^{\text {§ }}$ | BI, BC SUFFIX |  |  | AI, AC SUFFIX |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply-voltage variation error |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V |  | $\pm 1 / 16$ | $\pm 1 / 4$ |  | $\pm 1 / 16$ | $\pm 1 / 4$ | LSB |
| Total unadjusted error (see Note 5) |  | $\begin{aligned} & V_{\text {ref }}=5 \mathrm{~V}, \\ & T_{A}-\text { MIN to MAX } \end{aligned}$ |  |  | $\pm 1 / 2$ |  |  | $\pm 1$ | LSB |
| Common-mode error |  | Differential mode |  | $\pm 1 / 16$ | $\pm 1 / 4$ |  | $\pm 1 / 16$ | $\pm 1 / 4$ | LSB |
| Propagation delay time, output data after CLK $\downarrow$ (see Note 6) | MSB-first data | $C_{L}=100 \mathrm{pF}$ |  | 650 | 1500 |  | 650 | 1500 | ns |
|  | LSB-first data |  |  | 250 | 600 |  | 250 | 600 |  |
| Output disable time, DO after $\overline{\mathrm{CS}} \uparrow$ |  | $\begin{aligned} & \hline \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF} \\ & \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega \\ & \hline \end{aligned}$ |  | 125 | 250 |  | 125 | 250 | ns |
|  |  | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}, \\ & \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega \end{aligned}$ |  |  | 500 |  |  | 500 |  |
| $\mathrm{t}_{\text {conv }} \begin{aligned} & \text { Conversion time (multiplexer } \\ & \text { addressing time not included) }\end{aligned}$ |  |  |  |  | 8 |  |  | 8 | clock periods |

[^6]

FIGURE 2. DATA OUTPUT TIMING

FIGURE 1. ADC0832 DATA INPUT TIMING

voltage waveforms

NOTE A: $C_{L}$ includes probe and jig capacitance.

FIGURE 3. OUTPUT DISABLE TIME TEST CIRCUIT AND VOLTAGE WAVEFORMS

TYPICAL CHARACTERISTICS

UNADJUSTED OFFSET ERROR
vs
REFERENCE VOLTAGE

$V_{\text {ref }}$-Reference Voltage-V
FIGURE 4
LINEARITY ERROR
vs
FREE-AIR TEMPERATURE


FIGURE 6

LINEARITY ERROR
vs
REFERENCE VOLTAGE


LINEARITY ERROR
VS
CLOCK FREQUENCY

$\mathbf{f}_{\text {clock-Clock }}$ Frequency -kHz
FIGURE 7

TYPICAL CHARACTERISTICS

ADC0831
SUPPLY CURRENT
vs
FREE-AIR TEMPERATURE


FIGURE 8

ADC0831
SUPPLY CURRENT
vS
CLOCK FREQUENCY


FIGURE 9

OUTPUT CURRENT
vs
FREE-AIR TEMPERATURE


FIGURE 10

- 8-Bit Resolution
- Easy Microprocessor Interface or StandAlone Operation
- Operates Ratiometrically or with 5-V Reference
- 4- or 8-Channel Multiplexer Options with Address Logic
- Shunt Regulator Allows Operation with High-Voltage Supplies
- Input Range 0 to 5 V with Single 5-V Supply
- Remote Operation with Serial Data Link
- Inputs and Outputs are Compatible with TTL and MOS
- Conversion Time of $32 \mu \mathrm{~s}$ at $\mathbf{f}_{\text {clock }}=250 \mathrm{kHz}$
- Designed to be Interchangeable with National Semiconductor ADC0834 and ADC0838

| DEVICE | TOTAL UNADJUSTED ERROR |  |
| :---: | :---: | :---: |
|  | A SUFFIX | B SUFFIX |
| ADC0834 | $\pm 1$ LSB | $\pm 1 / 2$ LSB |
| ADC0838 | $\pm 1$ LSB | $\pm 1 / 2$ LSB |

## description

These devices are 8 -bit successiveapproximation analog-to-digital converters, each with an input-configurable multichannel multiplexer and serial input/output. The serial input/output is configured to interface with standard shift registers or microprocessors. Detailed information on interfacing with most popular microprocessors is readily available from the factory.

The ADC0834 (4-channel) and ADC0838 (8-channel) multiplexer is software configured for single-ended or differential inputs as well as pseudo-differential input assignments. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

ADC0834 . . . N PACKAGE (TOP VIEW)


ADC0838 . . . N PACKAGE (TOP VIEW)

| CHO | 1 U20 | $\mathrm{V}_{\mathrm{Cc}}$ |
| :---: | :---: | :---: |
| CH 1 | 219 | $\mathrm{V}+$ |
| CH 2 | 318 | $\overline{\text { CS }}$ |
| CH 3 | $4 \quad 17$ | DI |
| CH 4 | 516 | CLK |
| CH5 | $6 \quad 15$ | SARS |
| CH6 | 714 | DO |
| CH 7 | 813 | $\overline{S E}$ |
| COM- | 912 | REF |
| GND |  | $\square \mathrm{ANLG}$ |

ADC0838 . . . FN PACKAGE (TOP VIEW)


The ADC0834AI, ADC0834BI, ADC0838AI, and ADC0838BI are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The ADC0834AC, ADC0834BC, ADC0838AC, and ADC0838BC are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.


# ADC0834A, ADC0838A, ADC0834B, ADC0838B A/D PERIPHERALS WITH SERIAL CONTROL 

## functional description

The ADC0834 and ADC0838 use a sample data comparator structure that converts differential analog inputs by a successive-approximation routine. Operation of both devices is similar with the exception of a select enable ( $\overline{\mathrm{SE}}$ ) input, an analog common input, and multiplexer addressing. The input voltage to be converted is applied to a channel terminal and is compared to ground (single-ended), to an adjacent input (differential), or to a common terminal (pseudo-differential) that can be an arbitrary voltage. The input terminals are assigned a positive ( + ) or negative ( - ) polarity. If the signal input applied to the assigned positive terminal is less than the signal on the negative terminal, the converter output is all zeros.
Channel selection and input configuration are under software control using a serial data link from the controlling processor. A serial communication format allows more functions to be included in a converter package with no increase in size. In addition, it eliminates the transmission of low-level analog signals by locating the converter at the analog sensor and communicating serially with the controlling processor. This process returns noise-free digital data to the processor.
A particular input configuration is assigned during the multiplexer addressing sequence. The multiplexer address is shifted into the converter through the data input (DI) line. The multiplexer address selects the analog inputs to be enabled and determines whether the input is single-ended or differential. When the input is differential, the polarity of the channel input is assigned. Differential inputs are assigned to adjacent channel pairs. For example, channel 0 and channel 1 may be selected as a differential pair. These channels cannot act differentially with any other channel. In addition to selecting the differential mode, the polarity may also be selected. Either channel of the channel pair may be designated as the negative or positive input.
The common input on the ADC0838 can be used for a pseudo-differential input. In this mode, the voltage on the common input is considered to be the negative differential input for all channel inputs. This voltage can be any reference potential common to all channel inputs. Each channel input can then be selected as the positive differential input. This feature is useful when all analog circuits are biased to a potential other than ground.
A conversion is initiated by setting the chip select ( $\overline{\mathrm{CS}}$ ) input low, which enables all logic circuits. The $\overline{\mathrm{CS}}$ input must be held low for the complete conversion process. A clock input is then received from the processor. On each low-to-high transition of the clock input, the data on the DI input is clocked into the multiplexer address shift register. The first logic high on the input is the start bit. A 3 - to 4 -bit assignment word follows the start bit. On each successive low-to-high transition of the clock input, the start bit and assignment word are shifted through the shift register. When the start bit is shifted into the start location of the multiplexer register, the input channel is selected and conversion starts. The SAR Status output (SARS) goes high to indicate that a conversion is in progress, and the DI input to the multiplexer shift register is disabled the duration of the conversion.
An interval of one clock period is automatically inserted to allow the selected multiplexed channel to settle. The data output DO comes out of the high-impedance state and provides a leading low for this one clock period of multiplexer settling time. The SAR comparator compares successive outputs from the resistive ladder with the incoming analog signal. The comparator output indicates whether the analog input is greater than or less than the resistive ladder output. As the conversion proceeds, conversion data is simultaneously output from the DO output pin, with the most significant bit (MSB) first.
After eight clock periods the conversion is complete and the SAR Status (SARS) output goes low.
The ADC0834 outputs the least-significant-bit-first data after the MSB-first data stream. If the shift enable $(\overline{\mathrm{SE}})$ line is held high on the ADC0838, the value of the least significant bit (LSB) will remain on the data line. When $\overline{S E}$ is forced low, the data is then clocked out as LSB-first data. (To output LSB first, the $\overline{\mathrm{SE}}$ control input must first go low, then the data stored in the 9 -bit shift register outputs LSB first.) When $\overline{\mathrm{CS}}$ goes high, all internal registers are cleared. At this time the output circuits go to the high-impedance state. If another conversion is desired, the $\overline{\mathrm{CS}}$ line must make a high-to-low transition followed by address information.

ADC0834A, ADC0838A, ADC0834B, ADC0838B

## A/D PERIPHERALS WITH SERIAL CONTROL

## functional description (continued)

The DI and DO pins can be tied together and controlled by a bidirectional processor I/O bit received on a single wire. This is possible because the DI input is only examined during the multiplexer addressing interval and the DO output is still in a high-impedance state.

Detailed information on interfacing to most popular microprocessors is readily available from the factory.

## sequence of operation


$H=$ high level, $L=$ low level, - or $+=$ polarity of selected input pin


ADC0838 MUX ADDRESS CONTROL LOGIC TABLE

| MUX ADDRESS |  |  |  | SELECTED CHANNEL NUMBER |  |  |  |  |  |  |  | COM |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SGL/ $/ \overline{\text { DIF }}$ | ODD/EVEN | SELECT |  | 0 |  | 1 |  | 2 |  | 3 |  |  |
|  |  | 1 | 0 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |  |
| L | L | L | L | + | - |  |  |  |  |  |  |  |
| L | L | L | H |  |  | + | - |  |  |  |  |  |
| L | L | H | L |  |  |  |  | + | - |  |  |  |
| L | L | H | H |  |  |  |  |  |  | + | - |  |
| L | H | L | L | - | + |  |  |  |  |  |  |  |
| L | H | L | H |  |  | - | + |  |  |  |  |  |
| L | H | H | L |  |  |  |  | + | - |  |  |  |
| L | H | H | H |  |  |  |  |  |  | - | $+$ |  |
| H | L | L | L | + |  |  |  |  |  |  |  | - |
| H | L | L | H |  |  | + |  |  |  |  |  | - |
| H | L | H | L |  |  |  |  | + |  |  |  | - |
| H | L | H | H |  |  |  |  |  |  | $+$ |  | - |
| H | H | L | L |  | + |  |  |  |  |  |  | - |
| H | H |  | H |  |  |  | + |  |  |  |  | - |
| H | H |  | L |  |  |  |  |  | + |  |  | - |
| H | H | H | H |  |  |  |  |  |  |  | $+$ | - |

$H=$ high level, $L=$ low level, - or $+=$ polarity of selected input
absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)
Supply voltage, VCC (see Notes 1 and 2) ..... 6.5 V
Input voltage range: Logic ..... -0.3 V to 15 V
Analog ..... -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$
Input current: V+input ..... 15 mA
Any other input ..... $\pm 5 \mathrm{~mA}$
Total input current for package ..... $\pm 20 \mathrm{~mA}$
Operating free-air temperature range: Al and BI suffixes ..... $40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
$A C$ and $B C$ suffixes ..... $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range ..... $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package ..... $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch) from case for 10 seconds: N package ..... $260^{\circ} \mathrm{C}$

## NOTES: 1. All voltage values, except differential voltages, are with respect to the network ground terminal.

2. Internal zener diodes are connected from the $V_{C C}$ input to ground and from the $V+i n p u t$ to ground. The breakdown voltage of each zener diode is approximately 7 V . One zener diode can be used as a shunt regulator and connects to $\mathrm{V}_{\mathrm{CC}}$ through a regular diode. When the voltage regulator powers the converter, this zener and regular diode combination ensures that the $\mathrm{V}_{\mathrm{CC}}$ input $(6.4 \mathrm{~V}$ ) is less than the zener breakdown voltage. A series resistor is recommended to limit current into the $\mathrm{V}+$ input.
recommended operating conditions

|  |  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }}$ | Supply voltage |  | 4.5 | 5 | 6.3 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 2 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  |  | 0.8 | V |
| ${ }^{\text {f clock }}$ | Clock frequency |  | 10 |  | 400 | kHz |
|  | Clock duty cycle (see Note 3) |  | 40 |  | 60 | \% |
| $\mathrm{t}_{\mathrm{WH}}(\mathrm{CS})$ | Pulse duration, $\overline{\mathrm{CS}}$ high |  | 220 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ | Setup time, $\overline{\mathrm{CS}}$ low, $\overline{\mathrm{SE}}$ low, or data valid before clock $\uparrow$ |  | 350 |  |  | ns |
| $t_{h}$ | Hold time, data valid after clock $\uparrow$ |  | 90 |  |  | ns |
| TA | Operating free-air temperature | AI and BI suffixes | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | $A C$ and $B C$ suffixes | 0 |  | 70 |  |

NOTE 3: The clock duty cycle range ensures proper operation at all clock frequencies. If a clock frequency is used outside the recommended duty cycle range, the minimum pulse duration (high or low) is $1 \mu \mathrm{~s}$.
electrical characteristics over recommended range of operating free-air temperature, V CC $=\mathrm{V}+=5 \mathrm{~V}, \mathrm{f}_{\text {clock }}=250 \mathrm{kHz}$ (unless otherwise noted)
digital section

| PARAMETER |  | TEST CONDITIONS ${ }^{\dagger}$ |  | AI, BI SUFFIX |  |  | AC, BC SUFFIX |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\ddagger}$ | MAX | MIN | TYP ${ }^{\ddagger}$ | MAX |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | ${ }^{1} \mathrm{OH}=-360 \mu \mathrm{~A}$ | 2.4 |  |  | 2.8 |  |  | V |
|  |  | $\mathrm{V}_{\text {CC }}=4.75 \mathrm{~V}$, | ${ }^{\mathrm{O}} \mathrm{OH}=-10 \mu \mathrm{~A}$ | 4.5 |  |  | 4.6 |  |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{V}_{\text {CC }}=5.25 \mathrm{~V}$, | ${ }^{1} \mathrm{OL}=1.6 \mathrm{~mA}$ |  |  | 0.4 |  |  | 0.34 | V |  |
| $\mathrm{I}_{1 \mathrm{H}}$ | High-level input current | $\mathrm{V}_{\text {IH }}=5 \mathrm{~V}$ |  |  | 0.005 | 1 |  | 0.005 | 1 | $\mu \mathrm{A}$ |  |
| IIL | Low-level input current | $V_{\text {IL }}=0$ |  |  | -0.005 | -1 |  | -0.005 | -1 | $\mu \mathrm{A}$ |  |
| ${ }^{\mathrm{I}} \mathrm{OH}$ | High-level output (source) current | $\mathrm{V}_{\mathrm{OH}}=0$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $-6.5-14$ |  |  | $-6.5-14$ |  |  | mA |  |
| ${ }^{\prime} \mathrm{OL}$ | Low-level output (sink) current | $\mathrm{V}_{\mathrm{OL}}=\mathrm{V}_{\mathrm{CC}}$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $8 \quad 16$ |  |  | 8 | 16 |  | mA |  |
| $\begin{array}{ll} \text { IOZ } & \begin{array}{l} \text { High-impedance-state output } \\ \text { current (DO or SARS) } \end{array} \end{array}$ |  | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V}$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 0.01 | 3 |  | 0.01 | 3 | $\mu \mathrm{A}$ |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=0$, | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -0.01 | -3 |  | -0.01 | -3 |  |  |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  |  | 5 |  |  | 5 |  |  | pF |  |
| $\mathrm{C}_{0}$ | Output capacitance |  |  | 5 |  |  | 5 |  |  | pF |  |

[^7]
## ADC0834A, ADC0838A, ADC0834B, ADC0838B A/D PERIPHERALS WITH SERIAL CONTROL

## electrical characteristics over recommended range of operating free-air temperature, $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}+=5 \mathrm{~V}$, fclock $=250 \mathrm{kHz}$ (unless otherwise noted)

analog and converter section

| PARAMETER |  |  | TEST CONDITIONS ${ }^{\dagger}$ | MIN | TYP ${ }^{\ddagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VICR Common-mode input voltage range |  |  | See Note 4 | $\begin{gathered} -0.05 \\ \text { to } \end{gathered}$ |  |  | v |
| I/(stdby) | Standby input current (see Note 5) | On-channel | $\mathrm{V}_{1}=5 \mathrm{~V}$ at on-channel, |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | Off-channel | $\mathrm{V}_{1}=0$ at off-channel |  |  | -1 |  |
|  |  | On-channel | $\mathrm{V}_{1}=0$ at on-channel, <br> $\mathrm{V}_{1}=5 \mathrm{~V}$ at off-channel |  |  | -1 |  |
|  |  | Off-channel |  |  |  | 1 |  |
| $\mathrm{r}_{\text {i }}$ (ref) | Input resistance to reference ladder |  |  | 1.3 | 2.4 | 5.9 | k $\Omega$ |

## total device

| PARAMETER | TEST CONDITIONS ${ }^{\dagger}$ | MIN | TYP $\ddagger$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathbf{Z}}$ Internal zener diode breakdown voltage | $I=15 \mathrm{~mA} \text { at } V+\text { pin, }$ <br> See Note 2 | 6.3 | 7 | 8.5 | V |
| ICC Supply current |  |  | 1 | 2.5 | mA |

${ }^{\dagger}$ All parameters are measured under open-loop conditions with zero common-mode input voltage.
${ }^{\ddagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}+=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 2. Internal zener diodes are connected from the $V_{C C}$ input to ground and from the $\mathrm{V}+$ input to ground. The breakdown voltage of each zener diode is approximately 7 V . One zener diode can be used as a shunt regulator and connects to $\mathrm{V}_{\text {CC }}$ through a regular diode. When the voltage regulator powers the converter, this zener and regular diode combination ensures that the $\mathrm{V}_{\mathrm{CC}}$ input ( 6.4 V ) is less than the zener breakdown voltage. A series resistor is recommended to limit current into the $\mathrm{V}+$ input.
4. If channel $\mathrm{IN}-$ is more positive than channel $\mathrm{IN}+$, the digital output code will be 00000000 . Connected to each analog input are two on-chip diodes that conduct forward current for analog input voltages one diode drop above $\mathrm{V}_{\mathrm{Cc}}$. Care must be taken during testing at low $\mathrm{V}_{\mathrm{CC}}$ levels ( 4.5 V ) because high-level analog input voltage ( 5 V ) can, especially at high temperatures, cause this input diode to conduct and cause errors for analog inputs that are near full-scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV , the output code will be correct. To achieve an absolute 0 V to 5 V input voltage range requires a minimum $\mathrm{V}_{\mathrm{CC}}$ of 4.950 V for all variations of temperature and load.
5. Standby input currents are currents going into or out of the on or off channels when the $A / D$ converter is not performing conversion and the clock is in a high or low steady-state condition.
operating characteristics $\mathrm{V}+=\mathrm{V} C \mathrm{C}=5 \mathrm{~V}, \mathrm{f}_{\text {clock }}=250 \mathrm{kHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=\mathbf{2 0} \mathrm{ns}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS ${ }^{\dagger}$ |  | BC SUF |  |  | AC SUF | FIX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Supply-voltage variation error |  |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V |  | $\pm 1 / 16$ | $\pm 1 / 4$ |  | $\pm 1 / 16$ | $\pm 1 / 4$ | LSB |
| Total unadjusted error (see Note 6) |  |  | $\begin{aligned} & \mathrm{V}_{\text {ref }}=5 \mathrm{~V}, \\ & T_{A}=\text { MIN to MAX } \end{aligned}$ |  |  | $\pm 1 / 2$ |  |  | $\pm 1$ | LSB |
| Common-mode error |  |  | Differential mode |  | $\pm 1 / 16$ | $\pm 1 / 4$ |  | $\pm 1 / 16$ | $\pm 1 / 4$ | LSB |
| Change in zero-error from $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ to internal zener diode operation (see Note 2) |  |  | $\begin{aligned} & I_{I}=15 \mathrm{~mA} \text { at } V+\text { pin, } \\ & V_{\text {ref }}=5 \mathrm{~V}, V_{\mathrm{CC}} \text { open } \end{aligned}$ |  |  | 1 |  |  | 1 | LSB |
|  | Propagation delay time, | MSB-first data | $C_{L}=100 \mathrm{pF}$ |  | 650 | 1500 |  | 650 | 1500 | ns |
|  | (see Note 7) | LSB-first data |  |  | 250 | 600 |  | 250 | 600 |  |
| $\mathrm{t}_{\text {dis }}$ | Output disable time, DO or SARS after CS $\uparrow$ |  | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  | 125 | 250 |  | 125 | 250 | ns |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$ |  |  | 500 |  |  | 500 |  |
| Conversion time (multiplexer $\mathrm{t}_{\text {conv }}$ addressing time not included) | Conversion time (multiplexer addressing time not included) |  |  | 8 |  |  |  |  | 8 | clock periods |

${ }^{\dagger}$ All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
NOTES: 2. Internal zener diodes are connected from the $V_{C C}$ input to ground and from the $V+$ input to ground. The breakdown voltage of each zener diode is approximately 7 V . One zener diode can be used as a shunt regulator and connects to $\mathrm{V}_{\mathrm{CC}}$ through a regular diode. When the voltage regulator powers the converter, this zener and regular diode combination ensures that the $V_{C C}$ input ( 6.4 V ) is less than the zener breakdown voltage. A series resistor is recommended to limit current into the $\mathrm{V}+$ input.
6. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.
7. The most significant bit (MSB) data is output directly from the comparator and therefore requires additional delay to allow for comparator response time.

PARAMETER MEASUREMENT INFORMATION


FIGURE 1. DATA INPUT TIMING

## ald PERIPHERALS WITH SERIAL CONTROL

PARAMETER MEASUREMENT INFORMATION

FIGURE 2. DATA OUTPUT TIMING


NOTE A: $C_{L}$ includes probe and jig capacitance.
FIGURE 3. OUTPUT DISABLE TIME TEST CIRCUIT AND VOLTAGE WAVEFORMS

## TYPICAL CHARACTERISTICS



FIGURE 4

## LINEARITY ERROR

VS
FREE-AIR TEMPERATURE


FIGURE 6


FIGURE 5
LINEARITY ERROR
vs
CLOCK FREQUENCY


FIGURE 7

## TYPICAL CHARACTERISTICS



FIGURE 8

SUPPLY CURRENT
vs
CLOCK FREQUENCY


FIGURE 9

OUTPUT CURRENT
vs
FREE-AIR TEMPERATURE


FIGURE 10

## - Advanced LinCMOS ${ }^{\text {™ }}$ Technology

- Zero Reading for 0-V Input
- Precision Null Detection with True Polarity at Zero
- 1-pA Typical Input Current
- True Differential Input
- Multiplexed Binary-Coded-Decimal Output
- Low Rollover Error: $\pm 1$ Count Maximum
- Control Signals Allow Interfacing with UARTs or Microprocessors
- Autoranging Capability with Over- and Under-Range Signals
- TTL-Compatible Outputs
- Direct Replacement for Teledyne TSC7135, Intersil ICL7135, Maxim ICL7135, and Siliconix Si7135


## description

The ICL7135C and TLC7135C converters are manufactured with Texas Instruments highly efficient Advanced LinCMOS ${ }^{\text {™ }}$ technology. This 4 1/2-digit dual-slope-integrating analog-todigital converter is designed to provide interfaces to both a microprocessor and a visual display. The digit-drive outputs D1 through D4 and multiplexed binary-coded-decimal outputs, B1 through B4, provide an interface for LED or LCD decoder/drivers as well as microprocessors.

The ICL7135C and TLC7135C offer 50-ppm (one part in 20,000 ) resolution with a maximum linearity error of one count. The zero error is less than $10 \mu \mathrm{~V}$ and zero drift is less than $0.5 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$. Source-impedance errors are minimized by low input current (less than 10 pA ). Rollover error is limited to $\pm 1$ count.
The BUSY, $\overline{\text { STROBE, RUN/ }} \overline{\text { HOLD }}$, OVER-RANGE, and UNDER-RANGE control signals support microprocessor-based measurement systems. The control signals also can support remote data acquisition systems with data transfer via universal asynchronous receiver transmitters (UARTs).

The ICL7135C and TLC7135C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

Caution. This device has limited built-in gate protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage.

Advanced LinCMOS ${ }^{\text {™ }}$ is a trademark of Texas Instruments Incorporated.
functional block diagram


ANALOG SECTION


## ICL7135C, TLC7135C <br> Advanced LinCMOS ${ }^{\text {TM }} 4$ 1/2-DIGIT PRECISION ANALOG-TO-DIGITAL CONVERTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage | 15 V |
| :---: | :---: |
| Analog input voltage (pin 9 or pin 10) | $V_{C C}-$ to $V_{C C}+$ |
| Reference voltage range | $V_{C C}$ - to $V_{\text {CC }}+$ |
| Clock input voltage range | 0 V to $\mathrm{V}_{\mathrm{CC}}+$ |
| Operating free-air temperature range | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range | $65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch) | $260^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN | 260 |

recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ | 4 | 5 | 6 | V |
| Supply voltage, $\mathrm{V}_{\text {CC }}$ - | -3 | -5 | -8 | V |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ |  | 1 |  | V |
| High-level input voltage, CLK, RUN/ $\overline{\text { HOLD }}, \mathrm{V}_{\text {IH }}$ | 2.8 |  |  | V |
| Low-level input voltage, CLK, RUN/HOLD, $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| Differential input voltage, $\mathrm{V}_{\text {ID }}$ | $\mathrm{V}_{\mathrm{CC}-+1}$ |  | $\mathrm{V}_{\text {CC }}+-0.5$ | V |
| Maximum operating frequency, fclock (see Note 1) | 1.2 | 2 |  | MHz |
| Operating free-air temperature range, $\mathrm{T}_{\mathrm{A}}$ | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTE 1: Clock frequency range extends down to 0 Hz .
electrical characteristics, $\mathrm{VCC}_{\mathrm{C}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=1 \mathrm{~V}, \mathrm{f}_{\text {clock }}=120 \mathrm{kHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | D1-D5,B1,B2, B4,B8 | $\mathrm{I}_{0}=-1 \mathrm{~mA}$ |  | 2.4 |  | 5 | V |
|  |  | Other outputs | $\mathrm{I}_{0}=-10 \mu \mathrm{~A}$ |  | 4.9 |  | 5 |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{I}_{0}=1.6 \mathrm{~mA}$ |  |  |  | 0.4 | V |
|  | Peak-to-peak output noise voltage (see Note 2) |  | $\mathrm{V}_{\mathrm{ID}}=0$, | Full Scale $=2 \mathrm{~V}$ |  | 15 |  | $\mu \mathrm{V}$ |
| ${ }^{\alpha} \mathrm{VO}$ | Zero-reading temperature coefficient of output voltage |  | $V_{\text {ID }}=0$, | $0^{\circ} \mathrm{C} \leq \mathrm{T}^{\text {A }} \leq 70^{\circ} \mathrm{C}$ |  | 0.5 | 2 | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{IIH}^{\text {H }}$ | High-level input current |  | $\mathrm{V}_{1}=5 \mathrm{~V}$, | $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ |  | 0.1 | 10 | $\mu \mathrm{A}$ |
| ILL | Low-level input current |  | $\mathrm{V}_{1}=0 \mathrm{~V}$, | $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ |  | -0.02 | -0.1 | mA |
|  | Input leakage current, pins 9 and 10 |  | $V_{I D}=0$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 1 | 10 | pA |
|  |  |  | $0^{\circ} \mathrm{C} \leq \mathrm{T}^{\text {A }} \leq 70^{\circ} \mathrm{C}$ |  |  | 250 | pA |  |
| ${ }^{\text {ICC }}+$ | Positive supply current |  |  | $\mathrm{f}_{\text {clock }}=0$ | $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ |  | 1 | 2 | mA |
|  |  |  | $0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ |  |  |  | 3 | mA |
| ${ }^{\text {ICC }}$ - | Negative supply current |  | $\mathrm{f}_{\text {clock }}=0$ | $\mathrm{T}_{\mathrm{A}}{ }^{\circ}=25^{\circ} \mathrm{C}$ |  | -0.8 | -2 | mA |
|  |  |  | $0^{\circ} \mathrm{C} \leq \mathrm{T}^{\text {A }} \leq 70^{\circ} \mathrm{C}$ |  |  | -3 |  |  |
| $\mathrm{C}_{\mathrm{pd}}$ | Power dissipation capacitance |  |  | See Note 3 |  |  | 40 |  | pF |

NOTES: 2. This is the peak-to-peak value that is not exceeded $95 \%$ of the time.
3. Factor relating clock-frequency to increase in supply current. At $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$
$I^{C C}+=I_{C C}+($ fclock $=0)+C_{p d} \times 5 \vee \times f_{\text {clock }}$
operating characteristics, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=1 \mathrm{~V}, \mathrm{f}_{\text {clock }}=120 \mathrm{kHz}$, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Full-scale temperature coefficient ${ }^{\alpha}$ FS (see Note 4) | $V_{\text {ID }}=2 \mathrm{~V}, \quad 0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ |  |  | 5 | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Linearity error | $-2 \mathrm{~V} \leq \mathrm{V}_{\text {ID }} \leq 2 \mathrm{~V}$ |  | 0.5 | 1 | count |
| Differential linearity error (see Note 5) | $-2 \mathrm{~V} \leq \mathrm{V}_{\text {ID }} \leq 2 \mathrm{~V}$ |  | 0.01 |  | LSB |
| $\pm$ Full-scale symmetry error (see Note 6) (rollover error) | $V_{\text {ID }}= \pm 2 \mathrm{~V}$ |  | 0.5 | 1 | count |
| Display reading with $0-\mathrm{V}$ input | $V_{\text {ID }}=0, \quad 0^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq 70^{\circ} \mathrm{C}$ | -0.0000 | $\pm 0.0000$ | +0.0000 | Digital <br> Reading |
|  | $\mathrm{V}_{\text {ID }}=\mathrm{V}_{\text {ref, }} \mathrm{T}_{\text {A }}=25^{\circ} \mathrm{C}$ | +0.9998 | +0.9999 | $+1.0000$ | Digital |
|  | $0^{\circ} \mathrm{C} \leq T_{A} \leq 70^{\circ} \mathrm{C}$ | +0.9995 | +0.9999 | +1.0005 | Reading |

NOTES: 4. This parameter is measured with an external reference having a temperature coefficient of less than $0.01 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
5. The magnitude of the difference between the worst case step of adjacent counts and the ideal step.
6. Rollover error is the difference between the absolute values of the conversion for 2 V and -2 V .
timing diagrams

${ }^{\dagger}$ Delay between BUSY going low and the first $\overline{\text { STROBE pulse is dependent upon the analog input. }}$
FIGURE 1


FIGURE 2

ICL7135C, TLC7135C
Advanced LinCMOS ${ }^{\text {TM }} 4$ 1/2-DIGIT PRECISION ANALOG-TO-DIGITAL CONVERTERS
timing diagrams (continued)


FIGURE 3
strobe T1T1T

${ }^{\dagger}$ First D5 of AUTO ZERO and DE-INTEGRATE is one count longer.
FIGURE 4

## PRINCIPLES OF OPERATION

A measurement cycle for the ICL7135C and TLC7135C consists of the following four phases.

1. Auto-Zero Phase. The internal $I N+$ and $I N$ - inputs are disconnected from the pins and internally connected to ANLG COMMON. The reference capacitor is charged to the reference voltage. The system is configured in a closed loop and the auto-zero capacitor is charged to compensate for offset voltages in the buffer amplifier, integrator, and comparator. The auto-zero accuracy is limited only by the system noise, and the overall offset, as referred to the input, is less than $10 \mu \mathrm{~V}$.
2. Signal Integrate Phase. The auto-zero loop is opened and the internal $I N+$ and $I N$ - inputs are connected to the external pins. The differential voltage between these inputs is integrated for a fixed period of time. If the input signal has no return with respect to the converter power supply, IN can be tied to ANLG COMMON to establish the correct common-mode voltage. Upon completion of this phase, the polarity of the input signal is recorded.
3. De-integrate Phase. The reference is used to perform the de-integrate task. The internal IN - is internally connected to ANLG COMMON and IN + is connected across the previously charged reference capacitor. The recorded polarity of the input signal is used to ensure that the capacitor will be connected with the correct polarity so that the integrator output polarity will return to zero. The time, which is required for the output to return to zero, is proportional to the amplitude of the input signal. The return time is displayed as a digital reading and is determined by the equation $10,000 \times\left(V_{\text {ID }} / V_{\text {ref }}\right)$. The maximum or full-scale conversion occurs when $V_{I D}$ is two times $V_{\text {ref }}$.
4. Zero Integrator Phase. The internal IN - is connected to ANLG COMMON. The system is configured in a closed loop to cause the integrator output to return to zero. Typically this phase requires 100 to 200 clock pulses. However, after an over-range conversion, 6200 pulses are required.

## description of analog circuits

## input signal range

The common mode range of the input amplifier extends from 1 V above the negative supply to 1 V below the positive supply. Within this range, the common mode rejection ratio (CMRR) is typically 86 dB . Both differential and common mode voltages cause the integrator output to swing. Therefore, care must be exercised to assure the integrator output does not saturate.

## analog common

Analog common (ANLG COMMON) is connected to the internal IN - during the auto-zero, de-integrate, and zero integrator phases. If $I N$ - is connected to a voltage which is different than analog common during the signal integrate phase, the resulting common mode voltage will be rejected by the amplifier. However, in most applications, IN LO will be set at a known fixed voltage (power supply common for instance). In this application, analog common should be tied to the same point, thus removing the common mode voltage from the converter. Removing the common mode voltage in this manner will slightly increase conversion accuracy.

## reference

The reference voltage is positive with respect to analog common. The accuracy of the conversion result is dependent upon the quality of the reference. Therefore, to obtain a high accuracy conversion, a high quality reference should be used.

## description of digital circuits

## RUN/ $\overline{\text { HOLD }}$ input

When the RUN/ $\overline{\text { HOLD }}$ input is high or open, the device will continuously perform measurement cycles every 40,002 clock pulses. If this input is taken low, the IC will continue to perform the ongoing measurement cycle and then hold the conversion reading for as long as the pin is held low. If the pin is held low after completion of a measurement cycle, a short positive pulse (greater than 300 ns ) will initiate a new measurement cycle. If this positive pulse occurs before the completion of a measurement cycle, it will not be recognized. The first STROBE pulse, which occurs 101 counts after the end of a measurement cycle, is an indication of the completion of a measurement cycle. Thus, the positive pulse could be used to trigger the start of a new measurment after the first STROBE pulse.

## $\overline{\text { STROBE input }}$

Negative going pulses from this input are used to transfer the BCD conversion data to external latches, UARTS, or microprocesors. At the end of the measurement cycle, the digit-drive (D5) input goes high and remains high for 201 counts. The most significant digit (MSD) BCD bits are placed on the BCD pins. After the first 101 counts, halfway through the duration of output D1-D5 going high, the STROBE pin goes low for $1 / 2$ clock pulse width. The placement of the $\overline{\text { STROBE }}$ pulse at the midpoint of the D5 high pulse allows the information to be latched into an external device on either a low-level or an edge. Such placement of the STROBE pulse also ensures that the BCD bits for the second MSD will not yet be competing for the $B C D$ lines and latching of the correct bits is assured. The above process is repeated for the second MSD and the D4 output. Similarly, the process is repeated through the least significant digit (LSD). Subsequently, inputs D5 through D1 and the BCD lines will continue scanning without the inclusion of STROBE pulses. This subsequent continuous scanning causes the conversion results to be continuously displayed. Such subsequent scanning does not occur when an over-range condition occurs.

## BUSY output

The BUSY output goes high at the beginning of the signal integrate phase and remains high until the first clock pulse after zero-crossing or at the end of the measurement cycle if an over-range condition occurs. It is possible to use the BUSY pin to serially transmit the conversion result. Serial transmission can be accomplished by ANDing the BUSY and CLOCK signals and transmitting the ANDed output. The transmitted output consists of 10,001 clock pulses, which occur during the signal integrate phase, and the number of clock pulses, which occur during the de-integrate phase. The conversion result can be obtained by subtracting 10,001 from the total number of clock pulses.

## OVER-RANGE output

When an over-range condition occurs, this pin goes high after the BUSY signal goes low at the end of the measurement cycle. As previously noted, the BUSY signal remains high until the end of the measurement cycle when an over-range condition occurs. The OVER-RANGE output goes high at end of BUSY and goes low at the beginning of the de-integrate phase in the next measurement cycle.

## UNDER-RANGE output

At the end of the BUSY signal, this pin goes high if the conversion result is less than or equal to $9 \%$ (count of 1800) of the full-scale range. The UNDER-RANGE output is brought low at the beginning of the signal integrate phase of the next measurement cycle.

# ICL7135C, TLC7135C <br> Advanced LinCMOS ${ }^{\text {TM }} 4$ 1/2-DIGIT PRECISION ANALOG-TO-DIGITAL CONVERTERS 

## PRINCIPLES OF OPERATION

## POLARITY output

The POLARITY output is high for a positive input signal and is updated at the beginning of each de-integrate phase. The polarity output is valid for all inputs including $\pm 0$ and over-range signals.

## digit-drive (D5, D4, D2 and D1) outputs

Each digit-drive output (D1 through D5) sequentially goes high for 200 clock pulses. This sequential process is continuous unless an over-range occurs. When an over-range occurs, all of the digit drive outputs are blanked from the end of the strobe sequence until the beginning of the de-integrate phase (when the sequential digit drive activation begins again). The blanking activity, during an over-range condition, may be used to cause the display to flash and indicate the over-range condition.

## BCD outputs

The $B C D$ bits ( $B 8, B 4, B 2$ and $B 1$ ) for a given digit are sequentially activated on these outputs. Simultaneously, the appropriate Digit-drive line for the given digit is activated.

## system aspects

## integrating resistor

The value of the integrating resistor ( $\mathrm{R}_{\mathrm{INT}}$ ) is determined by the full scale input voltage and the output current of the integrating amplifier. The integrating amplifier can supply $20 \mu \mathrm{~A}$ of current with negligible non-linearity. The equation for determining the value of this resistor is as follows:

$$
\text { RINT }=\frac{\text { FULL-SCALE VOLTAGE }}{\text { IINT }}
$$

Integrating amplifier current, IINT, from 5 to $40 \mu \mathrm{~A}$ will yield good results. However, the nominal and recommended current is $20 \mu \mathrm{~A}$.

## integrating capacitor

The product of the integrating resistor and capacitor should be selected to give the maximum voltage swing without causing the integrating amplifier output to saturate and get too close to the power supply voltages. If the amplifier output is within 0.3 V of either supply, saturation will occur. With $\pm 5-\mathrm{V}$ supplies and ANLG COMMON connected to ground, the designer should design for a $\pm 3.5-\mathrm{V}$ to $\pm 4-\mathrm{V}$ integrating amplifier swing. A nominal capacitor value is $0.47 \mu \mathrm{~F}$. The equation for determining the value of the integrating capacitor ( $\mathrm{C}_{\mathrm{INT}}$ ) is as follows:

$$
\mathrm{C}_{\text {INT }}=\frac{10,000 \times \text { CLOCK PERIOD } \times \operatorname{IINT}}{\text { INTEGRATOR OUTPUT VOLTAGE SWING }}
$$

where: IINT is nominally $20 \mu \mathrm{~A}$.
Capacitors with large tolerances and high dielectric absorption can induce conversion inaccuracies. A capacitor, which is too small could cause the integrating amplifier to saturate. High dielectric absorption causes the effective capacitor value to be different during the signal integrate and de-integrate phases. Polypropylene capacitors have very low dielectric absorption. Polystyrene and Polycarbonate capacitors have higher dielectric absorption, but also work well.

## Advanced LinCMOS ${ }^{\text {TM }} 4$ 1/2-DIGIT PRECISION

 ANALOG-TO-DIGITAL CONVERTERS
## PRINCIPLES OF OPERATION

## auto-zero and reference capacitor

Large capacitors will tend to reduce noise in the system. Dielectric absorption is unimportant except during power-up or overload recovery. Typical values are $1 \mu \mathrm{~F}$.

## reference voltage

For high-accuracy absolute measurements, a high quality reference should be used.

## rollover resistor and diode

The ICL7135C and TLC7135C have a small rollover error, however it can be corrected. The correction is to connect the cathode of any silicon diode to the INT OUT pin and the anode to a resistor. The other end of the resistor is connected to ANLG COMMON or ground. For the recommended operating conditions the resistor value is $100 \mathrm{k} \Omega$. This value may be changed to correct any rollover error which has not been corrected. In many non-critical applications, the resistor and diode are not needed.

## maximum clock frequency

For most dual-slope A/D converters, the maximum conversion rate is limited by the frequency response of the comparator. In this circuit, the comparator follows the integrator ramp with a $3 \mu \mathrm{~s}$ delay. Therefore, with a $160-\mathrm{kHz}$ clock frequency ( $6 \mu \mathrm{~s}$ period), half of the first reference integrate clock period is lost in delay. Hence, the meter reading will change from 0 to 1 with a $50-\mu \mathrm{V}$ input, 1 to 2 with a $150-\mu \mathrm{V}$ input, 2 to 3 with a $250-\mu \mathrm{V}$ input, etc. This transition at midpoint is desirable; however, if the clock frequency is increased appreciably above 160 kHz , the instrument will flash " 1 " on noise peaks even when the input is shorted. The above transition points assume a $2-\mathrm{V}$ input range is equivalent to 20,000 clock cycles.
If the input signal is always of one polarity, comparator delay need not be a limitation. Clock rates of 1 MHz . are possible since non-linearity and noise do not increase substantially with frequency. For a fixed clock frequency, the extra count or counts caused by comparator delay will be a constant and can be subtracted out digitally.

For signals with both polarities, the clock frequency can be extended above 160 kHz without error by using a low value resistor in series with the integrating capacitor. This resistor causes the integrator to jump slightly towards the zero-crossing level at the beginning of the de-integrate phase and thus, compensates for the comparator delay. This series resistor should be $10 \Omega$ to $50 \Omega$. This approach allows clock frequencies up to 480 kHz .

## minimum clock frequency

The minimum clock frequency limitations result from capacitor leakage from the auto-zero and reference capacitors. Measurement cycles as high as 10 s are not influenced by leakage error.

## rejection of 50 Hz or 60 Hz pickup

To maximize the rejection of 50 Hz or 60 Hz pickup, the clock frequency should be chosen so that an integral multiple of 50 Hz or 60 Hz periods occur during the signal integrate phase. To achieve rejection of these signals, some clock frequencies which could be used are as follows:
$50 \mathrm{~Hz}: 250,166.66,125,100 \mathrm{kHz}$, etc.
$60 \mathrm{~Hz}: 300,200,150,120,100,40,33.33 \mathrm{kHz}$, etc.

## PRINCIPLES OF OPERATION

## zero-crossing flip-flop

This flip-flop interrogates the comparator's zero-crossing status. The interrogation is performed after the previous clock cycle and the positive half of the ongoing clock cycle have occurred so that any comparator transients which result from the clock pulses do not affect the detection of a zero-crossing. This procedure delays the zero-crossing detection by one clock cycle. To eliminate the inaccuracy, which is caused by this delay, the counter is disabled for one clock cycle at the beginning of the de-integrate phase. Therefore, when the zero-crossing is detected one clock cycle later than the zero-crossing actually occurs, the correct number of counts is displayed.

## noise

The peak-to-peak noise around zero is approximately $15 \mu \mathrm{~V}$ (peak-to-peak value not exceeded $95 \%$ of the time). Near full scale, this value increases to approximately $30 \mu \mathrm{~V}$. Much of the noise originates in the auto-zero loop, and is proportional to the ratio of the input signal to the reference.

## analog and digital grounds

For high-accuracy applications, ground loops must be avoided. Return currents from digital circuits must not be sent to the analog ground line.

## power supplies

The ICL7135C and TLC7135C are designed to work with $\pm 5-\mathrm{V}$ power supplies. However, $5-\mathrm{V}$ operation is possible if the input signal does not vary more than $\pm 1.5 \mathrm{~V}$ from mid-supply.

# TL0808, TL0809 <br> LOW-POWER CMOS ANALOG-TO-DIGITAL CONVERTERS WITH 8.CHANNEL MULTIPLEXERS 

D2642, FEBRUARY 1986 - REVISED MAY 1988

- Total Unadjusted Error . . . $\pm 0.75$ LSB Max for TL0808 and $\pm 1.25$ LSB Max for TL0809 Over Temperature Range
- Ideal for Battery Operated, Portable Instrumentation Applications
- Resolution of 8 Bits
- $100 \mu \mathrm{~s}$ Conversion Time
- Ratiometric Conversion
- Monotonic Over the Entire A/D Conversion Range
- No Missing Codes
- Easy Interface with Microprocessors
- Latched 3-State Outputs
- Latched Address Inputs
- Single $2.75-\mathrm{V}$ to $5.5-\mathrm{V}$ Supply
- Extremely Low Power Consumption . . 0.3 mW Typ
- Improved Direct Replacements for ADC0808, ADC0809


## description

The TL0808 and TL0809 are monolithic CMOS devices with an 8-channel multiplexer, an 8-bit analog-to-digital (A/D) converter, and microprocessor-compatible control logic. The 8 -channel multiplexer can be controlled by a microprocessor through a 3-bit address decoder with address load to select any one of eight single-ended analog switches connected directly to the comparator. The 8-bit A/D converter uses the successive-approximation conversion technique featuring a high-impedance threshold detector, a switched-capacitor array, a sample-and-hold, and a successive-approximation register (SAR). Detailed information on interfacing to most popular microprocessors is readily available from the factory. These devices are designed to operate from common microprocessor control buses, with three-state output latches driving the data bus. The devices can be made to appear to the microprocessor as a memory location or an I/O port.

The comparison and converting methods used eliminate the possibility of missing codes, nonmonotonicity, and the need for zero or full-scale adjustment. Also featured are latched 3-state outputs from the SAR and latched inputs to the multiplexer address decoder. The single $2.75-\mathrm{V}$ to $5.5-\mathrm{V}$ supply and extremely low power requirements make the TL0808 and TL0809 especially useful for a wide variety of applications including portable battery and LCD applications. Ratiometric conversion is made possible by access to the reference voltage input terminals.

The TL0808 and TL0809 are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## functional block diagram (positive logic)



MULTIPLEXER FUNCTION TABLE

| INPUTS |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| SELECTED <br> ADDRESS | ADDRESS | ANALOG |  |  |
|  | B | A | STROBE | CHANNEL |
| L | L | L | $\uparrow$ | 0 |
| L | L | H | $\uparrow$ | 1 |
| L | $H$ | L | $\uparrow$ | 2 |
| L | $H$ | $H$ | $\uparrow$ | 3 |
| H | L | L | $\uparrow$ | 4 |
| H | L | H | $\uparrow$ | 5 |
| H | $H$ | L | $\uparrow$ | 6 |
| $H$ | $H$ | $H$ | $\uparrow$ | 7 |

[^8]operating sequence


LOW-POWER CMOS ANALOG-TO-DIGITAL CONVERTERS WITH 8.CHANNEL MULTIPLEXERS

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) | 6.5 V |
| :---: | :---: |
| Input voltage range: control inputs | 0.3 to 15 V |
| all other inputs | -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ |
| Operating free-air temperature range | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| Storage temperature range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN | $260^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}(1 / 16$ inch | $260^{\circ} \mathrm{C}$ |

NOTE 1: All voltage values are with respect to network ground terminal.
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ | 2.75 |  | 5.5 | V |
| Positive reference voltage, $\mathrm{V}_{\text {ref }}$ ( (see Notes 2, 3, and 4) | 2.75 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {ref }}$ - (see Notes 2, 3, and 4) | -0.1 | 0 |  | V |
| Differential reference voltage, $\mathrm{V}_{\text {ref }+}-\mathrm{V}_{\text {ref }}$ ( (see Note 4) |  | 3 |  | V |
| High-level input voltage, control inputs, $\mathrm{V}_{\mathrm{IH}}$ | $0.7 \mathrm{~V}_{\mathrm{CC}}$ |  |  | V |
| Low-level input voltage, control inputs, $\mathrm{V}_{\text {IL }}$ |  |  | $0.3 \mathrm{~V}_{\mathrm{CC}}$ | V |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ (see Note 4) | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 2. The accuracy of the conversion will depend on the stability of the reference voltages applied.
3. Analog voltages greater than or equal to $V_{\text {ref }}+$ convert to all highs, and all voltages less than $V_{\text {ref }}$ convert to all lows.
4. For proper operation of the TL0808 and TL0809 at free-air temperatures below $0^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}$ and $\left(\mathrm{V}_{\text {ref }}+-\mathrm{V}_{\text {ref }}\right)$ should not be less than 3 V .
electrical characteristics over recommended operating free-air temperature range, $\mathrm{VCC}=3 \mathrm{~V}$ to 5.25 V (unless otherwise noted)
total device

| PARAMETER |  |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ High-level output voltage |  |  | ${ }^{\prime} \mathrm{O}=-360 \mu \mathrm{~A}$ | $\mathrm{V}_{\text {CC-0 }} 0.6$ |  | V |
| VOL Low-level output voltage |  | Data outputs | $10=1.6 \mathrm{~mA}$ |  | 0.45 | V |
|  |  | End of conversion | $\mathrm{I}_{0}=1.2 \mathrm{~mA}$ |  | 0.45 |  |
| IOZ | Off-state (high-impedance-state) output current |  | $\mathrm{V}_{0}=\mathrm{V}_{\mathrm{CC}}$ |  | 1 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  | -1 |  |
| $1 /$ | Control input current at maximum input voltage |  | $\mathrm{V}_{1}=15 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
| 1 IL | Low-level control input current |  | $V_{1}=0$ |  | -1 | $\mu \mathrm{A}$ |
| ICC Supply current |  |  | $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ | 100 | 500 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ | 0.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, control inputs |  | $\mathrm{T}_{\text {A }}=25^{\circ} \mathrm{C}$ | 10 | 15 | pF |
| $\mathrm{C}_{0}$ Output capacitance, data outputs | Output capacitance, data outputs |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 10 | 15 | pF |
|  | Resistance from pin 12 to pin 16 |  |  | 11000 |  | k $\Omega$ |

[^9]TL0808, TL0809
LOW-POWER CMOS ANALOG-TO-DIGITAL CONVERTERS WITH 8.CHANNEL MULTIPLEXERS
analog multiplexer

| PARAMETER |  | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Ion | Channel on-state current (see Note 5) | $\begin{array}{ll}\mathrm{V}_{1}=3 \mathrm{~V}, & \mathrm{f}_{\text {clock }}=640 \mathrm{kHz} \\ \mathrm{V}_{1}=0, & \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}\end{array}$ |  |  |  | 2 | $\mu \mathrm{A}$ |
|  |  |  |  |  | -2 |  |  |
| $l_{\text {off }}$ | Channel off-state current | $\mathrm{V}_{\text {CC }}=3 \mathrm{~V}$, | $\mathrm{V}_{1}=3 \mathrm{~V}$ |  | 10 | 200 | nA |
|  |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $V_{1}=0$ |  | -10 | -200 |  |
|  |  | $V_{C C}=3 \mathrm{~V}$ | $\mathrm{V}_{1}=3 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  |  | $V_{1}=0$ |  |  | -1 |  |

${ }^{\dagger}$ Typical values are at $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTE 5: Channel on-state current is primarily due to the bias current into or out of the threshold detector, and it varies directly with clock frequency.
timing requirements, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{ref}}+=3 \mathrm{~V}, \mathrm{~V}_{\text {ref }}-=0$ (unless otherwise noted)

|  |  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {conv }}$ | Conversion time (see Note 6) |  | 90 | 100 | 116 | $\mu \mathrm{s}$ |
| $\mathrm{f}_{\text {clock }}$ | Clock frequency | $\mathrm{V}_{\mathrm{CC}}=2.75 \mathrm{~V}$ to 4 V | 10 |  | 640 | kHz |
|  |  | $\mathrm{V}_{\mathrm{CC}}=4 \mathrm{~V}$ to 5.5 V | 10 |  | 1280 |  |
| $t_{w}(\mathrm{~s})$ | Start pulse duration |  | 200 |  |  | ns |
| $t_{\text {w }}$ (ALC) | Address load control pulse duration |  | 200 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ | Address setup time |  | 50 |  |  | ns |
| th | Address hold time |  | 50 |  |  | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{EOC})$ | Delay time, end of conversion output (see Notes 6 and 7) |  | 0 |  | 14.5 | $\mu \mathrm{s}$ |

operating characteristics, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }+}=3 \mathrm{~V}, \mathrm{~V}_{\text {ref }-}=0, \mathrm{f}_{\text {clock }}=640 \mathrm{kHz}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | TL0808 |  |  | TL0809 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| kSVS | Supply voltage sensitivity |  |  | $\begin{aligned} & V_{\mathrm{CC}}=\mathrm{V}_{\text {ref }+}=3 \mathrm{~V} \text { to } 5.25 \mathrm{~V}, \\ & T_{A}=-40^{\circ} \mathrm{C} \text { to } 85^{\circ} \mathrm{C} \text {, See Note } 8 \end{aligned}$ |  | $\pm 0.05$ |  |  | $\pm 0.05$ |  |  | \%/V |
|  | Linearity error (see Note 9) |  |  | $\pm 0.5$ |  |  | $\pm 1$ |  |  | LSB |
|  | Zero error (see Note 10) |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ |  |  | LSB |
|  | Total unadjusted | $\mathrm{f}_{\text {clock }}=$ $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$ <br> 125 kHz $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |  |  | $\pm 0.25$ | $\pm 0.5$ |  | $\pm 0.5$ | $\pm 1$ | LSB |
|  | error (See Note 11) |  |  |  |  | $\pm 0.75$ |  |  | $\pm 1.25$ |  |
| $t_{\text {en }}$ | Output enable time | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  |  | 80 | 250 |  | 80 | 250 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ |  |  | 105 | 300 |  | 105 | 300 | ns |

[^10]
## LOW-POWER CMOS ANALOG-TO-DIGITAL CONVERTERS

 WITH 8.CHANNEL MULTIPLEXERS
## PRINCIPLES OF OPERATION

The TLO808 and TL0809 each consists of an analog signal multiplexer, an 8-bit successive-approximation converter, and related control and output circuitry.

## multiplexer

The analog multiplexer selects 1 of 8 single-ended input channels as determined by the address decoder. Address load control loads the address code into the decoder on a low-to-high transition. The output latch is reset by the positive-going edge of the start pulse. Sampling also starts with the positive-going edge of the start pulse and lasts for 32 clock periods. The conversion process may be interrupted by a new start pulse before the end of 64 clock periods. The previous data will be lost if a new start of conversion occurs before the 64th clock pulse. Continuous conversion may be accomplished by connecting the End-of-Conversion output to the start input. If used in this mode an external pulse should be applied after power up to assure start up.

## converter

The CMOS threshold detector in the successive-approximation conversion system determines each bit by examining the charge on a series of binary-weighted capacitors (Figure 1). In the first phase of the conversion process, the analog input is sampled by closing switch $\mathrm{S}_{\mathrm{C}}$ and all $\mathrm{S}_{\mathrm{T}}$ switches, and by simultaneously charging all the capacitors to the input voltage.
in the next phase of the conversion process, all $\mathrm{S}_{\mathrm{T}}$ and $\mathrm{S}_{\mathrm{C}}$ switches are opened and the threshold detector begins identifying bits by identifying the charge (voltage) on each capacitor relative to the reference voltage. In the switching sequence, all eight capacitors are examined separately until all 8 bits are identified, and then the charge-convert sequence is repeated. In the first step of the conversion phase, the threshold detector looks at the first capacitor (weight $=128$ ). Node 128 of this capacitor is switched to the reference voltage, and the equivalent nodes of all the other capacitors on the ladder are switched to REF - If the voltage at the summing node is greater than the trip-point of the threshold detector (approximately onehalf the $V_{C C}$ voltage), a bit is placed in the output register, and the 128 -weight capacitor is switched to REF - . If the voltage at the summing node is less than the trip point of the threshold detector, this 128 -weight capacitor remains connected to REF + through the remainder of the capacitor-sampling (bitcounting) process. The process is repeated for the 64 -weight capacitor, the 32 -weight capacitor, and so forth down the line, until all bits are counted.
With each step of the capacitor-sampling process, the initial charge is redistributed among the capacitors. The conversion process is successive approximation, but relies on charge redistribution rather than a successive-approximation register (and reference DAC) to count and weigh the bits from MSB to LSB.

figure 1. Simplified model of the successive-approximation system

- Functionally Interchangeable with Siliconix DG182, DG185, DG188, DG191 with Same Terminal Assignments
- Monolithic Construction
- Adjustable Reference Voltage
- JFET Inputs


## description

The TL182, TL185, TL188, and TL191 are monolithic high-speed analog switches using $\mathrm{BI}-$ MOS technology. They comprise JFET-input buffers, level translators, and output JFET switches. The TL182 switches are SPST; the TL185 switches are SPDT. The TL188 is a pair of complementary SPST switches as is each half of the TL191.

A high level at a control input of the TL182 turns the associated switch off. A high level at a control input of the TL185 turns the associated switch on. For the TL188, a high level at the control input turns the associated switches S1 on and S2 off.

The threshold of the input buffer is determined by the voltage applied to the reference input (Vref). The input threshold is related to the reference input by the equation $V_{\text {th }}=V_{\text {ref }}+1.4 \mathrm{~V}$. Thus, for TTL compatibility, the $V_{\text {ref }}$ input is connected to ground. The JFET input makes the device compatible with bipolar, MOD, and CMOS logic families. Threshold compatibility may, again, be determined by $\mathrm{V}_{\mathrm{th}}=\mathrm{V}_{\text {ref }}+1.4 \mathrm{~V}$.
The output switches are junction field-effect transistors featuring low on-state resistance and high off-state resistance. The monolithic structure ensures uniform matching.

BI-MOS technology is a major breakthrough in linear integrated circuit processing. BI-MOS can have ion-implanted JFETs, p-channel MOS-FETs, plus the usual bipolar components all on the same chip. BI-MOS provides for monolithic circuit designs that previously have been available only as expensive hybrids.

M-suffix devices are characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. I-suffix devices are characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and C -suffix devices are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## - Uniform On-State Resistance for Minimum Signal Distortion

- $\pm 10-\mathrm{V}$ Analog Voltage Range
- TTL, MOS, and CMOS Logic Control Compatibility


## TL182, TL185

## BI-MOS SWITCHES

TL182 TWIN SPST SWITCH
schematic (each channel)
symbol


FUNCTION TABLE (EACH HALF)

| INPUT | SWITCH |
| :---: | :---: |
| A | S |
| L | ON (CLOSED) |
| H | OFF (OPEN) |

TL185 TWIN DPST SWITCH
schematic (each channel)

symbol


FUNCTION TABLE (EACH HALF)

| INPUT | SWITCHES |
| :---: | :---: |
| A | SW1 AND SW2 |
| L | OFF (OPEN) |
| H | ON (CLOSED) |

## TL188 DUAL COMPLEMENTARY SPST SWITCH

schematic


TL191 TWIN DUAL COMPLEMENTARY SPST SWITCH
schematic (each channel)
symbol


FUNCTION TABLE

| INPUT | SWITCHES |  |
| :---: | :---: | :--- |
| A | SW1 | SW2 |
| L | OFF (OPEN) | ON (CLOSED) |
| H | ON (CLOSED) | OFF (OPEN) |

## BI-MOS SWITCHES

## functional block diagram


absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Positive supply to negative supply voltage, $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{EE}}$ ..... 36 V
Positive supply voltage to either drain, $V_{C C}-V_{D}$ ..... 33 V
Drain to negative supply voltage, $\mathrm{V}_{\mathrm{D}}-\mathrm{V}_{\mathrm{EE}}$ ..... 33 V
Drain to source voltage, $V_{D}-V_{S}$ ..... $\pm 22 \mathrm{~V}$
Logic supply to negative supply voltage, $\mathrm{V}_{\mathrm{LL}}-\mathrm{V}_{\mathrm{EE}}$ ..... 36 V
Logic supply to logic input voltage, $\mathrm{V}_{\mathrm{LL}}-\mathrm{V}_{\mathrm{I}}$ ..... 33 V
Logic supply to reference voltage, $\mathrm{V}_{\mathrm{LL}}-\mathrm{V}_{\text {ref }}$ ..... 33 V
Logic input to reference voltage, $\mathrm{V}_{\mathrm{l}}-\mathrm{V}_{\text {ref }}$ ..... 33 V
Reference to negative supply voltage, $\mathrm{V}_{\text {ref }}$ - $\mathrm{V}_{\mathrm{EE}}$ ..... 27 V
Reference to logic input voltage, $\mathrm{V}_{\text {ref }}-\mathrm{V}_{\mathrm{l}}$ ..... 2 V
Current (any terminal) ..... 30 mA
Operating free-air temperature range: TL182M, TL185M, TL188M, TL191M $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$TL1821, TL185I, TL188I, TL1911 .......... . $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$TL182C, TL185C, TL188C, TL191C . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from case for 10 seconds ..... $260^{\circ} \mathrm{C}$
electrical characteristics, $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-15 \mathrm{~V}, \mathrm{~V}_{\mathrm{LL}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=\mathbf{0} \mathrm{V}$

| PARAMETER | TEST CONDITIONS |  | TL1_M | TL1_1 | TL1_C | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN MAX | MIN MAX | MIN MAX |  |
| $\mathrm{V}_{\mathrm{IH}} \quad$High-level control <br> input voltage |  | $\mathrm{T}_{\mathrm{A}}=$ MIN TO MAX | $\mathrm{V}_{\text {ref }}+2$ | $\mathrm{V}_{\text {ref }}+2$ | $\mathrm{V}_{\text {ref }}+2$ | V |
| VIL $\quad$Low-level control <br> input voltage |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MIN}$ to MAX | $\mathrm{V}_{\text {ref }}+0.8$ | $\mathrm{V}_{\text {ref }}+0.8$ | $\mathrm{V}_{\text {ref }}+0.8$ | V |
| HiU High-level control | $\mathrm{V}_{1}=5 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 10 | 10 | 20 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{1 \mathrm{H}} \quad$ input current |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}$ | 20 | 20 | 20 |  |
| IIL $\quad$Low-level control <br> input current | $v_{1}=0$ | $T_{A}=$ MIN to MAX | -250 | -250 | -250 | $\mu \mathrm{A}$ |
| Off-state drain current | $\begin{array}{ll} \mathrm{V}_{\mathrm{D}}=10 \mathrm{~V}, & \mathrm{~V}_{\mathrm{S}}=-10 \mathrm{~V}, \\ \mathrm{~V}_{\mathrm{IH}}=2 \mathrm{~V}, & \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \end{array}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 5 | 5 | nA |
|  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}$ | 100 | 100 | 100 |  |
| Off-state source current | $\begin{array}{ll} \hline \mathrm{V}_{\mathrm{D}}=-10 \mathrm{~V}, & \mathrm{~V}_{\mathrm{S}}=10 \mathrm{~V}, \\ \mathrm{~V}_{\mathrm{IH}}=2 \mathrm{~V}, & \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \end{array}$ | $T_{A}=25^{\circ} \mathrm{C}$ |  | 5 | 5 | nA |
|  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}$ | 100 | 100 | 100 |  |
| ${ }^{\prime} D(o n)^{+I} S(o n)$On-state chann <br> leakage current | $\begin{array}{ll} \mathrm{V}_{\mathrm{D}}=-10 \mathrm{~V}, & \mathrm{~V}_{\mathrm{S}}=-10 \mathrm{~V} \\ \mathrm{~V}_{\mathrm{IH}}=2 \mathrm{~V}, & \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \\ \hline \end{array}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | -10 | -10 | nA |
|  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}$ | -200 | -200 | -200 |  |
| Drain-to-source on-state resistance | $\begin{array}{ll} \mathrm{V}_{\mathrm{D}}=-10 \mathrm{~V}, & \mathrm{I}_{\mathrm{S}}=1 \mathrm{~mA} \\ \mathrm{~V}_{\mathrm{IH}}=2 \mathrm{~V}, & \mathrm{~V}_{\mathrm{IL}}=0.8 \mathrm{~V} \end{array}$ | $T_{A}=\operatorname{MIN}$ to $25^{\circ} \mathrm{C}$ | 75 | 100 | 100 | $\Omega$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}$ | 100 | 150 | 150 |  |
|  |  | $T_{A}=\operatorname{MIN}$ to $25^{\circ} \mathrm{C}$ | 125 | 150 | 150 |  |
|  |  | $T_{A}=\mathrm{MAX}$ | 250 | 300 | 300 |  |
| $\mathrm{I}^{\text {CC }}$ S Supply current from $\mathrm{V}_{\mathrm{CC}}$ | Both control inputs at 0 V | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 1.5 | 1.5 | 1.5 | mA |
| $\mathrm{I}_{\mathrm{EE}} \quad$ Supply current from $\mathrm{V}_{\mathrm{EE}}$ |  |  | -5 | -5 | -5 |  |
| ILL $\quad$ Supply current from $\mathrm{V}_{\mathrm{LL}}$ |  |  | 4.5 | 4.5 | 4.5 |  |
| Iref $\quad$ Reference current |  |  | -2 | -2 | -2 |  |
| $\mathrm{I}_{\text {CC }} \quad$ Supply current from $\mathrm{V}_{\mathrm{CC}}$ | Both control inputs at 5 V | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 1.5 | 1.5 | 1.5 | mA |
| $\mathrm{I}_{\mathrm{EE}} \quad$ Supply current from $\mathrm{V}_{\mathrm{EE}}$ |  |  | -5 | -5 | -5 |  |
| ILL $\quad$ Supply current from $\mathrm{V}_{\mathrm{LL}}$ |  |  | 4.5 | 4.5 | 4.5 |  |
| Iref Reference current |  |  | -2 | -2 | -2 |  |

switching characteristics, $\mathrm{V}_{\mathrm{CC}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=-20 \mathrm{~V}, \mathrm{~V}_{\mathrm{LL}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

| PARAMETER |  | TEST CONDITIONS | TL1_M | TL1_I | TL1_C | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | TYP | TYP | TYP |  |
| $\mathrm{t}_{\text {on }}$ | Turn-on time |  | $R_{L}=300 \Omega, \quad C_{L}=30 \mathrm{pF}$, | 175 | 175 | 175 | ns |
| $t_{\text {off }}$ | Turn-off time | 350 |  | 350 | 350 |  |  |

## PARAMETER MEASUREMENT INFORMATION


$\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance

$$
\begin{aligned}
& V_{S}=3 V \text { for } t_{\text {on }} \text { and }-3 V \text { for } t_{o f f} \\
& V_{O}=V_{S} \frac{R_{L}}{R_{L}+r_{D S(o n)}}
\end{aligned}
$$

TEST CIRCUIT


NOTE: A. The solid waveform applies for TL185 and SW1 of TL185 and TL191; the dashed waveform applies for TL182 and SW2 of TL185 and TL191.
B. $V_{\mathrm{O}}$ is the steady-state output with the switch on. Feed through via the gate capacitance may result in spikes (not shown) at the leading and trailing edges of the output waveform

FIGURE 1. VOLTAGE WAVEFORMS

TL500I, TL500C, TL501I, TL501C ANALOG PROCESSORS<br>- True Differential Inputs<br>- Automatic Zero<br>- Automatic Polarity<br>- High Input Impedance . . . $10^{9}$ Ohms Typically

TL500I, TL500C CAPABILITIES

- Resolution . . 14 Bits (with TL502C)
- Linearity Error . . . 0.001 \%
- 4 1/2-Digit Readout Accuracy with External Precision Reference

TL502C/TL503C
DIGITAL PROCESSORS

- Fast Display Scan Rates
- Internal Oscillator May Be Driven or Free-Running
- Interdigit Blanking
- Over-Range Blanking
- 4 1/2-Digit Display Circuitry


## TL501I, TL501C CAPABILITIES

- Resolution . . 10-13 Bits (with TL502C)
- Linearity Error . . . 0.01\%
- 3 1/2-Digit Readout Accuracy

TL502C CAPABILITIES

- Compatible with Popular Seven-Segment Common-Anode Displays
- High-Sink-Current Segment Driver for Large Displays


## TL503C CAPABILITIES

- Multiplexed BCD Outputs
- High-Sink-Current BCD Outputs
- High-Sink-Current Digit Driver for Large Displays

Caution. These devices have limited built-in gate protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## description

The TL500I, TL500C, TL501I, and TL501C analog processors and TL502C and TL503C digital processors provide the basic functions for a dual-slope-integrating analog-to-digital converter.

The TL500 and TL501 contain the necessary analog switches and decoding circuits, reference voltage generator, buffer, integrator, and comparator. These devices may be controlled by the TL502C, TL503C, by discrete logic, or by a software routine in a microprocessor.
The TL502C and TL503C each includes oscillator, counter, control logic, and digit enable circuits. The TL502C provides multiplexed outputs for seven-segment displays, while the TL503C has multiplexed BCD outputs.

When used in complementary fashion, these devices form a system that features automatic zero-offset compensation, true differential inputs, high input impedance, and capability for $41 / 2$-digit accuracy. Applications include the conversion of analog data from high-impedance sensors of pressure, temperature, light, moisture, and position. Analog-to-digital-logic conversion provides display and control signals for weight scales, industrial controllers, thermometers, light-level indicators, and many other applications.

## principles of operation

The basic principle of dual-slope-integrating converters is relatively simple. A capacitor, $\mathrm{C}_{\mathrm{X}}$, is charged through the integrator from $V_{C T}$ for a fixed period of time at a rate determined by the value of the unknown voltage input. Then the capacitor is discharged at a fixed rate (determined by the reference voltage) back to $V_{C T}$ where the discharge time is measured precisely. The relationship of the charge and discharge values are shown below (see Figure 1).

$$
\begin{array}{ll}
V_{C X}=V_{C T}-\frac{V_{1 t_{1}}}{R_{X} C_{X}} & \text { Charge } \\
V_{C T}=V_{C X}-\frac{V_{\text {ref } t_{2}}}{R_{X} C_{X}} & \text { Discharge } \tag{2}
\end{array}
$$

Combining equations 1 and 2 results in:

$$
\begin{equation*}
\frac{V_{1}}{V_{\text {ref }}}=-\frac{t_{2}}{t_{1}} \tag{3}
\end{equation*}
$$

where:
$\mathrm{V}_{\mathrm{CT}}=$ Comparator (offset) threshold voltage
$V_{C X}=$ Voltage change across $C_{X}$ during $t_{1}$ and during $t_{2}$ (equal in magnitude)
$V_{I}=$ Average value of input voltage during $t_{1}$
$\mathrm{t}_{1}=$ Time period over which unknown voltage is integrated
t2 2 Unknown time period over which a known reference voltage is integrated.
Equation (3) illustrates the major advantages of a dual-slope converter:
a. Accuracy is not dependent on absolute values of $t_{1}$ and $t_{2}$, but is dependent on their ratios. Longterm clock frequency variations will not affect the accuracy.
b. Offset values, $\mathrm{V}_{\mathrm{C}}$, are not important.

The BCD counter in the digital processor (see Figure 2) and the control logic divide each measurement cycle into three phases. The BCD counter changes at a rate equal to one-half the oscillator frequency.

## auto-zero phase

The cycle begins at the end of the integrate-reference phase when the digital processor applies low levels to inputs $A$ and $B$ of the analog processor. If the trigger input is at a high level, a free-running condition exists and continuous conversions are made. However, if the trigger input is low, the digital processor stops the counter at 20,000, entering a hold mode. In this mode, the processor samples the trigger input every 4000 oscillator pulses until a high level is detected. When this occurs, the counter is started again and is carried to completion at 30,000 . The reference voltage is stored on reference capacitor Cref, comparator offset voltage is stored on integration capacitor $C_{X}$, and the sum of the buffer and integrator offset voltages is stored on zero capacitor $\mathrm{C}_{Z}$. During the auto-zero phase, the comparator output is characterized by an oscillation (limit cycle) of indeterminate waveform and frequency that is filtered and $d-c$ shifted by the level shifter.

## integrate-input phase

The auto-zero phase is completed at a BCD count of 30,000, and high levels are applied to both control inputs to initiate the integrate-input phase. The integrator charges $C_{X}$ for a fixed time of $10,000 \mathrm{BCD}$ counts at a rate determined by the input voltage. Note that during this phase, the analog inputs see only the high impedance of the noninverting operational amplifier input. Therefore, the integrator responds only to the difference between the analog input terminals, thus providing true differential inputs.

## TL500I, TL500C, TL501I, TL501C, TL502C, TL503C ANALOG-TO-DIGITAL-CONVERTER BUILDING BLOCK

## integrate-reference phase

At a $B C D$ count of $39,999+1=40,000$ or 0 , the integrate-input phase is terminated and the integratereference phase is begun by sampling the comparator output. If the comparator output is low corresponding to a negative average analog input voltage, the digital processor applies a low and a high to inputs $A$ and $B$, respectively, to apply the reference voltage stored on Cref to the buffer. If the comparator output is high corresponding to a positive input, inputs $A$ and $B$ are made high and low, respectively, and the negative of the stored reference voltage is applied to the buffer. In either case, the processor automatically selects the proper logic state to cause the integrator to ramp back toward zero at a rate proportional to the reference voltage. The time required to return to zero is measured by the counter in the digital processor. The phase is terminated when the integrator output crosses zero and the counter contents are transferred to the register, or when the BCD counter reaches 20,000 and the over-range indication is activated. When activated, the over-range indication blanks all but the most significant digit and sign.

Seventeen parallel bits (4-1/2 digits) of information are strobed into the buffer register at the end of the integration phase. Information for each digit is multiplexed out to the BCD outputs (TL503C) or the sevensegment drivers (TL502C) at a rate equal to the oscillator frequency divided by 200.

BCD COUNTER VALUES


[^11]FIGURE 1. VOLTAGE WAVEFORMS AND TIMING DIAGRAM

DIGITAL PROCESSOR
TL502C OR TL503C
(See Note A)

## description of analog processors

The TL500 and TL501 analog processors are designed to automatically compensate for internal zero offsets, integrate a differential voltage at the analog inputs, integrate a voltage at the reference input in the opposite direction, and provide an indication of zero-voltage crossing. The external control mechanism may be a microcomputer and software routing, discrete logic, or a TL502C or TL503C controller. The TL500 and TL501 are designed primarily for simple, cost-effective, dual-slope analog-todigital converters. Both devices feature true differential analog inputs, high input impedance, and an internal reference-voltage source. The TL500 provides 4-1/2-digit readout accuracy when used with a precision external reference voltage. The TL501 provides $100-\mathrm{ppm}$ linearity error and 3-1/2-digit accuracy capability. These devices are manufactured using TI's advanced technology to produce JFET, MOSFET, and bipolar devices on the same chip. The TL500C and TL501C are characterized for operation over the temperature range of $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$. The TL500l and TL5011 are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

J PACKAGE
(TOP VIEW)

| analog input 1 | ${ }^{18} 7$ |
| :---: | :---: |
| ANALOG INPUT 2 | 17 |
| REF OUTPUT ${ }^{3}$ | ${ }_{16} \mathrm{~V}_{\mathrm{CC}}+$ |
| REF input ${ }^{4}$ | 15 buffer output |
| ANALOG GND ${ }^{5}$ | 14 integrator input |
| $\mathrm{c}_{\text {ref }}+\mathrm{C}^{6}$ | 13 integrator output |
| $\mathrm{Cref}_{\text {- }} \mathrm{C}^{7}$ | ${ }_{12} \mathrm{~V}_{\text {CC }}-$ |
| CONTROL B input 8 | 11 digital common |
| CONTROL A INPUT 9 | 10. Comparator output |

DW PACKAGE
(TOP VIEW)

| ANALOG INPUT 101 | $\left.\mathrm{U}_{20}\right] \mathrm{Cz}$ |
| :---: | :---: |
| analog input $2{ }^{2}$ | ${ }_{19}{ }^{1} \mathrm{C}$ Z |
| REF OUTPUT ${ }^{3}$ | $18.10 \mathrm{Cc}+$ |
| REF INPUT 4 | 17 buffer output |
| ANALOG GND-5 | 16 Integrator input |
| $\mathrm{C}_{\text {ref }}+\square^{6}$ | 15 integrator output |
| $\mathrm{c}_{\text {ref }}{ }^{7}$ | ${ }_{14}{ }^{13} \mathrm{VCC}-$ |
| NC ${ }^{-1}$ | 13.12 |
| CONTROL B INPUT 9 | 12 digital common |
| CONTROL A INPUT 10 | 11. comparator output |

NC - No internal connection

## AVAILABLE OPTIONS

| TA $_{\mathbf{A}}$ | LINEARITY <br> ERROR | CERAMIC DIP <br> (J) | WIDE-BODY SO <br> (DW) |
| :---: | :---: | :---: | :---: |
|  |  | TL500CJ | TL500CDW |
|  | $0.05 \%$ FS | TL501CJ | TL501CDW |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $0.005 \%$ FS | TL500IJ | TL500IDW |
|  | $0.05 \%$ FS | TL5011J | TL501IDW |

## schematics of inputs and outputs


absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Positive supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ (see Note 1 )
Negative supply voltage, $\mathrm{V}_{\text {CC }}$ - . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 18 V
Input voltage, $\mathrm{V}_{\mathrm{I}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm$ VCC
Comparator output voltage range (see Note 2) ..................................... . . 0 V to VCC $_{+}$
Comparator output sink current (see Note 2) . ............................................. . 20 mA
Buffer, reference, or integrator output source current (see Note 2) . . . . . . . . . . . . . . . . . . . 10 mA
Total dissipation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . See Dissipation Rating Table
Operating free-air temperature range: TL500I, TL501I . . . . . . . . . . . . . . . . . . . . . . . . . -40 to $85^{\circ} \mathrm{C}$ TL500C, TL501C . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: DW package . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 60 seconds: J package ............. . $300^{\circ} \mathrm{C}$
NOTES: 1. Voltage values, except differential voltages, are with respect to the analog ground common pin tied together.
2. Buffer, integrator, and comparator outputs are not short-circuit protected.

DISSIPATION RATING TABLE

| PACKAGE | $T_{A} \leq 25{ }^{\circ} \mathrm{C}$ <br> POWER RATING | DERATING FACTOR <br> ABOVE TA$=25^{\circ} \mathrm{C}$ | $T_{A}=70^{\circ} \mathrm{C}$ <br> POWER RATING | $T_{A}=85^{\circ} \mathrm{C}$ <br> POWER RATING |
| :---: | :---: | :---: | :---: | :---: |
| DW | 1125 mW | $9 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 720 mW | 585 mW |
| J | 1025 mW | $8.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 656 mW | 533 mW |

## TL500I, TL500C, TL501I, TL501C ANALOG PROCESSORS

recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Positive supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ |  | 7 | 12 | 15 | V |
| Negative supply voltage, $\mathrm{V}_{\text {CC }}$ - |  | -9 | -12 | -15 | V |
| Reference input voltage, $\mathrm{V}_{\text {ref(I) }}$ |  | 0.1 |  | 5 | V |
| Analog input voltage, $\mathrm{V}_{1}$ |  |  |  | $\pm 5$ | V |
| Differential analog input voltage, $\mathrm{V}_{1 \mathrm{D}}$ |  |  |  | 10 | V |
| High-level input voltage, $\mathrm{V}_{1}$ | Control inputs | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ | Control inputs |  |  | 0.8 | V |
| Peak positive integrator output voltage, $\mathrm{V}_{\mathrm{OM}}+$ |  | +9 |  |  | V |
| Peak negative integrator output voltage, $\mathrm{V}_{\mathrm{OM}}$ - |  | -5 |  |  | V |
| Full scale input voltage |  |  |  | $\mathrm{V}_{\text {ref }}$ |  |
| Autozero and reference capacitors, $\mathrm{C}_{Z}$ and $\mathrm{C}_{\text {ref }}$ |  | 0.2 |  |  | $\mu \mathrm{F}$ |
| Integrator capacitor, $\mathrm{C}_{X}$ |  | 0.2 |  |  | $\mu \mathrm{F}$ |
| Integrator resistor, $\mathrm{R}_{\mathrm{X}}$ |  | 15 |  | 100 | k $\Omega$ |
| Integrator time constant, $\mathrm{R}_{\mathrm{X}} \mathrm{C}_{\mathrm{X}}$ |  | See <br> Note |  |  |  |
| Free-air operating temperature, $\mathrm{T}_{\mathrm{A}}$ | TL5001, TL5011 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TL500C, TL501C | 0 |  | 70 |  |
| Maximum conversion rate with TL502C or TL503C |  |  | 3 | 12.5 | conv/sec |

system electrical characteristics at $\mathrm{VCC}_{ \pm}= \pm 12 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=1,000 \pm 0.03 \mathrm{mV}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted) (see Figure 3)

| PARAMETER | TEST CONDITIONS | TL501 |  |  | TL500 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Zero error |  |  | 50 | 300 |  | 10 | 30 | $\mu \mathrm{V}$ |
| Linearity error relative to full scale | $\mathrm{V}_{1}=2 \mathrm{~V}$ to 2 V |  | 0.005 | 0.05 |  | 0.001 | 0.005 | \%FS |
| Full scale temperature coefficient | $\mathrm{T}_{\mathrm{A}}=$ full range | 6 |  |  | 6 |  |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Temperature coefficient of zero error |  | 4 |  |  | 1 |  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| Rollover error ${ }^{\dagger}$ |  |  | 200 | 500 |  | 30 | 100 | $\mu \mathrm{V}$ |
| Equivalent peak-to-peak input noise voltage |  | 20 |  |  |  | 20 |  | $\mu \mathrm{V}$ |
| Analog input resistance | Pin 1 or 2 | $10^{9}$ |  |  |  | $10^{9}$ |  | $\Omega$ |
| Common-mode rejection ratio | $\mathrm{V}_{\text {IC }}=-1 \mathrm{~V}$ to +1 V | 86 |  |  |  | 90 |  | dB |
| Current into analog input | $\mathrm{V}_{1}= \pm 5 \mathrm{~V}$ | 50 |  |  |  | 50 |  | pA |
| Supply voltage rejection ratio |  | 90 |  |  |  | 90 |  | dB |

${ }^{\dagger}$ Rollover error is the voltage difference between the conversion results of the full-scale positive 2 V and the full-scale negative 2 V . NOTE 3. The minimum integrator time constant may be found by use of the following formula:

$$
\text { Minimum } R_{X} C_{X}=\frac{V_{I D}(\text { full scale }) t_{1}}{\left|V_{O M}-\right|-V_{1}(\text { pin } 2)}
$$

where
$V_{I D}=$ voltage at pin with respect to pin 2
$V_{l}(\operatorname{pin} 2)=$ voltage at pin 2 with respect to analog ground
$\mathrm{t}_{1}=$ input integration time seconds

## TL5001, TL500C, TL501I, TL501C <br> ANALOG PROCESSORS

## electrical characteristics at $\mathrm{VCC}_{ \pm}= \pm 12 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=1 \mathrm{~V}, \mathrm{TA}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (see Figure 3)

integrator and buffer operational amplifiers

| PARAMETER |  | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{10}$ | Input offset voltage |  |  | 15 |  | mV |
| IB | Input bias current |  |  | 50 |  | pA |
| $\mathrm{V}_{\text {OM }}+$ | Positive output voltage swing |  | 9 | 11 |  | V |
| $\mathrm{V}_{\text {OM }}$ - | Negative output voltage swing |  | -5 | -7 |  | V |
| AVD | Voltage amplification |  |  | 110 |  | dB |
| $\mathrm{B}_{1}$ | Unity-gain bandwidth |  |  | 3 |  | MHz |
| CMRR | Common mode rejection | $\mathrm{V}_{\text {IC }}=-1 \mathrm{~V}$ to +1 V |  | 100 |  | dB |
| SR | Output slew rate |  |  | 5 |  | $\mathrm{V} / \mu \mathrm{S}$ |

comparator

|  | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{10}$ | Input offset voltage |  | 15 |  | mV |
| IIB | Input bias current |  | 50 |  | pA |
| AVD | Voltage amplification |  | 100 |  | dB |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ | 200 | 400 | mV |
| ${ }^{\mathrm{I}} \mathrm{OH}$ | High-level output current | $\mathrm{V}_{\mathrm{OH}}=3 \mathrm{~V}$ | 5 | 20 | nA |

voltage reference output

|  | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {ref }}(0)$ | Reference voltage |  | 1.12 | 1.22 | 1.32 | V |
| $\alpha \mathrm{V}_{\text {ref }}$ | Reference-voltage temperature coefficient | $\mathrm{T}_{\mathrm{A}}=$ full range |  | 80 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| ro | Reference output resistance |  |  | 3 |  | $\Omega$ |

logic control section

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | ---: | ---: | :---: | :---: |
| $I_{\text {IH }}$ | High-level input current | $\mathrm{V}_{\text {IH }}=2 \mathrm{~V}$ | 1 | 10 | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{IL}}$ | Low-level input current | $\mathrm{V}_{\text {IL }}=0.8 \mathrm{~V}$ | -40 | -300 | $\mu \mathrm{~A}$ |

total device

| PARAMETER | TEST CONDITIONS | MIN | TYP |
| :---: | :---: | :---: | :---: |
| ICC $+\quad$ Positive supply current |  | 15 | 20 |
| ICC - Negative supply current |  | mA |  |

## PARAMETER MEASUREMENT INFORMATION



NOTES: C. Tests are started approximately 5 seconds after power-on.
D. Capacitors used are TRW's $X 363 \cup W$ polypropylene or equivalent for $C_{X}, C_{r e f}$, and $C_{Z}$; however for $C_{r e f}$ and $C_{Z}$ film-dielectric capacitors may be substituted.

## FIGURE 3. TEST CIRCUIT CONFIGURATION

## external-component selection guide

The autozero capacitor $\mathrm{C}_{Z}$ and reference capacitor $\mathrm{C}_{\text {ref }}$ should be within the recommended range of operating conditions and should have low-leakage characteristics. Most film-dielectric capacitors and some tantalum capacitors provide acceptable results. Ceramic and aluminum capacitors are not recommended because of their relatively high-leakage characteristics.

The integrator capacitor $C_{X}$ should also be within the recommended range and must have good voltage linearity and low dielectric absorption. A polypropylene-dielectric capacitor similar to TRW's X363UW is recommended for 4-1/2-digit accuracy. For 3-1/2-digit applications, polyester, polycarbonate, and other film dielectrics are usually suitable. Ceramic and electrolytic capacitors are not recommended.

Stray coupling from the comparator output to any analog pin (in order of importance 17, 18, 14, 7, 6, $13,1,2,15$ ) must be minimized to avoid oscillations. In addition, all power supply pins should be bypassed at the package, for example, by a $0.01-\mu \mathrm{F}$ ceramic capacitor.

Analog and digital common are internally isolated and may be at different potentials. Digital common can be within 4 V of positive or negative supply with the logic decode still functioning properly.

The time constant $\mathrm{R}_{\mathrm{X}} \mathrm{C}_{\mathrm{X}}$ should be kept as near the minimum value as possible and is given by the formula:

$$
\text { Minimum } R_{X} C_{X}=\frac{V_{I D}\left(\text { full scale) } t_{1}\right.}{\left|V_{O M}-\right|-V_{I}(\operatorname{pin} 2)}
$$

where:
$\mathrm{V}_{\text {ID }}$ (full scale) $=$ Voltage on pin 1 with respect to pin 2
$\mathrm{t}_{1}=$ Input integration time in seconds
$\mathrm{V}_{\mathrm{I}(\mathrm{pin} 2)}=$ Voltage on pin 2 with respect to analog ground.

## description of digital processors

The TL502C and TL503C are control logic devices designed to complement the TL500 and TL501 analog processors. They feature interdigit blanking, over-range blanking, an internal oscillator, and a fast display scan rate. The internal-oscillator input is a Schmitt trigger circuit that can be driven by an external clock pulse or provide its own time base with the addition of a capacitor. The typical oscillator frequency is 120 kHz with a $470-\mathrm{pF}$ capacitor connected between the oscillator input and ground.

The TL502C provides seven-segment-display output drivers capable of sinking 100 mA and compatible with popular common-anode displays. The TL503C has four BCD output drivers capable of $100-\mathrm{mA}$ sink currents. The code (see next page and Figure 4) for each digit is multiplexed to the output drivers in phase with a pulse on the appropriate digit-enable line at a digit rate equal to $f_{\text {osc }}$, divided by 200 . Each digit-enable output is capable of sinking $20-\mathrm{mA}$.

The comparator input of each device, in addition to monitoring the output of the zero-crossing detector in the analog processor, may be used in the display test mode to check for wiring and display faults. A high logic level ( 2 to 6.5 V ) at the trigger input with the comparator input at or below 6.5 V starts the integrate-input phase. Voltage levels equal to or greater than 7.9 V on both the trigger and comparator inputs clear the system and set the BCD counter to 20,000 . When normal operation resumes, the conversion cycle is restarted at the auto zero phase.

These devices are manufactured using 12 L and bipolar techniques. The TL502C and TL503C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.


TABLE OF SPECIAL FUNCTIONS
$V_{C C}=5 \mathrm{~V} \pm 10 \%$

| TRIGGER <br> INPUT | COMPARATOR <br> INPUT | FUNCTION |
| :--- | :---: | :--- |
| $\mathrm{V}_{1} \leq 0.8 \mathrm{~V}$ | $\mathrm{~V}_{1} \leq 6.5 \mathrm{~V}$ | Hold at auto-zero cycle after completion of conversion |
| $2 \mathrm{~V} \leq \mathrm{V}_{1} \leq 6.5 \mathrm{~V}$ | $\mathrm{~V}_{1} \leq 6.5 \mathrm{~V}$ | Normal operation (continuous conversion) |
| $\mathrm{V}_{1} \leq 6.5 \mathrm{~V}$ | $\mathrm{~V}_{1} \geq 7.9 \mathrm{~V}$ | Display Test: All BCD outputs high |
| $\mathrm{V}_{1} \geq 7.9 \mathrm{~V}$ | $\mathrm{~V}_{1} \leq 6.5 \mathrm{~V}$ | Internal Test |
| Both inputs to go $\mathrm{V}_{1} \geq 7.9 \mathrm{~V}$ <br> simultaneously | System clear: Sets BCD counter to 20,000. <br> When normal operation is resumed, cycle begins with Auto Zero. |  |

DIGIT 5 (MOST SIGNIFICANT DIGIT) CHARACTER CODES

| CHARACTER | TL502C SEVEN-SEGMENT LINES |  |  |  |  |  |  | TL503C BCD OUTPUT LINES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | A | B | C | D | E | F | G | 03 | 02 | Q1 | 00 |
| + | H | H | H | H | L | L | L | H | L | H | L |
| + 1 | H | L | L | H | L | L | L | H | H | H | L |
| - | L | H | H | L | H | H | L | H | L | H | H |
| -1 | L | L | L | L | H | H | L | H | H | H | H |

DIGITS 1 THRU 4 NUMERIC CODE (See Figure 4)

| NUMBER | TL502C SEVEN-SEGMENT LINES |  |  |  |  |  |  | TL503C BCD OUTPUT LINES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | A | B | C | D | E | F | G | $\begin{gathered} 03 \\ 8 \end{gathered}$ | O2 | $\begin{gathered} \mathrm{Q1} \\ \text { ? } \end{gathered}$ | $00$ |
| 0 | L | L | L | L | L | L | H | L | L | L | L |
| 1 | H | L | L | H | H | H | H | L | L | L | H |
| 2 | L | L | H | L | L | H | L | L | L | H | L |
| 3 | L | L | L | L | H | H | L | L | L | H | H |
| 4 | H | L | L | H | H | L | L | L | H | L | L |
| 5 | L | H | L | L | H | L | L | L | H | L | H |
| 6 | L | H | L | L | L | L | L | L | H | H | L |
| 7 | L | L | L | H | H | H | H | L | H | H | H |
| 8 | L | L | L | L | L | L | L | H | L | L | L |
| 9 | L | L | L | L | H | L | L | H | L | L | H |

$H=$ high level, $L=$ low level
schematics of inputs and outputs


## TL502C, TL503C

DIGITAL PROCESSORS

## absolute maximum ratings

| Supply voltage, $\mathrm{V}_{\text {CC }}$ (see Note 4) |  | 7 | V |
| :---: | :---: | :---: | :---: |
| Input voltage, $\mathrm{V}_{\mathrm{l}}$ | Oscillator | 5.5 | V |
|  | Comparator or Trigger | 9 |  |
| Output current | BCD or Segment drivers | 120 | mA |
|  | Digit-enable outputs | 40 |  |
|  | Pin 18 (TL502C only) | 20 |  |
| Total power dissipation at (or below) $30^{\circ} \mathrm{C}$ free-air temperature (see Note 5) |  | 1100 | mW |
| Operating free-air temperature range |  | 0 to 70 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature range |  | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch) from case for 10 seconds |  | 260 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 4. Voltage values are with respect to the network ground terminal.
5. For operation above $30^{\circ} \mathrm{C}$ free-air temperature, derate linearly to 736 mW at $70^{\circ} \mathrm{C}$ at the rate of $9.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$.

## recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | 4.5 | 5 | 5.5 | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | Comparator and trigger inputs | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ | Comparator and trigger inputs |  |  | 0.8 | V |
| Operating free-air temperature |  | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |


|  | PARAMETER | TERMINAL | TEST CONDITIONS | TL502C | TL503C |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN TYP MAX | MIN | TYP MAX |  |
|  | $\mathrm{V}_{\mathrm{IK}} \quad$ Input clamp voltage | All inputs | $\mathrm{V}_{C C}=4.5 \mathrm{~V}, \quad \mathrm{I}=-12 \mathrm{~mA}$ | -0.8 -1.5 |  | -0.8 -1.5 | V |
|  | $V_{T+} \quad$Positive-going input <br> threshold voltage | Oscillator | $\mathrm{V}_{C C}=5 \mathrm{~V}$ | 1.5 |  | 1.5 | v |
|  | $V_{T-} \quad$Negative-going input <br> threshold voltage | Oscillator | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | 0.9 |  | 0.9 | v |
|  | $\mathrm{V}_{\mathrm{T}+}-\mathrm{V}_{\mathrm{T}_{-}}$Hysteresis | Oscillator | $\mathrm{V}_{C C}=5 \mathrm{~V}$ | 0.4 0.6 0.8 | 0.4 | 0.6 |  |
|  | $1 T+\quad$Input current at <br> positive-going input <br> threshold voltage | Oscillator | $V_{C C}=5 \mathrm{~V}$ | $\begin{array}{llll}-40 & -94 & -170\end{array}$ | -40 | -94-170 | $\mu \mathrm{A}$ |
|  | IT- $\quad$Input current at <br> negative-going input <br> threshold voltage | Oscillator | $V_{C C}=5 \mathrm{~V}$ | $40 \quad 117 \quad 170$ | 40 | 117170 | $\mu \mathrm{A}$ |
|  |  | Digit enable |  | $4.15 \quad 4.4$ | 4.15 | 4.4 |  |
|  | $\mathrm{V}_{\mathrm{OH}} \quad$ High-level output voltage | Pin 18 (TL502C only) | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}, \quad \mathrm{I}^{\text {OH }}=0$ | 4.254 .4 |  |  | V |
|  |  | Control A and B |  | $4.25 \quad 4.4$ | 4.25 | 4.4 |  |
|  |  | Digit enable | $1 \mathrm{OL}=20 \mathrm{~mA}$ |  |  | 0.20 .5 |  |
|  |  | Pin 18 (TL502C only) | $\mathrm{IOL}=10 \mathrm{~mA}$ | $0.15 \quad 0.4$ |  |  |  |
|  | VOL Low-level output voltage | Control A and B | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} \quad 1 \mathrm{OL}=2 \mathrm{~mA}$ | $0.088 \quad 0.4$ |  | $0.088 \quad 0.4$ | $v$ |
|  |  | Segment drivers | $\mathrm{I}^{\mathrm{OL}}=100 \mathrm{~mA}$ | $0.17 \quad 0.3$ |  |  |  |
|  |  | BCD drivers | $\mathrm{OL}=100 \mathrm{~mA}$ |  |  | $0.17 \quad 0.3$ |  |
|  | I Input current | Comparator, Trigger | $\mathrm{V}_{C C}=5.5 \mathrm{~V}, \quad \mathrm{~V}_{1}=5.5 \mathrm{~V}$ | $65 \quad 100$ |  | $65 \quad 100$ | $\mu \mathrm{A}$ |
|  | I Input current | Oscillator | $V_{C C}=5.5 \mathrm{~V}, \quad V_{1}=5.5 \mathrm{~V}$ | 1 |  | 1 | mA |
|  | IHH High-level input current | Comparator, Trigger |  | $\begin{array}{ll}-0.6 & -1\end{array}$ |  | -0.6 -1 | mA |
|  | IH High-level input current | Oscillator | $V_{C C}=5.5 \mathrm{~V}, \quad V_{1}=2.4 \mathrm{~V}$ | 0.5 |  | 0.5 | mA |
|  | II Low-level input voltage | Oscillator | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \quad \mathrm{~V}_{1}=0.4 \mathrm{~V}$ | -0.1-0.17 |  | -0.1-0.17 | mA |
|  | ILL Low-level input votage | Comparator, Trigger | $v_{C C}=5.5 \mathrm{~V}, \quad v_{1}=0.4 \mathrm{~V}$ | -1-1.6 |  | -1 -1.6 | ma |
|  |  | Digit enable | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$, | -2.5 - 4 | -2.5 | -4 |  |
|  |  | Pin 18 (TL502C only) | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ | -0.5 -0.9 |  |  |  |
|  | $\mathrm{IOH}$ <br> (Output transistor off) | Control A and B | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V} \quad \mathrm{~V}_{\mathrm{O}}=0.5 \mathrm{~V}$ | -0.25 -0.4 | -0.25 | -0.4 | mA |
|  |  | Segment drivers | $\mathrm{V}_{\mathrm{O}}=5.5 \mathrm{~V}$ | 0.25 |  |  |  |
|  |  | BCD drivers | $\mathrm{V}_{0}=5.5 \mathrm{~V}$ |  |  | 0.25 |  |
|  | IOL $\quad$Low-level output current <br> (Output transistor on) | Digit enable | $\mathrm{V}_{\mathrm{CC}}=4.5 \mathrm{~V}, \quad \mathrm{~V}_{\mathrm{O}}=3.55 \mathrm{~V}$ | 1823 |  |  | mA |
|  | ICC Supply current | $\mathrm{V}_{\text {CC }}$ | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ | $73 \quad 110$ |  | $73 \quad 110$ | mA |

## TL502C, TL503C <br> DIGITAL PROCESSORS

## special functions ${ }^{\dagger}$ operating characteristics at $25^{\circ} \mathrm{C}$ free-air temperature

| PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | ---: | ---: | :---: |
| Input current into <br> comparator or trigger inputs | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \quad \mathrm{~V}_{1}=8.55 \mathrm{~V}$ | 1.2 | 1.8 | mA |
|  | $\mathrm{~V}_{\mathrm{CC}}=5.5 \mathrm{~V}, \quad \mathrm{~V}_{1}=6.25 \mathrm{~V}$ | 0.5 | mA |  |

${ }^{\dagger}$ The comparator and trigger inputs may be used in the normal mode or to perform special functions. See the Table of Special Functions.

TYPICAL APPLICATION DATA
2


NOTE E: The BCD or seven-segment driver outputs are present for a particular digit slightly before the falling edge of that digit enable.
FIGURE 4. TL502C, TL503C DIGIT TIMING WITH $\mathbf{1 2 0}-\mathrm{kHz}$ CLOCK SIGNAL AT OSCILLATOR INPUT

- 3-Digit Accuracy (0.1\%)
- 10-Bit Resolution
- Automatic Zero
- Internal Reference Voltage
- Single-Supply Operation
- High-Impedance MOS Input
- Designed for Use with TMS1000 Type Microprocessors for Cost-Effective High-Volume Applications
- BI-MOS Technology
- Only 40 mW Typical Power Consumption

Caution. This device has limited built-in gate protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## description

The TL505C is an analog-to-digital converter building block designed for use with TMS1000 type microprocessors. It contains the analog elements (operational amplifier, comparator, voltage reference, analog switches, and switch drivers) necessary for a unipolar automatic-zeroing dual-slope converter. The logic for the dual-slope conversion can be performed by the associated MPU as a software routine or can be implemented with other components, such as the TL502 logic-control device.

The high-impedance MOS inputs permit the use of less expensive, lower value capacitors for the integration and offset capacitors and permit conversion speeds from 20 per second to 0.05 per second.
The TL505C is a product of TI's BI-MOS process, which incorporates bipolar and MOSFET transistors on the same monolithic circuit. The TL505C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## TL505C

## ANALOG-TO-DIGITAL CONVERTER

functional block diagram


NOTE: Analog and digital GND are internally connected together.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

> Supply voltage, VCC (see Note 1)
> Input voltage, pins 2, 4, 6, and 7 . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . VCC
> Continuous total dissipation at (or below) $25^{\circ} \mathrm{C}$ free-air temperature (see Note 2) . . . . . . 1150 mW
> Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
> Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
> Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16$ inch) from case for 10 seconds . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$

NOTES: 1. Voltage values are with respect to the two ground terminals connected together.
2. For operation above $25^{\circ} \mathrm{C}$ free-air temperature, derate linearly to 736 mW at $70^{\circ} \mathrm{C}$ at the rate of $9.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$.
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ | 7 | 9 | 15 | V |
| Analog input voltage, $\mathrm{V}_{1}$ | 0 |  | 4 | V |
| Reference input voltage, $\mathrm{V}_{\text {ref( }}(\mathrm{I})$ | 0.5 |  | 3 | V |
| High-level input voltage at $A$ or $B, V_{1 H}$ | 3.6 |  | $\mathrm{V}_{\mathrm{CC}}+1$ | V |
| Low-level input voltage at A or $\mathrm{B}, \mathrm{V}_{\text {IL }}$ | 0.2 |  | 1.8 | V |
| Integrator capacitor, $\mathrm{C}_{X}$ | See "component selection" |  |  |  |
| Integrator resistor, $\mathrm{R}_{\mathbf{X}}$ | 0.5 |  | 2 | $\mathrm{M} \Omega$ |
| Integration time, $\mathrm{t}_{1}$ | 16.6 |  | 500 | ms |
| Operating free-air temperature, $T_{A}$ | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

electrical characteristics, $V_{C C}=9 \mathrm{~V}, \mathrm{~V}_{\mathrm{ref}}(\mathrm{I})=1 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, connected as shown in Figure 1 (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage at pin 8 | $\mathrm{I}^{\mathrm{OH}}=0$ | 7.58 .5 |  | V |
| ${ }^{\mathrm{I}} \mathrm{OH}$ | High-level output current at pin 8 | $\mathrm{V}_{\mathrm{OH}}=7.5 \mathrm{~V}$ | -100 |  | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage at pin 8 | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ | 200 | 400 | mV |
| VOM | Maximum peak output voltage swing at integrator output | $R X \geq 500 \mathrm{k} \Omega$ | $V_{C C}-2 V_{C C}-1$ |  | V |
| $V_{\text {ref( }}(0)$ | Reference output voltage | $I_{\text {ref }}=-100 \mu \mathrm{~A}$ | $1.15 \quad 1.22$ | 1.35 | V |
| $\alpha$ Vref | Temperature coefficient of reference output voltage | $\mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | $\pm 100$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| I H | High-level input current into A or B | $\mathrm{V}_{1}=9 \mathrm{~V}$ | 1 | 10 | $\mu \mathrm{A}$ |
| IIL | Low-level input current into A or B | $\mathrm{V}_{1}=1 \mathrm{~V}$ | 10 | 200 | $\mu \mathrm{A}$ |
| II | Current into analog input | $\mathrm{V}_{1}=0$ to 4 V , A input at 0 V | $\pm 10$ | $\pm 200$ | pA |
| I/B | Total integrator input bias current |  | $\pm 10$ |  | pA |
| ${ }^{1} \mathrm{CC}$ | Supply current | No load | 4.5 | 8 | mA |

system electrical characteristics, $\mathrm{VCC}=9 \mathrm{~V}, \mathrm{~V}_{\text {ref }}(\mathrm{I})=1 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, connected as shown in Figure 1 (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP |
| :--- | :--- | :---: | :---: |
| Zero error | $\mathrm{V}_{1}=0$ | 0.1 | 0.4 |
| Linearity error | $\mathrm{V}_{1}=0$ to 4 V | mV |  |
| Ratiometric reading | $\mathrm{V}_{1}=\mathrm{V}_{\text {ref }(I)} \approx 1 \mathrm{~V}$ | 0.02 | 0.1 |
| Temperature coefficient of <br> ratiometric reading | $\mathrm{V}_{\text {ref }}(1) \operatorname{constant~and~} \approx 1 \mathrm{~V}$, |  |  |

## DEFINITION OF TERMS

## Zero Error

The intercept (b) of the anolog-to-digital converter system transfer function $y=m x+b$, where $y$ is the digital output, $x$ is the analog input, and $m$ is the slope of the transfer function, which is approximated by the ratiometric reading.

## Linearity Error

The maximum magnitude of the deviation from a straight line between the end points of the transfer function.

## Ratiometric Reading

The ratio of negative integration time $\left(\mathrm{t}_{2}\right)$ to positive time $\left(\mathrm{t}_{1}\right)$.

## PRINCIPLES OF OPERATION

A block diagram of an MPU system using the TL505C is shown in Figure 1. The TL505C operates in a modified positive-integration, three-step, dual-slope conversion mode. The A/D converter waveforms during the conversion process are illustrated in Figure 2.


FIGURE 1. FUNCTIONAL BLOCK DIAGRAM OF TL505C INTERFACE WITH A MICROPROCESSOR SYSTEM


FIGURE 2. CONVERSION PROCESS TIMING DIAGRAMS

## PRINCIPLES OF OPERATION (Continued)

The first step of the conversion process is the auto-zero period to. By the end of this period, the integrator offset is stored in the autozero capacitor, and the offset of the comparator is stored in the integrator capacitor. To achieve this end, the MPU takes the A and B inputs low, which closes S1 and S2. The output of the comparator is connected to the input of the integrator through the low-pass filter consisting of $\mathrm{R}_{\mathrm{Z}}$ and $C_{Z}$. The closed loop of $A 1$ and $A 2$ seeks a null condition in which the offsets of the integrator and comparator are stored in $\mathrm{C}_{Z}$ and $\mathrm{C}_{X}$, respectively. This null condition is characterized by a high-frequency oscillation at the output of the comparator. The purpose of $S 2 B$ is to shorten the amount of time required to reach the null condition.
At the conclusion of $t_{0}$, the MPU takes the $A$ and $B$ inputs both high, which closes $S 3$ and opens all other switches. The input signal $V_{1}$ is applied to the noninverting input of $A 1$ through $C_{Z} . V_{1}$ is then positively integrated by $A 1$. Since the offset of $A 1$ is stored in $C_{Z}$, the change in voltage across $C_{X}$ is due to only the input voltage. Since the input is integrated in a positive integration during $\mathrm{t}_{1}$, the output of A 1 will be the sum of the input voltage, the integral of the input voltage, and the comparator offset, as shown in Figure 2. The change in voltage across capacitor $C_{X}\left(V_{C X}\right)$ during $t_{1}$ is given by

$$
\begin{equation*}
\Delta V_{C X}(1)=\frac{V_{1} t_{1}}{R_{1} C X} \tag{1}
\end{equation*}
$$

where $R_{1}=R_{X}+R_{S 3} B$ and $R_{S 3}$ is the resistance of switch S3B.
At the end of $t 1$, the MPU takes the A input low and the B input high, which closes S1 and S4 and opens all other switches. In this state, the reference is integrated by A1 in a negative sense until the integrator output reaches the comparator threshold. At this point, the comparator output goes high. This change in state is sensed by the MPU, which terminates $t_{2}$ by again taking the $A$ and $B$ inputs both low. During $t_{2}$, the change in voltage across $C X$ is given by

$$
\begin{equation*}
\Delta V_{C X}(2)=\frac{V_{\text {reft }}}{R_{2} C_{X}} \tag{2}
\end{equation*}
$$

where $R_{2}=R_{X}+R_{S 4}+R_{r e f}$ and $R_{r e f}$ is the equivalent resistance of the reference divider.
Since $\Delta \mathrm{V}_{\mathrm{CX}} 1=-\Delta \mathrm{V}_{\mathrm{CX}}$, equations (1) and (2) can be combined to give

$$
\begin{equation*}
V_{1}=V_{\text {ref }} \frac{R_{1} \cdot t_{2}}{R_{2} \cdot t_{1}} \tag{3}
\end{equation*}
$$

This equation is a variation on the ideal dual-slope equation, which is

$$
\begin{equation*}
V_{1}=V_{\text {ref }} \frac{t_{2}}{t_{1}} \tag{4}
\end{equation*}
$$

Ideally then, the ratio of $\mathrm{R}_{1} / \mathrm{R}_{2}$ would be exactly equal to one. In a typical TL505C system where $R_{X}=1 \mathrm{M} \Omega$, the scaling error introduced by the difference in $R_{1}$ and $R_{2}$ is so small that it can be neglected, and equation (3) reduces to (4).

## PRINCIPLES OF OPERATION (Continued)

## component selection

The autozero capacitor $C_{Z}$ should be within the recommended range of operating conditions and should have low leakage characteristics. Most film-dielectric capacitors and some tantalum capacitors provide acceptable results. Ceramic and aluminum capacitors are not recommended because of their relatively high leakage characteristics.

The integrator capacitor $C_{X}$ should also be within the recommended range and must have good voltage linearity and low dielectric absorption. For 10-bit applications, polyster, polycarbonate, and other film dielectrics are usually suitable. If greater precision or stability is required, a polypropylene-dielectric capacitor similar to TRW's X363UW might be appropriate.

Stray coupling from the comparator output to any analog pin (in order of importance, 13, 11, 10, 2, 4) must be minimized to avoid oscillations. In addition, all power supply pins should be bypassed at the package, for example, by a $0.01-\mu \mathrm{F}$ ceramic capacitor.

The time constant $\mathrm{RX}_{X} \mathrm{C}_{X}$ should be kept as near the minimum value as possible and is given by the formula:

$$
\text { Minimum } R_{X} C_{X}=\frac{V_{I(\max )} t_{1}}{\left(V_{C C}-2 V-V_{I(\max )}\right)}
$$

where:

$$
\begin{aligned}
\mathrm{t}_{1} & =\text { Input integration time in seconds, } \\
\mathrm{V}_{\mathrm{I}(\max )} & =\text { the maximum value of the analog input voltage }, \\
\mathrm{V}_{\mathrm{CC}}-2 \mathrm{~V} & =\text { the maximum voltage swing of the integrator input. }
\end{aligned}
$$

## TYPICAL APPLICATION DATA



NOTE 3: Connect to either 9 V or 0 V depending on which device in the TMS 1000 series is used and how it is programmed.
FIGURE 3. TL505C IN CONJUNCTION WITH A TMS1000 SERIES MICROPROCESSOR FOR A 3-DIGITAL PANEL METER APPLICATION


FIGURE 4. AUDIO PEAK POWER METER

| 2 |
| :--- |
| 0 |
| 0 |
| 0 |
| 0 |
| 0 |
|  |
| 0 |
| 0 |
| 0 |
| 0 |

- Low Cost
- 7-Bit Resolution
- Monotonicity Over Entire A/D Conversion Range
- Ratiometric Conversion
- Conversion Speed . . . Approximately 1 ms
- Single-Supply Operation . . . Either Unregulated 8-V to 18-V (VCC2 Input), or Regulated 3.5-V to 6-V (VCC1 Input)
- $\mathbf{1 2}^{2}$ Technology
- Power Consumption at 5 V ... 25 mW Typ
- Regulated 5.5 V Output ( $\leq 1 \mathrm{~mA}$ )


## description

The TL507 is a low-cost single-slope analog-todigital converter designed to convert analog input voltages between $0.25 \mathrm{~V}_{\mathrm{CC}} 1$ and 0.75 $V_{C C 1}$ into a pulse-width-modulated output code. The device contains a 7-bit synchronous counter, a binary weighted resistor ladder network, an operational amplifier, two comparators, a buffer amplifier, an internal regulator, and necessary logic circuitry. Integrated-injection logic ( 2 L ) technology makes it possible to offer this complex circuit at low cost in a small dual-in-line 8-pin package.
In continuous operation, conversion speeds of up to 1000 conversions per second are possible. The TL507 requires external signals for clock, reset, and enable. Versatility and simplicity of operation, coupled with low cost, makes this converter especially useful for a wide variety of applications.
The TL5071 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TL507C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram (positive logic)



Sindicates an $n-p-n$ open-collector output.

## schematics of inputs and outputs


absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VCC1 (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Supply voltage, $\mathrm{VCC}_{\mathrm{CC}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 V
Input voltage at analog input . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Input voltage at enable, clock, and reset inputs . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 20 \mathrm{~V}$
On-state output voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6 V
Off-state output voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20 V
Continuous total dissipation at (or below) $25^{\circ} \mathrm{C}$ free-air temperature (see Note 2) . . . . . . 1000 mW

Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
NOTES: 1. Voltage values are with respect to network ground terminal unless otherwise noted.
2. For operation above $25^{\circ} \mathrm{C}$ free-air temperature, derate linearly to 520 mW at $85^{\circ} \mathrm{C}$ at the rate of $8.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$.

## TL507I, TL507C ANALOG-TO-DIGITAL CONVERTER

recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ | 3.5 | 5 | 6 | V |
| Supply voltage, $\mathrm{V}_{\mathrm{CC} 2}$ | 8 | 15 | 18 | V |
| Input voltage at analog input | 0 |  | 5.5 | V |
| Input voltage at chip enable, clock, and reset inputs |  |  | $\pm 18$ | V |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$, reset and enable | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{1 \mathrm{LL}}$, reset and enable |  |  | 0.8 | V |
| On-state output voltage |  |  | 5.5 | V |
| Off-state output voltage |  |  | 18 | V |
| Clock frequency, fclock | 0 | 125 | 150 | kHz |

electrical characteristics over recommended operating free-air temperature range,
$\mathrm{V}_{\mathrm{CC}} 1=\mathrm{V}$ CC2 $=5 \mathrm{~V}$ (unless otherwise noted)
regulator section

| PARAMETER | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC1 }}$ Supply voltage (output) | $\mathrm{V}_{\mathrm{CC} 2}=10$ to 18 V , | ICC1 $=0$ to -1 mA | 5 | 5.5 | 6 | V |
| ICC1 Supply current | $\mathrm{V}_{\mathrm{CC} 1}=5 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{C}} 2$ open |  | 5 | 8 | mA |
| ICC2 Supply current | $\mathrm{V}_{\mathrm{CC} 2}=15 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{CC} 1}$ open |  | 7 | 10 | mA |

inputs

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{T}+}$ Positive-going threshold voltage ${ }^{\ddagger}$ | Clock Input |  |  |  | 4.5 | V |
| $\mathrm{V}_{\mathrm{T}}$ - Negative-going threshold voltage ${ }^{\ddagger}$ |  |  | 0.4 |  |  | V |
| $\mathrm{V}_{\text {hys }}$ Hysteresis ( $\mathrm{V}_{\mathrm{T}+}-\mathrm{V}_{\mathrm{T}-}$ ) |  |  | 2 | 2.6 | 4 | V |
| High-level input current | Reset, Enable, and Clock | $\mathrm{V}_{1}=2.4 \mathrm{~V}$ |  | 17 | 35 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{1}=18 \mathrm{~V}$ | 130 | 220 | 320 |  |
| IIL Low-level input current |  | $\mathrm{V}_{1}=0$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| II Analog input current |  | $\mathrm{V}_{1}=4 \mathrm{~V}$ |  | 10 | 300 | nA |

output section

| PARAMETER | TEST CONDITIONS | MIN | TYP $\dagger$ | MAX |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{OH}}$ | High-level output current | $\mathrm{V}_{\mathrm{OH}}=18 \mathrm{~V}$ | 0.1 | 100 |
| $\mathrm{I}_{\mathrm{OL}}$ | Low-level output current | $\mathrm{V}_{\mathrm{OL}}=5.5 \mathrm{~V}$ | $\mu \mathrm{~A}$ |  |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ | 5 | 10 |

operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}} 1=\mathrm{V}_{\mathrm{CC}}=5.12 \mathrm{~V}$

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ |
| :--- | :---: | :---: | :---: |
| Overall error |  | MAX | UNIT |
| Differential nonlinearity | See Figure 1 | $\pm 80$ | mV |
| Zero error ${ }^{\ddagger}$ | Binary count $=0$ | $\pm 20$ | mV |
| Scale error | Binary count $=127$ | $\pm 80$ | mV |
| Full scale input voltage ${ }^{\ddagger}$ | Binary count $=127$ | $\pm 80$ | mV |
| Propagation delay time from reset or enable |  | 3.74 | 3.82 |

[^12]
## TL507I, TL507C

## ANALOG-TO-DIGITAL CONVERTER

## definitions

## zero error

The absolute value of the difference between the actual analog voltage at the 01 H -to- 00 H transition and the ideal analog voltage at that transition.
overall error
The magnitude of the deviation from a straight line between the endpoints of the transfer function.

## differential nonlinearity

The maximum deviation of analog-value change associated with a 1-bit code change ( 1 clock pulse) from its theoretical value of 1 LSB.

PARAMETER MEASUREMENT INFORMATION


FIGURE 1. MONOTONICITY AND NONLINEARITY TEST CIRCUIT

## TL507I, TL507C ANALOG-TO-DIGITAL CONVERTER

## PRINCIPLES OF OPERATION

The TL507 is a single-slope analog-to-digital converter. All single-slope converters are basically voltage-to-time or current-to-time converters. A study of the functional block diagram shows the versatility of the TL507.

An external clock signal is applied through a buffer to a negative-edge-triggered synchronous counter. Binaryweighted resistors from the counter are connected to an operational amplifier used as an adder. The operational amplifier generates a signal that ramps from $0.75 \cdot \mathrm{~V}_{\mathrm{CC}} 1$ down to $0.25 \cdot \mathrm{~V}_{\mathrm{CC}} 1$. Comparator 1 compares the ramp signal to the analog input signal. Comparator 2 functions as a fault defector. With the analog input voltage in the range $0.25 \cdot V_{C C 1}$ to $0.75 \cdot V_{C C 1}$, the duty cycle of the output signal is determined by the unknown analog input, as shown in Figure 2 and the Function Table.

For illustration, assume $\mathrm{V}_{\mathrm{CC}} 1=5.12 \mathrm{~V}$,

$$
\begin{aligned}
0.25 \cdot \mathrm{~V}_{\mathrm{CC} 1} & =1.28 \mathrm{~V} \\
1 \text { binary count } & =\frac{(0.75-0.25) \mathrm{VCC}_{\mathrm{CC}}}{128}=20 \mathrm{mV} \\
0.75 \cdot \mathrm{~V}_{\mathrm{CC} 1}-1 \text { count } & =3.82 \mathrm{~V}
\end{aligned}
$$

The output is an open-collector n-p-n transistor capable of withstanding up to 18 V in the off state. The output is current limited to the 8 - to $12-\mathrm{mA}$ range; however, care must be taken to ensure that the output does not exceed 5.5 V in the on state.

The voltage regulator section allows operation from either an unregulated 8- to $18-\mathrm{V} \mathrm{V}_{\mathrm{CC}}$ source or a regulated 3.5 - to $6-V_{\text {CC1 }}$ source. Regardless of which external power source is used, the internal circuitry operates at $V_{C C 1}$. When operating from a $V_{C C 1}$ source, $V_{C C 2}$ may be connected to $V_{C C 1}$ or left open. When operating from a $V_{C C 2}$ source, $V_{C C 1}$ can be used as a reference voltage output.


OUTPUT FOR INPUT LEVEL 2

FIGURE 2

2

## - Switch $\pm 10-\mathrm{V}$ Analog Signals

## TTL Logic Capability

- 5- to 30-V Supply Ranges
- Low (100 $\Omega$ ) On-State Resistance
- High (1011 $\Omega$ ) Off-State Resistance
- 8-Pin Functions


## description

The TL601, TL604, TL607, and TL610 are a family of monolithic P-MOS analog switches that provide fast switching speeds with high $r_{\text {off }} / r_{\text {on }}$ ratio and no offset voltage. The p-channel enhancement-type MOS switches accept analog signals up to $\pm 10 \mathrm{~V}$ and are controlled by TTLcompatible logic inputs. The monolithic structure is made possible by $\mathrm{BI}-\mathrm{MOS}$ technology, which combines p-channel MOS with standard bipolar transistors.

These switches are particularly useful in military, industrial, and commercial applications such as data acquisition, multiplexers, $A / D$ and $D / A$ converters, MODEMS, sample-and-hold systems, signal multiplexing, integrators, programmable operational amplifiers, programmable voltage regulators, crosspoint switching networks, logic interface, and many other analog systems.
The TL601 is an SPDT switch with two logic control inputs. The TL604 is a dual complementary SPST switch with a single control input. The TL607 is an SPDT switch with one logic control input and one enable input. The TL610 is an SPST switch with three logic control inputs. The TL610 features a higher $r_{\text {off }} / r_{\text {on }}$ ratio than the other members of the family.
The TL601M, TL604M, TL607M, and TL610M are characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$, the TL601I, TL604I, TL607I, and TL610I are characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TL601C, TL604C, TL607C, and TL610C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

JG OR P PACKAGE
(TOP VIEW)
TL601


TL604


TL607


TL6 10


TYPICAL OF ALL INPUTS


TYPICAL OF
ALL SWITCHES


## TL601, TL604, TL607, TL610

P-MOS ANALOG SWITCHES
logic symbols ${ }^{\dagger}$ and switch diagrams


| FUNCTION TABLE |  |  |  |
| :---: | :---: | :---: | :---: |
| LOGIC INPUTS | ANALOG SWITCH |  |  |
| A | B | S1 | S2 |
| L | X | OFF (OPEN) | ON (CLOSED) |
| X | L | OFF (OPEN) | ON (CLOSED) |
| H | H | ON (CLOSED) | OFF (OPEN) |



FUNCTION TABLE

| INPUTS |  | ANALOG SWITCH |  |
| :---: | :---: | :---: | :--- |
| E ENABLE |  | S1 | S2 |
| X | L | OFF (OPEN) | OFF (OPEN) |
| L | H | OFF (OPEN) | ON (CLOSED) |
| $H$ | $H$ | ON (CLOSED) | OFF (OPEN) |



FUNCTION TABLE

| INPUTS |  |  | ANALOG SWITCH |
| :---: | :---: | :---: | :---: |
| $A$ | $B$ | $C$ |  |
| L | $X$ | $X$ | OFF (OPEN) |
| $X$ | $L$ | $X$ | OFF (OPEN) |
| $X$ | $X$ | L | OFF (OPEN) |
| $H$ | $H$ | $H$ | ON (CLOSED) |

${ }^{\dagger}$ These symbols are in accordance with ANSI/IEEE Std 91-1984.
TL607 logic diagram (positive logic)


## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

$$
\text { Supply voltage, VCC + (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 30 \text { V }
$$

Supply voltage, VCC - ..... 30 V
$V_{C C}+$ to $V_{C C}$ - supply voltage differential ..... 35 V
Control input voltage ..... VCC +
Switch off-state voltage ..... 30 V
Switch on-state current ..... 10 mA
Operating free-air temperature range: TL601M, TL604M, TL607M, TL610M $\ldots-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ TL601I, TL604I, TL607I, TL610I . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$TL601C, TL604C, TL607C, TL610C . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$Storage temperature range$-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$Lead temperature ( $1,6 \mathrm{~mm}$ ) 1/16 inch from case for 60 seconds: JG package$300^{\circ} \mathrm{C}$Lead temperature ( $1,6 \mathrm{~mm}$ ) $1 / 16$ inch from case for 10 seconds: P package . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$

NOTE 1: All voltage values are with respect to network ground terminal.
recommended operating conditions

|  | TL601M, TL604M TL607M, TL610M |  |  | TL601I, TL604I TL607I, TL610I |  |  | TL601C, TL604C TL607C, TL610C |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOM | MAX | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ (see Figure 1) | 5 | 10 | 25 | 5 | 10 | 25 | 5 | 10 | 25 | V |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ - (see Figure 1) | -5 | -20 | -25 | -5 | -20 | -25 | -5 | -20 | -25 | V |
| $\mathrm{V}_{\mathrm{CC}}+$ to $\mathrm{V}_{\text {CC }}$ - supply voltage differential (see Figure 1) | 15 |  | 30 | 15 |  | 30 | 15 |  | 30 | V |
| High-level control input voltage, $\mathrm{V}_{\mathrm{IH}}$ | 2 |  | 5.5 | 2 |  | 5.5 | 2 |  | 5.5 | V |
| Low-level control input voltage, $\mathrm{V}_{\mathrm{IL}} \quad$ All inputs |  |  | 0.8 |  |  | 0.8 |  |  | 0.8 |  |
| Voltage at any analog switch (S) terminal | $\mathrm{V}_{\mathrm{CC}-+}$ |  | $\mathrm{V}_{\mathrm{CC}+}$ | $\mathrm{V}_{\text {CC- }}$ |  | $\mathrm{V}_{\mathrm{CC}+}$ | $\mathrm{V}_{\mathrm{CC}}$ - |  | $\mathrm{V}_{\mathrm{CC}+}$ | V |
| Switch on-state current |  |  | 10 |  |  | 10 |  |  | 10 | mA |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | -55 |  | 125 | -25 |  | 85 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V} C \mathrm{C}+=10 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}^{-}=-20 \mathrm{~V}$, analog switch test current $=1 \mathrm{~mA}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS ${ }^{\dagger}$ |  |  | $\begin{gathered} \text { TL6_-M } \\ \text { TL6_- I } \end{gathered}$ |  | TL6_ ${ }^{\text {C }}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP ${ }^{\ddagger}$ MAX | MIN | TYP ${ }^{\ddagger}$ | MAX |  |
| $\mathrm{I}_{\text {IH }}$ High-level input current | $\mathrm{V}_{1}=5.5 \mathrm{~V}$ |  |  |  | 0.510 |  | 0.5 | 10 | $\mu \mathrm{A}$ |
| IIL Low-level input current | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  |  |  | -50-250 |  | -50 | -250 | $\mu \mathrm{A}$ |
| Ioff Switch off-state current | $\mathrm{V}_{\mathrm{I}(\mathrm{sw})}=-10 \mathrm{~V},$ <br> See Note 2 |  | $\mathrm{T}^{\prime}{ }^{\text {a }}=25^{\circ} \mathrm{C}$ |  | -400 |  | -500 |  | pA |
|  |  |  | $\mathrm{T}_{\mathrm{A}}=\mathrm{MAX}{ }^{\dagger}$ |  | $-50-100$ |  | -10 | -20 | nA |
| ron Switch on-state resistance | $\begin{aligned} & \mathrm{V}_{\mathrm{l}(\mathrm{sw})}=10 \mathrm{~V}, \\ & \mathrm{l}(\mathrm{sw})=-1 \mathrm{~mA} \end{aligned}$ |  | $\begin{array}{\|l\|l\|} \hline \text { TL601 } \\ \text { TL604 } \\ \text { TL607 } \\ \hline \end{array}$ |  | 55100 |  | 75 | 200 | $\Omega$ |
|  |  |  | TL610 |  | $40 \quad 80$ |  | 40 | 100 |  |
|  | $\begin{aligned} & \mathrm{V}_{\mathrm{I}(\mathrm{sw})}=-10 \mathrm{~V}, \\ & \mathrm{l}(\mathrm{sw})=-1 \mathrm{~mA} \end{aligned}$ |  | $\begin{array}{\|l\|} \hline \text { TL601 } \\ \text { TL604 } \\ \text { TL607 } \\ \hline \end{array}$ |  | 220400 |  | 220 | 600 |  |
|  |  |  | TL610 |  | $120 \quad 300$ |  | 120 | 400 |  |
| $r_{\text {off }}$ Switch off-state resistance |  |  |  |  | 25 |  | 20 |  | G $\Omega$ |
| $\mathrm{C}_{\text {on }}$ Switch on-state input capacitance | $\mathrm{V}_{1(\mathrm{sw})}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  |  |  | 16 |  | 16 |  | pF |
| $\mathrm{C}_{\text {off }}$ Switch off-state input capacitance | $\mathrm{V}_{\mathrm{l}}(\mathrm{sw})=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  |  |  | 8 |  | 8 |  | pF |
| ICC + Supply current from $\mathrm{V}_{\mathrm{CC}}+$ | Logic input(s)at 5.5 V,All switchterminalsopen |  | $\begin{aligned} & \text { TL601 } \\ & \text { TL604 } \end{aligned}$ |  | 510 |  | 5 | 10 | mA |
|  |  | Enable input high | TL607 |  | 510 |  | 5 | 10 |  |
|  |  | Enable input low |  |  | 35 |  | 3 | 5 |  |
|  |  |  | TL610 |  | $5 \quad 10$ |  | 5 | 10 |  |
| ICC - Supply current from $\mathrm{V}_{\text {CC }}$ - | Logic input(s) <br> at 5.5 V , <br> All switch <br> terminals <br> open |  | $\begin{array}{l\|} \hline \text { TL601 } \\ \text { TL604 } \end{array}$ |  | -1.2-2.5 |  | -1.2 | -2.5 | mA |
|  |  | $\begin{array}{\|l\|} \hline \text { Enable } \\ \text { input high } \\ \hline \end{array}$ | TL607 |  | -2.5 -5 |  | -2.5 | -5 |  |
|  |  | Enable input low |  |  | -0.05 -0.5 |  | -0.05 | -0.5 |  |
|  |  |  | TL610 |  | $\begin{array}{ll}-1.2 & -2.5\end{array}$ |  | -1.2 | -2.5 |  |

${ }^{\dagger}$ MAX is $125^{\circ} \mathrm{C}$ for M-suffix types, $85^{\circ} \mathrm{C}$ for I-suffix types, and $70^{\circ} \mathrm{C}$ for C -suffix types.
$\ddagger$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$ except for $\mathrm{I}_{\text {off }}$ at $T_{A}=\mathrm{MAX}$.
NOTE 2: The other terminal of the switch under test is at $\mathrm{V}_{\mathrm{CC}}+=10 \mathrm{~V}$.
switching characteristics, $\mathrm{V}_{\mathrm{CC}}+=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}-=-20 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

|  | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {off }}$ | Switch turn-off time | $R_{L}=1 \mathrm{k} \Omega, \mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$, See Figure 2 |  | 400 | 500 | ns |
| $\mathrm{t}_{\text {on }}$ | Switch turn-on time |  |  | 100 | 150 |  |

Figure 1 shows power supply boundary conditions for proper operation of the TL601 Series. The range of operation for supply $V_{C C}+$ from +5 V to +25 V is shown on the vertical axis. The range of $\mathrm{V}_{\mathrm{CC}}-$ from -5 V to -25 V is shown on the horizontal axis. A recommended $30-\mathrm{V}$ maximum voltage differential from $V_{C C}+$ to $V_{C C}$ - governs the maximum $V_{C C}+$ for a chosen $V_{C C}$ - (or vice versa). A minimum recommended difference of 15 V from $\mathrm{V}_{\mathrm{C}} \mathrm{C}+$ to $\mathrm{V}_{\mathrm{C}} \mathrm{C}$ - and the boundaries shown in Figure 1 allow the designer to select the proper combinations of the two supplies.

The designer-selected $V_{C C}+$ supply value for a chosen $V_{C C}$ - supply value limits the maximum input voltage that can be applied to either switch terminal; that is, the input voltage should be between $\mathrm{V}_{\mathrm{CC}}$ +8 V and $\mathrm{V}_{\mathrm{CC}}+$ to keep the on-state resistance within specified limits.


FIGURE 1

TL601, TL604, TL607, TL610
P.MOS ANALOG SWITCHES

## PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT
NOTES: A. The pulse generator has the following characteristics:
$Z_{\text {out }}=50 \Omega, \mathrm{t}_{\mathrm{r}} \leq 15 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 15 \mathrm{~ns}, \mathrm{t}_{\mathrm{w}}=500 \mathrm{~ns}$. B. $C_{L}$ includes probe and jig capacitance.

$V_{O}=(10 \mathrm{~V}) \frac{1 \mathrm{k} \Omega}{1 \mathrm{k} \Omega+r_{\mathrm{on}}}$
VOLTAGE WAVEFORMS

FIGURE 2

TYPICAL CHARACTERISTICS

M-SUFFIX DEVICES
I-SUFFIX DEVICES SWITCH ON-STATE RESISTANCE
vs
SWITCH ANALOG VOLTAGE


FIGURE 3

M-SUFFIX DEVICES
I-SUFFIX DEVICES
SWITCH ON-STATE RESISTANCE
vs
FREE-AIR TEMPERATURE


FIGURE 4

- Low Clock-to-Cutoff-Frequency Ratio Error

TLC04/MF4A-50 . . $\pm 0.8 \%$
TLC14/MF4A-100 . . . $\pm 1 \%$

- Filter Cutoff Frequency Dependent Only on External-Clock Frequency Stability
- Minimum Filter Response Deviation Due to External Component Variations Over Time and Temperature
- Cutoff Frequency Range from 0.1 Hz to $30 \mathrm{kHz}, \mathrm{VCC}_{ \pm}= \pm 2.5 \mathrm{~V}$
- 5-V to 12-V Operation
- Self Clocking or TTL-Compatible and CMOSCompatible Clock Inputs
- Low Supply Voltage Sensitivity
- Designed to be Interchangeable with National MF4-50 and MF4-100


## description

The TLC04/MF4A-50 and TLC14/MF4A-100 are monolithic Butterworth low-pass switched-capacitor filters. Each is designed as a low-cost, easy-to-use device providing accurate fourth-order low-pass filter functions in circuit design configurations.

Each filter features cutoff frequency stability that is dependent only on the external-clock frequency stability. The cutoff frequency is clock tunable and has a clock-to-cutoff frequency ratio of $50: 1$ with less than $\pm 0.8 \%$ error for the TLC04/MF4A-50 and a clock-to-cutoff frequency ratio of $100: 1$ with less than $\pm 1 \%$ error for the TLC14/MF4A-100. The input clock features self-clocking or TTL- or CMOS-compatible options in conjunction with the level shift (LS) pin.
The TLC04M/MF4A-50M and TLC14M/MF4A-100M are characterized over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC04I/MF4A-50I and TLC14I/MF4A-1001 are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The TLC04C/MF4A-50C and TLC14C/MF4A-100C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram



## TLC04/MF4A-50, TLC14/MF4A-100

 BUTTERWORTH FOURTH-ORDER LOW-PASS SWITCHED-CAPACITOR FILTERSAVAILABLE OPTIONS

| ${ }^{T}$ A | CLOCK-TO-CUTOFF FREQUENCY RATIO | PACKAGE |  |
| :---: | :---: | :---: | :---: |
|  |  | SMALL OUTLINE <br> (D) | PLASTIC DIP (P) |
| $\begin{gathered} 0^{\circ} \mathrm{C} \\ \text { to } \\ 70^{\circ} \mathrm{C} \end{gathered}$ | $\begin{array}{r} 50: 1 \\ 100: 1 \end{array}$ | TLC04CD/MF4A-50CD <br> TLC14CD/MF4A-100CD | TLC04CP/MF4A-50CP <br> TLC14CP/MF4A-100CP |
| $\begin{gathered} -40^{\circ} \mathrm{C} \\ \text { to } \\ 85^{\circ} \mathrm{C} \end{gathered}$ | $50: 1$ $100: 1$ | TLC04ID/MF4A-50ID <br> TLC14ID/MF4A-100ID | TLC04IP/MF4A-50IP <br> TLC14IP/MF4A-100IP |
| $\begin{gathered} -55^{\circ} \mathrm{C} \\ \text { to } \\ 125^{\circ} \mathrm{C} \end{gathered}$ | $\begin{array}{r} 50: 1 \\ 100: 1 \end{array}$ |  | TLC04MP/MF4A-50MP <br> TLC14MP/MF4A-100MP |

The D package is available taped and reeled. Add the suffix $R$ to the device type (e.g., TLC04CDR/MF4A-50CDR).

## pin description

| PIN NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| AGND | 6 | 1 | Analog Ground - The noninverting input to the operational amplifiers of the Butterworth fourth-order lowpass filter. |
| CLKIN | 1 | 1 | Clock In - The clock input terminal for CMOS-compatible clock or self-clocking options. For either option, the Level Shift (LS) terminal is at $\mathrm{V}_{\mathrm{CC}}$-. For self-clocking, a resistor is connected between the CLKIN and CLKR terminal pins and a capacitor is connected from the CLKIN terminal pin to ground. |
| CLKR | 2 | 1 | Clock R - The clock input for a TTL-compatible clock. For a TTL clock, the level shift pin is connected to mid-supply and the CLKIN pin may be left open, but it is recommended that it be connected to either $\mathrm{V}_{\mathrm{CC}}+$ or $\mathrm{V}_{\mathrm{CC}}$-. |
| FILTER IN | 8 | 1 | Filter Input |
| FILTER OUT | 5 | 0 | Butterworth fourth-order low-pass Filter Output |
| LS | 3 | 1 | Level Shift - This terminal accommodates the various input clocking options. For CMOS-compatible clocks or self-clocking, the level-shift terminal is at $\mathrm{V}_{\mathrm{CC}}$ - and for TTL-compatible clocks, the level-shift terminal is at mid-supply. |
| $\mathrm{V}_{\text {CC }+}$ | 7 | 1 | Positive supply voltage terminal |
| $\mathrm{V}_{\text {CC }}$ - | 4 | 1 | Negative supply voltage terminal |

## TLC04/MF4A-50, TLC14/MF4A-100 BUTTERWORTH FOURTH-ORDER LOW-PASS SWITCHED-CAPACITOR FILTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, $\mathrm{V}_{\mathrm{CC}} \pm$ (see Note 1) ...................................................... . $\pm 7$ V Operating free-air temperature range: TLC04M/MF4A-50M, TLC14M/MF4A-100M $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ TLC04I/MF4A-50I, TLC14I/MF4A-1001 . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ TLC04C/MF4A-50C, TLC14C/MF4A-100C . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$

NOTE 1: All voltage values are with respect to the AGND terminal.
recommended operating conditions

|  |  |  | TLC04/MF4A-50 |  | TLC14/MF4A-100 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | MAX | MIN | MAX |  |
| $\mathrm{V}_{\mathrm{CC}+}$ | Positive supply voltage |  | 2.25 | 6 | 2.25 | 6 | V |
| $\mathrm{V}_{\mathrm{CC}}$ - | Negative supply voltage |  | -2.25 | -6 | -2.25 | -6 | V |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 2 |  | 2 |  | V |
| VIL | Low-level input voltage |  |  | 0.8 |  | 0.8 | V |
|  |  | $\mathrm{V}_{\mathrm{CC} \pm}= \pm 2.5 \mathrm{~V}$ | 5 | $1.5 \times 10^{6}$ | 5 | $1.5 \times 10^{6}$ | Hz |
|  |  | $\mathrm{V}_{\mathrm{CC} \pm}= \pm 5 \mathrm{~V}$ | 5 | $2 \times 10^{6}$ | 5 | $2 \times 10^{6}$ |  |
| $\mathrm{f}_{\mathrm{CO}}$ | Cutoff frequency (see Note 3) |  | 0.1 | $40 \times 10^{3}$ | 0.05 | $20 \times 10^{3}$ | Hz |
|  |  | TLC04M/MF4A-50M, TLC14M/MF4A-100M | -55 | 125 | - 55 | 125 |  |
| $\mathrm{T}_{\mathrm{A}}$ | Operating free-air temperature | $\begin{aligned} & \text { TLC04I/MF4A-50I, } \\ & \text { TLC14I/MF4A-100I } \end{aligned}$ | -40 | 85 | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | TLC04C/MF4A-50C, TLC14C/MF4A-100C | 0 | 70 | 0 | 70 |  |

NOTES: 2. Above 250 kHz , the input clock duty cycle should be $50 \%$ to allow the operational amplifiers the maximum time to settle while processing analog samples.
3. The cutoff frequency is defined as the frequency where the response is 3.01 dB less than the dc gain of the filter.

TLCO4/MF4A-50, TLC14/MF4A-100
BUTTERWORTH FOURTH-ORDER LOW.PASS
SWITCHED.CAPACITOR FILTERS
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+\mathbf{=} 2.5 \mathrm{~V}$, $\mathrm{VCC}_{\text {- }}=\mathbf{- 2 . 5 ~ V}$, fclock $\leq 250 \mathrm{kHz}$ (unless otherwise noted)
filter section

| PARAMETER |  | TEST CONDITIONS | TLC04/MF4A-50 |  |  | TLC14/MF4A-100 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| Output voltage offset |  |  |  | 25 |  |  | 50 |  |  | mV |
| VOM Peak output voltages | $\mathrm{V}_{\mathrm{OM}}+$ | $R_{L}=10 \mathrm{k} \Omega$ | 1.8 | 2 |  | 1.8 | 2 |  | V |
|  | VOM - |  | -1.25 | -1.7 |  | -1.25 | -1.7 |  |  |
| Short-circuit output current | Source | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C},$ <br> See Note 4 |  | -0.5 |  |  | -0.5 |  | mA |
|  | Sink |  | 4 |  |  |  | 4 |  |  |
| Supply current |  | $\mathrm{f}_{\text {clock }}=250 \mathrm{kHz}$ |  | 1.2 | 2.25 |  | 1.2 | 2.25 | mA |

NOTE 4: IOS (source current) is measured by forcing the output to its maximum positive voltage and then shorting the output to the negative supply ( $\mathrm{V}_{\mathrm{CC}}-$ ) terminal. I OS (sink current) is measured by forcing the output to its maximum negative voltage and then shorting the output to the positive supply ( $\mathrm{V}_{\mathrm{CC}}+$ ) terminal.
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=2.5 \mathrm{~V}$, VCC- = - 2.5 V (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | TLC04/MF4A-50 |  |  | TLC14/MF4A-100 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\text { }}$ | MAX |  |
| Maximum clock frequency, $f_{\text {max }}$ | See Note 2 |  | 1.5 | 3 |  | 1.5 | 3 |  | MHz |
| Clock-to-cutoff-frequency ratio ( $\mathrm{f}_{\text {clock }} / \mathrm{f}_{\mathrm{co}}$ ) | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}, \quad \mathrm{T}_{\text {A }}=25^{\circ} \mathrm{C}$ |  | 49.27 | 50.07 | 50.87 | 99 | 100 | 101 |  |
| Temperature coefficient of clock-to-cutoff frequency ratio | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}$ |  |  | $\pm 25$ |  |  | $\pm 25$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Frequency response above and below cutoff frequency (see Note 5) | $\begin{aligned} & \mathrm{f}_{\mathrm{co}}=5 \mathrm{kHz}, \\ & \mathrm{f}_{\mathrm{clk}}=250 \mathrm{kHz}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $f=6 \mathrm{kHz}$ | -7.9 | $-7.57$ | -7.1 |  |  |  | dB |
|  |  | $f=4.5 \mathrm{kHz}$ | $-1.7$ | $-1.46$ | $-1.3$ |  |  |  |  |
|  | $\begin{aligned} & \mathrm{f}_{\mathrm{co}}=2.5 \mathrm{kHz}, \\ & \mathrm{f}_{\mathrm{clk}}=250 \mathrm{kHz}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | $\mathrm{f}=3 \mathrm{kHz}$ |  |  |  | -7.9 | -7.42 | $-7.1$ |  |
|  |  | $f=2.25 \mathrm{kHz}$ |  |  |  | -1.7 | - 1.51 | $-1.3$ |  |
| Dynamic range (see Note 6) | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 80 |  |  | 78 |  | dB |
| Stop-band frequency attentuation at $2 \mathrm{f}_{\mathrm{co}}$ | ${ }^{\text {clock }}$ $\leq 250 \mathrm{kHz}$ |  | 24 | 25 |  | 24 | 25 |  | dB |
| DC voltage amplification | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}, \quad \mathrm{RS} \leq 2 \mathrm{k} \Omega$ |  | -0.15 | 0 | 0.15 | $-0.15$ | 0 | 0.15 | dB |
| Peak-to-peak clock feedthrough voltage | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 5 |  |  | 5 |  | mV |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 2. Above 250 kHz , the input clock duty cycle should be $50 \%$ to allow the operational amplifiers the maximum time to settle while processing analog samples.
5. The frequency responses at $f$ are referenced to a dc gain of 0 dB .
6. The dynamic range is referenced to $1.06 \mathrm{~V} \mathrm{rms}(1.5 \mathrm{~V}$ peak) where the wideband noise over a $30-\mathrm{kHz}$ bandwidth is typically $106 \mu \mathrm{~V} \mathrm{rms}$ for the TLC04/MF4A-50 and $135 \mu \mathrm{~V}$ rms for the TLC14/MF4A-100.
electrical characteristics over recommended operating free-air temperature range, $\mathrm{VCC}+=5 \mathrm{~V}$, VCC - $=-5 \mathrm{~V}$, f clock $\leq 250 \mathrm{kHz}$, (unless otherwise noted)
filter section

| PARAMETER |  | TEST CONDITIONS | TLC04/MF4A-50 |  |  | TLC14/MF4A-100 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| $\mathrm{V}_{\text {OO }}$ Output voltage offset |  |  |  |  | 150 |  |  | 200 |  | mV |
| VOM Peak output voltages | $\mathrm{V}_{\mathrm{OM}}+$ | $\mathrm{R}_{\mathrm{L}}=10 \mathrm{k} \Omega$ | 3.75 | 4.3 |  | 3.75 | 4.5 |  | V |
|  | $\mathrm{V}_{\mathrm{OM}}$ - |  | -3.75 | -4.1 |  | $-3.75$ | -4.1 |  |  |
| IOS Short-circuit output current | Source | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> See Note 4 |  | -2 |  |  | -2 |  | mA |
|  | Sink |  |  | 5 |  |  | 5 |  |  |
| ICC Supply current |  | $\mathrm{f}_{\text {clock }}=250 \mathrm{kHz}$ |  | 1.8 | 3 |  | 1.8 | 3 | mA |
| $\mathrm{k}_{\text {svs }}$ Supply voltage sensitivity (see Figures 1 and 2) |  |  |  | -30 |  |  | -30 |  | dB |

NOTE 4: IOS (source current) is measured by forcing the output to its maximum positive voltage and then shorting the output to the negative supply ( $V_{C C-}$ ) terminal. IOS (sink current) is measured by forcing the output to its maximum negative voltage and then shorting the output to the positive supply $\left(\mathrm{V}_{\mathrm{CC}}+\right.$ ) terminal.

## clocking section

| PARAMETER |  | TEST CONDITIONS ${ }^{\ddagger}$ | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{T}+}+$ Positive-going input threshold voltage | CLKIN | $\mathrm{V}_{\mathrm{CC}+}=10 \mathrm{~V}_{\text {, }} \mathrm{V}_{\text {CC- }}=0$ | 6.1 | 7 | 8.9 | $\checkmark$ |
|  |  | $\mathrm{V}_{\mathrm{CC}+}=5 \mathrm{~V}_{1} \quad \mathrm{~V}_{\text {CC- }}=0$ | 3.1 | 3.5 | 4.4 |  |
| $\mathrm{V}_{\mathrm{T} \text { - }}$ Negative-going input threshold voltage |  | $\mathrm{V}_{\mathrm{CC}+}=10 \mathrm{~V}, \mathrm{~V}_{\text {CC- }}=0$ | 1.3 | 3 | 3.8 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}+}=5 \mathrm{~V}$, $\mathrm{V}_{\text {CC- }}=0$ | 0.6 | 1.5 | 1.9 |  |
| $\mathrm{V}_{\text {hys }}$ Hysteresis ( $\mathrm{V}_{\mathrm{T}+}-\mathrm{V}_{\mathrm{T}-\mathrm{l}}$ ) |  | $\mathrm{V}_{C C+}=10 \mathrm{~V}$, $\mathrm{V}_{\text {CC- }}=0$ | 2.3 | 4 | 7.6 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}+}=5 \mathrm{~V}, \quad \mathrm{~V}_{\text {CC- }}=0$ | 1.2 | 2 | 3.8 |  |
| $\mathrm{V}_{\text {OH }}$ High-level output voltage | CLKR | $10=-10 \mu \mathrm{~A}$ | 9 |  |  | V |
|  |  |  | 4.5 |  |  |  |
| VOL Low-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=10 \mathrm{~V}$ |  |  | 1 | V |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  |  | 0.5 |  |
| Input leakage current |  | $\mathrm{V}_{\mathrm{CC}}=10 \mathrm{~V}$ Level Shift pin at mid-supply. |  |  | 2 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {CC }}=5 \mathrm{~V} \quad \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 2 |  |
| Output current |  | $\mathrm{V}_{\text {CC }}=10 \mathrm{~V}$ CLKR and CLKIN | -3 | -7 |  | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ shorted to $\mathrm{V}_{\mathrm{CC}}$ - | -0.75 | -2 |  |  |
| Output current |  | $\mathrm{V}_{\text {CC }}=10 \mathrm{~V}$ CLKR and CLKIN | 3 | 7 |  | mA |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ shorted to $\mathrm{V}_{\mathrm{CC}}+$ | 0.75 | 2 |  |  |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
${ }^{\ddagger} \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{CC}}+-\mathrm{V}_{\mathrm{CC}}-$.
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, VCC- = - 5 V (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | TLC04/MF4A-50 |  |  | TLC14/MF4A-100 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| Maximum clock frequency, $f_{\text {max }}$ (see Note 2) |  |  | 2 | 4 |  | 2 | 4 |  | MHz |
| Clock-to-cutoff-frequency ratio (f clock $/{ }^{\text {co }}$ ) | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}, \quad \mathrm{T}_{\text {A }}=25^{\circ} \mathrm{C}$ |  | 49.58 | 49.98 | 50.38 | 99 | 100 | 101 |  |
| Temperature coefficient of clock-to-cutoff frequency ratio | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}$ |  |  | $\pm 15$ |  |  | $\pm 15$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Frequency response above and below cutoff frequency (see Note 5) | $\begin{aligned} & \mathrm{f}_{\mathrm{co}}=5 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{clk}}=250 \mathrm{kHz} \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $f=6 \mathrm{kHz}$ | $-7.9$ | -7.57 | -7.1 |  |  |  | dB |
|  |  | $f=4.5 \mathrm{kHz}$ | $-1.7$ | $-1.44$ | -1.3 |  |  |  |  |
|  | $\begin{aligned} & \mathrm{f}_{\mathrm{co}}=2.5 \mathrm{kHz} \\ & \mathrm{f}_{\mathrm{clk}}=250 \mathrm{kHz} \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | $f=3 \mathrm{kHz}$ |  |  |  | -7.9 | $-7.42$ | -7.1 | dB |
|  |  | $f=2.25 \mathrm{kHz}$ |  |  |  | $-1.7$ | $-1.51$ | $-1.3$ |  |
| Dynamic range (see Note 7) | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 86 |  |  | 84 |  |  | dB |
| Stop-band frequency attentuation at $2 \mathrm{f}_{\mathrm{co}}$ | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}$ |  | 24 | 25 |  | 24 | 25 |  | dB |
| DC voltage amplification | $\mathrm{f}_{\text {clock }} \leq 250 \mathrm{kHz}, \quad \mathrm{RS} \leq 2 \mathrm{k} \Omega$ |  | -0.15 | 0 | 0.15 | -0.15 | 0 | 0.15 | dB |
| Peak-to-peak clock feedthrough voltage | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | 7 |  |  | 7 |  |  | mV |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 2. Above 250 kHz , the input clock duty cycle should be $50 \%$ to allow the operational amplifiers the maximum time to settle while processing analog samples.
5. The frequency responses at $f$ are referenced to a dc gain of 0 dB .
7. The dynamic range is referenced to $2.82 \mathrm{~V} \mathrm{rms}(4 \mathrm{~V}$ peak) where the wideband noise over a $30-\mathrm{kHz}$ bandwidth is typically $142 \mu \mathrm{~V} \mathrm{rms}$ for the TLC04/MF4A-50 and $178 \mu \mathrm{~V} \mathrm{rms}$ for the TLC14/MF4A-100.

TYPICAL CHARACTERISTICS
FILTER OUTPUT
vs
SUPPLY VOLTAGE VCC + RIPPLE FREQUENCY



FIGURE 2

TYPICAL APPLICATION DATA


FIGURE 3. CMOS-CLOCK-DRIVEN, DUAL-SUPPLY OPERATION


FIGURE 4. TTL-CLOCK-DRIVEN, DUAL-SUPPLY OPERATION

TYPICAL APPLICATION DATA


FIGURE 5. SELF-CLOCKING THROUGH SCHMITT-TRIGGER OSCILLATOR, DUAL-SUPPLY OPERATION


NOTES: A. The external clock used must be of CMOS level because the clock is input to a CMOS Schmitt trigger.
B. The Filter input signal should be dc-biased to mid-supply or ac-coupled to the terminal.
C. The AGND terminal must be biased to mid-supply.

FIGURE 6. EXTERNAL-CLOCK-DRIVEN SINGLE-SUPPLY OPERATION

TYPICAL APPLICATION DATA


NOTE A: The AGND terminal must be biased to mid-supply
FIGURE 7. SELF-CLOCKING THROUGH SCHMITT-TRIGGER OSCILLATOR, SINGLE-SUPPLY OPERATION

## TYPICAL APPLICATION DATA



FIGURE 8. DC OffSET ADJUSTMENT

- Maximum Clock to Center-Frequency Ratio Error

$$
\begin{aligned}
& \text { TLC10 . . . } \pm 0.6 \% \\
& \text { TLC20 . . } \pm 1.5 \%
\end{aligned}
$$

- Filter Cutoff Frequency Stability Dependent Only on External-Clock Frequency Stability
- Minimum Filter Response Deviation Due to External Component Variations over Time and Temperature
- Critical-Frequency Times 0 Factor Range Up to $\mathbf{2 0 0} \mathbf{~ k H z}$
- Critical-Frequency Operation Up to 30 kHz
- Designed to be Interchangeable with:

National MF10
Maxim MF10
Linear Technology LTC1060

## description

The TLC10/MF10A and TLC20/MF10C are monolithic generai-purpose switched-capacitor CMOS filters each containing two independent active-filter sections. Each device facilitates configuration of Butterworth, Bessel, Cauer, or Chebyshev filter design.
Filter features include cutoff frequency stability that is dependent only on the external clock frequency stability and minimal response deviation over time and temperature. Features also include a critical-frequency times filter quality (Q) factor range of up to 200 kHz .

With external clock and resistors, each filter section can be used independently to produce various second-order functions or both sections can be cascaded to produce fourth-order functions. For functions greater than fourthorder, ICs can be cascaded.
The TLC10/MF10A and TLC20/MF10C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

N DUAL-IN-LINE PACKAGE
(TOP VIEW)


FN CHIP CARRIER PACKAGE (TOP VIEW)


AVAILABLE OPTIONS

| TA $_{\text {A }}$ | MAX <br> $\mathbf{f}_{\text {clock }} / \mathbf{f c}$ ERROR | PACKAGE |  |
| :---: | :---: | :---: | :---: |
|  | CHIP CARRIER <br> (FN) | PLASTIC DIP <br> (N) |  |
|  |  |  |  |
| to |  |  |  |
| $70^{\circ} \mathrm{C}$ | $\pm 0.6 \%$ | TLC10CFN <br> or <br> MF10ACFN | TLC10CN <br> or <br> MF10ACN |
|  | $\pm 1.5 \%$ | TLC20CFN <br> or <br> MF10CCFN | TLC2OCN <br> or <br> MF10CCN |

## TLC10/MF10A, TLC20/MF10C

 UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER| PIN |  | I/O | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| NAME | NO. |  |  |
| AGND | 15 | 1 | Analog Ground - The noninverting inputs to the input operational amplifiers of both filter sections. This terminal should be at ground for dual supplies or at mid-supply level for single-supply operation. |
| 1APIN 2APIN | $\begin{array}{r} 5 \\ 16 \end{array}$ | 1 | All-Pass Inputs - The all-pass input to the summing amplifier of each respective filter section used for all-pass filter applications in configuration modes $1 \mathrm{a}, 4,5$, and 6 . This terminal should be driven from a source having an impedance of less than $1 \mathrm{k} \Omega$. In all other modes, this terminal is grounded. See Typical Application Data. |
| $\begin{aligned} & 1 \mathrm{BP} \\ & 2 \mathrm{BP} \end{aligned}$ | $\begin{array}{r} 2 \\ 19 \end{array}$ | 0 | Band-Pass Outputs - The band-pass output of each respective filter section provides the second-order bandpass filter functions. |
| CF/CL | 12 | 1 | Center Frequency/Current Limit - This input terminal provides the option to select the input-clock-to-centerfrequency ratio of $50: 1$ or $100: 1$ or to limit the current of the IC. For a $50: 1$ ratio, the CF/CL terminal is set to $V_{D D}+$. For a 100:1 ratio, the CF/CL terminal is set to ground for dual supplies or to mid-supply level for single-supply operation. For current limiting, the CF/CL terminal is set to $V_{D D}-$. This aborts filtering and limits the IC current to 0.5 milliamperes. |
| $\begin{aligned} & 1 \mathrm{CLK} \\ & 2 \mathrm{CLK} \end{aligned}$ | $\begin{aligned} & 10 \\ & 11 \end{aligned}$ | 1 | Clock Inputs - The clock input to the two-phase nonoverlapping generator of each respective filter section is used to generate the center frequency of the complex pole pair second-order function. Both clocks should be of the same level (TTL or CMOS) and have duty cycles close to $50 \%$, especially when clock frequencies ( $\mathrm{f}_{\text {clock }}$ ) greater than 200 kHz are used. At this duty cycle, the operational amplifiers have the maximum time to settle while processing analog samples. |
| $\begin{aligned} & 1 \mathrm{IN}- \\ & 2 \mathrm{IN}- \end{aligned}$ | $\begin{array}{r} 4 \\ 17 \end{array}$ | 1 | Inverting Inputs - The inverting input side of the input operational amplifier whose output drives the summing amplifier of each respective filter section. |
| $\begin{aligned} & 1 \mathrm{LP} \\ & 2 \mathrm{LP} \end{aligned}$ | $\begin{array}{r} 1 \\ 20 \end{array}$ | 0 | Low-Pass Outputs - The low-pass outputs of the second-order filters. |
| LS | 9 | 1 | Level Shift - This terminal accommodates various input clock levels of bipolar (CMOS) or unipolar (TTL or other clocks) to function with single or dual supplies. For CMOS ( $\pm 5$-volt) clocks, $V_{D D}$ - or ground is applied to the LS terminal. For TTL and other clocks, ground is applied to the LS terminal. |
| 1 NAH 2NAH | $\begin{array}{r} 3 \\ 18 \end{array}$ | 0 | Notch, All-Pass, or High-Pass Outputs - The output of each respective filter section can be used to provide either a second-order notch, all-pass, or high-pass output filter function, depending on circuit configuration. |
| SW | 6 | 1 | Switch Input - This input terminal is used to control internal switches to connect either the AGND input or the LP output to one of the inputs of the summing amplifier. The terminal controls both independent filter sections and places them in the same configuration simultaneously. If $\mathrm{V}_{\mathrm{CC}}$ - is applied to the SW terminal, the AGND input terminal will be connected to one of the inputs of each summing amplifier. If $\mathrm{V}_{\mathrm{CC}}+$ is applied to the SW terminal, the LP output will be connected to one of the inputs of the summing amplifier. |
| $\mathrm{V}_{\mathrm{CC}}+$ | 7 |  | Analog positive supply voltage terminal |
| $\mathrm{V}_{\mathrm{CC}}$ - | 14 |  | Analog negative supply voltage terminal |
| $\mathrm{V}_{\text {DD }}+$ | 8 |  | Digital positive supply voltage terminal |
| VDD - | 13 |  | Digital negative supply voltage terminal |

functional block diagram


## TLC10/MF10A, TLC20/MF10C <br> UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

```
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
    Analog supply voltage, \(\mathrm{V}_{\mathrm{CC}} \pm\) (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 7 \mathrm{~V}\)
    Digital supply voltage, VDD \(\pm\). . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(\pm 7\) V
    Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(0^{\circ} \mathrm{C}\) to \(70^{\circ} \mathrm{C}\)
    Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . \(-65^{\circ} \mathrm{C}\) to \(150^{\circ} \mathrm{C}\)
    Lead temperature \(1,6 \mathrm{~mm}\) ( \(1 / 16\) inch) from case for 10 seconds: FN or N package \(\ldots . . . .260^{\circ} \mathrm{C}\)
```

NOTE 1: All voltage values are with respect to the AGND terminal.

## recommended operating conditions

|  | MIN | NOM | MAX |
| :--- | ---: | ---: | :---: |
| UNIT |  |  |  |
| Analog supply voltage, $\mathrm{V}_{\mathrm{CC}}{ }^{\prime}$, (see Note 2) | $\pm 4$ | $\pm 5$ | $\pm 6$ |

NOTES: 2. A common supply voltage source should be used for the analog and digital supply voltages. Although each has separate terminals, they are connected together internally at the substrate. $\mathrm{V}_{\mathrm{CC}}+$ and $\mathrm{V}_{\mathrm{DD}}+$ can be connected together at the device terminals or at the supply voltage source. The same is true for $\mathrm{V}_{\mathrm{CC}}$ - and $\mathrm{V}_{\mathrm{DD}}$ - .
3. Both input clocks should be of the same level type (TTL or CMOS), and their duty cycles should be at $50 \%$ above 200 kHz to allow the operational amplifiers the maximum time to settle while processing analog samples.
electrical characteristics at $\mathrm{VCC}_{ \pm}= \pm 5 \mathrm{~V}, \mathrm{VDD}_{ \pm}+= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | TLC10/MF10A |  |  | TLC20/MF10C |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| VOPP | Maximum peak-to-peak output voltage swing |  |  | $\mathrm{R}_{\mathrm{L}}=3.5 \mathrm{k} \Omega$ at all outputs | $\pm 4$ | $\pm 4.1$ |  | $\pm 3.8$ | $\pm 3.9$ |  | V |
| Ios | Short-circuit output current, Pins 3 and 18 | Source | See Note 4 |  | 2 |  |  | 2 |  | mA |
|  |  | Sink |  |  | 50 |  |  | 50 |  |  |
| ICC | Supply current |  |  |  | 8 | 10 |  | 8 | 10 | mA |

NOTE 4: The short-circuit output current for pins $1,2,19$, and 20 will be typically the same as pins 3 and 18.
operating characteristics at $\mathrm{V}_{\mathrm{CC}} \pm= \pm 5 \mathrm{~V}, \mathrm{VDD} \pm= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)


## TLC10/MF10A, TLC20/MF10C UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

## TYPICAL APPLICATION DATA

## modes of operation

The TLC10/MF10A and TLC20/MF10C are switched-capacitor (sampled-data) filters that closely approximate continuous filters. Each filter section is designed to approximate the response of a secondorder variable filter. When the sampling frequency is much larger than the frequency band of interest, the sampled-data filter is a good approximation to its continuous time equivalent. In the case of the TLC10/MF10A and TLC20/MF10C, the ratio is about 50:1 or 100:1. To fully describe their transfer function, a time domain approach would be appropriate. Since this may appear cumbersome, the following application examples are based on the well known frequency domain. It should be noted that in order to obtain the actual filter response, the filter's response must be examined in the z-domain.

$f_{0}=f_{\text {clock }} / 100$ or $f_{\text {clock }} / 50$
$f_{\text {notch }}=f_{0}$
$H_{\text {OLP }}=-$ R2/R1 (as $f \rightarrow 0$ )
$H_{\text {OBP }}=-R 3 / R 1$ (at $f=f_{0}$ )
$H_{O N}=$ notch gain $\left\{\begin{array}{l}\text { as } f \text { approaches } 0-R 2 / R 1 \\ \text { as } f \text { approaches } 0.5 f\end{array}\right.$
$a=f_{0} / B W=R 3 / R 2$
Circuit dynamics:
The following expressions determine the swing at each output as a function of the desired $Q$ of the second-order function.
$\mathrm{H}_{\mathrm{OLP}}=\mathrm{H}_{\mathrm{OBP}} / \mathrm{Q}$ or $\mathrm{H}_{\mathrm{OLP}} \times \mathrm{Q}=\mathrm{H}_{\mathrm{ON}} \times \mathrm{Q}$
$H_{\text {OLP }}$ (peak) $=\mathrm{O} \times \mathrm{H}_{\text {OLP }}$ (for high Qs)
FIGURE 1. MODE 1 FOR NOTCH, BAND-PASS, AND LOW-PASS OUTPUTS: $\boldsymbol{f}_{\text {notch }}=\mathbf{f}_{0}$

## TLC10/MF10A, TLC20/MF10C UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

TYPICAL APPLICATION DATA


```
fo
Q = R3/R2
HOLP = - 1 HOLP (peak) = Q }\times\mp@subsup{H}{\mathrm{ OLP (for high Qs)}}{\mathrm{ ( }
HOBP1 = - R3/R2
HOBP2 = 1 (noninverting)
Circuit dynamics:
    HOBP1 = 0
```

FIGURE 2. MODE 1a FOR NONINVERTING BAND-PASS AND LOW-PASS OUTPUTS

TYPICAL APPLICATION DATA

$f_{0}=f_{\text {notch }} \times \sqrt{\text { R2/R4 +1 }}$
$f_{\text {notch }}=f_{\text {clock }} / 100$ or $f_{\text {clock }} / 50$
$Q=\frac{\sqrt{R 2 / R 4+1}}{R 2 / R 3}$
$H_{O L P}($ as $f$ approaches 0$)=\frac{-R 2 / R 1}{R 2 / R 4+1}$
$H_{O B P}\left(\right.$ at $\left.f=f_{0}\right)=-R 3 / R 1$
$\mathrm{H}_{\mathrm{ON} 1}$ (as f approaches 0 ) $=\frac{-\mathrm{R} 2 / \mathrm{R} 1}{\mathrm{R} 2 / \mathrm{R} 4+1}$
$H_{O N 2}$ (as f approaches $0.5 \mathrm{f}_{\text {clock }}$ ) $=-\mathrm{R} 2 / \mathrm{R} 1$
Circuit dynamics:
$\mathrm{H}_{\mathrm{OBP}}=\mathrm{Q} \sqrt{\mathrm{HOLP} \times \mathrm{H}_{\mathrm{ON} 2}}=\mathrm{Q} \sqrt{\mathrm{HON}_{\mathrm{ON}} \times \mathrm{HON} 2}$
FIGURE 3. MODE 2 FOR NOTCH 2, BAND-PASS, AND LOW-PASS OUTPUTS: $\boldsymbol{f}_{\text {notch }}$ < $\mathrm{f}_{\mathrm{o}}$

## TYPICAL APPLICATION DATA


$f_{0}=\left(f_{\text {clock }} / 100\right.$ or $\left.\mathrm{f}_{\text {clock }} / 50\right) \sqrt{\text { R2/R4 }}$
$\mathrm{Q}=\sqrt{\mathrm{R2} / \mathrm{R4}} \times \mathrm{R} 3 / \mathrm{R} 2$
HOHP (as f approaches $0.5 \mathrm{f}_{\text {clock }}$ ) $=-\mathrm{R} 2 / \mathrm{R} 1$
HOLP (as $f$ approaches 0 ) $=-R 4 / R 1$
$H_{\mathrm{OBP}}$ (at $\mathrm{f}=\mathrm{f}_{\mathrm{O}}$ ) $=-\mathrm{R} 3 / \mathrm{R} 1$
Circuit dynamics:
R2/R4 $=\mathrm{H}_{\mathrm{OHP}} / \mathrm{H}_{\mathrm{OLP}}: \mathrm{H}_{\mathrm{OBP}}=\sqrt{\mathrm{H}_{\mathrm{OHP}} \times \mathrm{H}_{\mathrm{OLP}}} \times \mathrm{Q}$
$H_{\text {OLP }}$ (peak) $=\mathrm{Q} \times \mathrm{H}_{\mathrm{OLP}}$ (for high Qs)
$\mathrm{H}_{\mathrm{OHP}}$ (peak) $=\mathrm{Q} \times \mathrm{H}_{\mathrm{OHP}}$ (for high Qs )
${ }^{\dagger}$ In this mode, the feedback loop is closed around the input summing amplifier; the finite GBW product of this operational amplifier will cause a slight Q enhancement. If this is a problem, connect a low-value capacitor ( 10 pF to 100 pF ) across R4 to provide some phase lead.

FIGURE 4. MODE 3 FOR HIGH-PASS, BAND-PASS, AND LOW-PASS OUTPUTS

$f_{0}=\left(f_{\text {clock }} / 100\right.$ or $\left.f_{\text {clock }} / 50\right) \sqrt{R 2 / R 4}$
$\mathrm{Q}=\sqrt{\mathrm{R} 2 / \mathrm{R} 4} \times \mathrm{R} 3 / \mathrm{R} 2$
$\mathrm{H}_{\text {OHP }}=-\mathrm{R} 2 / \mathrm{R} 1$
$H_{\text {OBP }}=-R 3 / R 1$
$H_{\text {OLP }}=-R 4 / R 1$
$f_{\text {notch }}=\left(f_{\text {clock }} / 100\right.$ or flock $\left.^{\prime} / 50\right) \sqrt{\text { Rh/Ri }}$
$H_{O N}\left(\right.$ at $\left.f=f_{0}\right)=\left|Q\left(R g / R i \times H_{O L P}-R g / R h \times H O H P\right)\right|$
HON1 $_{\text {ON }}$ (as approaches 0 ) $=\mathrm{Rg} / \mathrm{Ri} \times \mathrm{H}_{\mathrm{OLP}}$
$H_{O N 2}$ (as $f$ approaches $0.5 f_{\text {clock }}$ ) $=-\mathrm{Rg} / \mathrm{Rh} \times \mathrm{H}_{\mathrm{OHP}}$
FIGURE 5. MODE 3a FOR HIGH-PASS, BAND-PASS, LOW-PASS, AND NOTCH OUTPUTS WITH EXTERNAL OPERATIONAL AMPLIFIER

## TLC10/MF10A, TLC20/MF10C UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

TYPICAL APPLICATION DATA


```
\(\mathrm{f}_{\mathrm{o}}=\mathrm{f}_{\text {clock }} / 100\) or \(\mathrm{f}_{\text {clock }} / 50\)
\(\mathrm{f}_{\mathrm{z}}=\mathrm{f}_{\mathrm{o}}{ }^{\dagger}\)
\(Q=f_{0} / B W=R 3 / R 2\)
\(\mathrm{O}_{\mathrm{z}}=\mathrm{R} 3 / \mathrm{R} 1\)
\(H_{\text {OAP }}\) (at \(0 \leq f \leq 0.5 f_{\text {clock }}\) ) \(=-R 2 / R 1=-1\)
    (for AP output R1 = R2)
\(H_{\text {OLP }}(\) as \(f\) approaches 0\()=-(R 2 / R 1+1)=-2\)
\(H_{\text {OBP }}\) (at \(\mathrm{f}=\mathrm{f}_{\mathrm{o}}\) ) \(=-\mathrm{R} 3 / \mathrm{R} 2(\mathrm{R} 2 / \mathrm{R} 1+1)=-2(\mathrm{R} 3 / \mathrm{R} 2)\)
```

Circuit dynamics:

$$
\mathrm{H}_{\mathrm{OBP}}=\mathrm{H}_{\mathrm{OLP}} \times \mathrm{Q}=\left(\mathrm{H}_{\mathrm{OAP}}+1\right) \mathrm{Q}
$$

${ }^{\dagger}$ Due to the sampled-data nature of the filter, a slight mismatch of $f_{z}$ and $f_{o}$ occurs causing a $0.4-\mathrm{dB}$ peaking around $f_{0}$ of the all-pass filter amplitude response (which theoretically should be a straight line). If this is unacceptable, Mode 5 is recommended.

FIGURE 6. MODE 4 FOR ALL-PASS, BAND-PASS, AND LOW-PASS OUTPUTS

TLC10/MF10A, TLC20/MF10C UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

## TYPICAL APPLICATION DATA


$f_{0}=\sqrt{R 2 / R 4+1} \times\left(f_{\text {clock }} / 100\right.$ or $\left.f_{\text {clock }} / 50\right)$
$\mathrm{f}_{\mathrm{z}}=\sqrt{1-\mathrm{R} 1 / \mathrm{R4}} \times\left(\mathrm{f}_{\text {clock }} / 100\right.$ or $\left.\mathrm{f}_{\text {clock }} / 50\right)$
$\mathrm{Q}=\sqrt{\mathrm{R} 2 / \mathrm{R} 4+1} \times \mathrm{R} 3 / \mathrm{R} 2$
$\mathrm{Q}_{\mathrm{z}}=\sqrt{1-\mathrm{R} 1 / \mathrm{R} 4} \times \mathrm{R} 3 / \mathrm{R} 1$
$H_{\text {OZ1 }}$ (as $f$ approaches 0 ) $=R 2(R 4-R 1) / R 1(R 2+R 4)$
$\mathrm{H}_{\mathrm{OZ2}}$ (as f approaches $0.5 \mathrm{f}_{\text {clock }}$ ) $=\mathrm{R} 2 / \mathrm{R} 1$
$H_{\text {OBP }}=(R 2 / R 1+1) \times R 3 / R 2$
$H_{\text {OLP }}=(R 2+R 1) /(R 2+R 4) \times R 4 / R 1$
FIGURE 7. MODE 5 FOR NUMERATOR COMPLEX ZEROS, BAND-PASS, AND LOW-PASS OUTPUTS

## TYPICAL APPLICATION DATA


$\mathrm{f}_{\mathrm{C}}=\mathrm{R} 2 / \mathrm{R} 3$ ( $\mathrm{f}_{\text {clock }} / 100$ or $\mathrm{f}_{\text {clock }} / 50$ )
$H_{O L P}=-R 3 / R 1$
$\mathrm{H}_{\mathrm{OHP}}=-\mathrm{R} 2 / \mathrm{R} 1$
FIGURE 8. MODE 6 FOR SINGLE-POLE HIGH-PASS AND LOW-PASS OUTPUT

## TYPICAL APPLICATION DATA



FIGURE 9. MODE 6a FOR SINGLE-POLE LOW-PASS OUTPUT (INVERTED AND NONINVERTED)

## TLC10/MF10A, TLC20/MF10C <br> UNIVERSAL DUAL SWITCHED-CAPACITOR FILTER

## TYPICAL APPLICATION DATA



FIGURE 10. FOURTH-ORDER $2-\mathrm{kHz}$ LOW-PASS BUTTERWORTH FILTER

## filter terminology

$\mathrm{f}_{\mathrm{C}} \quad$ The cutoff frequency of the low-pass or high-pass filter output
$f_{\text {clock }}$ The input clock frequency to the device
fnotch The notch frequency of the notch output
$f_{0} \quad$ The center frequency of the complex pole pair second-order function
$f_{Z} \quad$ The center frequency of the complex zero pair
HOBP The band-pass output voltage gain (V/V) at the band-pass center frequency
HOHP The high-pass output voltage gain (V/V) as the frequency approaches 0.5 flock
HOLP The low-pass output voltage gain (V/V) as the frequency approaches 0
HON The notch output voltage gain (V/V) at the notch frequency
HON1 The low-side notch output voltage gain as the frequency approaches 0
HON2 The high-side notch output voltage gain as the frequency approaches $0.5 \mathrm{f}_{\text {clock }}$
HOZ1 Gain at complex zero output (as $f \rightarrow 0 \mathrm{~Hz}$ )
HOZ2 Gain at complex zero output (as $f$ approaches 0.5 fclock)
Q The quality factor of the complex pole pair second-order function. Q is the ratio of $\mathrm{f}_{\mathrm{O}}$ to the $3-\mathrm{dB}$ bandwidth of the band-pass output. The value of Q also affects the possible peaking of the low-pass and high-pass outputs.
$\mathrm{Q}_{z} \quad$ The quality factor of the complex zero pair, if such a complex pair exists. This parameter is used when an all-pass filter output is desired.


$$
\begin{aligned}
& Q=\frac{f_{O}}{f_{H}-f_{L}} ; f_{O}=\sqrt{f_{L} f_{H}} \\
& f_{L}=f_{O}\left(\frac{-1}{2 Q}+\sqrt{\left.\left(\frac{1}{2 Q}\right)^{2}+1\right)}\right. \\
& f_{H}=f_{O}\left(\frac{1}{2 Q}+\sqrt{\left.\left(\frac{1}{2 Q}\right)^{2}+1\right)}\right.
\end{aligned}
$$

FIGURE 11. BAND-PASS OUTPUT



FIGURE 13. HIGH-PASS OUTPUT

# TLC532AM, TLC532AI, TLC533AM, TLC533AI LinCMOSTM 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS 

- LinCMOS ${ }^{m \times}$ Technology
- 8-Bit Resolution
- Total Unadjusted Error . . . $\pm 0.5$ LSB Max
- Ratiometric Conversion
- Access Plus Conversion Time:

TLC532A . . . $15 \mu \mathrm{~s}$ Max
TLC533A . . . $30 \mu \mathrm{~s}$ Max

- 3-State, Bidirectional I/O Data Bus
- 5 Analog and 6 Dual-Purpose Inputs
- On-Chip 12-Channel Analog Multiplexer
- Three On-Chip 16-Bit Data Registers
- Software Compatible with Larger TL530 and TL531 (21-Input Versions)
- On-Chip Sample-and-Hold Circuit
- Single 5-V Supply Operation
- Low Power Consumption . . . 6.5 mW Typ
- Improved Direct Replacements for Texas Instruments TL532 and TL533, National Semiconductor ADC0829, and Motorola MC14442


## description

The TLC532A and TLC533A are monolithic LinCMOS ${ }^{\text {M }}$ peripheral integrated circuits each designed to interface a microprocessor for analog data acquisition. These devices are complete peripheral data acquisition systems on a single chip and can convert analog signals to digital data from up to 11 external analog terminals. Each device operates from a single $5-\mathrm{V}$ supply and contains a 12 -channel analog multiplexer, an 8-bit ratiometric analog-to-digital (A/D) converter, a sample-and-hold, three 16 -bit registers, and microprocessorcompatible control circuitry. Additional features include a built-in self-test, six multipurpose (analog or digital) inputs, five external analog inputs, and an 8-pin input/output (I/O) data port. The three on-chip data registers store the control data, the conversion results, and the input digital data that can be accesssed via the microprocessor data bus in two 8-bit bytes (most-significant byte first). In this manner, a microprocessor can access up to 11 external analog inputs or 6 digital signals and the positive reference voltage that may be used for self-test.

function table

| ADDRESS/CONTROL |  |  |  |  | DESCRIPTION |
| :---: | :---: | :---: | :---: | :---: | :---: |
| R/W | RS | $\overline{\mathrm{CS}}$ | $\overline{\mathbf{R}}$ | CLK |  |
| X | X | X | $L^{\dagger}$ |  | Reset |
| L | H | L | H | $\downarrow$ | Write bus data to control register |
| H | L | L | H | $\uparrow$ | Read data from analog conversion register |
| H | H | L | H | $\uparrow$ | Read data from ditigal data register |
| $\times$ | X | H | H | X | No response |

[^13]
# TLC532AM, TLC532AI, TLC533AM, TLC533AI LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS 

## description (continued)


#### Abstract

The A/D conversion uses the successive-approximation technique and switched-capacitor circuitry. This method eliminates the possibility of missing codes, nonmonotonicity, and a need for zero or full-scale adjustment. Any one of 11 analog inputs (or self-test) can be converted to an 8 -bit digital word and stored within $10 \mu \mathrm{~s}$ (TLC532A) or $20 \mu \mathrm{~s}$ (TLC533A) after instructions from the microprocessor are recognized. The on-chip sample-and-hold automatically minimizes errors due to noise on the analog inputs. Furthermore, differential high-impedance reference inputs are available to help isolate the analog circuitry from the logic and supply noises while easing ratiometric conversion and scaling.


The TLC532AM and TLC533AM are available in both the $N$ and FN plastic packages and are characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC532AI and TLC533AI are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## functional description

The TLC532A and TLC533A provide direct interface to a microprocessor-based system. Control of the TLC532A and TLC533A is handled via the 8 -line TTL-compatible 3 -state data bus, the three control inputs (Read/Write, Register Select, and Chip Select), and the Clock input. Each device contains three 16 -bit internal registers - the control register, the analog conversion data register, and the digital data register

A high level at the Read/Write input and a low level at the Chip Select input set the device to output data on the 8 -line data bus for the processor to read. A low level at the Read/Write input and a low level at the Chip Select input set the device to receive instructions into the internal control register on the 8 -line data bus from the processor. When the device is in the read mode and the Register Select input is low, the processor reads the data contained in the analog conversion data register. However, when the Register Select input is high, the processor reads the data contained in the digital data register.

The control register is a write-only register into which the microprocessor writes command instructions for the device to start A/D conversion and to select the analog channel to be converted. The analog conversion data register is a read-only register that contains the current converter status and most recent conversion results. The digital data register is also a read-only register that holds the digital input logic levels from the six dual-purpose inputs.

Internally each device contains a byte pointer that selects the appropriate byte during two cycles of the Clock input in a normal 16 -bit microprocessor instruction. The internal pointer automatically points to the most significant (MS) byte after the first complete clock cycle any time that the Chip Select is at the high level for at least one clock cycle. The device treats the next signal on the 8 -line data bus as the MS byte. A low level at the Chip Select input activates the inputs and outputs and an internal function decoder. However, no data is transferred until the Clock goes high. The internal byte pointer first points to the MS byte of the selected register during the first clock cycle. After the first clock cycle in which the MS byte is accessed, the internal pointer switches to the LS byte and remains there for as long as Chip Select is low. The MS byte of any register may be accessed by either an 8 -bit or a 16 -bit microprocessor instruction; however, the LS byte may only be accessed by a 16 -bit microprocessor instruction.

Normally, a 2-byte word is written or read from the controlling processor, but a single byte can be read by the processor by manipulating the Chip Select input. This can be used to read conversion status from the analog conversion data register or the digital multipurpose input levels from the digital data register. The format and content of each 2-byte word is shown in Figures 1 through 3.

TLC532AM, TLC532AI, TLC533AM, TLC533AI LinCMOS ${ }^{\text {tM }} 8$-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS

## functional description (continued)

A conversion cycle starts after a 2-byte instruction is written to the control register and the start conversion (SC) bit is a logic high. This 2-byte instruction also selects the input analog channel to be converted. The status (EOC) bit in the analog conversion data register is reset, and it remains reset until the conversion is complete, at which time the status bit is set again. After conversion, the results are loaded into the analog conversion data register. These results remain in the analog conversion data register until the next conversion cycle is complete. If a new conversion command is entered into the control register while the conversion cycle is in progress, the on-going conversion is aborted and a new channel acquisition cycle begins immediately.

The Reset input allows the device to be externally forced to a known state. When a low level is applied to the Reset input for a minimum of three clock periods, the start conversion bit is cleared. The A/D converter is then idled and all the outputs are placed in the high-impedance off-state. However, the content of the analog conversion data register is not affected by the Reset input going to a low level.
Detailed information on interfacing to most popular microprocessors is readily available from the factory.

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TLC532AM, TLC532AI, TLC533AM, TLC533AI LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS
read or write cycle time sequence


NOTES: $A$. The reset pulse ( $\bar{R}$ low) is required only during power-up.
B. The most significant byte output of Data Out occurs when CLK is high. When CLK is low, Data Out is in the high-impedance (off) state. When CLK goes high again, the least significant byte is placed on the data bus. At this point, the least significant byte remains on the bus for as long as CLK is kept high.

DATA BUS


Unused Bits $(X)$ - The MS byte bits 2-1 through 2-7 and LS byte bits 2-1 through 2-4 of the control register are not used internally. Start Conversion (SC) - When the SC bit in the MS byte is set to a logical 1, and analog-to-digital conversion on the specified analog channel begins immediately after the completion of the control register write.
Analog Multiplex Address (AO-A3) - These four address bits are decoded by the analog multiplexer and used to select the appropriate analog channel as shown below:

Hexadecimal Address $(A 3=M S B)$
0
1
2-5
6-9 (not used)
A-F

Channel Select
AO
$R E F+(A 1)$
A2-A5

A10-A15

FIGURE 1. WORD FORMAT AND CONTENT FOR CONTROL REGISTER 2-BYTE WRITE

DATA BUS


A/D Status (EOC) - The A/D status end-of-conversion (EOC) bit is set whenever an analog-to-digital conversion is successfully completed by the A/D converter. The status bit is cleared by a 16 -bit write from the microprocessor to the control register. The remainder of the bits in the MS byte of the analog conversion data register are always reset to logical 0 to simplify microprocessor interrogation of the A/D converter status.
A/D Result (RO-R7) - The LS byte of the analog conversion data register contains the result of the analog-to-digital conversion. Result bit R7 is the MSB and the converter follows the standard convention of assigning a code of all ones (11111111) to a full-scale analog voltage. There are no special overflow or underflow indications.

FIGURE 2. WORD FORMAT AND CONTENT FOR ANALOG CONVERSION DATA REGISTER 1-BYTE AND 2-BYTE READ

DATA BUS


Shared Digital Port (A10/D1-A15/D6) - The voltage present on these pins is interpreted as a digital signal, and the corresponding states are read from these bits. A digital value is given for each pin even if some or all of these pins are being used as analog inputs. Analog Multiplexer Address (AO-A3) - The address of the selected analog channel presently addressed is given by these bits.
Unused Bits $(X)$ - LS byte bits 2-3 through 2-8 of the digital data register are not used.
FIGURE 3. WORD FORMAT AND CONTENT FOR DIGITAL DATA REGISTER 1-BYTE AND 2-BYTE READ

TLC532AM, TLC532AI, TLC533AM, TLC533AI LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 1) -0.3 V to 6.5 V Input voltage range: Positive reference voltage .......................... . . VREF - to VCC +0.3 V

Negative reference voltage . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\text {REF }}+$
All other inputs -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Input current, II (any input) $\pm 10 \mathrm{~mA}$
Total input current, (all inputs) $\pm 20 \mathrm{~mA}$
Operating free-air temperature range: TLC532AM, TLC533AM ................ . $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
TLC532AI, TLC533AI ................... . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: N package . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$

TLC532AM, TLC532AI
LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS
electrical characteristics over recommended operaising free-air temperature range, $\mathrm{V}_{\mathrm{REF}}+=\mathrm{V}_{\mathrm{CC}}$, $V_{\text {REF }}$ - at ground, f CLK $=\mathbf{2 ~ M H z}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{I}_{\mathrm{OH}}=-1.6 \mathrm{~mA}$ | 2.4 |  |  | V |
| VOL | Low-level output voltage |  | $\mathrm{OLL}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |
| IIH | High-level input current | Any digital or Clock input | $\mathrm{V}_{\mathrm{IH}}=5.5 \mathrm{~V}$ |  |  | 10 |  |
|  |  | Any control input |  |  |  | 1 | $\mu \mathrm{A}$ |
| IL | Low-level input current | Any digital or Clock input | $\mathrm{V}_{\mathrm{IL}}=0$ |  |  | -10 | ${ }^{\text {A }}$ |
|  |  | Any control input |  |  |  | -1 | $\mu \mathrm{A}$ |
| Ioz | Off-state (high-impedance state) output current |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ |  |  | 10 |  |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  |  | -10 | $\mu \mathrm{A}$ |
| 11 | Analog input current (see Note 3) |  | $\mathrm{V}_{1}=0$ to $\mathrm{V}_{\text {c }}$ |  |  | $\pm 500$ | nA |
|  | Leakage current between selected channel and all other analog channels |  | $\mathrm{V}_{1}=0 \text { to } \mathrm{V}_{\mathrm{CC}},$ <br> Clock input at 0 V |  |  | $\pm 400$ | $n A$ |
| $\mathrm{C}_{i}$ | Input capacitance | Digital pins 3 thru 10 |  |  | 4 | 30 | pF |
|  |  | Any other input pin |  |  | 2 | 15 | pF |
| ${ }^{\text {I C }}$ C + IREF + | Supply current plus reference current |  | $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{REF}}+=5.5 \mathrm{~V},$ <br> Outputs open |  | 1.5 | 3 | mA |
| ICC | Supply current |  | $\mathrm{V}_{\mathrm{CC}}=5.5 \mathrm{~V}$ |  | 1.4 | 2 | mA |

NOTE 3: Analog input current is an average of the current flowing into a selected analog channel input during one full conversion cycle.
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{REF}}+=\mathrm{V}_{\mathrm{CC}}$, VREF - at ground, fCLK $=\mathbf{2 ~ M H z}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity error (see Note 4) |  |  |  |  |  | $\pm 0.5$ | LSB |
| Zero error (see Note 5) |  |  |  |  |  | $\pm 0.5$ | LSB |
| Full-scale error (see Note 5) |  |  |  |  |  | $\pm 0.5$ | LSB |
| Total unadjusted error (see Note 6) |  |  |  |  |  | $\pm 0.5$ | LSB |
| Absolute accuracy error (see Note 7) |  |  |  |  |  | $\pm 1$ | LSB |
| $\mathrm{t}_{\text {conv }}$ | Conversion time (including channel acquisition time) |  |  |  | 30 |  | Clock <br> Cycles |
| $t_{\text {acq }}$ | Channel acquisition time prior to starting conversion |  |  |  | 10 |  | Clock <br> Cycles |
| $t_{\text {en }}$ | Data output enable time (see Note 8) |  | $C_{L}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$, |  |  | 250 | ns |
| $t_{\text {dis }}$ | Data output disable time |  | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ | 10 |  |  | ns |
| tr ${ }^{\text {bus) }}$ | Data bus output rise time | High impedance to high level | $C_{L}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |  |  | 150 | ns |
|  |  | Low-to-high level |  |  |  | 300 |  |
| $\mathrm{t}_{\mathrm{f} \text { (bus) }}$ | Data bus output fall time | High impedance to low level | $C_{L}=50 \mathrm{pF}, \mathrm{R}_{\mathrm{L}}=3 \mathrm{k} \Omega$ |  |  | 150 | ns |
|  |  | High-to-low level |  |  |  | 300 |  |

${ }^{\dagger}$ Typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 4. Linearity error is the deviation from the best straight line through the A/D transfer characteristics.
5. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
6. Total unadjusted error is the sum of linearity, zero, and full-scale errors.
7. Absolute accuracy error is the maximum difference between an analog value and the nominal midstep value within any step. This includes all errors including inherent quantization error, which is the $\pm 0.5$ LSB uncertainty caused by the A/D converters' finite resolution.
8. If chip-select setup time, $\mathrm{t}_{\mathrm{su}}(\mathrm{CS})$, is less than $0.14 \mu \mathrm{~s}$, the effective data output enable time, $\mathrm{t}_{\mathrm{en}}$, may extend such that $\mathrm{t}_{\mathrm{su}}(\mathrm{CS})+\mathrm{t}_{\mathrm{en}}$ is equal to a maximum of $0.475 \mu \mathrm{~s}$.

TLC533AM, TLC533AI LinCMOS ${ }^{\text {m }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH 5 ANALOG AND 6 DUAL-PURPOSE INPUTS
electrical characteristics over recommended ranges $\mathrm{V}_{\mathrm{C}}, \mathrm{V}_{\text {REF }}+$, and operating free-air temperature, $V_{\text {REF }}$ - at ground, $\mathrm{f}_{\mathrm{CLK}}=1.048 \mathrm{MHz}$ (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{\mathrm{VOH}}$ | High-level output voltage |  | $\mathrm{I}_{\mathrm{OH}}=-1.6 \mathrm{~mA}$ | 2.4 |  |  | V |
| VOL | Low-level output voltage |  | $\mathrm{IOL}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |
| ${ }^{1} \mathrm{IH}$ | High-level input current | Any digital or Clock input | $\mathrm{V}_{1 \mathrm{H}}=5.5 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |
|  |  | Any control input |  |  |  | 1 |  |
| IIL | Low-level input current | Any digital or Clock input | $\mathrm{V}_{\text {IL }}=0$ |  |  | -10 | $\mu \mathrm{A}$ |
|  |  | Any control input |  |  |  | -1 |  |
| ${ }^{\text {I O }}$ | Off-state (high-impedance state) output current |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ |  |  | 10 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  |  | -10 |  |
| 1 | Analog input current (see Note 3) |  | $V_{1}=0$ to $V_{C C}$ |  |  | $\pm 500$ | nA |
|  | Leakage current between selected channel and all other analog channels |  | $\mathrm{V}_{\mathrm{I}}=0 \text { to } \mathrm{V}_{\mathrm{CC}} .$ <br> Clock input at 0 V |  |  | $\pm 400$ | nA |
| $\mathrm{C}_{i}$ | Input capacitance | Digital pins 3 thru 10 |  |  | 4 | 30 | pF |
|  |  | Any other input pin |  |  | 2 | 15 |  |
| ${ }^{\text {I CC }}+{ }^{\text {IREF }}+$ | Supply current plus reference current |  | $V_{C C}=V_{R E F}+=5.5 \mathrm{~V},$ <br> Outputs open |  | 1.3 | 3 | mA |
| ICC | Supply current |  | $\mathrm{V}_{C C}=5.5 \mathrm{~V}$ |  | 1.2 | 2 | mA |

NOTE 3: Analog input current is an average of the current flowing into a selected analog channel input during one full conversion cycle.
operating characteristics over recommended ranges $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{REF}}+$, and operating free-air temperature, $\mathrm{V}_{\text {REF }}$ - at ground, $\mathrm{f}_{\text {clock }}=1.048 \mathrm{MHz}$ (unless otherwise noted)

$\dagger_{\text {Typical values are at }} \mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 4. Linearity error is the deviation from the best straight line through the $A / D$ transfer characteristics.
5. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
6. Total unadjusted error is the sum of linearity, zero, and full-scale errors.
7. Absolute accuracy error is the maximum difference between an analog value and the nominal midstep value within any step. This includes all errors including inherent quantization error, which is the $\pm 0.5$ LSB uncertainty caused by the A/D converters' finite resolution.
8. If chip-select setup time, $\mathrm{t}_{\text {su( }}(\mathrm{CS})$, is less than $0.14 \mu \mathrm{~s}$, the effective data output enable time, $\mathrm{t}_{\text {en }}$, may extend such that $\mathrm{t}_{\text {:ui }}(\mathrm{CS})+\mathrm{t}_{\mathrm{en}}$ is equal to a maximum of $0.475 \mu \mathrm{~s}$.

# TLC540M, TLC540I, TLC541M, TLC541I LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS <br> D2799, OCTOBER 1983-REVISED OCTOBER 1988 

- LinCMOS ${ }^{\text {™ }}$ Technology
- 8-Bit Resolution A/D Converter
- Microprocessor Peripheral or Stand-Alone Operation
- On-Chip 12-Channel Analog Multiplexer
- Built-In Self-Test Mode
- Software-Controllable Sample and Hold
- Total Unadjusted Error . . . $\pm 0.5$ LSB Max
- TLC541 is Direct Replacement for Motorola MC145040 and National Semiconductor ADC0811. TLC540 is Capable of Higher Speed
- Pinout and Control Signals Compatible with TLC1540 Family of 10-Bit A/D Converters

| TYPICAL PERFORMANCE | TLC540 | TLC541 |
| :--- | :---: | :---: |
| Channel Acquisition Sample Time | $2 \mu \mathrm{~s}$ | $3.6 \mu \mathrm{~s}$ |
| Conversion Time | $9 \mu \mathrm{~s}$ | $17 \mu \mathrm{~s}$ |
| Samples per Second | $75 \times 10^{3}$ | $40 \times 10^{3}$ |
| Power Dissipation | 6 mW | 6 mW |

## description

The TLC540 and TLC541 are LinCMOS ${ }^{\text {TM }}$ A/D peripherals built around an 8 -bit switchedcapacitor successive-approximation A/D converter. They are designed for serial interface to a microprocessor or peripheral via a threestate output with up to four control inputs [including independent System Clock, I/O Clock, Chip Select ( $\overline{\mathrm{CS}}$ ), and Address Input]. A $4-\mathrm{MHz}$ system clock for the TLC540 and a $2.1-\mathrm{MHz}$ system clock for the TLC541 with a design that includes simultaneous read/write operation allow high-speed data transfers and sample rates of up to 75,180 samples per second for the TLC540 and 40,000 samples per second for the TLC541. In addition to the high-speed converter and versatile control logic, there is an onchip 12-channel analog multiplexer that can be used to sample any one of 11 inputs or an internal "selftest" voltage, and a sample-and-hold that can operate automatically or under microprocessor control. Detailed information on interfacing to most popular microprocessors is readily available from the factory.
The converters incorporated in the TLC540 and TLC541 feature differential high-impedance reference inputs that facilitate ratiometric conversion, scaling, and analog circuitry isolation from logic and supply noises. A switched-capacitor design allows low-error ( $\pm 0.5$ LSB) conversion in $9 \mu \mathrm{~s}$ for the TLC540 and $17 \mu \mathrm{~s}$ for the TLC541 over the full operating temperature range.
The M-suffix versions are characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The I -suffix versions are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

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## functional block diagram


operating sequence


NOTES: A. The conversion cycle, which requires 36 System Clock periods, is initiated on the 8 th falling edge of the $\mathrm{I} / \mathrm{O}$ Clock after $\overline{\mathrm{CS}}$ goes low for the channel whose address exists in memory at that time. If $\overline{\mathrm{CS}}$ is kept low during conversion, the I/O Clock must remain low for at least 36 System Clock cycles to allow conversion to be completed.
B. The most significant bit (MSB) will automatically be placed on the DATA OUT bus after $\overline{\mathrm{CS}}$ is brought low. The remaining seven bits (A6-A0) will be clocked out on the first seven I/O Clock falling edges.
C. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for three System Clock cycles (or less) after a chip select falling edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in address data until the minimum chip-select setup time has elapsed.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, | 6.5 V |
| :---: | :---: |
| Input voltage range (any input) | -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$ |
| Output voltage range | -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$ |
| Peak input current range (any input) | $\pm 10 \mathrm{~mA}$ |
| Peak total input current (all inputs) | $\pm 30 \mathrm{~mA}$ |
| Operating free-air temperature range: TLC5401, TLC5411 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| TLC540M, TLC541M | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |
| Storage temperature range | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN package | $260^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 | ackage . . . . . . . $260^{\circ}$ |

NOTE 1: All voltage values are with respect to digital ground with REF - and GND wired together (unless otherwise noted).
recommended operating conditions

|  |  |  |  | LC540 |  |  | LC541 |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  |  | 4.75 | 5 | 5.5 | 4.75 | 5 | 5.5 | V |
| Positive reference voltage, $\mathrm{V}_{\text {REF }+ \text { ( }}$ (see Note 2) |  |  | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{C C}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF }}$ - (see Note 2) |  |  | -0.1 | 0 | 2.5 | 0.1 | 0 | 2.5 | v |
| Differential reference voltage, $V_{\text {REF }}+V_{\text {REF }}$ (see Note 2) |  |  | 1 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{C C}+0.2$ | 1 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.2$ | V |
| Analog input voitage (see Note 2) |  |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level control input voltage, $\mathrm{V}_{1 \text { H }}$ |  |  | 2 |  |  | 2 |  |  | V |
| Low-level control input voltage, $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  | 0.8 |  |  | 0.8 | V |
| Setup time, address bits at data input before I/O CLK ${ }^{\dagger}, \mathrm{t}_{\text {sul }}$ (A) |  |  | 200 |  |  | 400 |  |  | ns |
| Hold time, address bits after I/O CLK $\uparrow$, $\mathrm{t}_{\mathrm{h}}(\mathrm{A})$ |  |  | 0 |  |  | 0 |  |  | ns |
| Setup time, $\overline{\mathrm{CS}}$ low before clocking in first address bit, $\mathrm{t}_{\text {su (CS) }}$ (see Note 3) |  |  | 3 |  |  | 3 |  |  | System <br> clock <br> cycles |
| CS high during conversion, $\mathrm{twH}_{\text {w }}$ (CS) |  |  | 36 |  |  | 36 |  |  | System <br> clock cycles |
| Input/Output clock frequency, ${ }^{\text {f }} \mathrm{CLK}(1 / \mathrm{O})$ |  |  | 0 |  | 2.048 | 0 |  | 1.1 | MHz |
| System clock frequency, ${ }^{\text {f CLK }}$ (SYS) |  |  | ${ }^{\text {f CLK }}$ (1) |  | 4 | ${ }^{\dagger} \mathrm{CLK}(1 / \mathrm{O})$ |  | 2.1 | MHz |
| System clock high, ${ }_{\text {wH }}$ (SYS) |  |  | 110 |  |  | 210 |  |  | ns |
| System clock low, ${ }_{\text {wLI }}$ (SYS) |  |  | 100 |  |  | 190 |  |  | ns |
| Input/Output clock hig | h, $\mathrm{t}_{\mathrm{wH}}(1 /$ |  | 200 |  |  | 404 |  |  | ns |
| Input/Output clock low, $\mathrm{t}_{\mathrm{wL}}(1 / \mathrm{O})$ |  |  | 200 |  |  | 404 |  |  | ns |
| Clock transition time (see Note 4) | ste | ${ }^{\text {f CLK }}$ (SYS) $\leq 1048 \mathrm{kHz}$ |  |  | 30 |  |  | 30 | ns$n s$ |
|  | Ste | ${ }^{\text {f CLK }}$ (SYS) $>1048 \mathrm{kHz}$ |  |  | 20 |  |  | 20 |  |
|  | 1/O | ${ }^{\text {f }}$ CLK $(1 / \mathrm{O}) \leq 525 \mathrm{kHz}$ |  |  | 100 |  |  | 100 |  |
|  |  | ${ }^{\mathrm{f}} \mathrm{CLK}(1 / \mathrm{O})>525 \mathrm{kHz}$ |  |  | 40 |  |  | 40 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ |  | TLC540M, TLC541M | -55 |  | 125 | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  |  | TLC5401, TLC5411 | -40 |  | 85 | -40 |  | 85 |  |

NOTES: 2. Analog input voltages greater than that applied to REF + convert as all " 1 "s (111111111), while input voltages less than that applied to REF - convert as all " 0 "'s $(00000000$ ). For proper operation, REF + voltage must be at least 1 V higher than REF voltage. Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 V .
3. To minimize errors caused by noise at the chip select input, the internal circuitry waits for three System Clock cycles (or less) after a chip select falling edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in an address until the minimum chip select setup time has elapsed.
4. This is the time required for the clock input signal to fall from $V_{I H} \min$ to $V_{I L} \max$ or to rise from $V_{I L} \max$ to $V_{I H} \min$. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as $2 \mu \mathrm{~s}$ for remote data acquisition applications where the sensor and the A/D converter are placed several feet away from the controlling microprocessor.

## TLC540M, TLC540I, TLC541M, TLC541I

LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 11 INPUTS
electrical characteristics over recommended operating temperature range,
$\mathrm{VCC}_{\mathrm{CC}}=\mathrm{VREF}_{\mathrm{R}}=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{fCLK}(\mathrm{I} / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC540 or f CLK $(\mathrm{I} / \mathrm{O})=1.1 \mathrm{MHz}$ for TLC541

| PARAMETER |  |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage (pin 16) |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \quad \mathrm{I}_{\mathrm{OH}}=360 \mu \mathrm{~A}$ | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \quad \mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  | 0.4 | V |
| 1 OZ | Off-state (high-impedance state) output current |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}, \quad \overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  | 10 | $\mu \mathrm{A}$ |
|  |  |  | $V_{O}=0, \quad \overline{\overline{C S}}$ at $V_{C C}$ |  | -10 |  |
| $\mathrm{IIH}^{\text {H }}$ | High-level input current |  | $V_{1}=V_{C C}$ | 0.005 | 2.5 | $\mu \mathrm{A}$ |
| 1 IL | Low-level input current |  | $V_{1}=0$ | -0.005 | -2.5 | $\mu \mathrm{A}$ |
| Selected channel leakage current |  |  | $\overline{\mathrm{CS}}$ at OV | 1.2 | 2.5 | mA |
|  |  |  | Selected channel at $V_{C C}$, <br> Unselected channel at 0 V | 0.4 | 1 | $\mu \mathrm{A}$ |
|  |  |  | Selected channel at 0 V , <br> Unselected channel at $\mathrm{V}_{\mathrm{CC}}$ | -0.4 | -1 |  |
| $I^{\prime} \mathrm{CC}+\mathrm{I}_{\text {REF }}$ | Supply and reference current |  | $\mathrm{V}_{\mathrm{REF}}+=\mathrm{V}_{\text {CC }}$, $\overline{\mathrm{CS}}$ at 0 V | 1.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance | Analog inputs |  | 7 | 55 | pF |
|  |  | Control inputs |  | 5 | 15 |  |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.

TLC540M, TLC540I, TLC541M, TLC541I
operating characteristics over recommended operating free-air temperature range,
$\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{REF}}+=4.75 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{fCLK}(\mathrm{I} / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC540 or 1.1 MHz for TLC541, fCLK(SYS) $=4 \mathrm{MHz}$ for TLC540 or $\mathbf{2 . 1} \mathrm{MHz}$ for TLC541.

| PARAMETER | TEST CONDITIONS | TLC540 |  | TLC541 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP MAX | MIN | TYP MAX |  |
| Linearity error | See Note 5 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
| Zero error | See Notes 2 and 6 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
| Full-scale error | See Notes 2 and 6 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
| Total unadjusted error | See Note 7 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
| Self-test output code | Input A11 address $=1011$ (See Note 8) | $\begin{gathered} 01111101 \\ (125) \end{gathered}$ | 10000011 $(131)$ | $\begin{aligned} & 01111101 \\ & (125) \end{aligned}$ | 10000011 $(131)$ |  |
| $\mathrm{t}_{\text {conv }}$ Conversion time | See Operating Sequence |  | 9 |  | 17 | $\mu \mathrm{S}$ |
| Total access and conversion time | See Operating Sequence |  | 13.3 |  | 25 | $\mu \mathrm{S}$ |
| Channel acquisition time tacq (sample cycle) | See Operating Sequence |  | 4 |  | 4 | I/O <br> clock cycles |
| Time output data $t_{V} \quad$ remains valid after //O clock $\downarrow$ |  | $10$ |  | 10 |  | ns |
| $\mathrm{t}_{\mathrm{d}}$ Delay time, $1 / \mathrm{O}$ clock $\downarrow$ <br> to data output valid | See Parameter <br> Measurement Information |  | 300 |  | 400 | ns |
| ten Output enable time |  |  | 150 |  | 150 | ns |
| $\mathrm{t}_{\text {dis }}$ Output disable time |  |  | 150 |  | 150 | ns |
| $\mathrm{t}_{\mathrm{r} \text { (bus) }}$ Data bus rise time |  |  | 300 |  | 300 | ns |
| $\mathrm{t}_{\mathrm{f} \text { (bus) }}$ Data bus fall time |  |  | 300 |  | 300 | ns |

NOTES: 2. Analog input voltages greater than that applied to REF + convert to all " 1 "s (111111111), while input voltages less than that applied to REF - convert to all " $\mathrm{O}^{\prime \prime}$ s (00000000). For proper operation, REF + voltage must be at least 1 V higher than REF voltage. Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 V .
5. Linearity error is the maximum deviation from the best straight line through the $A / D$ transfer characteristics.
6. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
7. Total unadjusted error is the sum of linearity, zero, and full-scale errors.
8. Both the input address and the output codes are expressed in positive logic.

## TLC540M, TLC540I, TLC541M, TLC541I

LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 11 INPUTS

## PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT FOR $t_{d}, t_{r}$, AND $t_{f}$

LOAD CIRCUIT FOR tPZH AND tPHZ

LOAD CIRCUIT FOR ${ }^{\text {tPZL }}$ AND $t_{P L Z}$


VOLTAGE WAVEFORMS FOR ENABLE AND DISABLE TIMES


NOTES: $A . C_{L}=50 \mathrm{pF}$ for TLC540 and 100 pF for TLC541.
B. $t_{\text {en }}=t_{P Z H}$ or $t_{P Z L}, t_{\text {dis }}=t_{P H Z}$ or $t_{p L Z}$.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

## principles of operation

The TLC540 and TLC541 are each complete data acquisition systems on a single chip. They include such functions as analog multiplexer, sample-and-hold, 8-bit A/D converter, data and control registers, and control logic. For flexibility and access speed, there are four control inputs (two clocks, chip select ( $\overline{\mathrm{CS}}$ ), and address]. These control inputs and a TTL-compatible 3-state output are intended for serial communications with a microprocessor or microcomputer. With judicious interface timing, with TLC540 a conversion can be completed in $9 \mu \mathrm{~s}$, while complete input-conversion-output cycles can be repeated every $13 \mu \mathrm{~s}$. With TLC541 a conversion can be completed in $17 \mu \mathrm{~s}$, while complete input-conversion-output cycles are repeated every $25 \mu \mathrm{~s}$. Furthermore, this fast conversion can be executed on any of 11 inputs or its built-in "selftest," and in any order desired by the controlling processor.
The System and I/O Clocks are normally used independently and do not require any special speed or phase relationships between them. This independence simplifies the hardware and software control tasks for the device. Once a clock signal within the specification range is applied to the System Clock input, the control hardware and software need only be concerned with addressing the desired analog channel, reading the previous conversion result, and starting the conversion by using the I/O Clock. The System Clock will drive the "conversion crunching" circuitry so that the control hardware and software need not be concerned with this task.
When $\overline{\mathrm{CS}}$ is high, the Data Output pin is in a three-state condition and the Address Input and 1/O Clock pins are disabled. This feature allows each of these pins, with the exception of the $\overline{C S}$ pin, to share a control logic point with their counterpart pins on additional A/D devices when additional TLC540/541 devices are used. In this way, the above feature serves to minimize the required control logic pins when using multiple A/D devices.
The control sequence has been designed to minimize the time and effort required to initiate conversion and obtain the conversion result. A normal control sequence is:

1. $\overline{\mathrm{CS}}$ is brought low. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and then a falling edge of the System Clock after a low $\overline{\mathrm{CS}}$ transition, before the low transition is recognized. This technique is used to protect the device against noise when the device is used in a noisy environment. The MSB of the previous conversion result will automatically appear on the Data Out pin.
2. A new positive-logic multiplexer address is shifted in on the first four rising edges of the I/O Clock. The MSB of the address is shifted in first. The negative edges of these four I/O clock pulses shift out the second, third, fourth, and fifth most significant bits of the previous conversion result. The on-chip sample-and-hold begins sampling the newly addressed analog input after the fourth falling edge. The sampling operation basically involves the charging of internal capacitors to the level of the analog input voitage.
3. Three clock cycles are then applied to the I/O pin and the sixth, seventh, and eighth conversion bits are shifted out on the negative edges of these clock cycles.
4. The final eighth clock cycle is applied to the $1 / O$ Clock pin. The falling edge of this clock cycle completes the analog sampling process and initiates the hold function. Conversion is then performed during the next 36 System Clock cycles. After this final !/O Clock cycle, $\overline{\mathrm{CS}}$ must go high or the I/O Clock must remain low for at least 36 System Clock cycles to allow for the conversion function.
$\overline{\mathrm{CS}}$ can be kept low during periods of multiple conversion. When keeping $\overline{\mathrm{CS}}$ low during periods of multiple conversion, special care must be exercised to prevent noise glitches on the I/O Clock line. If glitches occur on the I/O Clock line, the I/O sequence between the microprocessor/controller and the device will lose synchronization. Also, if $\overline{\mathrm{CS}}$ is taken high, it must remain high until the end of the conversion. Otherwise, a valid falling edge of $\overline{\mathrm{CS}}$ will cause a reset condition, which will abort the conversion in progress.

A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the 36 System Clock cycles occur. Such action will yield the conversion result of the previous conversion and not the ongoing conversion.

# TLC540M, TLC540I, TLC541M, TLC541I LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS 

## principles of operation (continued)

It is possible to connect the System and I/O Clock pins together in special situations in which controlling circuitry points must be minimized. In this case, the following special points must be considered in addition to the requirements of the normal control sequence previously described.

1. When $\overline{\mathrm{CS}}$ is recognized by the device to be at a low level, the common clock signal is used as an I/O Clock. When $\overline{\mathrm{CS}}$ is recognized by the device to be at a high level, the common clock signal is used to drive the "conversion crunching" circuitry.
2. The device will recognize a $\overline{C S}$ low transition only when the $\overline{C S}$ input changes and subsequently the System Clock pin receives two positive edges and then a negative edge. For this reason, after a $\overline{\mathrm{CS}}$ negative edge, the first two clock cycles will not shift in the address because a low $\overline{\mathrm{CS}}$ must be recognized before the I/O Clock can shift in an analog channel address. Also, upon shifting in the address, $\overline{\mathrm{CS}}$ must be raised after the sixth I/O Clock pulse that has been recognized by the device, so that a $\overline{\mathrm{CS}}$ low level will be recognized upon the lowering of the eighth I/O Clock signal that is recognized by the device. Otherwise, additional common clock cycles will be recognized as I/O Clock pulses and will shift in an erroneous address.

For certain applications, such as strobing applications, it is necessary to start conversion at a specific point in time. This device will accommodate these applications. Although the on-chip sample-and-hold begins sampling upon the negative edge of the fourth I/O Clock cycle, the hold function is not initiated until the negative edge of the eighth I/O Clock cycle. Thus, the control circuitry can leave the I/O Clock signal in its high state during the eighth I/O Clock cycle until the moment at which the analog signal must be converted. The TLC540/TLC541 will continue sampling the analog input until the eighth falling edge of the I/O Clock. The control circuitry or software will then immediately lower the I/O Clock signal and hold the analog signal at the desired point in time and start conversion.

Detailed information on interfacing to most popular microprocessors is readily available from the factory.
－LinCMOS ${ }^{T M}$ Technology

## －8－Bit Resolution A／D Converter

－Microprocessor Peripheral or Stand－Alone Operation
－On－Chip 20－Channel Analog Multiplexer
－Built－In Self－Test Mode
－Software－Controllable Sample and Hold
－Total Unadjusted Error ．．．$\pm 0.5$ LSB Max
－Timing and Control Signals Compatible with 8－Bit TLC540 and 10－Bit TLC1540 A／D Converter Families

| TYPICAL PERFORMANCE | TL545 | TL546 |
| :--- | :---: | :---: |
| Channel Acquisition Time | $1.5 \mu \mathrm{~s}$ | $2.7 \mu \mathrm{~s}$ |
| Conversion Time | $9 \mu \mathrm{~s}$ | $17 \mu \mathrm{~s}$ |
| Sampling Rate | $76 \times 10^{3}$ | $40 \times 10^{3}$ |
| Power Dissipation | 6 mW | 6 mW |

## description

The TLC545 and TLC546 are LinCMOS ${ }^{\text {TM }}$ A／D peripherals built around an 8－bit switched－ capacitor successive－approximation A／D converter．They are designed for serial interface to a microprocessor or peripheral via a 3－state output with up to four control inputs［including independent System Clock，I／O Clock，Chip Select（ $\overline{\mathrm{CS}}$ ），and Address Input］．A $4-\mathrm{MHz}$ system clock for the TLC545 and a $2.1-\mathrm{MHz}$ system clock for the TLC546 with a design that includes simultaneous read／write operation allowing high－speed data transfers and sample rates of up to 76，923 samples per second for the TLC545，and 40，000 samples per second for the TLC546．In addition to the high－speed converter and versatile control logic，there is an on－chip 20－channel analog multiplexer that can be used to sample any one of 19 inputs or an internal ＂self－test＂voltage，and a sample－and－hold that can operate automatically or under microprocessor control．
The converters incorporated in the TLC545 and TLC546 feature differential high－impedance reference inputs that facilitate ratiometric conversion，scaling，and analog circuitry isolation from logic and supply noises．A totally switched－ capacitor design allows low－error（ $\pm 0.5$ LSB）

N DUAL－IN－LINE PACKAGE
（TOP VIEW）


FN CHIP CARRIER PACKAGE （TOP VIEW）

## TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C <br> LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 19 INPUTS

conversion in $9 \mu$ s for the TLC545, and $17 \mu$ s for the TLC546, over the full operating temperature range. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The TLC545M and the TLC546M are characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC545I and the TLC546I are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The TLC545C and the TLC546C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram


operating sequence

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, $\mathrm{V}_{\text {CC }}$ (see Note 1) |  |  |
| :---: | :---: | :---: |
| Input voltage range (any input) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\text {cC }}+0.3 \mathrm{~V}$ |  |  |
| Output voltage range |  | -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$ |
| Peak input current range (any input) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 10 \mathrm{~mA}$ |  |  |
| Peak total input current (all inputs) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 30 \mathrm{~mA}$ |  |  |
| Operating free-air temperature range: | TLC545M, TLC546M | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ |
|  | TLC5451, TLC5461 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
|  | TLC545C, TLC546C | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -65 ${ }^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |  |  |
| Case temperature for 10 seconds: FN | package. | $260{ }^{\circ} \mathrm{C}$ |
| Lead temperature 1,6 |  |  |

NOTE 1: All voltage values are with respect to network ground terminal.

TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C
LinCMOS ${ }^{\text {TM }}$ - 8 -BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 19 INPUTS
recommended operating conditions

|  |  |  | TLC545 |  |  | TLC546 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  |  | 4.75 | 5 | 5.5 | 4.75 | 5 | 5.5 | V |
| Positive reference vo | ge, $V_{\text {ref }}$ + | ee Note 3) | 0 | $\mathrm{V}_{\text {CC }}$ | $V_{C C}+0.1$ | 0 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Negative reference volt | age, $\mathrm{V}_{\text {ref - }}$ | see Note 2) | -0.1 | 0 | $\mathrm{V}_{\text {CC }}$ | $-0.1$ | 0 | $\mathrm{V}_{\mathrm{CC}}$ | V |
| Differential reference | oltage, $\mathrm{V}_{\text {ref }}$ | - $\mathrm{V}_{\text {ref - }}$ (see Note 2) | 0 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.2$ | 0 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.2$ | V |
| Analog input voltage | ee Note 2) |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level control inp | voltage, $\mathrm{V}_{1}$ |  | 2 |  |  | 2 |  |  | V |
| Low-level control inp | voltage, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 |  |  | 0.8 | V |
| Setup time, address | s at data in | ut before I/O CLK $\uparrow$, $\mathrm{t}_{\text {su }}(\mathrm{A})$ | 200 |  |  | 400 |  |  | ns |
| Address hold time, |  |  | 0 |  |  | 0 |  |  | ns |
| Setup time, $\overline{\mathrm{CS}}$ low address bit, tsu(CS) | ore clocking <br> e Note 3) | in first | 3 |  |  | 3 |  |  | System clock cycles |
| Chip select high durin | conversion, | wH(CS) | 36 |  |  | 36 |  |  | System clock cycles |
| Input/Output clock fr | uency, fCLK | (1/0) | 0 |  | 2.048 | 0 |  | 1.1 | MHz |
| System clock frequen | , fCLK/SYS |  | ${ }^{\text {f CLK }}$ (1/0) |  | 4 | ${ }^{\text {f CLLK(I/O) }}$ |  | 2.1 | MHz |
| System clock high, $\mathrm{t}^{\text {}}$ | (SYS) |  | 110 |  |  | 210 |  |  | ns |
| System clock low, $\mathrm{t}_{\mathrm{w}}$ | (SYS) |  | 100 |  |  | 190 |  |  | ns |
| Input/Output clock hig | , $\mathrm{t}_{\mathrm{w}} \mathrm{H}(1 / \mathrm{O})$ |  | 200 |  |  | 404 |  |  | ns |
| Input/Output clock lo | $\mathrm{t}_{\mathrm{WL}}(1 / \mathrm{O})$ |  | 200 |  |  | 404 |  |  | ns |
|  | System | $\mathrm{f}_{\text {CLK }}(\mathrm{SYS}) \leq 1048 \mathrm{kHz}$ |  |  | 30 |  |  | 30 | n |
| Clock transition time |  | ${ }^{\text {f CLK }}$ (SYS) $>1048 \mathrm{kHz}$ |  |  | 20 |  |  | 20 |  |
| (see Note 4) | 1/0 | $\mathrm{f}^{\text {CLK }}$ (I/O) $\leq 525 \mathrm{kHz}$ |  |  | 100 |  |  | 100 | ns |
|  |  | $\mathrm{f}_{\mathrm{CLK}}(\mathrm{I} / \mathrm{O})>525 \mathrm{kHz}$ |  |  | 40 |  |  | 40 | ns |
|  |  | TLC545M, TLC546M | -55 |  | 125 | -55 |  | 125 |  |
| Operating free-air tem | erature, $\mathrm{T}_{\mathrm{A}}$ | TLC545I, TLC546I | -40 |  | 85 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  |  | TLC545C, TLC546C | 0 |  | 70 | 0 |  | 70 |  |

NOTES: 2. Analog input voltages greater than that applied to REF + convert as all " 1 " $s$ (11111111), while input voltages less than that applied to REF - convert as all " 0 "'s (00000000). As the differential reference voltage decreases below 4.75 V , the total unadjusted error tends to increase.
3. To minimize errors caused by noise at the Chip Select input, the internal circuitry waits for three system clock cycles (or less) after a chip select falling edge or rising edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in address data until the minimum chip select setup time has elapsed.
4. This is the time required for the clock input signal to fall from $V_{\text {IH }}$ min to $V_{\text {IL }}$ max or to rise from $V_{\text {IL }}$ max to $V_{\text {IH }}$ min. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as $2 \mu \mathrm{~s}$ for remote data acquisition applications where the sensor and the A/D converter are placed several feet away from the controlling microprocessor.

# TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 19 INPUTS 

electrical characteristics over recommended operating temperature range,
$\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }}+=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{fCLK}(1 / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC545 or $\operatorname{fCLK}(1 / O)=1.1 \mathrm{MHz}$ for TLC546

| PARAMETER |  |  | TEST CONDITIONS |  | MIN TYP ${ }^{\text {t }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage (pin 24) |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}^{\mathrm{OH}}=-360 \mu \mathrm{~A}$ | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OL}}=3.2 \mathrm{~mA}$ |  | 0.4 | V |
| IOZ | Off-state (high-impedance state) output current |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\text {CC }}$ | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  | 10 | $\mu \mathrm{A}$ |
|  |  |  | $V_{0}=0$, | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  | -10 |  |
| ${ }_{1} \mathrm{H}$ | High-level input current |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ |  | 0.005 | 2.5 | $\mu \mathrm{A}$ |
| 1 l | Low-level input current |  | $\mathrm{V}_{1}=0$ |  | -0.005 | -2.5 | $\mu \mathrm{A}$ |
| ${ }^{\text {ICC }}$ | Operating supply current |  | $\overline{\mathrm{CS}}$ at 0 V |  | 1.2 | 2.5 | mA |
|  | Selected channe! leakage current |  | Selected channel at $\mathrm{V}_{\mathrm{CC}}$, <br> Unselected channel at 0 V |  | 0.4 | 1 | $\mu \mathrm{A}$ |
|  |  |  | Selected channel at 0 V , <br> Unselected channel at $V_{C C}$ |  | -0.4 | -1 |  |
| $I_{C C}+I_{\text {ref }}$ | Supply and reference current |  | $\mathrm{V}_{\text {ref }+}=\mathrm{V}_{\text {CC }}$. | $\overline{\mathrm{CS}}$ at 0 V | 1.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance | Analog inputs |  |  | 7 | 55 | pF |
|  |  | Control inputs |  |  | 5 | 15 |  |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
operating characteristics over recommended operating free-air temperature range,
$\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {ref }}+=4.75 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{fCLK}(1 / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC545 or 1.1 MHz for
TLC546, f CLK(SYS) $=4 \mathrm{MHz}$ for TLC545 or 2.1 MHz for TLC546

|  | PARAMETER | TEST CONDITIONS | TLC545 |  | TLC546 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP MAX | MIN | TYP MAX |  |
|  | Linearity error | See Note 5 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
|  | Zero error | See Note 6 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
|  | Full-scale error | See Note 6 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
|  | Total unadjusted error | See Note 7 |  | $\pm 0.5$ |  | $\pm 0.5$ | LSB |
|  | Self-test output code | Input A19 address = 10011 (See Note 8) | $\begin{gathered} 01111101 \\ (125) \end{gathered}$ | $10000011$ <br> (131) | $\begin{gathered} 01111101 \\ (125) \end{gathered}$ | $10000011$ <br> (131) |  |
| ${ }^{t}$ conv | Conversion time | See Operating Sequence |  | 9 |  | 17 | $\mu \mathrm{S}$ |
|  | Total access and conversion time | See Operating Sequence |  | 13 |  | 25 | $\mu \mathrm{S}$ |
| tacq | Channel acquisition time (sample cycle) | See Operating Sequence |  | 3 |  | 3 | I/O <br> clock cycles |
| $t_{v}$ | Time output data remains valid after I/O clock $\downarrow$ |  | 10 |  | 10 |  | ns |
| ${ }^{t}{ }_{d}$ | Delay time, 1/O clock $\downarrow$ to data output valid | See Parameter <br> Measurement <br> Information |  | 300 |  | 400 | ns |
| ten | Output enable time |  |  | 150 |  | 150 | ns |
| $t_{\text {dis }}$ | Output disable time |  |  | 150 |  | 150 | ns |
| tr (bus) | Data bus rise time |  |  | 300 |  | 300 | ns |
| tf(bus) | Data bus fall time |  |  | 300 |  | 300 | ns |

NOTES: 5. Linearity error is the maximum deviation from the best straight line through the A/D transfer characteristics.
6. Zero Error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
7. Total unadjusted error is the sum of linearity, zero, and full-scale errors.
8. Both the input address and the output codes are expressed in positive logic. The A19 analog input signal is internally generated and is used for test purposes.

TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C
LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 19 INPUTS

## PARAMETER MEASUREMENT INFORMATION



(SEE NOTE B)

(SEE NOTE B)

LOAD CIRCUIT FOR $t_{d}, t_{r}$ AND $t_{f}$

LOAD CIRCUIT FOR ${ }^{\text {tPZL }}$ AND tpLZ


VOLTAGE WAVEFORMS FOR ENABLE AND DISABLE TIMES


NOTES: A. $C_{L}=50 \mathrm{pF}$ for TLC545 and 100 pF for TLC546
B. $t_{\text {en }}=t_{P Z H}$ or $t_{P Z L}, t_{\text {dis }}=t_{P H Z}$ or $t_{P L Z}$
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

# TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C LinCMOS ${ }^{\text {Tw }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 19 INPUTS 

## principles of operation

The TLC545 and TLC546 are both complete data acquisition systems on single chips. Each includes such functions as system clock, sample-and-hold, 8-bit A/D converter, data and control registers, and control logic. For flexibility and access speed, there are four control inputs; Chip Select ( $\overline{\mathrm{CS}}$ ), Address Input, I/O clock, and System clock. These control inputs and a TTL-compatible 3-state output facilitate serial communications with a microprocessor or microcomputer. The TLC545 and TLC546 can complete conversions in a maximum of 9 and $17 \mu$ s respectively, while complete input-conversion-output cycles can be repeated at a maximum of 13 and $25 \mu \mathrm{~s}$, respectively.

The System and I/O clocks are normally used independently and do not require any special speed or phase relationships between them. This independence simplifies the hardware and software control tasks for the device. Once a clock signal within the specification range is applied to the System clock input, the control hardware and software need only be concerned with addressing the desired analog channel, reading the previous conversion result, and starting the conversion by using the I/O clock. The System clock will drive the "conversion crunching" circuitry so that the control hardware and software need not be concerned with this task.
When $\overline{\mathrm{CS}}$ is high, the Data Output pin is in a high-impedance condition, and the Address Input and I/O Clock pins are disabled. This feature allows each of these pins, with the exception of the $\overline{\mathrm{CS}}$, to share a control logic point with their counterpart pins on additional A/D devices when additional TLC545/TLC546 devices are used. Thus, the above feature serves to minimize the required control logic pins when using multiple A/D devices.

The control sequence has been designed to minimize the time and effort required to initiate conversion and obtain the conversion result. A normal control sequence is:

1. $\overline{\mathrm{CS}}$ is brought low. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and then a falling edge of the System clock after a $\overline{\mathrm{CS}}$ transition before the transition is recognized. The MSB of the previous conversion result will automatically appear on the Data Out pin.
2. A new positive-logic multiplexer address is shifted in on the first five rising edges of the $\mathrm{I} / \mathrm{O}$ clock. The MSB of the address is shifted in first. The negative edges of these five I/O clocks shift out the 2 nd, 3 rd, 4 th, 5 th, and 6 th most significant bits of the previous conversion result. The onchip sample-and hold begins sampling the newly addressed analog input after the 5th falling edge. The sampling operation basically involves the charging of internal capacitors to the level of the analog input voltage.
3. Two clock cycles are then applied to the $1 / O$ pin and the 7 th and 8 th conversion bits are shifted out on the negative edges of these clock cycles.
4. The final 8th clock cycle is applied to the $1 / O$ clock pin. The falling edge of this clock cycle completes the analog sampling process and initiates the hold function. Conversion is then performed during the next 36 system clock cycles. After this final I/O clock cycle, $\overline{\mathrm{CS}}$ must go high or the I/O clock must remain low for at least 36 system clock cycles to allow for the conversion function.
$\overline{\mathrm{CS}}$ can be kept low during periods of multiple conversion. When keeping $\overline{\mathrm{CS}}$ low during periods of multiple conversion, special care must be exercised to prevent noise glitches on the I/O Clock line. If glitches occur on the I/O Clock line, the I/O sequence between the microprocessor/controller and the device will lose synchronization. Also, if $\overline{\mathrm{CS}}$ is taken high, it must remain high until the end of conversion. Otherwise, a valid falling edge of $\overline{\mathrm{CS}}$ will cause a reset condition, which will abort the conversion in progress.

A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the 36 system clock cycles occur. Such action will yield the conversion result of the previous conversion and not the ongoing conversion.

# TLC545M, TLC545I, TLC545C, TLC546M, TLC546I, TLC546C <br> LinCMOS ${ }^{\text {Tw }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS <br> WITH SERIAL CONTROL AND 19 INPUTS 

## principles of operation (continued)

It is possible to connect the system and I/O clocks together in special situations in which controlling circuitry points must be minimized. In this case, the following special points must be considered in addition to the requirements of the normal control sequence previously described.

1. When $\overline{\mathrm{CS}}$ is recognized by the device to be at a low level, the common clock signal is used as an I/O clock. When the $\overline{\mathrm{CS}}$ is recognized by the device to be at a high level, the common clock signal is used to drive the "conversion crunching" circuitry.
2. The device will recognize a $\overline{C S}$ transition only when the $\overline{C S}$ input changes and subsequently the system clock pin receives two positive edges and then a negative edge. For this reason, after a $\overline{C S}$ negative edge, the first two clock cycles will not shift in the address because a low $\overline{\mathrm{CS}}$ must be recognized before the I/O clock can shift in an analog channel address. Also, upon shifting in the address, $\overline{\mathrm{CS}}$ must be raised after the 6 th I/O clock, which has been recognized by the device, so that a $\overline{\mathrm{CS}}$ low level will be recognized upon the lowering of the 8 th I/O clock signal recognized by the device. Otherwise, additional common clock cycles will be recognized as I/O clocks and will shift in an erroneous address.

For certain applications, such as strobing applications, it is necessary to start conversion at a specific point in time. This device will accommodate these applications. Although the on-chip sample-and-hold begins sampling upon the negative edge of the 5 th I/O clock cycle, the hold function is not initiated until the negative edge of the 8th I/O clock cycle. Thus, the control circuitry can leave the I/O clock signal in its high state during the 8 th $1 / O$ clock cycle, until the moment at which the analog signal must be converted. The TLC545/546 will continue sampling the analog input until the 8 th falling edge of the I/O clock. The control circuitry or software must then immediately lower the I/O clock signal to initiate the hold function at the desired point in time and to start conversion.

Detailed information on interfacing to most popular microprocesors is readily available from the factory.

- LinCMOS ${ }^{\text {TM }}$ Technology
- Microprocessor Peripheral or Stand-Alone Operation
- 8-Bit Resolution A/D Converter
- Differential Reference Input Voltages
- Conversion Time . . . $17 \mu \mathrm{~s}$ Max
- Total Access and Conversion Cycles Per Second TLC548 . . . up to 45,500 TLC549 . . . up to 40,000
- On-Chip Software-Controllable Sample-and-Hold
- Total Unadjusted Error . . . $\pm 0.5$ LSB Max
- 4-MHz Typical Internal System Clock
- Wide Supply Range . . . 3 V to 6 V
- Low Power Consumption . . . 6 mW Typ
- Ideal for Cost-Effective, High-Performance Applications Including Battery-Operated Portable Instrumentation
- Pinout and Control Signals Compatible with the TLC540 and TLC545 8-Bit A/D Converters and with the TLC1540 10-Bit A/D Converter


## description

The TLC548 and TLC549 are LinCMOS ${ }^{T M}$ A/D peripheral integrated circuits built around an 8-bit switchedcapacitor successive-approximation ADC. They are designed for serial interface with a microprocessor or peripheral through a 3-state data output and an analog input. The TLC548 and TLC549 use only the Input/Output Clock (I/O Clock) input along with the Chip Select ( $\overline{\mathrm{CS}}$ ) input for data control. The maximum I/O clock input frequency of the TLC548 is guaranteed up to 2.048 MHz , and the I/O clock input frequency of the TLC549 is guaranteed to 1.1 MHz . Detailed information on interfacing to most popular microprocessors is readily available from the factory.
Operation of the TLC548 and the TLC549 is very similar to that of the more complex TLC540 and TLC541 devices; however, the TLC548 and TLC549 provide an on-chip system clock that operates typically at 4 MHz and requires no external components. The on-chip system clock allows internal device operation to proceed independently of serial input/output data timing and permits manipulation of the TLC548 and TLC549 as desired for a wide range of software and hardware requirements. The I/O Clock together with the internal system clock allow high-speed data transfer and conversion rates of 45,500 conversions per second for the TLC548, and 40,000 conversions per second for the TLC549.

Additional TLC548 and TLC549 features include versatile control logic, an on-chip sample-and-hold circuit that can operate automatically or under microprocessor control, and a high-speed converter with differential high-impedance reference voltage inputs that ease ratiometric conversion, scaling, and circuit isolation from logic and supply noises. Design of the totally switched-capacitor successive-approximation converter circuit allows conversion with a maximum total error of $\pm 0.5$ least significant bit (LSB) in less than $17 \mu \mathrm{~s}$.

The TLC548M and TLC549M are characterized for operation over the temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC548I and TLC5491 are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The TLC548C and TLC549C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

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TLC548, TLC549
LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL
PERIPHERAL WITH SERIAL CONTROL
functional block diagram

operating sequence


NOTES: A. The conversion cycle, which requires 36 internal system clock periods ( $17 \mu \mathrm{~s}$ maximum), is initiated with the 8 th $\mathrm{I} / \mathrm{O}$ clock pulse trailing edge after $\overline{C S}$ goes low for the channel whose address exists in memory at the time.
B. The most significant bit (A7) will automatically be placed on the DATA OUT bus after $\overline{\mathrm{CS}}$ is brought low. The remaining seven bits (A6-AO) will be clocked out on the first seven I/O clock falling edges. B7-BO will follow in the same manner.

# TLC548, TLC549 LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERAL WITH SERIAL CONTROL 

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
$\qquad$
Input voltage range at any input. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to VCC +0.3 V
Output voltage range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$
Peak input current range (any input) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 10 \mathrm{~mA}$
Peak total input current range (all inputs) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 30 \mathrm{~mA}$
Operating free-air temperature range (see Note 2): TLC548M, TLC549M ....... - $55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ TLC548I, TLC5491 ............ $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC548C, TLC549C ............ . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range
$-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
NOTES: 1. All voltage values are with respect to the network ground terminal with the REF - and GND terminal pins connected together unless otherwise noted.
2. The $D$ package is not recommended below $-40^{\circ} \mathrm{C}$.
recommended operating conditions

|  |  | TLC548 |  |  | TLC549 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\text {CC }}$ |  | 3 | 5 | 6 | 3 | 5 | 6 | V |
| Positive reference voltage, $\mathrm{V}_{\mathrm{REF}}+$ | Note 3) | 2.5 |  | C+0.1 | 2.5 |  | C+0.1 | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF }}$ - | ee Note 3) | -0.1 | 0 | 2.5 | -0.1 | 0 | 2.5 | V |
| Differential reference voltage, $\mathrm{V}_{\text {REF }}$ | $\mathrm{V}_{\text {REF - }}$ ( see Note 3) | 1 | $\mathrm{V}_{\text {CC }}$ | C+0.2 | 1 | $V_{\text {CC }}$ | +0.2 | V |
| Analog input voltage (see Note 3) |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\text {CC }}$ | V |
| High-level control input voltage, $\mathrm{V}_{\text {IH }}$ | or $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) | 2 |  |  | 2 |  |  | V |
| Low-level control input voltage, $\mathrm{V}_{\text {IL }}$ | or $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) |  |  | 0.8 |  |  | 0.8 | V |
| Input/output clock frequency, f CLK (for $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) |  | 0 |  | 2.048 | 0 |  | 1.1 | MHz |
| Input/output clock high, $\mathrm{t}_{\mathrm{wH}} \mathrm{H}(1 / \mathrm{O})$ ( | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) | 200 |  |  | 404 |  |  | ns |
| Input/output clock low, $\mathrm{t}_{\mathrm{wL}}(1 / \mathrm{O})$ (fo | $\mathrm{CC}=4.75 \mathrm{~V}$ to 5.5 V ) | 200 |  |  | 404 |  |  | ns |
| Input/output clock transition time, (for $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) | O) (see Note 4) |  |  | 100 |  |  | 100 | ns |
| Duration of $\overline{\mathrm{CS}}$ input high state durin (for $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) | conversion, $\mathrm{t}_{\mathrm{w}} \mathrm{H}(\mathrm{CS})$ | 17 |  |  | 17 |  |  | $\mu \mathrm{S}$ |
| Setup time, $\overline{\mathrm{CS}}$ low before first I/O (for $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V ) (see | ck, $\mathrm{t}_{\text {su( }}$ (CS) <br> 5) | 1.4 |  |  | 1.4 |  |  | $\mu \mathrm{S}$ |
|  | TLC548M, TLC549M | -55 |  | 125 | -55 |  | 125 |  |
| Operating free-air temperature, $\mathrm{T}_{\text {A }}$ | TLC548I, TLC5491 | -40 |  | 85 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC548C, TLC549C | 0 |  | 70 | 0 |  | 70 |  |

NOTES: 3. Analog input voltages greater than that applied to REF + convert to all ones (11111111), while input voltages less than that applied to REF - convert to all zeros (00000000). For proper operation, the positive reference voltage $\mathrm{V}_{\mathrm{REF}}+$, must be at least 1 V greater than the negative reference voltage $\mathrm{V}_{\mathrm{REF}}$ _ . In addition, unadjusted errors may increase as the differential reference voltage $\mathrm{V}_{\mathrm{REF}}+-\mathrm{V}_{\mathrm{REF}}$ - falls below 4.75 V .
4. This is the time required for the input/output clock input signal to fall from $V_{I H} \min$ to $V_{\text {IL }}$ max or to rise from $V_{\text {IL }}$ max to $V_{I H} \mathrm{~min}$. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as $2 \mu \mathrm{~s}$ for remote data acquisition applications in which the sensor and the ADC are placed several feet away from the controlling microprocessor.
5. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and one falling edge of internal system clock after $\overline{\mathrm{CS}} \downarrow$ before responding to control input signals. This $\overline{\mathrm{CS}}$ set-up time is given by the $\mathrm{t}_{\mathrm{en}}$ and $\mathrm{t}_{\text {su }}(\mathrm{CS})$ specifications.

## TLC548, TLC549

LinCMOS ${ }^{\text {TM }}$ - 8 -BIT ANALOG-TO-DIGITAL
PERIPHERAL WITH SERIAL CONTROL
electrical characteristics over recommended operating free-air temperature range,
$\mathrm{VCC}=\mathrm{VREF}+=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{fCLK}(1 / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC548 or 1.1 MHz for TLC549

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \quad \mathrm{I}^{\text {OH }}=-360 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}, \quad \mathrm{I}^{\mathrm{OL}}=3.2 \mathrm{~mA}$ |  |  | 0.4 | V |
| IOZ | Off-state (high-impedance state) output current |  | $V_{O}=V_{C C}, \quad \overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  |  | 10 | V |
|  |  |  | $V_{O}=0, \quad \overline{C S}$ at $V_{C C}$ |  |  | -10 |  |
| IIH | High-level input current, control inputs |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ |  | 0.005 | 2.5 | $\mu \mathrm{A}$ |
| IIL | Low-level input current, control inputs |  | $V_{1}=0$ |  | -0.005 | -2.5 | $\mu \mathrm{A}$ |
| I(on) | Analog channel on-state input current, during sample cycle |  | Analog input at $\mathrm{V}_{\text {CC }}$ |  | 0.4 | 1 | $\mu \mathrm{A}$ |
|  |  |  | Analog input at 0 V |  | -0.4 | -1 |  |
| ${ }^{1} \mathrm{CC}$ | Operating supply current |  | $\overline{\mathrm{CS}}$ at 0 V |  | 1.8 | 2.5 | mA |
| ${ }^{\text {I CC }}+{ }^{\text {IREF }}$ | Supply and reference current |  | $\mathrm{V}_{\mathrm{REF}+}=\mathrm{V}_{\mathrm{CC}}$ |  | 1.9 | 3 | mA |
| $\mathrm{C}_{i}$ | Input capacitance | Analog inputs |  |  | 7 | 55 | pF |
|  |  | Control inputs |  |  | 5 | 15 |  |

operating characteristics over recommended operating free-air temperature range,
$\mathrm{VCC}=\mathrm{VREF}_{+}=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{fCLK}(\mathrm{I} / \mathrm{O})=2.048 \mathrm{MHz}$ for TLC548
or 1.1 MHz for TLC549

| PARAMETER | TEST CONDITIONS | TLC548 |  |  | TLC549 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\text { }}$ | MAX |  |
| Linearity error | See Note 6 |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | ESB |
| Zero error | See Note 7 |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
| Full-scale error | See Note 7 |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
| Total unadjusted error | See Note 8 |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
| $\mathrm{t}_{\text {conv }}$ Conversion time | See Operating Sequence |  | 8 | 17 |  | 12 | 17 | $\mu \mathrm{S}$ |
| Total access and conversion time | See Operating Sequence |  | 12 | 22 |  | 19 | 25 | $\mu \mathrm{S}$ |
| Channel acquisition time tacq (sample cycle) | See Operating Sequence |  |  | 4 |  |  | 4 | I/O <br> clock cycles |
| $\mathrm{t} v \quad$ Time output data remains valid after $1 / \mathrm{O}$ clock |  | 10 |  |  | 10 |  |  | ns |
| $\mathrm{t}_{\mathrm{d}} \quad$Delay time to data <br> output valid | I/O clock $\downarrow$ |  |  | 300 |  |  | 400 | ns |
| $\mathrm{t}_{\mathrm{en}} \quad$ Output enable time |  |  |  | 1.4 |  |  | 1.4 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{\text {dis }} \quad$ Output disable time | See Parameter <br> Measurement Information |  |  | 150 |  |  | 150 | ns |
| $\mathrm{t}_{\mathrm{r} \text { (bus) }}$ Data bus rise time |  |  |  | 300 |  |  | 300 | ns |
| $\mathrm{t}_{\mathrm{f} \text { (bus) }}$ Data bus fall time |  |  |  | 300 |  |  | 300 | ns |

${ }^{\dagger}$ All typicals are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 6. Linearity error is the deviation from the best straight line through the A/D transfer characteristics.
7. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
8. Total unadjusted error is the sum of linearity, zero, and full-scale errors.

## PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS FOR ENABLE AND DISABLE TIMES


NOTES: A. $C_{L}=50 \mathrm{pF}$ for TLC548 and 100 pF for TLC549; $\mathrm{C}_{\mathrm{L}}$ includes jig capacitance.
B. $t_{e n}=t_{P Z H}$ or $t_{P Z L}, t_{d i s}=t_{\text {PHZ }}$ or tPLZ .
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

## PRINCIPLES OF OPERATION

The TLC548 and TLC549 are each complete data acquisition systems on a single chip. Each contains an internal system clock, sample-and-hold, 8-bit A/D converter, data register, and control logic circuitry. For flexibility and access speed, there are two control inputs: I/O Clock and Chip Select ( $\overline{\mathrm{CS}}$ ). These control inputs and a TTLcompatible three-state output facilitate serial communications with a microprocessor or minicomputer. A conversion can be completed in $17 \mu$ s or less, while complete input-conversion-output cycles can be repeated in $22 \mu \mathrm{~s}$ for the TLC548 and in $25 \mu \mathrm{~s}$ for the TLC549.

The internal system clock and I/O clock are used independently and do not require any special speed or phase relationships between them. This independence simplifies the hardware and software control tasks for the device. Due to this independence and the internal generation of the system clock, the control hardware and software need only be concerned with reading the previous conversion result and starting the conversion by using the I/O clock. In this manner, the internal system clock drives the "conversion crunching" circuitry so that the control hardware and software need not be concerned with this task.
When $\overline{\mathrm{CS}}$ is high, the data output pin is in a high-impedance condition and the I/O clock pin is disabled. This $\overline{\mathrm{CS}}$ control function allows the I/O Clock pin to share the same control logic point with its counterpart pin when additional TLC548 and TLC549 devices are used. This also serves to minimize the required control logic pins when using multiple TLC548 and TLC549 devices.

The control sequence has been designed to minimize the time and effort required to initiate conversion and obtain the conversion result. A normal control sequence is:

1. $\overline{\mathrm{CS}}$ is brought low. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and then a falling edge of the internal system clock after a $\overline{\mathrm{CS}} \downarrow$ before the transition is recognized. However, upon a $\overline{C S}$ rising edge, DATA OUT will go to a high-impedance state within the $t_{\text {dis }}$ specification even though the rest of the IC's circuitry will not recognize the transition until the $t_{\text {su(CS) }}$ specification has elapsed. This technique is used to protect the device against noise when used in a noisy environment. The most significant bit (MSB) of the previous conversion result will initially appear on the DATA OUT pin when $\overline{\mathrm{CS}}$ goes low.
2. The falling edges of the first four $1 / O$ clock cycles shift out the $2 \mathrm{nd}, 3 \mathrm{rd}, 4$ th, and 5 th most significant bits of the previous conversion result. The on-chip sample-and-hold begins sampling the analog input after the 4th high-to-low transition of the I/O Clock. The sampling operation basically involves the charging of internal capacitors to the level of the analog input voltage.
3. Three more I/O clock cycles are then applied to the I/O pin and the 6 th, 7 th, and 8 th conversion bits are shifted out on the falling edges of these clock cycles.
4. The final, (the 8 th), clock cycle is applied to the I/O clock pin. The on-chip sample-and-hold begins the hold function upon the high-to-low transition of this clock cycle. The hold function will continue for the next four internal system clock cycles, after which the holding function terminates and the conversion is performed during the next 32 system clock cycles, giving a total of 36 cycles. After the 8 th I/O clock cycle, $\overline{\mathrm{CS}}$ must go high or the I/O clock must remain low for at least 36 internal system clock cycles to allow for the completion of the hold and conversion functions. $\overline{\mathrm{CS}}$ can be kept low during periods of multiple conversion. When keeping $\overline{\mathrm{CS}}$ low during periods of multiple conversion, special care must be exercised to prevent noise glitches on the I/O Clock line. If glitches occur on the I/O Clock line, the I/O sequence between the microprocessor/controller and the device will lose synchronization. If $\overline{\mathrm{CS}}$ is taken high, it must remain high until the end of conversion. Otherwise, a valid high-to-low transition of $\overline{\mathrm{CS}}$ will cause a reset condition, which will abort the conversion in progress.

A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the 36 internal system clock cycles occur. Such action will yield the conversion result of the previous conversion and not the ongoing conversion.

## TLC548, TLC549 <br> LinCMOS ${ }^{\text {TM }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERAL WITH SERIAL CONTROL

## PRINCIPLES OF OPERATION

For certain applications, such as strobing applications, it is necessary to start conversion at a specific point in time. This device will accommodate these applications. Although the on-chip sample-and-hold begins sampling upon the high-to-low transition of the 4th I/O clock cycle, the hold function does not begin until the high-to-low transition of the 8th I/O clock cycle, which should occur at the moment when the analog signal must be converted. The TLC548 and TLC549 will continue sampling the analog input until the high-to-low transition of the 8th I/O clock pulse. The control circuitry or software will then immediately lower the I/O clock signal and start the holding function to hold the analog signal at the desired point in time and start conversion.

Detailed information on interfacing to the most popular microprocessor is readily available from Texas Instruments.

# TLC0820A, TLC0820B, ADC0820B, ADC0820C Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIQUES <br> D2873, SEPTEMBER 1986-REVISED FEBRUARY 1989 

- Advanced LinCMOS ${ }^{\text {M }}$ Silicon-Gate Technology
- 8-Bit Resolution
- Differential Reference Inputs
- Parallel Microprocessor Interface
- Conversion and Access Time Over Temperature Range

Write-Read Mode . . . $1.18 \mu \mathrm{~s}$ and $1.92 \mu \mathrm{~s}$ Read Mode . . $2.5 \mu \mathrm{~s}$ Max

- No External Clock or Oscillator Components Required
- On-Chip Track-and-Hold
- Low Power Consumption . . . 50 mW Typ
- Single 5-V Supply
- TLC0820B is Direct Replacement for National Semiconductor ADC0820B/BC and Analog Devices AD7820L/C/U;
TLC0820A is Direct Replacement for National Semiconductor ADC0820C/CC and Analog Devices AD7820K/B/T


## description

The TLC0820A, TLC0820B, ADC0820B, and ADC0820C are Advanced LinCMOS ${ }^{\text {™ }} 8$-bit analog-to-digital converters each consisting of two 4-bit "flash" converters, a 4-bit digital-toanalog converter, a summing (error) amplifier, control logic, and a result latch circuit. The modified "flash" technique allows low-power integrated circuitry to complete an 8-bit conversion in $1.18 \mu \mathrm{~s}$ over temperature. The onchip track-and-hold circuit has a 100 ns sample window and allows these devices to convert continuous analog signals having slew rates of up to $100 \mathrm{mV} / \mu \mathrm{s}$ without external sampling components. TTL-compatible three-state output drivers and two modes of operation allow interfacing to a variety of microprocessors. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

(TOP VIEW)

| ANLG IN ${ }^{1}$ | $\square_{20}$ | $\mathrm{V}_{\mathrm{C}} \mathrm{C}$ |
| :---: | :---: | :---: |
| (LSB) DO 2 | 219 | NC |
| D1 3 | 18 | $\overline{O F L W}$ |
| D2 4 | 17 | D7 (MSB) |
| D3 5 | 516 | D6 |
| $\overline{\text { WR/RDY }} 6$ | 15 | D5 |
| MODE 7 | 14 | D4 |
| $\overline{\mathrm{RD}} \square^{8}$ | 813 | $\overline{\mathrm{CS}}$ |
| $\overline{\text { INT }} 9$ | -12 | REF + |
| GND 10 | 1011 | 17EF- |

TLC0820_M . . . FK PACKAGE TLC0820__I, TLC0820__C . . . FN PACKAGE ADC0820_CI, ADC0820_C. . . . FN PACKAGE (TOP VIEW)


NC - No internal connection

The M -suffix devices are characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The l-suffix devices are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The C-suffix devices are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$. See Available Options.

## TLC0820A, TLC0820B, ADC0820B, ADC0820C <br> Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIQUES

| AVAILABLE OPTIONS |  |  |  |
| :---: | :---: | :---: | :---: |
| SYMBOLIZATION ${ }^{\text {+ }}$ |  | OPERATING | TOTAL |
| DEVICE | PACKAGE SUFFIX | TEMPERATURE RANGE | UNADJUSTED ERROR |
| TLC0820AC | DW, FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | $\pm 1$ LSB |
| TLC0820AI | DW, FN, N | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $\pm 1$ LSB |
| TLC0820AM | DW, FK, J, N | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | $\pm 1$ LSB |
| TLC0820BC | DW, FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | $\pm 0.5$ LSB |
| TLC0820BI | DW, FN, N | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $\pm 0.5$ LSB |
| TLC0820BM | DW, FK, J, N | $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | $\pm 0.5$ LSB |
| ADC0820BC | DW, FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | $\pm 0.5$ LSB |
| ADC0820BCI | DW, FN, N | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $\pm 0.5$ LSB |
| ADC0820CC | DW, FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | $\pm 1$ LSB |
| ADC0820CCI | DW, FN, N | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | $\pm 1$ LSB |

${ }^{\dagger}$ In many instances, these ICs may have both TLC0820 and ADC0820 labeling on the package.
functional block diagram


## TLC0820A, TLC0820B, ADC0820B, ADC0820C Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIOUES

| PIN |  | DESCRIPTION |
| :---: | :---: | :---: |
| NAME | NUMBER |  |
| ANLG IN | 1 | Analog input |
| $\overline{\mathrm{CS}}$ | 13 | This input must be low in order for $\overline{\mathrm{RD}}$ or $\overline{W R}$ to be recognized by the ADC. |
| DO | 2 | Three-state data output, bit 1 (LSB) |
| D1 | 3 | Three-state data output, bit 2 |
| D2 | 4 | Three-state data output, bit 3 |
| D3 | 5 | Three-state data output, bit 4 |
| D4 | 14 | Three-state data output, bit 5 |
| D5 | 15 | Three-state data output, bit 6 |
| D6 | 16 | Three-state data output, bit 7 |
| D7 | 17 | Three-state data output, bit 8 (MSB) |
| GND | 10 | Ground |
| $\overline{\mathrm{INT}}$ | 9 | In the WRITE-READ mode, the interrupt output, $\overline{\text { INT }}$, going low indicates that the internal count-down delay time, $t_{d}$ (int), is complete and the data result is in the output latch. $t_{d}$ (int) is typically 800 ns starting after the rising edge of the $\overline{W R}$ input (see operating characteristics and Figure 3). If $\overline{R D}$ goes low prior to the end of $t_{d}$ (int), $\overline{\mathrm{INT}}$ goes low at the end of $\mathrm{t}_{\mathrm{dRIL}}$ and the conversion results are available sooner (see Figure 2 ). $\overline{\mathrm{NT}}$ is reset by the rising edge of either $\overline{\mathrm{RD}}$ or $\overline{\mathrm{CS}}$. |
| MODE | 7 | Mode-selection input. It is internally tied to GND through a $50-\mu \mathrm{A}$ current source, which acts like a pull-down resistor. <br> READ mode: Occurs when this input is low. <br> WRITE-READ mode: Occurs when this input is high. |
| NC | 19 | No internal connection |
| $\overline{\text { OFLW }}$ | 18 | Normally the $\overline{\text { OFLW }}$ output is a logical high. However, if the analog input is higher than the $\mathrm{V}_{\text {REF }}+, \overline{\mathrm{OFLW}}$ will be low at the end of conversion. It can be used to cascade 2 or more devices to improve resolution 19 or 10 -bits). |
| $\overline{\mathrm{RD}}$ | 8 | In the WRITE-READ mode with $\overline{\mathrm{CS}}$ low, the 3 -state data outputs DO through D7 are activated when $\overline{\mathrm{RD}}$ goes low. $\overline{\mathrm{RD}}$ can also be used to increase the conversion speed by reading data prior to the end of the internal count-down delay time. As a result, the data transferred to the output latch is latched after the falling edge of $\overline{\mathrm{RD}}$. In the READ mode with $\overline{\mathrm{CS}}$ low, the conversion starts with $\overline{\mathrm{RD}}$ going low. $\overline{\mathrm{RD}}$ also enables the three-state data outputs upon completion of the conversion. The RDY output going into the high-impedance state and $\overline{\mathrm{INT}}$ going low indicates completion of the conversion. |
| REF - | 11 | This input voltage is placed on the bottom of the resistor ladder. |
| REF + | 12 | This input voltage is placed on the top of the resistor ladder. |
| $\mathrm{V}_{\mathrm{CC}}$ | 20 | Power supply voltage |
| $\overline{W R} / R D Y$ | 6 | In the WRITE-READ mode with $\overline{C S}$ low, the conversion is started on the falling edge of the $\overline{W R}$ input signal. The result of the conversion is strobed into the output latch after the internal count-down delay time, $\mathrm{t}_{\mathrm{d}}$ (int), provided that the $\overline{R D}$ input does not go low prior to this time. $t_{d}(i n t)$ is approximately 800 ns . In the READ mode, RDY (an open-drain output) will go low after the falling edge of $\overline{C S}$, and will go into the high-impedance state when the conversion is strobed into the output latch. It is used to simplify the interface to a microprocessor system. |

## TLC0820A, TLC0820B, ADC0820B, ADC0820C <br> Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIQUES

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

|  | TLC0820_M | $\begin{array}{\|c} \hline \text { TLC0820_I } \\ \text { ADC0820_CI } \end{array}$ | $\begin{aligned} & \text { TLC0820_C } \\ & \text { ADC0820_C } \end{aligned}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\text {CC }}$ (see Note 1) | 10 | 10 | 10 | V |
| Input voltage range, all inputs (see Note 1) | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | V |
| Output voltage range, all outputs (see Note 1) | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | $\begin{gathered} -0.2 \text { to } \\ v_{C C}+0.2 \\ \hline \end{gathered}$ | V |
| Operating free-air temperature range | -55 to 125 | -40 to 85 | 0 to 70 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature range | -65 to 150 | -65 to 150 | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |
| Case temperature for 60 seconds: FK package | 260 |  |  | ${ }^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: FN package |  | 260 | 260 | ${ }^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch) from case for 60 seconds: J package | 300 |  |  | ${ }^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch) from case for 10 seconds: DW or N package | 260 | 260 | 260 | ${ }^{\circ} \mathrm{C}$ |

NOTE 1: All voltages are with respect to network ground terminal, pin 10.
recommended operating conditions

|  |  |  |  | 0820 | _M |  | $\begin{aligned} & \mathrm{CO82O} \\ & \mathrm{C} 0820 \end{aligned}$ | $\begin{aligned} & 0 \_1 \\ & 0 \_C l \end{aligned}$ |  | $\begin{aligned} & \mathrm{COP2O} \\ & \mathrm{C} 0820 \\ & \hline \end{aligned}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  |  | 4.5 | 5 | 8 | 4.5 | 5 | 8 | 4.5 | 5 | 8 | V |
| Analog input voltage |  |  | -0.1 |  | $\mathrm{V}_{\text {CC }}+0.1$ | -0.1 |  | $\mathrm{V}_{\mathrm{CC}}+0.1$ | -0.1 |  | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Positive reference voltage, $\mathrm{V}_{\text {REF }+}$ |  |  | $V_{\text {REF - }}$ |  | $\mathrm{V}_{\text {CC }}$ | $\mathrm{V}_{\text {REF }}$ - |  | $\mathrm{V}_{\mathrm{CC}}$ | $V_{\text {REF - }}$ |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF }}$ - |  |  | GND |  | $\mathrm{V}_{\text {REF }+}$ | GND |  | $\mathrm{V}_{\text {REF }}+$ | GND |  | $\mathrm{V}_{\text {REF }+}$ | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V} \\ \text { to } 5.25 \mathrm{~V} \end{gathered}$ | $\frac{\overline{\mathrm{CS}}, \overline{\mathrm{WR}} / \mathrm{RDY}, \overline{\mathrm{RD}}}{\mathrm{MODE}}$ | $\begin{array}{r} 2 \\ 3.5 \end{array}$ |  |  | $\begin{array}{r} 2 \\ 3.5 \\ \hline \end{array}$ |  |  | $\begin{array}{r} 2 \\ 3.5 \\ \hline \end{array}$ |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\mathrm{IL}}$ | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V} \\ \text { to } 5.25 \mathrm{~V} \end{gathered}$ | $\frac{\overline{\mathrm{CS}}, \overline{\mathrm{WR}} / \mathrm{RDY}, \overline{\mathrm{RD}}}{\mathrm{MODE}}$ | $\begin{aligned} & 0.8 \\ & 1.5 \\ & \hline \end{aligned}$ |  |  |  |  | $\begin{aligned} & 0.8 \\ & 1.5 \end{aligned}$ |  |  | $\begin{aligned} & 0.8 \\ & 1.5 \end{aligned}$ | V |
| Delay to next conversion, $\mathrm{t}_{\mathrm{d}}(\mathrm{NC})$ (see Figures 1, 2, 3, and 4) |  |  | 500 |  |  | 500 |  |  | 500 |  |  | ns |
| Delay time from $\overline{\mathrm{WR}}$ to $\overline{\mathrm{RD}}$ in write-read mode, $t_{d W R}$ (see Figure 2) |  |  | 0.4 |  |  | 0.4 |  |  | 0.4 |  |  | $\mu \mathrm{S}$ |
| Write-pulse duration in write-read mode, $\mathrm{t}_{\mathrm{w}} \mathrm{W}$ (see Figures 2, 3, and 4) |  |  | 0.5 |  | 50 | 0.5 |  | 50 | 0.5 |  | 50 | $\mu \mathrm{S}$ |
| Operating free-air temperature, $\mathrm{T}_{A}$ |  |  | -55 |  | 125 | -40 |  | 85 | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

TLC0820A, TLC0820B, ADC0820B, ADC0820C Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIOUES
electrical characteristics at specified operating free-air temperature, $\mathrm{V}_{\mathrm{C}}=5 \mathrm{~V}$ (unless otherwise noted)

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

TLC0820A, TLCO820B, ADC0820B, ADC0820C
Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIQUES
operating characteristics, $\mathrm{V}_{\mathrm{C}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}+}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}-}=0, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=20 \mathrm{~ns}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS |  | $\begin{aligned} & \text { TLC0820B } \\ & \text { ADC0820B } \\ & \hline \end{aligned}$ |  |  | TLC0820A ADC0820C |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| ksVS | Supply voltage sensitivity | $\mathrm{V}_{C C}=5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{MIN}$ to MAX |  |  | $\pm 1 / 16$ | $\pm 1 / 4$ |  | $\pm 1 / 16$ | $\pm 1 / 4$ | LSB |
|  | Total unadjusted error ${ }^{\dagger}$ | MODE pin at $0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=$ MIN to MAX |  |  |  | 1/2 |  |  | 1 | LSB |
| $\mathrm{t}_{\text {convR }}$ | Read mode conversion time | MODE pin at 0 V , See Figure 1 |  |  | 1.6 | 2.5 |  | 1.6 | 2.5 | $\mu \mathrm{S}$ |
| ${ }^{\text {d }}$ (int) | Internal countdown delay time | MODE pin at 5 V , <br> See Figures 3 and | $C_{L}=50 \mathrm{pF},$ |  | 800 | 1300 |  | 800 | 1300 | ns |
| $\mathrm{taR}_{\text {a }}$ | Access time from $\overline{\mathrm{RD}} \downarrow$ | MODE pin at 0 V , | Figure 1 |  | $\begin{aligned} & \mathrm{t}_{\text {convR }} \\ & +20 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{t}_{\text {conv }} \\ & +50 \\ & \hline \end{aligned}$ |  | $\begin{aligned} & \mathrm{t}_{\text {convR }} \\ & +20 \\ & \hline \end{aligned}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{convR}} \\ & +50 \\ & \hline \end{aligned}$ | ns |
| $\mathrm{taR1}$ | Access time from $\overline{\mathrm{RD}} \downarrow$ | $\begin{aligned} & \text { MODE pin at } 5 \mathrm{~V} \text {, } \\ & \mathrm{t}_{\mathrm{d} W R}<\mathrm{t}_{\mathrm{d}(\mathrm{int})} \\ & \text { See Figure } 2 \\ & \hline \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 190 | 280 |  | 190 | 280 |  |
|  |  |  | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  | 210 | 320 |  | 210 | 320 | ns |
| taR | Access time from $\overline{\mathrm{RD}} \downarrow$ | MODE pin at 5 V , <br> $\mathrm{t}_{\mathrm{d} W}>\mathrm{t}_{\mathrm{d}(\text { int })}$ <br> See Figure 3 | $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 70 | 120 |  | 70 | 120 |  |
|  |  |  | $C_{L}=100 \mathrm{pF}$ |  | 90 | 150 |  | 90 | 150 | ns |
| talnt | Access time from $\overline{\mathrm{NT} T} \downarrow$ | MODE pin at 5 V , See Figure 4 |  |  | 20 | 50 |  | 20 | 50 | ns |
| ${ }^{\text {d dis }}$ | Disable time from $\overline{\mathrm{RD}} \uparrow$ | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \quad \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF},$ <br> See Figures 1, 2, 3, and 5 |  |  | 70 | 95 |  | 70 | 95 | ns |
| $t_{d R D Y}$ | Delay time from $\overline{\mathrm{CS}} \downarrow$ to RDY $\downarrow$ | MODE pin at $0 \mathrm{~V}, \quad C_{\mathrm{L}}=50 \mathrm{pF}$, <br> See Figure 1 |  |  | 50 | 100 |  | 50 | 100 | ns |
| ${ }^{\text {d }}$ dRIH | Delay time from $\overline{\mathrm{RD}} \uparrow$ to $\overline{\mathrm{NT}} \uparrow \uparrow$ | $C_{L}=50 \mathrm{pF},$ <br> See Figures 1, 2, and 3 |  |  | 125 | 225 |  | 125 | 225 | ns |
| ${ }^{\text {t }}$ dRIL | Delay time from $\overline{\mathrm{RD}} \downarrow$ to $\overline{\mathrm{INT}} \downarrow$ | MODE pin at $5 \mathrm{~V}, \quad \mathrm{t}_{\mathrm{d} W}<\mathrm{t}_{\mathrm{d}(\text { int })}$, <br> See Figure 2 |  |  | 200 | 290 |  | 200 | 290 | ns |
| ${ }^{\mathrm{t}} \mathrm{dWIH}$ | Delay time from $\overline{\mathrm{WR}} \uparrow$ to $\overline{\mathrm{NT}} \uparrow$ | MODE pin at $5 \mathrm{~V}, \quad \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, See Figure 4 |  |  | 175 | 270 |  | 175 | 270 | ns |
|  | Slew rate tracking |  |  |  | 0.1 |  |  | 0.1 |  | $\mathrm{V} / \mu \mathrm{s}$ |

$\dagger$ Total unadjusted error includes offset, full-scale, and linearity errors.

## PARAMETER MEASUREMENT INFORMATION



FIGURE 1. READ MODE WAVEFORMS (MODE PIN LOW)


FIGURE 2. WRITE-READ MODE WAVEFORMS [MODE PIN HIGH AND $t_{d W R}<t_{d}($ int $)$ ]


FIGURE 3. WRITE-READ WAVEFORMS [MODE PIN HIGH AND $t_{d W R}>t_{d}($ int $)$ ]


FIGURE 4. WRITE-READ MODE WAVEFORMS
(STAND-ALONE OPERATION, MODE PIN HIGH, AND RD LOW)

PARAMETER MEASUREMENT INFORMATION

test circuit voltage waveforms
FIGURE 5. TEST CIRCUIT AND VOltage waveforms

## TLC0820A, TLC0820B, ADC0820B, ADC0820C Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIOUES

## PRINCIPLES OF OPERATION

The TLC0820A, TLC0820B, ADC0820B and ADC0820C each employ a combination of "sampled-data" comparator techniques and "flash" techniques common to many high-speed converters. Two 4-bit "flash" analog-to-digital conversions are used to give a full 8-bit output.

The recommended analog input voltage range for conversion is -0.1 V to $\mathrm{V}_{\mathrm{C}}+0.1 \mathrm{~V}$. Analog input signals that are less than $V_{\text {REF }}-+1 / 2$ LSB or greater than $V_{\text {REF }}+-1 / 2$ LSB convert to 00000000 or 11111111 respectively. The reference inputs are fully differential with common-mode limits defined by the supply rails. The reference input values define the full-scale range of the analog input. This allows the gain of the ADC to be varied for ratiometric conversion by changing the $\mathrm{V}_{\text {REF }}+$ and $\mathrm{V}_{\text {REF }}$ - voltages.

The device operates in two modes, read (only) and write-read, which are selected by the MODE pin (pin 7). The converter is set to the read (only) mode when pin 7 is low. In the read mode, the $\overline{W R} / R D Y$ pin is used as an output and is referred to as the "ready" pin. In this mode, a low on the "ready" pin while $\overline{\mathrm{CS}}$ is low indicates that the device is busy. Conversion starts on the falling edge of $\overline{\mathrm{RD}}$ and is completed no more than $2.5 \mu \mathrm{~s}$ later when $\overline{\mathrm{NT}}$ falls and the "ready" pin returns to a high-impedance state. Data outputs also change from high-impedance to active states at this time. After the data is read, $\overline{\mathrm{RD}}$ is taken high, $\overline{\mathrm{INT}}$ returns high, ard the data outputs return to their high-impedance states.

The converter is set to the write-read mode when pin 7 is high and $\overline{W R} / R D Y$ is referred to as the "write" pin. Taking $\overline{C S}$ and the "write" pin low selects the converter and initiates measurement of the input signal. Approximately 600 ns after the "write" pin returns high, the conversion is completed. Conversion starts on the rising edge of $\overline{W R} / R D Y$ in the write-read mode.

The high-order 4-bit "flash" ADC measures the input by means of 16 comparators operating simultaneously. A high precision 4-bit DAC then generates a discrete analog voltage from the result of that conversion. After a time delay, a second bank of comparators does a low-order conversion on the analog difference between the input level and the high-order DAC output. The results from each of these conversions enter an 8-bit latch and are output to the three-state buffers on the falling edge of $\overline{\mathrm{RD}}$.

Advanced LinCMOS ${ }^{\text {TM }}$ HIGH-SPEED 8-BIT ANALOG-TO-DIGITAL CONVERTERS USING MODIFIED "FLASH" TECHNIQUES

TYPICAL APPLICATION DATA


FIGURE 6. CONFIGURATION FOR 9-bIT RESOLUTION

## - LinCMOS ${ }^{\text {™ }}$ Technology

- 10-Bit Resolution A/D Converter
- Microprocessor Peripheral or Stand-Alone Operation
- On-Chip 12-Channel Analog Multiplexer
- Built-In Self-Test Mode
- Software-Controllable Sample and Hold
- Total Unadjusted Error . . .

TLC1540: $\pm 0.5$ LSB Max
TLC1541: $\pm 1.0$ LSB Max

- Pinout and Control Signals Compatible with TLC540 and TLC549 Families of 8-Bit A/D Converters

| TYPICAL PERFORMANCE |  |
| :--- | :---: |
| Channel Acquisition Sample Time | $5.5 \mu \mathrm{~s}$ |
| Conversion Time | $21 \mu \mathrm{~s}$ |
| Samples per Second | $32 \times 10^{3}$ |
| Power Dissipation | 6 mW |

## description

The TLC1540 and TLC1541 are LinCMOS ${ }^{\text {TM }}$ A/D peripherals built around a 10-bit, switchedcapacitor, successive-approximation, A/D converter. They are designed for serial interface to a microprocessor or peripheral via a threestate output with up to four control inputs [including independent System Clock, I/O Clock, Chip Select ( $\overline{\mathrm{CS}}$ ), and Address input]. A 2.1-megahertz system clock for the TLC1540 and TLC1541, with a design that includes simultaneous read/write operation, allows highspeed data transfers and sample rates of up to 32,258 samples per second. In addition to the high-speed converter and versatile control logic, there is an on-chip 12-channel analog multiplexer that can be used to sample any one of 11 inputs or an internal "self-test" voltage, and a sample-and-hold that can operate automatically or under microprocessor control. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The converters incorporated in the TLC1540 and TLC1541 feature differential high-impedance reference inputs that facilitate ratiometric conversion, scaling, and analog circuitry isolation from logic and supply noises. A totally switched-capacitor design allows guaranteed low-error conversion ( $\pm 0.5$ LSB for the TLC1540, $\pm 1$ LSB for the TLC1541) in 21 microseconds over the full operating temperature range.

The TLC1540 and the TLC1541 are available in FK, FN, J, and N packages. The M-suffix versions are characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The I-suffix versions are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## functional block diagram


operating sequence


NOTES: A. The conversion cycle, which requires 44 System Clock periods, is initiated on the 10 th falling edge of the $\mathrm{I} / \mathrm{O}$ Clock $\downarrow$ after $C S \downarrow$ goes low for the channel whose address exists in memory at that time. If $\overline{C S}$ is kept low during conversion, the I/O Clock must remain low for at least 44 System Clock cycles to allow conversion to be completed.
B. The most significant bit (MSB) will automatically be placed on the DATA OUT bus after $\overline{C S}$ is brought low. The remaining nine bits (A8-A0) will be clocked out on the first nine I/O Clock falling edges.
C. To minimize errors caused by noise at the CS input, the internal circuitry waits for three System Clock cycles (or less) after a chip-select falling edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in address data until the minimum chip-select setup time has elapsed.

TLC1540M, TLC1540I, TLC1541M, TLC1541I
LinCMOS ${ }^{\text {IT }}$ 10-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 1) ..... 6.5 V
Input voltage range (any input) ..... -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$
Output voltage range -0.3 V to $\mathrm{V} \mathrm{CC}+0.3 \mathrm{~V}$
Peak input current range (any input) $\pm 10 \mathrm{~mA}$
Peak total input current (all inputs) ..... $\pm 30 \mathrm{~mA}$
Operating free-air temperature range: TLC1540I, TLC15411 ..... $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC1540M, TLC1541M $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Storage temperature range $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 60 seconds: FK package ..... $260^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package ..... $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from the case for 60 seconds: J package ..... $300^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from the case for 10 seconds: N package ..... $260^{\circ} \mathrm{C}$
NOTE 1: All voltage values are with respect to digital ground with REF - and GND wired together (unless otherwise noted).

TLC1540M, TLC1540I, TLC1541M, TLC1541I
LinCMOS ${ }^{\text {TM }}$ 10-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 11 INPUTS
recommended operating conditions

|  |  |  | TLC1540, TLC1541 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  |  | 4.75 | 5 | 5.5 | V |
| Positive reference voltage, VREF + (see Note 2) |  |  | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\text {CC }}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF }}$ - (see Note 2) |  |  | -0.1 | 0 | 2.5 | V |
| Differential reference voltage, $\mathrm{V}_{\text {REF }}+-\mathrm{V}_{\text {REF }}$ - (see Note 2) |  |  | 1 | $\mathrm{V}_{\text {CC }}$ | $\mathrm{V}_{\text {CC }}+0.2$ | V |
| Analog input voltage (see Note 2) |  |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level control input voltage, $\mathrm{V}_{1} \mathrm{H}$ |  |  | 2 |  |  | V |
| Low-level control input voltage, $\mathrm{V}_{\mathrm{IL}}$ |  |  |  |  | 0.8 | V |
| Setup time, address bits before 1/O CLK $\uparrow$, $\mathrm{t}_{\text {su }}(\mathrm{A})$ |  |  | 400 |  |  | ns |
| Hold time, address bits after I/O CLLK $\uparrow$, $\operatorname{th}(\mathrm{A})$ |  |  | 0 |  |  | ns |
| Setup time, $\overline{\mathrm{CS}}$ low before clocking in first address bit, $\mathrm{t}_{\text {su }}\left(\mathrm{CS}\right.$ ) (see Note ${ }^{\text {3) }}$ |  |  | 3 |  |  | $\begin{gathered} \hline \text { System } \\ \text { clock } \\ \text { cycles } \end{gathered}$ |
| $\overline{\mathrm{CS}}$ high during conversion, $\mathrm{t}_{\mathrm{wH}}$ (CS) |  |  | 44 |  |  | System clock cycles |
| Input/Output clock frequency, $\mathrm{f}_{\text {CLK (1/O) }}$ |  |  | 0 |  | 1.1 | MHz |
| System clock frequency, fCLK(SYS) |  |  | ${ }^{\text {f CLK }}$ (1/O) |  | 2.1 | MHz |
| System clock high, ${ }_{\text {wH }}$ (SYS $)$ |  |  | 210 |  |  | ns |
| System clock low, $\mathrm{t}_{\text {wL }}$ (SYS) |  |  | 190 |  |  | ns |
| Input/Output clock high, $\mathrm{t}_{\mathrm{wH}}(1 / \mathrm{O})$ |  |  | 404 |  |  | ns |
| Input/Output clock low, $\mathrm{t}_{\mathrm{w} L}(1 / \mathrm{O})$ |  |  | 404 |  |  | ns |
| Clock transition time (see Note 4) | System | ${ }^{\text {f CLK }}$ (SYS) $\leq 1048 \mathrm{kHz}$ |  |  | 30 | ns |
|  |  | ${ }^{\text {f CLK }}$ (SYS) $>1048 \mathrm{kHz}$ |  |  | 20 |  |
|  | 1/O | ${ }^{\text {f CLK }}$ (I/O) $\leq 525 \mathrm{kHz}$ |  |  | 100 | ns |
|  |  | ${ }^{\text {f CLK }(1 / O) ~}>525 \mathrm{kHz}$ |  |  | 40 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ |  | TLC1540M, TLC1541M | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  |  | TLC1540I, TLC1541I | -40 |  | 85 |  |

NOTES: 2. Analog input voltages greater than that applied to REF + convert as all " 1 "s (111111111), while input voltages less than that applied to REF - convert as all " 0 "s (00000000). For proper operation, REF + voltage must be at least 1 volt higher than REF - voltage. Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 volts.
3. To minimize errors caused by noise at the chip select input, the internal circuitry waits for three System Clock cycles (or less) after a chip select falling edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in an address until the minimum chip select setup time has elapsed.
4. This is the time required for the clock input signal to fall from $V_{I H}$ min to $V_{I L} \max$ or to rise from $V_{I L}$ max to $V_{I H} m i n$. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as 2 microseconds for remote data acquisition applications where the sensor and the A/D converter are placed several feet away from the controlling microprocessor.

TLC1540M, TLC1540I, TLC1541M, TLC1541I LinCMOS ${ }^{\text {T" }}$ 10-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS
electrical characteristics over recommended operating temperature range, $\mathrm{VCC}_{\mathrm{C}}=\mathrm{V}_{\mathrm{REF}}+=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{fCLK}(\mathrm{I} / \mathrm{O})=1.1 \mathrm{MHz}, \mathrm{fCLK}(\mathrm{SYS})=2.1 \mathrm{MHz}$

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage (pin 16) |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | ${ }^{1} \mathrm{OH}=360 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$. | $1 \mathrm{OL}=3.2 \mathrm{~mA}$ |  |  | 0.4 | V |
| ${ }^{\prime} \mathrm{OZ}$ | Off-state (high-impedance state) output current |  | $V_{O}=V_{C C}$ | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  |  | 10 | $\mu \mathrm{A}$ |
|  |  |  | $V_{0}=0$, | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  |  | -10 |  |
| $I_{1 H}$ | High-level input current |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}$ |  |  | 0.005 | 2.5 | $\mu \mathrm{A}$ |
| IIL | Low-level input current |  | $\mathrm{V}_{1}=0$ |  |  | -0.005 | -2.5 | $\mu \mathrm{A}$ |
| ${ }^{\text {I CC }}$ | Operating supply current |  | $\overline{\mathrm{CS}}$ at 0 V |  |  | 1.2 | 2.5 | mA |
| Selected channel leakage current |  |  | Selected channel at $\mathrm{V}_{\mathrm{CC}}$, <br> Unselected channel at 0 V |  |  | 0.4 | 1 | A |
|  |  |  | Selected channel at 0 V , <br> Unselected channel at $V_{C C}$ |  |  | -0.4 | -1 | $\mu \mathrm{A}$ |
| ${ }^{\prime} \mathrm{CC}+\mathrm{I}^{\text {REF }}$ | Supply and reference current |  | $\mathrm{V}_{\mathrm{REF}+}=\mathrm{V}_{\text {CC }}$, | $\overline{\mathrm{CS}}$ at 0 V |  | 1.3 | 3 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance | Analog inputs |  |  |  | 7 | 55 |  |
|  |  | Control inputs |  |  |  | 5 | 15 | pF |

${ }^{\dagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## operating characteristics over recommended operating free-air temperature range, <br> $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{REF}}+=4.75 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{fCLK}(\mathrm{I} / \mathrm{O})=1.1 \mathrm{MHz}, \mathrm{fCLK}(\mathrm{SYS})=2.1 \mathrm{MHz}$

| PARAMETER |  |  | TEST CONDITIONS | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity error |  | TLC1540 | See Note 5 |  | $\pm 0.5$ | LSB |
|  |  | TLC1541 |  |  | $\pm 1$ |  |
| Zero error |  | TLC1540 | See Notes 2 and 6 |  | $\pm 0.5$ | LSB |
|  |  | TLC1541 |  |  | $\pm 1$ |  |
| Full-scale error |  | TLC1540 | See Notes 2 and 6 |  | $\pm 0.5$ | LSB |
|  |  | TLC1541 |  |  | $\pm 1$ |  |
| Total unadjusted error |  | TLC1540 | See Note 7 |  | $\pm 0.5$ | LSB |
|  |  | TLC1541 |  |  | $\pm 1$ |  |
| Self-test output code |  |  | Input A11 address = 1011 (See Note 8) | $\begin{aligned} & 0111110100 \\ & (500) \\ & \hline \end{aligned}$ | $\begin{gathered} 1000001100 \\ (524) \\ \hline \end{gathered}$ |  |
| $\mathrm{t}_{\text {conv }}$ | Conversion time |  | See Operating Sequence |  | 21 | $\mu \mathrm{s}$ |
|  | Total access and conversion time |  | See Operating Sequence |  | 31 | $\mu \mathrm{s}$ |
| taca | Channel acquisition time (sample cycle) |  | See Operating Sequence |  | 6 | I/O <br> clock <br> cycles |
| $t_{v}$ | Time output data remains valid after I/O clock $\downarrow$ |  |  | 10 |  | ns |
| $\mathrm{t}_{\mathrm{d}}$ | Delay time, I/O clock $\downarrow$ to data output valid |  | See Parameter Measurement Information |  | 400 | ns |
| ten | Output enable time |  |  |  | 150 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time |  |  |  | 150 | ns |
| $t_{r}$ (bus) | Data bus rise time |  |  |  | 300 | ns |
| $t_{\text {f }}$ (bus) | Data bus fall time |  |  |  | 300 | ns |

NOTES: 2. Analog input voltages greater than that applied to REF + convert to all " 1 "s (11111111), while input voltages less than that applied to REF - convert to all" 0 " s ( 00000000 ). For proper operation, REF + voltage must be at least 1 volt higher than REF - voltage. Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 volts.
5. Linearity error is the maximum deviation from the best straight line through the $A / D$ transfer characteristics.
6. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
7. Total unadjusted error comprises linearity, zero, and full-scale errors.
8. Both the input address and the output codes are expressed in positive logic. The A11 analog input signal is internally generated and is used for test purposes.


VOLTAGE WAVEFORMS FOR ENABLE AND DISABLE TIMES


# TLC1540M, TLC1540I, TLC1541M, TLC1541I LinCMOS ${ }^{\text {TM }}$ 10-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS 

## principles of operation

The TLC1540 and TLC1541 are complete data acquisition systems on single chips. Each includes such functions as sample-and-hold, 10-bit A/D converter, data and control registers, and control logic. For flexibility and access speed, there are four control inputs; Chip Select ( $\overline{\mathrm{CS}}$ ), Address Input, I/O Clock, and System Clock. These control inputs and a TTL-compatible three-state output are intended for serial communications with a microprocessor or microcomputer. The TLC1540 and TLC1541 can complete conversions in a maximum of 21 microseconds, while complete input-conversion-output cycles can be repeated at a maximum of 31 microseconds.

The System and I/O Clocks are normally used independently and do not require any special speed or phase relationships between them. This independence simplifies the hardware and software control tasks for the device. Once a clock signal within the specification range is applied to the System Clock input, the control hardware and software need only be concerned with addressing the desired analog channel, reading the previous conversion result, and starting the conversion by using the I/O Clock. The System Clock will drive the "conversion crunching' circuitry so that the control hardware and software need not be concerned with this task.

When $\overline{\mathrm{CS}}$ is high, the Data Output pin is in a three-state condition and the Address Input and I/O Clock pins are disabled. This feature allows each of these pins, with the exception of the $\overline{\mathrm{CS}}$ pin, to share a control logic point with their counterpart pins on additional A/D devices when additional TLC1540/1541 devices are used. In this way, the above feature serves to minimize the required control logic pins when using multiple A/D devices.

The control sequence has been designed to minimize the time and effort required to initiate conversion and obtain the conversion result. A normal control sequence is:

1. $\overline{\mathrm{CS}}$ is brought low. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and then a falling edge of the System Clock after a low $\overline{\mathrm{C}} \overline{\mathrm{S}}$ transition, before the low transition is recognized. This technique is used to protect the device against noise when the device is used in a noisy environment. The MSB of the previous conversion result will automatically appear on the Data Out pin.
2. A new positive-logic multiplexer address is shifted in on the first four rising edges of the I/O Clock. The MSB of the address is shifted in first. The negative edges of these four I/O Clock pulses shift out the second, third, fourth, and fifth most significant bits of the previous conversion result. The on-chip sample-and-hold begins sampling the newly addressed analog input after the fourth falling edge. The sampling operation basically involves the charging of internal capacitors to the level of the analog input voltage.
3. Five clock cycles are then applied to the $I / O$ pin and the sixth, seventh, eighth, ninth, and tenth conversion bits are shifted out on the negative edges of these clock cycles.
4. The final tenth clock cycle is applied to the I/O Clock pin. The falling edge of this clock cycle completes the analog sampling process and initiates the hold function. Conversion is then performed during the next 44 System Clock cycles. After this final I/O Clock cycle, $\overline{\mathrm{CS}}$ must go high or the I/O Clock must remain low for at least 44 System Clock cycles to allow for the conversion function.
$\overline{\mathrm{CS}}$ can be kept low during periods of multiple conversion. When keeping $\overline{\mathrm{CS}}$ low during periods of multiple conversion, special care must be exercised to prevent noise glitches on the I/O Clock line. If glitches occur on the I/O Clock line, the I/O sequence between the microprocessor/controller and the device will lose synchronization. Also, if $\overline{\mathrm{CS}}$ is taken high, it must remain high until the end of the conversion. Otherwise, a valid falling edge of $\overline{\mathrm{CS}}$ will cause a reset condition, which will abort the conversion in progress.

A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the 44 System Clock cycles occur. Such action will yield the conversion result of the previous conversion and not the ongoing conversion.

# TLC1540M, TLC1540I, TLC1541M, TLC1541I LinCMOS ${ }^{\text {TM }}$ 10-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS 

## principles of operation (continued)

It is possible to connect the System and I/O Clock pins together in special situations in which controlling circuitry points must be minimized. In this case, the following special points must be considered in addition to the requirements of the normal control sequence previously described.

1. When $\overline{\mathrm{CS}}$ is recognized by the device to be at a low level, the common clock signal is used as an I/O Clock. When $\overline{\mathrm{CS}}$ is recognized by the device to be at a high level, the common clock signal is used to drive the "conversion crunching" circuitry.
2. The device will recognize a $\overline{C S}$ low transition only when the $\overline{C S}$ input changes and subsequently the System Clock pin receives two positive edges and then a negative edge. For this reason, after a $\overline{\mathrm{CS}}$ negative edge, the first two clock cycles will not shift in the address because a low $\overline{\mathrm{CS}}$ must be recognized before the I/O Clock can shift in an analog channel address. Also, upon shifting in the address, $\overline{\mathrm{CS}}$ must be raised after the eighth I/O Clock that has been recognized by the device, so that a $\overline{\mathrm{CS}}$ low level will be recognized upon the lowering of the tenth I/O Clock signal that is recognized by the device. Otherwise, additional common clock cycles will be recognized as I/O Clock pulses and will shift in an erroneous address.

For certain applications, such as strobing applications, it is necessary to start conversion at a specific point in time. This device will accommodate these applications. Although the on-chip sample-and-hold begins sampling upon the negative edge of the fourth I/O Clock cycle, the hold function is not initiated until the negative edge of the tenth I/O Clock cycle. Thus, the control circuitry can leave the I/O Clock signal in its high state during the tenth I/O Clock cycle until the moment at which the analog signal must be converted. The TLC1540/TLC1541 will continue sampling the analog input until the tenth falling edge of the I/O Clock. The control circuitry or software will then immediately lower the I/O Clock signal and hold the analog signal at the desired point in time and start conversion.

Detailed information on interfacing to most popular microprocessors is readily available from the factory.

- High Degree of Linearity
- High On-Off Output Voltage Ratio
- Low Crosstalk Between Switches
- Low On-State Impedance . . . $50 \Omega$ Typ at $V_{C C}=9 \mathrm{~V}$
- Individual Switch Controls
- Extremely Low Input Current


## description

The TLC4016 is a silicon-gate CMOS quadruple analog switch designed to handle both analog and digital signals. Each switch permits signals with amplitudes up to 12 V peak to be transmitted in either direction.
Each switch section has its own enable input control. A high-level voltage applied to this control terminal turns on the associated switch section.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-toanalog conversion systems.

The TLC4016M is characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$, and the TLC40161 is characterized from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.


| 1A 1 | U14 | $V^{C C}$ |
| :---: | :---: | :---: |
| 1B-2 | 13 | 1 C |
| $2 \mathrm{~B} \square^{3}$ | 12 | - 4 C |
| $2 \mathrm{~A} \square^{4}$ | 11 | -4A |
| 2C $\square_{5}$ | 10 | $4 B$ |
| 3C $\square^{6}$ | 9 | -3B |
| GND $\square^{7}$ |  | - 3 A |

logic symbol ${ }^{\dagger}$

${ }^{\dagger}$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
logic diagram (positive logic)


## TLC4016M, TLC4016I <br> SILICON-GATE CMOS QUADRUPLE BILATERAL ANALOG SWITCH

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

$$
\begin{aligned}
& \text { Supply voltage range (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-0.5 \mathrm{~V} \text { to } 15 \mathrm{~V} \\
& \text { Control-input diode current }\left(\mathrm{V}_{\mathrm{I}}<0 \text { or } \mathrm{V}_{\mathrm{I}}>\mathrm{V}_{\mathrm{CC}} \text { ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 20 \mathrm{~mA}\right. \\
& \mathrm{I} / \mathrm{O} \text { port diode current }\left(\mathrm{V}_{\mathrm{I}}<0 \text { or } \mathrm{V}_{\mathrm{I} / \mathrm{O}}>\mathrm{V}_{\mathrm{CC}} \text { ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \quad \pm 20 \mathrm{~mA}\right. \\
& \text { On-state switch current ( } \mathrm{V}_{\mathrm{I} / \mathrm{O}}=0 \text { to } \mathrm{V}_{\mathrm{CC}} \text { ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 25 \mathrm{~mA} \\
& \text { Continuous current through VCC or GND pins . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } \pm 50 \mathrm{~mA} \\
& \text { Continuous total dissipation . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . see Dissipation Rating Table } \\
& \text { Operating free-air temperature range: TLC4016M . . . . . . . . . . . . . . . . . . . . . }-55^{\circ} \mathrm{C} \text { to } 125^{\circ} \mathrm{C} \\
& \text { TLC4016I . . . . . . . . . . . . . . . . . . . . . . . . . }-40^{\circ} \mathrm{C} \text { to } 85^{\circ} \mathrm{C} \\
& \text { Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }-65^{\circ} \mathrm{C} \text { to } 150^{\circ} \mathrm{C} \\
& \text { Lead temperature } 1,6 \mathrm{~mm}(1 / 16 \mathrm{inch}) \text { from case for } 10 \text { seconds: } \mathrm{D} \text { or } \mathrm{N} \text { package . . . . . . . } 260^{\circ} \mathrm{C} \\
& \text { Lead temperature } 1,6 \mathrm{~mm}(1 / 16 \mathrm{inch}) \text { from case for } 60 \text { seconds: J package . . . . . . . . . . . } 300^{\circ} \mathrm{C}
\end{aligned}
$$

NOTE 1: All voltages are with respect to ground unless otherwise specified.
dissipation rating table

| PACKAGE | $\mathrm{T}_{\mathrm{A}} \leq 25^{\circ} \mathrm{C}$ <br> POWER RATING | DERATING FACTOR <br> ABOVE TA $=25^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{A}}=70^{\circ} \mathrm{C}$ <br> POWER RATING | $\mathrm{T}_{\mathrm{A}}=85^{\circ} \mathrm{C}$ <br> POWER RATING | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ <br> POWER RATING |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D | 950 mW | $7.6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 608 mW | 494 mW | N/A |
| $J$ | 1375 mW | $11.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 880 mW | 715 mW | 275 mW |
| N | 1150 mW | $9.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 736 mW | 598 mW | 230 mW |

recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | $2^{\dagger}$ | 5 | 12 | V |
| I/O port voltage, $\mathrm{V}_{1 / \mathrm{O}}$ |  | 0 |  | $\mathrm{V}_{\text {CC }}$ | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ | 1.5 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | 3.15 |  | $\mathrm{V}_{\mathrm{CC}}$ |  |
|  | $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$ | 6.3 |  | $\mathrm{V}_{\text {CC }}$ |  |
|  | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | 8.4 |  | $\mathrm{V}_{\mathrm{CC}}$ |  |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\text {CC }}=2 \mathrm{~V}$ | 0 |  | 0.3 | V |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | 0 |  | 0.9 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$ | 0 |  | 1.8 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | 0 |  | 2.4 |  |
| Input rise time, $\mathrm{t}_{\mathrm{r}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 | ns |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ |  |  | 500 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$ |  |  | 400 |  |
| Input fall time, $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 | ns |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ |  |  | 500 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$ |  |  | 400 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC4016M | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC4016I | -40 |  | 85 |  |

[^14]electrical characteristics over recommended operating free-air temperature range (unless otherwise noted).

| PARAMETER |  |  | TEST CONDITIONS | $\mathrm{V}_{\mathrm{Cc}}$ | TLC4016M |  |  | TLC40161 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN |  | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| rSon | On-state switch resistance |  |  | $\begin{aligned} & I_{S}=1 \mathrm{~mA}, \\ & V_{A}=0 \text { to } V_{C C} \end{aligned}$ <br> See Figure 1 | 4.5 V |  | 100 | 220 |  | 100 | 200 | $\Omega$ |
|  |  |  | 9 V |  |  | 50 | 120 |  | 50 | 105 |  |  |
|  |  |  | 12 V |  |  | 30 | 100 |  | 30 | 85 |  |  |
|  |  |  | $\begin{aligned} & \mathrm{I}_{\mathrm{S}}=1 \mathrm{~mA} \\ & \mathrm{~V}_{\mathrm{A}}=0 \text { or } \mathrm{V}_{\mathrm{CC}} \end{aligned}$ <br> See Figure 1 | 2 V |  | 120 | 240 |  | 120 | 215 |  |  |
|  |  |  | 4.5 V |  | 50 | 120 |  | 50 | 100 |  |  |
|  |  |  | 9 V |  | 35 | 80 |  | 35 | 75 |  |  |
|  |  |  | 12 V |  | 20 | 70 |  | 20 | 60 |  |  |
| On-state switch resistance matching |  |  |  | $\mathrm{V}_{\mathrm{A}}=0 \text { to } \mathrm{V}_{\mathrm{CC}}$ <br> See Figure 1 | 4.5 V |  | 10 | 20 |  | 10 | 20 | $\Omega$ |
|  |  |  | 9 V |  |  | 5 | 15 |  | 5 | 15 |  |  |
|  |  |  | 12 V |  |  | 5 | 15 |  | 5 | 15 |  |  |
|  | Control input current |  |  | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{\mathrm{CC}}$ | $\begin{aligned} & 2 \mathrm{~V} \\ & \text { to } \\ & 6 \mathrm{~V} \end{aligned}$ |  |  | $\pm 1$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
|  |  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=0 \text { or } \mathrm{V}_{\mathrm{CC}}, \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ |  |  |  | $\pm 0.1$ |  |  | $\pm 0.1$ |  |  |
| ISoff | Off-state switch leakage current |  |  | $V_{S}= \pm V_{C C}$ <br> See Figure 2 | 5.5 V |  | $\pm 10$ | $\pm 600$ |  | $\pm 10$ | $\pm 600$ | nA |
|  |  |  | 9 V |  |  | $\pm 15$ | $\pm 800$ |  | $\pm 15$ | $\pm 800$ |  |  |
|  |  |  | 12 V |  | $\pm 20 \pm 1000$ |  |  | $\pm 20 \pm 1000$ |  |  |  |  |
| ISon | On-state switch leakage current |  | $\mathrm{V}_{\mathrm{A}}=0 \text { or } \mathrm{V}_{\mathrm{CC}}$ <br> See Figure 3 | 5.5 V |  | $\pm 10$ | $\pm 150$ |  | $\pm 10$ | $\pm 150$ | nA |  |
|  |  |  | 9 V |  | $\pm 15$ | $\pm 200$ |  | $\pm 15$ | $\pm 200$ |  |  |
|  |  |  | 12 V |  | $\pm 20$ | $\pm 300$ |  | $\pm 20$ | $\pm 300$ |  |  |
| ${ }^{1} \mathrm{CC}$ | Supply current |  |  | $\begin{aligned} & V_{1}=0 \text { or } V_{C C} \\ & I_{0}=0 \end{aligned}$ | 5.5 V |  | 2 | 40 |  | 2 | 20 | $\mu \mathrm{A}$ |
|  |  |  | 9 V |  |  | 8 | 160 |  | 8 | 80 |  |  |
|  |  |  | 12 V |  |  | 16 | 320 |  | 16 | 160 |  |  |
| $\mathrm{C}_{i}$ | Input capacitance | A or B |  |  | $\begin{array}{r} 2 \mathrm{~V} \text { to } \\ 12 \mathrm{~V} \end{array}$ | 15 |  |  | 15 |  |  | pF |
|  |  | C |  |  |  | 5 | 10 |  | 5 | 10 |  |  |
| $C_{f}$ | Feedthrough capacitance | A to B | $V_{1}=0$ | $\begin{array}{r} \hline 2 \mathrm{~V} \text { to } \\ 12 \mathrm{~V} \end{array}$ | 5 |  |  | 5 |  |  | pF |  |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## TLC4016M, TLC4016I

## SILICON-GATE CMOS OUADRUPLE BILATERAL ANALOG SWITCH

switching characteristics over recommended operating free-air temperature range, $C_{L}=50 \mathrm{pF}$ (unless otherwise noted)

2

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## PARAMETER MEASUREMENT INFORMATION



FIGURE 1. TEST CIRCUIT FOR ON-STATE RESISTANCE


FIGURE 2. TEST CIRCUIT FOR OFF-STATE SWITCH LEAKAGE CURRENT

## PARAMETER MEASUREMENT INFORMATION



FIGURE 3. TEST CIRCUIT FOR ON-STATE SWITCH LEAKAGE CURRENT



FIGURE 4. PROPAGATION DELAY TIME, SIGNAL INPUT TO SIGNAL OUTPUT

## PARAMETER MEASUREMENT INFORMATION



FIGURE 5. SWITCHING TIME (tpZL, tplz), CONTROL TO SIGNAL OUTPUT

## PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT


FIGURE 6. SWITCHING TIME (tPZH, tPhz), CONTROL TO SIGNAL OUTPUT

## SILICON.GATE CMOS OUADRUPLE BILATERAL ANALOG SWITCH

PARAMETER MEASUREMENT INFORMATION


TEST CIRCUIT


FIGURE 7. CONTROL FEEDTHROUGH VOLTAGE


NOTE: ADJUST $f$ for $a x=\frac{V_{\mathrm{O} 2}}{V_{\mathrm{O} 1}}=50 \mathrm{~dB}$.
FIGURE 8. CROSSTALK BETWEEN ANY TWO SWITCHES, TEST CIRCUIT

- High Degree of Linearity
- High On-Off Output Voltage Ratio
- Low Crosstalk Between Switches
- Low On-State Impedance . . . $30 \Omega$ Typ at $\mathrm{VCC}=12 \mathrm{~V}$
- Individual Switch Controls
- Extremely Low Input Current
- Functionally Interchangeable with National Semiconductor MM54/74HC4066, Motorola MC54/74HC4066, and RCA CD4066A


## description

The TLC4066 is a silicon-gate CMOS quadruple analog switch designed to handle both analog and digital signals. Each switch permits signals with amplitudes up to 12 V peak to be transmitted in either direction.

Each switch section has its own enable input control. A high-level voltage applied to this control terminal turns on the associated switch section.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-toanalog conversion systems.
The TLC4066M is characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC40661 is characterized from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

logic symbol ${ }^{\dagger}$

†This symbol is in accordance with ANSI/IEEE Std 91-1984 and
IEC Publication 617-12.
logic diagram (positive logic)


## TLC4066M, TLC4066I <br> SILICON-GATE CMOS OUADRUPLE BILATERAL ANALOG SWITCH

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)



NOTE 1: All voltages are with respect to ground unless otherwise specified.
dissipation rating table

| PACKAGE | $\mathrm{T}_{\mathrm{A}} \leq 25^{\circ} \mathrm{C}$ <br> POWER RATING | DERATING FACTOR <br> ABOVE $T_{A}=25^{\circ} \mathrm{C}$ | $T_{A}=70^{\circ} \mathrm{C}$ <br> POWER RATING | $T_{A}=85^{\circ} \mathrm{C}$ <br> POWER RATING | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ <br> POWER RATING |
| :---: | :---: | :---: | :---: | :---: | :---: |
| D | 950 mW | $7.6 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 608 mW | 494 mW | N/A |
| $J$ | 1375 mW | $11.0 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 880 mW | 715 mW | 275 mW |
| N | 1150 mW | $9.2 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ | 736 mW | 598 mW | 230 mW |

recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | $2^{\dagger}$ | 5 | 12 | V |
| I/O port voltage, $\mathrm{V}_{1 / \mathrm{O}}$ |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ | 1.5 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | 3.15 |  | $\mathrm{V}_{\text {CC }}$ |  |
|  | $\mathrm{V}_{C C}=9 \mathrm{~V}$ | 6.3 |  | $\mathrm{V}_{\mathrm{CC}}$ |  |
|  | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | 8.4 |  | $\mathrm{V}_{\mathrm{CC}}$ |  |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ | $\mathrm{V}_{\text {CC }}=2 \mathrm{~V}$ | 0 |  | 0.3 | V |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ | 0 |  | 0.9 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=9 \mathrm{~V}$ | 0 |  | 1.8 |  |
|  | $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | 0 |  | 2.4 |  |
| Input rise time, $\mathrm{t}_{\mathrm{r}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 | ns |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ |  |  | 500 |  |
|  | $\mathrm{V}_{C C}=9 \mathrm{~V}$ |  |  | 400 |  |
| Input fall time, $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{V}_{\mathrm{CC}}=2 \mathrm{~V}$ |  |  | 1000 | ns |
|  | $\mathrm{V}_{C C}=4.5 \mathrm{~V}$ |  |  | 500 |  |
|  | $\mathrm{V}_{\text {CC }}=9 \mathrm{~V}$ |  |  | 400 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC4066M | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC4066I | -40 |  | 85 |  |

[^15]electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | $\mathrm{V}_{\mathbf{C C}}$ | TLC4066M |  |  | TLC40661 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN |  | TYP ${ }^{\text { }}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| ${ }^{\text {r }}$ Son | On-state switch resistance |  |  | $\mathrm{I}_{\mathrm{S}}=1 \mathrm{~mA}$, | 4.5 V |  | 100 | 220 |  | 100 | 200 | $\Omega$ |
|  |  |  | $\mathrm{V}_{\mathrm{A}}=0$ to $\mathrm{V}_{\mathrm{CC}}$, | 9 V |  | 50 | 110 |  | 50 | 105 |  |  |
|  |  |  | See Figure 1 | 12 V |  | 30 | 90 |  | 30 | 85 |  |  |
|  |  |  | $\begin{aligned} & \mathrm{I} \mathrm{~S}=1 \mathrm{~mA}, \\ & \mathrm{~V}_{\mathrm{A}}=0 \text { or } \mathrm{V}_{\mathrm{CC}} . \end{aligned}$ <br> See Figure 1 | 2 V |  | 120 | 240 |  | 120 | 215 |  |  |
|  |  |  | 4.5 V |  | 50 | 120 |  | 50 | 100 |  |  |
|  |  |  | 9 V |  | 35 | 80 |  | 35 | 75 |  |  |
|  |  |  | 12 V |  | 20 | 70 |  | 20 | 60 |  |  |
| On-state switch resistance matching |  |  |  | $\mathrm{V}_{\mathrm{A}}=0 \text { to } \mathrm{V}_{\mathrm{CC}}$ <br> See Figure 1 | 4.5 V |  | 10 | 20 |  | 10 | 20 | $\Omega$ |
|  |  |  | 9 V |  |  | 5 | 15 |  | 5 | 15 |  |  |
|  |  |  | 12 V |  |  | 5 | 15 |  | 5 | 15 |  |  |
| I | Control input current |  |  | $V_{1}=0$ or $V_{C C}$ | $\begin{aligned} & 2 \mathrm{~V} \\ & \text { or } \\ & 6 \mathrm{~V} \end{aligned}$ | $\pm 1$ |  |  | $\pm 1$ |  |  | $\mu \mathrm{A}$ |
| ISoff | Off-state switch leakage current |  |  | $V_{S}= \pm V_{C C}$ <br> See Figure 2 | 5.5 V |  | $\pm 10$ | $\pm 600$ |  | $\pm 10$ | $\pm 600$ | nA |
|  |  |  | 9 V |  |  | $\pm 15$ | $\pm 800$ |  | $\pm 15$ | $\pm 800$ |  |  |
|  |  |  | 12 V |  | $\pm 20 \pm 1000$ |  |  | $\pm 20 \pm 1000$ |  |  |  |  |
| ISon | On-state switch leakage current |  | $V_{A}=0 \text { or } V_{C C}$ <br> See Figure 3 | 5.5 V |  | $\pm 10$ | $\pm 150$ |  | $\pm 10$ | $\pm 150$ | nA |  |
|  |  |  | 9 V |  | $\pm 15$ | $\pm 200$ |  | $\pm 15$ | $\pm 200$ |  |  |
|  |  |  | 12 V |  | $\pm 20$ | $\pm 300$ |  | $\pm 20$ | $\pm 300$ |  |  |
| ${ }^{\text {I CC }}$ | Supply current |  |  | $\begin{aligned} & V_{1}=0 \text { or } V_{C C} \\ & I_{0}=0 \end{aligned}$ | 5.5 V |  | 2 | 40 |  | 2 | 20 | $\mu \mathrm{A}$ |
|  |  |  | 9 V |  |  | 8 | 160 |  | 8 | 80 |  |  |
|  |  |  | 12 V |  |  | 16 | 320 |  | 16 | 160 |  |  |
| $\mathrm{C}_{i}$ | Input capacitance | A or B |  |  | $\begin{gathered} 2 \mathrm{~V} \text { to } \\ 12 \mathrm{~V} \end{gathered}$ | 15 |  |  | 15 |  |  | pF |
|  |  | C |  |  |  | 5 | 10 |  | 5 | 10 |  |  |
| $C_{f}$ | Feedthrough capacitance | $A$ to $B$ | $V_{1}=0$ | $\begin{gathered} 2 \mathrm{~V} \text { to } \\ 12 \mathrm{~V} \end{gathered}$ | 5 |  |  | 5 |  |  | pF |  |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

## TLC4066M, TLC4066I <br> SILICON-GATE CMOS QUADRUPLE BILATERAL ANALOG SWITCH

switching characteristics over recommended operating free-air temperature range, $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | $\mathrm{V}_{\mathrm{CC}}$ | TLC4066M |  |  | TLC40661 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN |  | TYP ${ }^{\dagger}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| ${ }^{t} \mathrm{pd}$ | Propagation delay time, $A$ to $B$ or $B$ to $A$ |  | See Figure 4 | 2 V |  | 25 | 75 |  | 15 | 30 | ns |
|  |  | 4.5 V |  |  | 5 | 15 |  | 5 | 13 |  |  |
|  |  | 9 V |  |  | 4 | 12 |  | 4 | 10 |  |  |
|  |  | 12 V |  |  | 3 | 13 |  | 3 | 11 |  |  |
| ton | Switch turn-on time | $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ <br> See Figures 5 and 6 | 2 V |  | 32 | 150 |  | 32 | 125 | ns |  |
|  |  |  | 4.5 V |  | 8 | 30 |  | 8 | 25 |  |  |
|  |  |  | 9 V |  | 6 | 18 |  | 6 | 15 |  |  |
|  |  |  | 12 V |  | 5 | 15 |  | 5 | 13 |  |  |
| toff | Switch turn-off time | $R_{\mathrm{L}}=1 \mathrm{k} \Omega$ <br> See Figures 5 and 6 | 2 V |  | 45 | 252 |  | 45 | 210 | ns |  |
|  |  |  | 4.5 V |  | 15 | 54 |  | 15 | 45 |  |  |
|  |  |  | 9 V |  | 10 | 48 |  | 10 | 40 |  |  |
|  |  |  | 12 V |  | 8 | 45 |  | 8 | 38 |  |  |
| ${ }^{\text {f }}$ co | Switch cutoff frequency (channel loss $=3 \mathrm{~dB}$ ) |  | 4.5 V |  | 100 |  |  | 100 |  | MHz |  |
|  |  |  | 9 V |  | 120 |  |  | 120 |  |  |  |
| $V_{\text {OCF }}(\mathrm{PP})$ | Control feedthrough voltage to any switch, peak to peak | See Figure 7 | 4.5 V | 350 |  |  |  |  | 350 | mV |  |
| - | Frequency at which crosstalk attenuation between any two switches equals 50 dB | See Figure 8 | 4.5 V | 1 |  |  | 1 |  |  | MHz |  |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
PARAMETER MEASUREMENT INFORMATION

figure 1. test circuit for on-state resistance

$\mathrm{v}_{\mathrm{S}}=\mathrm{v}_{\mathrm{A}}-\mathrm{v}_{\mathrm{B}}$
CONDITION 1: $\mathrm{V}_{\mathrm{A}}=0, \mathrm{~V}_{\mathrm{B}}=\mathrm{V}_{\mathrm{CC}}$
CONDITION 2: $\mathrm{V}_{\mathbf{A}}=\mathrm{V}_{\mathbf{C}}, \mathrm{V}_{\mathbf{B}}=\mathbf{0}$
FIGURE 2. TEST CIRCUIT FOR OFF-STATE SWITCH LEAKAGE CURRENT

PARAMETER MEASUREMENT INFORMATION


FIGURE 3. TEST CIRCUIT FOR ON-STATE SWITCH LEAKAGE CURRENT


FIGURE 4. PROPAGATION DELAY TIME, SIGNAL INPUT TO SIGNAL OUTPUT

## SILICON-GATE CMOS OUADRUPLE BILATERAL ANALOG SWITCH

PARAMETER MEASUREMENT INFORMATION



FIGURE 5. SWITCHING TIME (tPZL, tPLZ), CONTROL TO SIGNAL OUTPUT

test circuit


FIGURE 6. SWITCHING TIME (tpZH, tPHZ), CONTROL TO SIGNAL OUTPUT

## SILICON-GATE CMOS QUADRUPLE BILATERAL ANALOG SWITCH

PARAMETER MEASUREMENT INFORMATION

test circuit


FIGURE 7. CONTROL FEEDTHROUGH VOLTAGE


FIGURE 8. CROSSTALK BETWEEN ANY TWO SWITCHES, TEST CIRCUIT

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- Easily Interfaced to Microprocessors
- On-Chip Data Latches
- Monotonic over the Entire A/D Conversion Range
- Segmented High-Order Bits Ensure LowGlitch Output
- Designed to be Interchangeable with Analog Devices AD7524, PMI PM-7524, and Micro Power Systems MP7524
- Fast Control Signaling for Digital Signal Processor Applications Including Interface with TMS320

| KEY PERFORMANCE SPECIFICATIONS |  |
| :--- | :--- |
| Resolution | 8 Bits |
| Linearity error | $1 / 2 \mathrm{LSB}$ Max |
| Power dissipation |  |
| at $V_{D D}=5 \mathrm{~V}$ | 5 mW Max |
| Settling time | 100 ns Max |
| Propagation delay | 80 ns Max |



NC - No internal connection

## description

The TLC7524 is an Advanced LinCMOS ${ }^{\text {TM }}$ 8-bit digital-to-analog converter (DAC) designed for easy interface to most popular microprocessors.
The TLC7524 is an 8-bit multiplying DAC with input latches and with a load cycle similar to the "write" cycle of a random access memory. Segmenting the high-order bits minimizes glitches during changes in the most-significant bits, which produce the highest glitch impulse. The TLC7524 provides accuracy to $1 / 2$ LSB without the need for thin-film resistors or laser trimming, while dissipating less than 5 milliwatts typically.
Featuring operation from a $5-\mathrm{V}$ to $15-\mathrm{V}$ single supply, the TLC7524 interfaces easily to most microprocessor buses or output ports. Excellent multiplying ( 2 or 4 quadrant) makes the TLC7524 an ideal choice for many microprocessor-controlled gain-setting and signal-control applications.

The TLC7524I is characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TLC7524C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## TLC7524

Advanced LinCMOS ${ }^{\text {T" }}$ 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

## functional block diagram


operating sequence

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VDD
-0.3 V to 16.5 V
Digital input voltage, $\mathrm{V}_{\mathrm{I}}$. ................................................ . . . 0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Reference voltage, $\mathrm{V}_{\text {ref }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 25 \mathrm{~V}$
Peak digital input current, I. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 10 10 A
Operating free-air temperature range: TLC75241 . . . . . . . . . . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC7524C . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: D or N package $\ldots . . . . .260^{\circ} \mathrm{C}$
recommended operating conditions

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{ref}}= \pm 10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | $V_{\text {DD }}=5 \mathrm{~V}$ |  |  | $V_{D D}=15 \mathrm{~V}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| ${ }^{11} \mathrm{H}$ | High-level input current |  |  | $V_{1}=V_{D D}$ |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ |
| ILL | Low-level input cur ent |  | $V_{1}=0$ |  |  | -10 |  |  | -10 | $\mu \mathrm{A}$ |
| IIkg | Output leakage current | OUT1 | DBO-DB7 at 0 V , $\overline{\mathrm{WR}}, \overline{\mathrm{CS}}$ at 0 V , $V_{\mathrm{ref}}= \pm 10 \mathrm{~V}$ |  |  | $\pm 400$ |  |  | $\pm 200$ | nA |
|  |  | OUT2 | DBO-DB7 at $\mathrm{V}_{\mathrm{DD}}, \overline{\mathrm{WR}}, \overline{\mathrm{CS}}$ at 0 V , $V_{\text {ref }}= \pm 10 \mathrm{~V}$ |  |  | $\pm 400$ |  |  | $\pm 200$ |  |
| 'DD | Supply current | Quiescent | DB0-DB7 at $\mathrm{V}_{\text {IH }}$ min or $\mathrm{V}_{\text {IL }}$ max |  |  | 1 |  |  | 2 | mA |
|  |  | Standby | DBO-DB7 at 0 V or ${ }^{\text {V }}$ DD |  |  | 500 |  |  | 500 | $\mu \mathrm{A}$ |
| kSVS | Supply voltage sensitivity, $\Delta$ gain/ $\Delta V_{D D}$ |  | $\Delta V_{\text {DD }}= \pm 10 \%$ |  | 0.01 | 0.16 |  | 0.005 | 0.04 | \%FSR/\% |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance, DBO-DB7, $\overline{\mathrm{WR}}, \overline{\mathrm{CS}}$ |  | $v_{1}=0$ |  |  | 5 |  |  | 5 | pF |
| C | Output capacitance | OUT1 | DB0-DB7 at 0 V , |  |  | 30 |  |  | 30 | pF |
|  |  | OUT2 | $\overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V |  |  | 120 |  |  | 120 |  |
| Co | Output capacitance | OUT1 | DBO-DB7 at $\mathrm{V}_{\text {DD }}$. |  |  | 120 |  |  | 120 | pF |
|  |  | OUT2 | $\overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at $\mathrm{O} V$ |  |  | 30 |  |  | 30 |  |
|  | Reference input impedance (Pin 15 to GND) |  |  | 5 |  | 20 | 5 |  | 20 | k $\Omega$ |

## operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}= \pm 10 \mathrm{~V}$, OUT1 and OUT2 at GND (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\text {DD }}=15 \mathrm{~V}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| Linearity error |  |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
| Gain error | See Note 1 |  |  | $\pm 2.5$ |  |  | $\pm 2.5$ | LSB |
| Settling time (to $1 / 2 \mathrm{LSB}$ ) | See Note 2 |  |  | 100 |  |  | 100 | ns |
| Propagation delay from digital input to $90 \%$ of final analog output current | See Note 2 |  |  | 80 |  |  | 80 | ns |
| Feedthrough at OUT1 or OUT2 | $V_{\text {ref }}= \pm 10 \mathrm{~V}$ (100-kHz sinewave) <br> $\overline{W R}$ and $\overline{C S}$ at 0 V , DBO-DB7 at 0 V |  |  | 0.5 |  |  | 0.5 | \%FSR |
| Temperature coefficient of gain | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ to MAX | $\pm 0.004$ |  |  | $\pm 0.001$ |  |  | \%FSR/ $/{ }^{\circ} \mathrm{C}$ |

NOTES: 1. Gain error is measured using the internal feedback resistor. Nominal Full Scale Range (FSR) $=\mathrm{V}_{\text {ref }}-1$ LSB.
2. OUT1 load $=100 \Omega, C_{e x t}=13 \mathrm{pF}, \overline{\mathrm{WR}}$ at $0 \mathrm{~V}, \overline{\mathrm{CS}}$ at $0 \mathrm{~V}, \mathrm{DBO}-\mathrm{DB} 7$ at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .

## principles of operation

The TLC7524 is an 8-bit multiplying D/A converter consisting of an inverted R-2R ladder, analog switches, and data input latches. Binary weighted currents are switched between the OUT1 and OUT2 bus lines, thus maintaining a constant current in each ladder leg independent of the switch state. The high-order bits are decoded and these decoded bits, through a modification in the R-2R ladder, control three equally weighted current sources. Most applications only require the addition of an external operational amplifier and a voltage reference.
The equivalent circuit for all digital inputs low is seen in Figure 1. With all digital inputs low, the entire reference current, Iref, is switched to OUT2. The current source $1 / 256$ represents the constant current flowing through the termination resistor of the R-2R ladder, while the current source $\mathrm{I}_{\mathrm{kg}}$ represents leakage currents to the substrate. The capacitances appearing at OUT1 and OUT2 are dependent upon the digital input code. With all digital inputs high, the off-state switch capacitance ( 30 pF maximum) appears at OUT2 and the on-state switch capacitance ( 120 pF maximum) appears at OUT1. With all digital inputs low, the situation is reversed as shown in Figure 1. Analysis of the circuit for all digital inputs high is similar to Figure 1; however, in this case, Iref would be switched to OUT1.

Interfacing the TLC7524 D/A converter to a microprocessor is accomplished via the data bus and the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ control signals. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ are both low, the TLC7524 analog output responds to the data activity on the DBO-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the $\overline{\mathrm{CS}}$ signal or $\overline{\mathrm{WR}}$ signal goes high, the data on the DBO-DB7 inputs are latched until the $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled regardless of the state of the $\overline{W R}$ signal.

The TLC7524 is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2 -quadrant or 4 -quadrant multiplication are shown in Figures 2 and 3. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.
principles of operation (continued)


FIGURE 2. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)


FIGURE 3. BIPOLAR OPERATION (4-QUADRANT OPERATION)
NOTES: 3. $R_{A}$ and $R_{B}$ used only if gain adjustment is required.
4. C phase compensation ( $10-15 \mathrm{pF}$ ) is required when using high-speed amplifiers to prevent ringing or oscillation.

TLC7524
Advanced LinCMOS ${ }^{\text {TM }}$ 8-BIT MULTIPLYING
DIGITAL-TO-ANALOG CONVERTER

## principles of operation (continued)

TABLE 1. UNIPOLAR BINARY CODE

| DIGITAL INPUT <br> ISEE NOTE 5) | ANALOG OUTPUT |
| :--- | :--- |
| MSB LSB |  |
| 11111111 | $-V_{\text {ref }}(255 / 256)$ |
| 10000001 | $-V_{\text {ref }}(129 / 256)$ |
| 10000000 | $-V_{\text {ref }}(128 / 256)=-\mathrm{V}_{\text {ref }} / 2$ |
| 01111111 | $-\mathrm{V}_{\text {ref }}(127 / 256)$ |
| 00000001 | $-\mathrm{V}_{\text {ref }}(1 / 256)$ |
| 00000000 | 0 |

TABLE 2. BIPOLAR (OFFSET BINARY) CODE

| DIGITAL INPUT <br> (SEE NOTE 6) | ANALOG OUTPUT |
| :--- | :--- |
| MSB LSB |  |
| 11111111 | $V_{\text {ref }}(127 / 128)$ |
| 10000001 | $V_{\text {ref }}(1 / 128)$ |
| 10000000 | 0 |
| 01111111 | $-V_{\text {ref }}(1 / 128)$ |
| 00000001 | $-V_{\text {ref }}(127 / 128)$ |
| 00000000 | $-V_{\text {ref }}$ |

NOTES: 5. LSB $=1 / 256\left(V_{\text {ref }}\right)$.
6. $L S B=1 / 128\left(V_{\text {ref }}\right)$.
microprocessor interfaces


FIGURE 4. TLC7524-Z-80A INTERFACE


FIGURE 5. TLC7524-6800 INTERFACE
microprocessor interfaces (continued)


FIGURE 6. TLC7524-8051 INTERFACE

## TLC7524 <br> Advanced LinCMOS ${ }^{\text {TM }}$ 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

## TYPICAL APPLICATION DATA

## voltage-mode operation

It is possible to operate the TLC7524 current multiplying D/A converter in a voltage mode. In the voltage mode, a fixed voltage is placed on the current output pin. The analog output voltage is then available at the reference voltage pin. Figure 7 is an example of a current multiplying $D / A$, which is operated in voltage mode.


REF (ANALOG OUTPUT VOLTAGE)



FIGURE 7. VOLTAGE MODE OPERATION
The relationship between the fixed input voltage and the analog output voltage is given by the following equation:
$V_{O}=V_{1}(D / 256)$
where
$\mathrm{V}_{\mathrm{O}}=$ analog output voltage
$V_{1}=$ fixed input voltage
$D=$ digital input code converted to decimal
In voltage-mode operation, the TLC7524 will meet the following specification:

| PARAMETER | TEST CONDITIONS | MIN | MAX |
| :---: | :---: | :---: | :---: |
| UNIT |  |  |  |
| Linearity error at REF | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$, OUT $1=2.5 \mathrm{~V}$, OUT2 at $\mathrm{GND}, \mathrm{T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | 1 | LSB |

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- Easily Interfaced to Microprocessors
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- Designed to be Interchangeable with Analag Devices AD7528 and PMI PM-7528
- Fast Control Signaling for Digital Signal Processor Applications Including Interface with TMS320
- Voltage-Mode Operation

| KEY PERFORMANCE SPECIFICATIONS |  |
| :--- | :---: |
| Resolution | 8 bits |
| Linearity Error | $1 / 2 \mathrm{LSB}$ |
| Power Dissipation at $V_{D D}=5 \mathrm{~V}$ | 5 mW |
| Settling Time at $V_{D D}=5 \mathrm{~V}$ | 100 ns |
| Propagation Delay at $V_{D D}=5 \mathrm{~V}$ | 80 ns |

## description

The TLC7528 is a dual 8 -bit digital-to-analog converter designed with separate on-chip data latches and featuring excellent DAC-to-DAC matching. Data is transferred to either of the two DAC data latches via a common 8-bit input port. Control input $\overline{\mathrm{DACA}} / \mathrm{DACB}$ determines which DAC is to be loaded. The "load" cycle of the TLC7528 is similar to the "write" cycle of a random-access memory, allowing easy interface to most popular microprocessor busses and output ports. Segmenting the high-order bits minimizes glitches during changes in the most significant bits, where glitch impulse is typically the strongest.
The TLC7528 operates from a 5-V to 15-V power supply and dissipates less than 15 mW (typical). Excellent 2- or 4-quadrant multiplying makes the TLC7528 a sound choice for many microprocessor-controlled gainsetting and signal-control applications. It can be operated in voltage mode, which produces a voltage output rather than a current output. Refer to the typical application data in this data sheet.
The TLC75281 is characterized for operation from -25 to $85^{\circ} \mathrm{C}$. The TLC7528C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

TLC7528
Advanced LinCMOS ${ }^{\text {Tw }}$ DUAL 8-BIT MULTIPLYING dIGITAL-TO-ANALOG CONVERTER
functional block diagram

operating sequence


## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ (to AGND or DGND) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 16.5 V Voltage between AGND and DGND........................................................ $\pm V_{D D}$ Input voltage, $\mathrm{V}_{\mathrm{I}}$ (to $\operatorname{DGND}$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3$ Reference voltage, $\mathrm{V}_{\text {refA }}$ or $\mathrm{V}_{\text {refB }}$ (to $A G N D$ ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 25 \mathrm{~V}$ Feedback voltage VRFBA or $V_{\text {RFBB }}$ (to AGND) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 25 \mathrm{~V}$
Output voltage, $\mathrm{V}_{\mathrm{OA}}$ or $\mathrm{V}_{\mathrm{OB}}$ (to AGND) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 25 \mathrm{~V}$
Peak input current . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 10 10 A
Operating free-air temperature range: TLC75281 ............................... . $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC7528C $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package........................................... . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: DW or N package . . . . . . $260^{\circ} \mathrm{C}$
recommended operating conditions


TLC7528
Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=\mathrm{V}_{\text {refB }}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{OA}}$ and VOB at 0 V (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS | $V_{D D}=5 \mathrm{~V}$ |  |  | $V_{D D}=15 \mathrm{~V}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP ${ }^{\text {t }}$ | MAX | MIN | TYP ${ }^{\dagger}$ | MAX |  |
| IIH | High-level input current |  |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{DD}}$ |  |  | 10 |  |  | 10 | $\mu \mathrm{A}$ |
| ILL | Low-level input current |  | $\mathrm{V}_{1}=0 \mathrm{~V}$ |  |  | -10 |  |  | -10 | $\mu \mathrm{A}$ |
|  | Reference input impedance (Pin 15 to GND) |  |  | 5 | 12 | 20 | 5 | 12 | 20 | $\mathrm{k} \Omega$ |
| $1 / \mathrm{kg}$ | Output leakage current | OUTA | DACA data latch loaded with 00000000, $V_{\text {refA }}= \pm 10 \mathrm{~V}$ |  |  | $\pm 400$ |  |  | $\pm 200$ | $n A$ |
|  |  | OUTB | DACB data latch loaded with 00000000, $V_{\text {refB }}= \pm 10 \mathrm{~V}$ |  |  | $\pm 400$ |  |  | $\pm 200$ |  |
|  | Input resistance match (REFA to REFB) |  |  |  |  | $\pm 1 \%$ |  |  | $\pm 1 \%$ |  |
|  | DC supply sensitivity, $\Delta$ gain/ $\Delta V_{D D}$ |  | $\Delta V_{D D}= \pm 10 \%$ |  |  | 0.04 |  |  | 0.02 | \%/\% |
| IDD | Supply current (quiescent) |  | DBO-DB7 at $\mathrm{V}_{\text {IH }}$ min or $V_{\text {IL }}$ max |  |  | 1 |  |  | 1 | mA |
| IDD | Supply current (standby) |  | DBO-DB7 at 0 V or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 0.5 |  |  | 0.5 | mA |
| $\mathrm{C}_{i}$ | Input capacitance | DB0-DB7 |  |  |  | 10 |  |  | 10 | pF |
|  |  | $\begin{aligned} & \overline{\mathrm{WR}, \overline{\mathrm{CS}}} \\ & \overline{\mathrm{DACA}} / \mathrm{DACB} \end{aligned}$ |  |  |  | 15 |  |  | 15 |  |
| $\mathrm{C}_{0}$ | Output capacitance, (OUTA, OUTB) |  | DAC data latches loaded with 00000000 |  |  | 50 |  |  | 50 | pF |
|  |  |  | DAC data latches loaded with 11111111 |  |  | 120 |  |  | 120 |  |

[^16]operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\text {ref }}=\mathrm{V}_{\text {ref }}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{OA}}$ and $\mathrm{V}_{\mathrm{OB}}$ at 0 V (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | $V_{D D}=5 \mathrm{~V}$ |  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Linearity error |  |  |  |  |  | $\pm 1 / 2$ |  |  | $\pm 1 / 2$ | LSB |
| Settling time (to | 2 LSB) | See Note 1 |  |  | 100 |  |  | 100 | ns |
| Gain error |  | See Note 2 |  |  | 2.5 |  |  | 2.5 | LSB |
| AC feedthrough | REFA to OUTA | See Note 3 |  |  | -65 |  |  | -65 | dB |
|  | REFB to OUTB |  |  |  | -65 |  |  | -65 |  |
| Temperature coefficient of gain |  | See Note 4 |  |  | 0.007 |  |  | 0035 | \%FSR $/{ }^{\circ} \mathrm{C}$ |
| Propagation delay (from digital input to $90 \%$ of final analog output current) |  | See Note 5 |  |  | 80 |  |  | 80 | ns |
| Channel-tochannel isolation | REFA to OUTB | See Note 6 | 77 |  |  | 77 |  |  | dB |
|  | REFB to OUTA | See Note 7 | 77 |  |  | 77 |  |  |  |
| Digital-to-analog glitch impulse area |  | Measured for code transition from 00000000 to 11111111 , $T_{A}=25^{\circ} \mathrm{C}$ | 160 |  |  | 440 |  |  | $n \mathrm{Vs}$ |
| Digital crosstalk glitch impulse area |  | Measured for code transition from 00000000 to 11111111 , $T_{A}=25^{\circ} \mathrm{C}$ | 30 |  |  | 60 |  |  | $n \mathrm{~V}$ |
| Harmonic distortion |  | $\begin{aligned} & V_{i}=6 \mathrm{Vrms}, \quad \mathrm{f}=1 \mathrm{kHz} \\ & \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C} \end{aligned}$ | -85 |  |  | -85 |  |  | dB |

NOTES: 1. OUTA, OUTB load $=100 \Omega, C_{e x t}=13 \mathrm{pF} ; \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V ; DBO-DB7 at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .
2. Gain error is measured using an internal feedback resistor. Nominal Full Scale Range (FSR) $=V_{\text {ref }}-1$ LSB.
3. $\mathrm{V}_{\text {ref }}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; DAC data latches loaded with 00000000 .
4. Temperature coefficient of gain measured from $0^{\circ} \mathrm{C}$ to $25^{\circ} \mathrm{C}$ or from $25^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
5. $V_{\text {ref }}=V_{\text {refB }}=10 \mathrm{~V}$; OUTA/OUTB load $=100 \Omega, C_{\text {ext }}=13 \mathrm{pF} ; \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V ; DBO-DB7 at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\text {DD }}$ to 0 V .
6. Both DAC latches loaded with $11111111 ; V_{\text {ref } A}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; $V_{\text {refB }}=0 ; \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
7. Both DAC latches loaded with $11111111 ; V_{\text {refB }}=20 \mathrm{~V}$ peak-to-peak, $100-\mathrm{kHz}$ sine wave; $V_{\text {ref }} A=0 ; T_{A}=25^{\circ} \mathrm{C}$.

## principles of operation

The TLC7528 contains two identical 8-bit multiplying D/A converters, DACA and DACB. Each DAC consists of an inverted R-2R ladder, analog switches, and input data latches. Binary-weighted currents are switched between DAC output and AGND, thus maintaining a constant current in each ladder leg independent of the switch state. Most applications require only the addition of an external operational amplifier and voltage reference. A simplified D/A circuit for DACA with all digital inputs low is shown in Figure 1.
Figure 2 shows the DACA equivalent circuit. A similar equivalent circuit can be drawn for DACB. Both DACs share the analog ground pin 1 (AGND). With all digital inputs high, the entire reference current flows to OUTA. A small leakage current (l/kg) flows across internal junctions, and as with most semiconductor devices, doubles every $10^{\circ} \mathrm{C} . \mathrm{C}_{\mathrm{O}}$ is due to the parallel combination of the NMOS switches and has a value that depends on the number of switches connected to the output. The range of $\mathrm{C}_{\mathrm{O}}$ is 50 pF to 120 pF maximum. The equivalent output resistance $r_{0}$ varies with the input code from $0.8 R$ to $3 R$ where $R$ is the nominal value of the ladder resistor in the R-2R network.

Interfacing the TLC7528 to a microprocessor is accomplished via the data bus, $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}$, and $\overline{\mathrm{DACA}} / \mathrm{DACB}$ control signals. When $\overline{C S}$ and $\overline{W R}$ are both low, the TLC7528 analog output, specified by the $\overline{\mathrm{DACA}} / \mathrm{DACB}$ control line, responds to the activity on the DBO-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the $\overline{C S}$ signal or $\overline{W R}$ signal goes high, the data on the DBO-DB7 inputs is latched until the $\overline{\mathrm{CS}}$ and $\overline{W R}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled regardless of the state of the $\overline{\mathrm{WR}}$ signal.
The digital inputs of the TLC7528 provide TTL compatibility when operated from a supply voltage of 5 V . The TLC7528 may be operated with any supply voltage in the range from 5 V to 15 V , however, input logic levels are not TTL compatible above 5 V .

TLC7528
Advanced LinCMOS ${ }^{\text {T" }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER


FIGURE 1. SIMPLIFIED FUNCTIONAL CIRCUIT FOR DACA


FIGURE 2. TLC7528 EQUIVALENT CIRCUIT, DACA LATCH LOADED WITH 11111111.
mOde selection table

| DACA <br> DACB | $\overline{\text { CS }}$ | WR | DACA | DACB |
| :---: | :---: | :---: | :---: | :---: |
| L | L | L | WRITE | HOLD |
| H | L. | L | HOLD | WRITE |
| X | H | X | HOLD | HOLD |
| X | X | H | HOLD | HOLD |

$L=$ low level, $H=$ high level, $X=$ don't care

## TYPICAL APPLICATION DATA

The TLC7528 is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2 -quadrant and 4 -quadrant multiplication are shown in Figures 3 and 4. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.


NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Make gain adjustment with digital input of 255 .
2. C 1 and C 2 phase compensation capacitors ( 10 pF to 15 pF ) are required when using high-speed amplifiers to prevent ringing or oscillation.

FIGURE 3. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)

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TYPICAL APPLICATION DATA


NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table in Figure 3 for recommended values. Adjust R1 for $\mathrm{V}_{\mathrm{OA}}=0 \mathrm{~V}$ with code 10000000 in DACA latch. Adjust R 3 for $\mathrm{V}_{\mathrm{OB}}=0 \mathrm{~V}$ with 10000000 in DACB latch.
2. Matching and tracking are essential for resistor pairs R6, R7, R9, and R10.
3. C1 and C2 phase compensation capacitors ( 10 pF to 15 pF ) may be required if A 1 and A 3 are high-speed amplifiers.

FIGURE 4. BIPOLAR OPERATION (4-QUADRANT OPERATION)

TABLE 1. UNIPOLAR BINARY CODE

| DAC LATCH CONTENTS <br> MSB LSB $^{\dagger}$ | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $-V_{i}(255 / 256)$ |
| 10000001 | $-V_{i}(129 / 256)$ |
| 10000000 | $-V_{i}(128 / 256)=-V_{i} / 2$ |
| 01111111 | $-V_{i}(127 / 256)$ |
| 00000001 | $-V_{i}(1 / 256)$ |
| 00000000 | $-V_{i}(0 / 256)=0$ |

${ }^{\dagger} 1 \mathrm{LSB}=(2-8) \mathrm{V}_{\mathrm{i}}$

TABLE 2. BIPOLAR (OFFSET BINARY) CODE

| DAC LATCH CONTENTS <br> MSB LSB $^{\ddagger}$ | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $\mathrm{~V}_{\mathrm{i}}(127 / 128)$ |
| 10000001 | $\mathrm{~V}_{\mathrm{i}}(1 / 128)$ |
| 10000000 | 0 V |
| 01111111 | $-\mathrm{V}_{\mathrm{i}}(1 / 128)$ |
| 00000001 | $-\mathrm{V}_{\mathrm{i}}(127 / 128)$ |
| 00000000 | $-\mathrm{V}_{\mathrm{i}}(128 / 128)$ |

$\ddagger 1 \mathrm{~L} . \mathrm{SB}=\left(2^{-7}\right) \mathrm{V}_{\mathrm{i}}$

TYPICAL APPLICATION DATA
microprocessor interface information


NOTE: $\quad A=$ decoded address for TLC7528 DACA
$A+1=$ decoded address for TLC7528 DACB.
FIGURE 5. TLC7528 - INTEL 8051 INTERFACE


NOTE: $\quad A=$ decoded addiess for TLC7528 DACA.
$A+1=$ decoded address for TLC7528 DACB.
FIGURE 6. TLC7528-6800 INTERFACE

## Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING

 DIGITAL-TO-ANALOG CONVERTERTYPICAL APPLICATION DATA


NOTE: $\quad A=$ decoded address for TLC7528 DACA.
$A+1=$ decoded address for TLC7528 DACB.
FIGURE 7. TLC7528 TO Z80-A INTERFACE
programmable window detector
The programmable window comparator shown in Figure 8 will determine if voltage applied to the DAC feedback resistors are within the limits programmed into the TLC7528 data latches. Input signal range depends on the reference and polarity, that is, the test input range is 0 to $-V_{\text {ref. }}$. The DACA and DACB data latches are programmed with the upper and lower test limits. A signal within the programmed limits will drive the output high.


FIGURE 8. DIGITALLY PROGRAMMABLE WINDOW COMPARATOR (UPPER- AND LOWER-LIMIT TESTER)

## TYPICAL APPLICATION DATA

## digitally controlled signal attenuator

Figure 9 shows the TLC7528 configured as a two-channel programmable attenuator. Applications include stereo audio and telephone signal level control. Table 3 shows input codes vs attenuation for a 0 to 15.5 dB range.

Attentuation $d b-20 \log _{10} \mathrm{D} / 256, \mathrm{D}=$ digital input code


FIGURE 9. DIGITALLY CONTROLLED DUAL TELEPHONE ATTENUATOR
TABLE 3. ATTENUATION vs DACA, DACB CODE

| ATTN(dB) | DAC INPUT CODE | CODE IN <br> DECIMAL | ATTN(dB) | DAC INPUT CODE | CODE IN <br> DECIMAL |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 11111111 | 255 | 8.0 | 01100110 | 102 |
| 0.5 | 11110010 | 242 | 8.5 | 01100000 | 96 |
| 1.0 | 11100100 | 228 | 9.0 | 01011011 | 91 |
| 1.5 | 11010111 | 215 | 9.5 | 01010110 | 86 |
| 2.0 | 11001011 | 203 | 10.0 | 01010001 | 81 |
| 2.5 | 11000000 | 192 | 10.5 | 01001100 | 76 |
| 3.0 | 10110101 | 181 | 11.0 | 01001000 | 72 |
| 3.5 | 10101011 | 171 | 11.5 | 01000100 | 68 |
| 4.0 | 10100010 | 162 | 12.0 | 01000000 | 64 |
| 4.5 | 10011000 | 152 | 12.5 | 00111101 | 61 |
| 5.0 | 10010000 | 144 | 13.0 | 00111001 | 57 |
| 5.5 | 10001000 | 136 | 13.5 | 00110110 | 54 |
| 6.0 | 10000000 | 128 | 14.0 | 00110011 | 51 |
| 6.5 | 01111001 | 121 | 14.5 | 00110000 | 48 |
| 7.0 | 01110010 | 114 | 15.0 | 00101110 | 46 |
| 7.5 | 01101100 | 108 | 15.5 | 00101011 | 43 |

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## TYPICAL APPLICATION DATA

## programmable state-variable filter

This programmable state-variable or universal filter configuration provides low-pass, high-pass, and bandpass outputs, and is suitable for applications in which microprocessor control of filter parameters is required.

As shown in Figure 10, DACA1 and DACB1 control the gain and $Q$ of the filter while DACA2 and DACB2 control the cutoff frequency. Both halves of the DACA2 and DACB2 must track accurately in order for the cutoff-frequency equation to be true. With the TLC7528, this is easily achieved.

The programmable range for the cutoff or center frequency is 0 to 15 kHz with a Q ranging from 0.3 to 4.5. This defines the limits of the component values.


$$
\mathrm{Q}=\frac{\mathrm{R}_{3}}{\mathrm{R}_{4}} \cdot \frac{\mathrm{R}_{\mathrm{F}}}{R_{\mathrm{fb}(D A C B 1)}}
$$

NOTES: A. Op-amps A1, A2, A3, and A4 are TL287.

$$
C_{1}=C_{2}, R_{1}=R_{2}, R_{4}=R_{5}
$$

$$
A_{o}=-\frac{R_{F}}{R_{S}}
$$

B. C3 compensates for the op-amp gain-bandwidth limitations.
C. DAC equivalent resistance equals $\frac{256 \times \text { (DAC ladder resistance) }}{\text { DAC digital code }}$

FIGURE 10. DIGITALLY CONTROLLED STATE-VARIABLE FILTER

## TYPICAL APPLICATION DATA

## voltage-mode operation

It is possible to operate the TLC7528 current multiplying D/A converter in a voltage mode. In the voltage mode, a fixed voltage is placed on the current output pin. The analog output voltage is then available at the reference voltage pin. Figure 11 is an example of a current multiplying $D / A$, which is operated in voltage mode.


FIGURE 11. VOLTAGE-MODE OPERATION
The relationship between the fixed input voltage and the analog output voltage is given by the following equation:

$$
V_{O}=V_{I}(D / 256)
$$

where
$\mathrm{V}_{\mathrm{O}}=$ analog output voltage
$V_{1}=$ fixed input voltage
$\mathrm{D}=$ digital input code converted to decimal
In voltage-mode operation, the TLC7528 will meet the following specification:

| PARAMETER | TEST CONDITIONS | MIN | MAX |
| :---: | :---: | :---: | :---: |
| UNIT |  |  |  |
| Linearity error at REFA or REFB | $V_{D D}=5 \mathrm{~V}$, OUTA or OUTB at $2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |  | 1 |

- Advanced LinCMOS ${ }^{\text {™ }}$ Silicon-Gate Process Technology
- 14-Bit Dynamic Range ADC and DAC
- Variable ADC and DAC Sampling Rate Up to 19,200 Samples per Second
- Switched-Capacitor Antialiasing Input Filter and Output-Reconstruction Filter
- Serial Port for Direct Interface to TMS32011, TMS320C17, TMS32020, and TMS320C25 Digital Processors
- Synchronous or Asynchronous ADC and DAC Conversion Rates with Programmable Incremental ADC and DAC Conversion Timing Adjustments
- Serial Port Interface to SN74299 Serial-toParallel Shift Register for Parallel Interface to TMS32010, TMS320C15, or Other Digital Processors

| PART <br> NUMBER | DESCRIPTION |
| :---: | :--- |
| TLC32040 | Analog Interface Circuit with internal <br> reference. Also a plug-in replacement <br> for TLC32041. <br> TLC32041 <br> Analog Interface Circuit without internal <br> reference. <br> Identical to TLC32040, but has a <br> slightly wider bandpass filter bandwidth |

## description

The TLC32040, TLC32041, and TLC32042 are complete analog-to-digital and digital-to-analog input/output systems, each on a single monolithic CMOS chip. This device integrates a bandpass switched-capacitor antialiasing input filter, a 14-bit-resolution A/D converter, four microprocessor-compatible serial port modes, a 14-bit-resolution D/A converter, and a low-pass switched-capacitor output-reconstruction filter. The device offers numerous combinations of Master Clock input frequencies and conversion/sampling rates, which can be changed via digital processor control.
Typical applications for this IC include modems (7.2-, 8-, 9.6-, 14.4-, and 19.2-kHz sampling rate), analog interface for digital signal processors (DSPs), speech recognition/storage systems, industrial process control, biomedical instrumentation, acoustical signal processing, spectral analysis, data acquisition, and instrumentation recorders. Four serial modes, which allow direct interface to the TMS32011, TMS320C17, TMS32020, and TMS320C25 digital signal processors, are provided. Also, when the transmit and receive sections of the Analog Interface Circuit (AIC) are operating synchronously, it will interface to two SN74299

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## description (continued)

serial-to-parallel shift registers. These serial-to-parallel shift registers can then interface in parallel to the TMS32010, TMS320C15, other digital signal processors, or external FIFO circuitry. Output data pulses are emitted to inform the processor that data transmission is complete or to allow the DSP to differentiate between two transmitted bytes. A flexible control scheme is provided so that the functions of the IC can be selected and adjusted coincidentally with signal processing via software control.

The antialiasing input filter comprises seventh-order and fourth-order CC-type (Chebyshev/elliptic transitional) low-pass and high-pass filters, respectively, and a fourth-order equalizer. The input filter is implemented in switched-capacitor technology and is preceded by a continuous time filter to eliminate any possibility of aliasing caused by sampled data filtering. When no filtering is desired, the entire composite filter can be switched out of the signal path. A selectable, auxiliary, differential analog input is provided for applications where more than one analog input is required.

The $A / D$ and $D / A$ converters each have 14 bits of resolution. The $A / D$ and $D / A$ architectures ensure no missing codes and monotonic operation. An internal voltage reference is provided on the TLC32040 and TLC32042 to ease the design task and to provide complete control over the performance of the IC. The internal voltage reference is brought out to a pin and is available to the designer. Separate analog and digital voltage supplies and grounds are provided to minimize noise and ensure a wide dynamic range. Also, the analog circuit path contains only differential circuitry to keep noise to an absolute minimum. The only exception is the DAC sample-and-hold, which utilizes pseudo-differential circuitry.

The output-reconstruction filter is a seventh-order CC-type (Chebyshev/elliptic transitional low-pass filter with a fourth-order equalizer) and is implemented in switched-capacitor technology. This filter is followed by a continuous-time filter to eliminate images of the digitally encoded signal.

The TLC32040I, TLC32041I, and TLC32O42I are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TLC32040C, TLC32041C, and TLC32042C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
functional block diagram


## PRINCIPLES OF OPERATION

## analog input

Two sets of analog inputs are provided. Normally, the $\mathbb{I N}+$ and $\mathbb{N}$ - input set is used; however, the auxiliary input set, $A \cup X I N+$ and $A \cup X I N-$, can be used if a second input is required. Each input set can be operated in either differential or single-ended modes, since sufficient common-mode range and rejection are provided. The gain for the $I N+, I N-, A \cup X I N+$, and $A U X I N$ - inputs can be programmed to be either 1,2 , or 4 (see Table 2). Either input circuit can be selected via software control. It is important to note that a wide dynamic range is assured by the differential internal analog architecture and by the separate analog and digital voltage supplies and grounds.

## A/D bandpass filter, A/D bandpass filter clocking, and A/D conversion timing

The A/D bandpass filter can be selected or bypassed via software control. The frequency response of this filter is presented in the following pages. This response results when the switched-capacitor filter clock frequency is 288 kHz . Several possible options can be used to attain a $288-\mathrm{kHz}$ switched-capacitor filter clock. When the filter clock frequency is not 288 kHz , the filter transfer function is frequency-scaled by the ratio of the actual clock frequency to 288 kHz . The low-frequency roll-off of the high-pass section is 300 Hz . However, the high-pass section low-frequency roll-off is less steep for the TLC32042 than for the TLC32040 and TLC32041.

The Internal Timing Configuration and AIC DX Data Word Format sections of this data sheet indicate the many options for attaining a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock. These sections indicate that the RX Counter A can be programmed to give a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock for several Master Clock input frequencies.

The A/D conversion rate is then attained by frequency-dividing the $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock with the $R X$ Counter $B$. Thus, unwanted aliasing is prevented because the $A / D$ conversion rate is an integral submultiple of the bandpass switched-capacitor filter sampling rate, and the two rates are synchronously locked.

## A/D converter performance specifications

Fundamental performance specifications for the $A / D$ converter circuitry are presented in the $A / D$ converter operating characteristics section of this data sheet. The realization of the A/D converter circuitry with switched-capacitor techniques provides an inherent sample-and-hold.

## analog output

The analog output circuitry is an analog output power amplifier. Both noninverting and inverting amplifier outputs are brought out of the IC. This amplifier can drive transformer hybrids or low-impedance loads directly in either a differential or single-ended configuration.

## D/A low-pass filter, D/A low-pass filter clocking, and D/A conversion timing

The frequency response of this filter is presented in the following pages. This response results when the low-pass switched-capacitor filter clock frequency is 288 kHz . Like the $A / D$ filter, the transfer function of this filter is frequency-scaled when the clock frequency is not 288 kHz . A continuous-time filter is provided on the output of the D/A low-pass filter to greatly attenuate any switched-capacitor clock feedthrough.
The D/A conversion rate is then attained by frequency-dividing the $288-\mathrm{kHz}$ switched-capacitor filter clock with TX Counter B. Thus, unwanted aliasing is prevented because the D/A conversion rate is an integral submultiple of the switched-capacitor low-pass filter sampling rate, and the two rates are synchronously locked.

## PRINCIPLES OF OPERATION (continued)

## asynchronous versus synchronous operation

If the transmit section of the AIC (low-pass filter and DAC) and receive section (bandpass filter and ADC) are operated asynchronously, the low-pass and band-pass filter clocks are independently generated from the Master Clock signal. Also, the D/A and A/D conversion rates are independently determined. If the transmit and receive sections are operated synchronously, the low-pass filter clock drives both low-pass and bandpass filters. In synchronous operation, the A/D conversion timing is derived from, and is equal to, the D/A conversion timing. (See description of the WORD/ $\overline{\mathrm{BYTE}}$ pin in the Pin Functional Description Section.)

## D/A converter performance specifications

Fundamental performance specifications for the D/A converter circuitry are presented in the D/A converter operating characteristics section of the data sheet. The D/A converter has a sample-and-hold that is realized with a switched-capacitor ladder.

## system frequency response correction

$\operatorname{Sin} \mathrm{x} / \mathrm{x}$ correction circuitry is performed in digital signal processor software. The system frequency response can be corrected via DSP software to $\pm 0.1 \mathrm{~dB}$ accuracy to a band-edge of 3000 Hz for all sampling rates. This correction is accomplished with a first-order digital correction filter, which requires only seven TMS320 instruction cycles. With a 200-ns instruction cycle, seven instructions represent an overhead factor of only $1.1 \%$ and $1.3 \%$ for sampling rates of 8 and 9.6 kHz , respectively (see the $\sin \mathrm{x} / \mathrm{x}$ Correction Section for more details).

## serial port

The serial port has four possible modes that are described in detail in the Functional Pin Description Section. These modes are briefly described below and in the Functional Description for Pin 13, WORD/BYTE.

1. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS32011 and TMS320C17.
2. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS32020 and the TMS320C25.
3. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS32011 and TMS320C17.
4. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS32020, TMS320C25, or two SN74299 serial-to-parallel shift registers, which can then interface in parallel to the TMS32010, TMS320C15, to any other digital signal processor, or to external FIFO circuitry.

## testing

An addendum accompanying this data sheet fully describes the test capabilities of the IC, provided by the design.

## operation of TLC32040 or TLC32042 with internal voltage reference

The internal reference of the TLC32040 and TLC32042 eliminates the need for an external voltage reference and provides overall circuit cost reduction. Thus, the internal reference eases the design task and provides complete control over the performance of the IC. The internal reference is brought out to a pin and is available to the designer. To keep the amount of noise on the reference signal to a minimum, an external capacitor may be connected between REF and ANLG GND.

## PRINCIPLES OF OPERATION (continued)

## operation of TLC32040, TLC32041, or TLC32042 with external voltage reference

The REF pin may be driven from an external reference circuit if so desired. This external circuit must be capable of supplying $250 \mu \mathrm{~A}$ and must be adequately protected from noise such as crosstalk from the analog input.

## reset

A reset function is provided to initiate serial communications between the AIC and DSP and to allow fast, cost-effective testing during manufacturing. The reset function will initialize all AIC registers, including the control register. After a negative-going pulse on the $\overline{\text { RESET pin, the AIC will be initialized. This }}$ initialization allows normal serial port communications activity to occur between AIC and DSP (see AIC DX Data Word Format section).

## loopback

This feature allows the user to test the circuit remotely. In loopback, the OUT + and OUT - pins are internally connected to the $I N+$ and $I N$ - pins. Thus, the DAC bits (d15 to d2), which are transmitted to the DX pin, can be compared with the ADC bits ( $\mathbf{d} 15$ to $d 2$ ), which are received from the DR pin. An ideal comparison would be that the bits on the DR pin equal the bits on the DX pin. However, in practice there will be some difference in these bits due to the ADC and DAC output offsets.
In loopback, if the $I N+$ and $I N$ - pins are enabled, the external signals on the $I N+$ and $I N$ - pins are ignored. If the AUX IN + and AUX IN - pins are enabled, the external signals on these pins are added to the OUT + and OUT - signals in loopback operation.

The loopback feature is implemented with digital signal processor control by transmitting the appropriate serial port bit to the control register (see AIC Data Word Format section).

| PIN <br> NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| ANLG GND | 17,18 |  | Analog ground return for all internal analog circuits. Not internally connected to DGTL GND. |
| AUX IN + | 24 | 1 | Noninverting auxiliary analog input stage. This input can be switched into the bandpass filter and A/D converter path via software control. If the appropriate bit in the Control register is a 1 , the auxiliary inputs will replace the $I N+$ and $I N$ - inputs. If the bit is a 0 , the $I N+$ and $I N$ - inputs will be used (see the AIC DX Data Word Format section). |
| AUX IN - | 23 | 1 | Inverting auxiliary analog input (see the above AUX IN + pin description). |
| DGTL GND | 9 |  | Digital ground for all internal logic circuits. Not internally connected to ANLG GND. |
| DR | 5 | 0 | This pin is used to transmit the ADC output bits from the AIC to the TMS320 serial port. This transmission of bits from the AIC to the TMS320 serial port is synchronized with the SHIFT CLK signal. |
| DX | 12 | 1 | This pin is used to receive the DAC input bits and timing and control information from the TMS320. This serial transmission from the TMS320 serial port to the AIC is synchronized with the SHIFT CLK signal. |
| $\overline{\text { EODR }}$ | 3 | 0 | (See the WORD/ BYTE pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of A/D information have been transmitted from the AIC to the TMS320 serial port. This signal can be used to interrupt a microprocessor upon completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or external FIFO RAM, and to facilitate parallel data bus communications between the AIC and the serial-to-parallel shift registers. During the byte-mode timing, this signal goes low after the first byte has been transmitted from the AIC to the TMS320 serial port and is kept low until the second byte has been transmitted. The TMS32011 or TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |

# TLC320401, TLC32040C, TLC320411, TLC32041C, <br> TLC320421, TLC32042C <br> ANALOG INTERFACE CIRCUITS 

| PIN <br> NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| $\overline{\text { EODX }}$ | 11 | 0 | (See the WORD/ $\overline{\text { BYTE }}$ pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of D/A converter and control or register information have been transmitted from the TMS320 serial port to the AIC. This signal can be used to interrupt a microprocessor upon the completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or an external FIFO RAM, and to facilitate parallel data-bus communications between the AIC and the serial-to-parallel shift registers. During the bytemode timing, this signal goes low after the first byte has been transmitted from the TMS320 serial port to the AIC and is kept low until the second byte has been transmitted. The TMS32011 or TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |
| $\overline{\text { FSR }}$ | 4 | 0 | In the serial transmission modes, which are described in the WORD/ $\overline{\text { BYTE }}$ pin description, the $\overline{\mathrm{FSR}}$ pin is held low during bit transmission. When the $\overline{F S R}$ pin goes low, the TMS320 serial port will begin receiving bits from the AIC via the DR pin of the AIC. The most significant DR bit will be present on the DR pin before $\overline{\mathrm{FSR}}$ goes low. (See Serial Port Timing and Internal Timing Configuration Diagrams.) |
| $\overline{\mathrm{FSX}}$ | 14 | 0 | When this pin goes low, the TMS320 serial port will begin transmitting bits to the AIC via the DX pin of the AIC. In all serial transmission modes, which are described in the WORD/ $\overline{B Y T E}$ pin description, the $\overline{\mathrm{FSX}}$ pin is held low during bit transmission (see Serial Port Timing and Internal Timing Configuration Diagrams). |
| IN + | 26 | 1 | Noninverting input to analog input amplifier stage |
| IN - | 25 | 1 | Inverting input to analog input amplifier stage |
| MSTR CLK | 6 | 1 | The Master Clock signal is used to derive all the key logic signals of the AIC, such as the Shift Clock, the switched-capacitor filter clocks, and the A/D and D/A timing signals. The Internal Timing Configuration diagram shows how these key signals are derived. The frequencies of these key signals are synchronous submultiples of the Master Clock frequency to eliminate unwanted aliasing when the sampled analog signals are transferred between the switched-capacitor filters and the A/D and D/A converters (see the Internal Timing Configuration). |
| OUT + | 22 | 0 | Noninverting output of analog output power amplifier. Can drive transformer hybrids or high-impedance loads directly in either a differential or a single-ended configuration. |
| OUT - | 21 | 0 | Inverting output of analog output power amplifier. Functionally identical with and complementary to OUT + . |
| REF | 8 | I/O | For the TLC32040 and TLC32042, the internal voltage reference is brought out on this pin. For the TLC32040, TLC32041, and TLC32042, an external voltage reference can be applied to this pin. |
| $\overline{\mathrm{RESET}}$ | 2 | 1 | A reset function is provided to initialize the TA, TA', TB, RA, RA', RB, and control registers. This reset function initiates serial communications between the AIC and DSP. The reset function will initialize all AIC registers including the control register. After a negative-going pulse on the $\overline{\operatorname{RESET}}$ pin, the AIC registers will be initialized to provide an $8-\mathrm{kHz}$ data conversion rate for a $5.184-\mathrm{MHz}$ master clock input signal. The conversion rate adjust registers, TA' and RA', will be reset to 1 . The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section). $d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1$ <br> This initialization allows normal serial-port communication to occur between AIC and DSP. |
| SHIFT CLK | 10 | 0 | The Shift Clock signal is obtained by dividing the Master Clock signal frequency by four. This signal is used to clock the serial data transfers of the AIC, described in the WORD/ $\overline{B Y T E}$ pin description below (see the Serial Port Timing and Internal Timing Configuration diagram). |
| $V_{\text {DD }}$ | 7 |  | Digital supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $V_{\text {CC }+}$ | 20 |  | Positive analog supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $\mathrm{V}_{\mathrm{CC}}$ - | 19 |  | Negative analog supply voltage -5V $\pm 5 \%$ |


| $$ | 1/0 | DESCRIPTION |
| :---: | :---: | :---: |
| WORD/ $\overline{\text { BYTE }} 13$ | 1 | This pin, in conjunction with a bit in the CONTROL register, is used to establish one of four serial modes. These four serial modes are described below. <br> AIC transmit and receive sections are operated asynchronous/y. <br> The following description applies when the AIC is configured to have asynchronous transmit and receive sections. If the appropriate data bit in the Control register is a 0 (see the AIC DX Data Word Format), the transmit and receive sections will be asynchronous. <br> L Serial port directly interfaces with the serial port of the TMS32011 or TMS320C17 and communicates in two 8-bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams). <br> 1. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought low. <br> 2. One 8-bit byte is transmitted or one 8-bit byte is received. <br> 3. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought low. <br> 4. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin emits a positive frame-sync pulse that is four Shift Clock cycles wide. <br> 5. One 8-bit byte is transmitted or one 8-bit byte is received. <br> 6. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought high. <br> 7. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin is brought high. <br> H Serial port directly interfaces with the serial port of the TMS32020, TMS320C25, or TMS320C30 and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams): <br> 1. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought low. <br> 2. One 16 -bit word is transmitted or one 16 -bit word is received. <br> 3. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought high. <br> 4. The $\overline{\overline{E O D X}}$ or $\overline{\mathrm{EODR}}$ pin emits a low-going pulse. <br> AIC transmit and receive sections are operated synchronously. <br> If the appropriate data bit in the Control register is a 1 , the transmit and receive sections will be configured to be synchronous. In this case, the bandpass switched-capacitor filter and the A/D conversion timing will be derived from the TX Counter A, TX Counter B, and TA, TA', and TB registers, rather than the RX Counter $A, R X$ Counter $B$, and RA, RA', and RB registers. In this case, the AIC $\overline{F S X}$ and $\overline{F S R}$ timing will be identical during primary data communication; however, $\overline{\mathrm{FSR}}$ will not be asserted during secondary data communication since there is no new A/D conversion result. The synchronous operation sequences are as follows (see Serial Port Timing diagrams). <br> L Serial port directly interfaces with the serial port of the TMS32011 or TMS320C17 and communicates in two 8-bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams): <br> 1. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought low. <br> 2. One 8-bit byte is transmitted and one 8 -bit byte is received. <br> 3. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought low. <br> 4. The $\overline{\mathrm{FSX}}$ and $\overline{\mathrm{FSR}}$ pins emit positive frame-sync pulses that are four Shift Clock cycles wide. <br> 5. One 8-bit byte is transmitted and one 8-bit byte is received. <br> 6. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought high. <br> 7. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high. <br> H Serial port directly interfaces with the serial port of the TMS32020, TMS320C25, or TMS320C30 and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams): <br> 1. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought low. <br> 2. One 16 -bit word is transmitted and one 16 -bit word is received. <br> 3. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high. <br> 4. The $\overline{E O D X}$ or $\overline{E O D R}$ pins emit low-going pulses. <br> Since the transmit and receive sections of the AIC are now synchronous, the AIC serial port, with additional NOR and AND gates, will interface to two SN74299 serial-to-parallel shift registers. Interfacing the AIC to the SN74299 shift register allows the AIC to interface to an external FIFO RAM and facilitates parallel, data bus communications between the AIC and the digital signal processor. The operation sequence is the same as the above sequence (see Serial Port Timing diagrams). |

INTERNAL TIMING CONFIGURATION


NOTE: Frequency $1,20.736 \mathrm{MHz}$, is used to show how 153.6 kHz (for a commercially available modem split-band filter clock), popular speech and modem sampling signal frequencies, and an internal $288-\mathrm{kHz}$ switched-capacitor filter clock can be derived synchronously and as submultiples of the crystal oscillator frequency. Since these derived frequencies are synchronous submultiples of the crystal frequency, aliasing does not occur as the sampled analog signal passes between the analog converter and switched-capacitor filter stages. Frequency $2,41.472 \mathrm{MHz}$, is used to show that the AIC can work with high-frequency signals, which are used by highspeed digital signal processors.
${ }^{\dagger}$ Split-band filtering can alternatively be performed after the analog input function via software in the TMS320.
$\ddagger$ These control bits are described in the AIC DX Data Word Format section.
explanation of internal timing configuration
All of the internal timing of the AIC is derived from the high-frequency clock signal that drives the Master Clock input pin. The Shift Clock signal, which strobes the serial port data between the AIC and DSP, is derived by dividing the Master Clock input signal frequency by four.

$$
\begin{aligned}
& \text { SCF Clock Frequency }=\frac{\text { Master Clock Frequency }}{2 \times \text { Contents of Counter A }} \\
& \text { Conversion Frequency }=\frac{\text { SCF Clock Frequency }}{\text { Contents of Counter B }} \\
& \text { Shift Clock Frequency }=\frac{\text { Master Clock Frequency }}{4}
\end{aligned}
$$

TX Counter A and TX Counter B, which are driven by the Master Clock signal, determine the D/A conversion timing. Similarly, RX Counter A and RX Counter B determine the A/D conversion timing. In order for the switched-capacitor low-pass and bandpass filters to meet their transfer function specifications, the frequency of the clock inputs of the switched-capacitor filters must be 288 kHz . If the frequencies of the clock inputs are not 288 kHz , the filter transfer function frequencies are scaled by the ratios of the clock frequencies to 288 kHz . Thus, to obtain the specified filter responses, the combination of Master Clock frequency and TX Counter $A$ and $R X$ Counter $A$ values must yield $288-\mathrm{kHz}$ switched-capacitor clock signals. These $288-\mathrm{kHz}$ clock signals can then be divided by the TX Counter B and RX Counter B to establish the $D / A$ and $A / D$ conversion timings.
$T X$ Counter $A$ and TX Counter $B$ are reloaded every D/A conversion period, while RX Counter $A$ and $R X$ Counter $B$ are reloaded every $A / D$ conversion period. The TX Counter $B$ and $R X$ Counter $B$ are loaded with the values in the TB and RB Registers, respectively. Via software control, the TX Counter A can be loaded with either the TA Register, the TA Register less the TA' Register, or the TA Register plus the TA'Register. By selecting the TA Register less the TA' Register option, the upcoming conversion timing will occur earlier by an amount of time that equals TA' times the signal period of the Master Clock. By selecting the TA Register plus the TA' Register option, the upcoming conversion timing will occur later by an amount of time that equals TA' times the signal period of the Master Clock. Thus, the D/A conversion timing can be advanced or retarded. An identical ability to alter the A/D conversion timing is provided. In this case, however, the RX Counter A can be programmed via software control with the RA Register, the RA Register less the RA' Register, or the RA Register plus the RA' Register.

The ability to advance or retard conversion timing is particularly useful for modem applications. This feature allows controlled changes in the $A / D$ and $D / A$ conversion timing. This feature can be used to enhance signal-to-noise performance, to perform frequency-tracking functions, and to generate nonstandard modem frequencies.
If the transmit and receive sections are configured to be synchronous (see WORD/ $\overline{\operatorname{BYTE}}$ pin description), then both the low-pass and bandpass switched-capacitor filter clocks are derived from TX Counter A. Also, both the $D / A$ and $A / D$ conversion timing are derived from the TX Counter $A$ and TX Counter B. When the transmit and receive sections are configured to be synchronous, the RX Counter $A, R X$ Counter $B, R A$ Register, RA' Register, and RB Registers are not used.

# TLC32040I, TLC32040C, TLC32041I, TLC32041C, <br> TLC32042I, TLC32042C <br> ANALOG INTERFACE CIRCUITS 

## AIC DR or DX word bit pattern

A/D or D/A MSB,

| 1st bit sent |
| :--- |
| \begin{tabular}{\|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline
\end{tabular} |
| D15 |

AIC DX data word format section

| d15 | d14 | d13 | d12 | d11 | d10 | d9 | d8 | d7 | d6 | d5 | d4 | d2 | d1 | d | COMMENTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| primary DX serial communication protocol |  |  |  |  |  |  |  |  |  |  |  |  |  |  |  |
| $\leftarrow$ d15 (MSB) through d2 go to the D/A converter register |  |  |  |  |  |  |  |  |  |  |  |  |  |  | The TX and RX Counter A's are loaded with the TA and RA register values. The TX and RX Counter B's are loaded with TB and RB register values. |
| $\leftarrow \mathrm{d} 15$ (MSB) through d2 go to the D/A converter register |  |  |  |  |  |  |  |  |  |  |  |  | 0 |  | The TX and RX Counter A's are loaded with the TA +TA' and $R A+R A$ ' register values. The TX and RX Counter B's are loaded with the TB and RB register values. NOTE: $d 1=0, d 0=1$ will cause the next $D / A$ and $A / D$ conversion periods to be changed by the addition of TA' and RA' Master Clock cycles, in which TA' and RA' can be positive or negative or zero. Please refer to Table 1. AIC Responses to Improper Conditions. |
| $\leftarrow \mathrm{d} 15$ (MSB) through d2 go to the D/A converter register |  |  |  |  |  |  |  |  |  |  |  |  |  |  | The TX and RX Counter A's are loaded with the TA - TA' and RA - RA' register values. The TX and RX Counter B's are loaded with the TB and RB register values. NOTE: $d 1=1, d 0=0$ will cause the next $D / A$ and $A / D$ conversion periods to be changed by the subtraction of TA' and RA' Master Clock cycles, in which TA' and RA' can be positive or negative or zero. Please refer to Table 1. AIC Responses to Improper Conditions. |
| $\leftarrow$ d15 (MSB) through d2 go to the D/A converter register |  |  |  |  |  |  |  |  |  |  |  |  |  |  | The TX and RX Counter A's are loaded with the TA and RA register values. The TX and RX Counter B's are loaded with the TB and RB register values. After a delay of four Shift Clock cycles, a secondary transmission will immediately follow to program the AIC to operate in the desired configuration. |

NOTE: Setting the two least significant bits to 1 in the normal transmission of DAC information (Primary Communications) to the AIC will initiate Secondary Communications upon completion of the Primary Communications.
Upon completion of the Primary Communication, $\overline{F S X}$ will remain high for four SHIFT CLOCK cycles and will then go low and initiate the Secondary Communication. The timing specifications for the Primary and Secondary Communications are identical. In this manner, the Secondary Communication, if initiated, is interleaved between successive Primary Communications. This interleaving prevents the Secondary Communication from interfering with the Primary Communications and DAC timing, thus preventing the AIC from skipping a DAC output. It is important to note that in the synchronous mode, $\overline{\mathrm{FSR}}$ will not be asserted during Secondary Communications.

## secondary DX serial communication protocol



## reset function

A reset function is provided to initiate serial communications between the AIC and DSP. The reset function will initialize all AIC registers, including the control register. After power has been applied to the AIC, a negative-going pulse on the $\overline{\text { RESET }}$ pin will initialize the AIC registers to provide an $8-\mathrm{kHz} \mathrm{A} / \mathrm{D}$ and D/A conversion rate for a 5.184 MHz master clock input signal. The AIC, excepting the CONTROL register, will be initialized as follows (see AIC DX Data Word Format section):

| REGISTER | INITIALIZED <br> REGISTER <br> VALUE (HEX) |
| :---: | :---: |
| TA | 9 |
| TA $^{\prime}$ | 1 |
| TB | 24 |
| RA | 9 |
| RA ${ }^{\prime}$ | 1 |
| RB | 24 |

The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section):

$$
d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1
$$

This initialization allows normal serial port communications to occur between AIC and DSP. If the transmit and receive sections are configured to operate synchronously and the user wishes to program different conversion rates, only the TA, TA', and TB register need to be programmed, since both transmit and receive timing are synchronously derived from these registers (see the Pin Descriptions and AIC DX Word Format sections).

The circuit shown below will provide a reset on power-up when power is applied in the sequence given under Power-Up Sequence. The circuit depends on the power supplies' reaching their recommended values a minimum of 800 ns before the capacitor charges to 0.8 V above DGTL GND.

TLC32040/
TLC32041/
TLC32042


# TLC32040I, TLC32040C, TLC32041I, TLC32041C, <br> TLC32042I, TLC32042C <br> ANALOG INTERFACE CIRCUITS 

power-up sequence
To ensure proper operation of the AIC, and as a safeguard against latch-up, it is recommmended that a Schottky diode with a forward voltage less than or equal to 0.4 V be connected from $\mathrm{V}_{\mathrm{CC}}$ - to ANLG GND (see Figure 17). In the absence of such a diode, power should be applied in the following sequence: ANLG GND and DGTL GND, $\mathrm{V}_{\mathrm{CC}}-$, then $\mathrm{V}_{\mathrm{C}}+$ and $\mathrm{V}_{\mathrm{DD}}$. Also, no input signal should be applied until after power-up.

## AIC responses to improper conditions

The AIC has provisions for responding to improper conditions. These improper conditions and the response of the AIC to these conditions are presented in Table 1 below.

## AIC register constraints

The following constraints are placed on the contents of the AIC registers:

1. TA register must be $>1$.
2. TA' register can be either positive, negative, or zero.
3. RA register must be $>1$.
4. RA' register can be either positive, negative, or zero.
5. (TA register $\pm$ TA' register) must be $>1$.
6. (RA register $\pm R A^{\prime}$ register) must be $>1$.
7. TB register must be $>1$.

TABLE 1. AIC RESPONSES TO IMPROPER CONDITIONS

| IMPROPER CONDITION | AIC RESPONSE |
| :---: | :---: |
| $\begin{aligned} & \text { TA register }+ \text { TA' register }=0 \text { or } 1 \\ & \text { TA register }- \text { TA' }^{\prime} \text { register }=0 \text { or } 1 \end{aligned}$ | Reprogram TX Counter A with TA register value |
| TA register + TA' register $<0$ | MODULO 64 arithmetic is used to ensure that a positive value is loaded into the TX Counter $A$, i.e., TA register + TA' register +40 HEX is loaded into TX Counter A |
| $\begin{aligned} & \text { RA register }+\mathrm{RA}^{\prime} \text { register }=0 \text { or } 1 \\ & \text { RA register }-\mathrm{RA}^{\prime} \text { register }=0 \text { or } 1 \end{aligned}$ | Reprogram RX Counter A with RA register value |
| RA register + RA' register $=0$ or 1 | MODULO 64 arithmetic is used to ensure that a positive value is loaded into RX Counter A , i.e., RA register + RA' register +40 HEX is loaded into RX Counter A |
| $\begin{aligned} & \text { TA register }=0 \text { or } 1 \\ & \text { RA register }=0 \text { or } 1 \end{aligned}$ | AIC is shut down |
| TB register $=0$ or 1 | Reprogram TB register with 24 HEX |
| RB register $=0$ or 1 | Reprogram RB register with 24 HEX |
| AIC and DSP cannot communicate | Hold last DAC output |

## improper operation due to conversion times being too close together

If the difference between two successive D/A conversion frame syncs is less that $1 / 19.2 \mathrm{kHz}$, the AIC operates improperly. In this situation, the second D/A conversion frame sync occurs too quickly and there is not enough time for the ongoing conversion to be completed. This situation can occur if the $A$ and $B$ registers are improperly programmed or if the $A+A^{\prime}$ register or $A-A^{\prime}$ register result is too small. When incrementally adjusting the conversion period via the $A+A^{\prime}$ register options, the designer should be very careful not to violate this requirement (see diagram below).


# TLC32040I, TLC32040C, TLC32041I, TLC32041C, TLC320421, TLC32042C ANALOG INTERFACE CIRCUITS 

## asynchronous operation - more than one receive frame sync occurring between two transmit frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. The command to use the incremental conversion period adjust option is sent to the AIC during a $\overline{F S X}$ frame sync. The ongoing conversion period is then adjusted. However, either Receive Conversion Period A or B may be adjusted. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. Therefore, if there is sufficient time between $t 1$ and $t 2$, the receive conversion period adjustment will be performed during Receive Conversion Period A. Otherwise, the adjustment will be performed during Receive Conversion Period B. The adjustment command only adjusts one transmit conversion period and one receive conversion period. To adjust another pair of transmit and receive conversion periods, another command must be issued during a subsequent $\overline{\mathrm{FSX}}$ frame (see figure below).

asynchronous operation - more than one transmit frame sync occurring between two receive frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. The command to use the incremental conversion period adjust options is sent to the AIC during a $\overline{\mathrm{FSX}}$ frame sync. The ongoing transmit conversion period is then adjusted. However, three possibilities exist for the receive conversion period adjustment in the diagram as shown in the figure below. If the adjustment command is issued during Transmit Conversion Period A, Receive Conversion Period A will be adjusted if there is sufficient time between t 1 and $t 2$. Or, if there is not sufficient time between $t 1$ and $t 2$, Receive Conversion Period $B$ will be adjusted. Or, the receive portion of an adjustment command may be ignored if the adjustment command is sent during a receive conversion period, which is already being or will be adjusted due to a prior adjustment command. For example, if adjustment commands are issued during Transmit Conversion Periods A, B, and $C$, the first two commands may cause Receive Conversion Periods $A$ and $B$ to be adjusted, while the third receive adjustment command is ignored. The third adjustment command is ignored since it was issued during Receive Conversion Period B, which already will be adjusted via the Transmit Conversion Period B adjustment command.


## asynchronous operation - more than one set of primary and secondary DX serial communication occurring between two receive frame sync (see AIC DX Data Word Format section)

The TA, TA', TB, and control register information that is transmitted in the secondary communications is always accepted and is applied during the ongoing transmit conversion period. If there is sufficient time betw'een $t 1$ and t2, the TA, RA', and RB register information, which is sent during Transmit Conversion Period A, will be applied to Receive Conversion Period A. Otherwise, this information will be applied during Receive Conversion Period B. If RA, RA', and RB register information has already been received and is being applied during an ongoing conversion period, any subsequent RA, RA', or RB information that is received during this receive conversion period will be disregarded (see diagram below).

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, $\mathrm{V}_{\text {CC }}+($ see Note 1$)$. |  | -0.3 V to 15 V |
| :---: | :---: | :---: |
| Supply voltage, VDD |  | -0.3V to 15 V |
| Output voltage, $\mathrm{V}_{\mathrm{O}}$ |  | -0.3 V to 15 V |
| Input voltage, $\mathrm{V}_{\mathrm{l}}$ |  | -0.3 V to 15 V |
| Digital ground voltage |  | -0.3 V to 15 V |
| Operating free-air temperature range: | TLC32040I, TLC320411, TLC320421 | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
|  | TLC32040C, TLC32041C, TLC32042C | . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range |  | $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Case temperature for 10 seconds: | V package | $260^{\circ} \mathrm{C}$ |
| Lead temperature $1,6 \mathrm{~mm}$ (1/16 inch | from case for 10 seconds: N package | $260^{\circ} \mathrm{C}$ |

NOTE 1: Voltage values for maximum ratings are with respect to VCC - .

## recommended operating conditions

| PARAMETER |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ (see Note 2) |  | 4.75 | 5 | 5.25 | V |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ - (see Note 2) |  | -4.75 | -5 | -5.25 | V |
| Digital supply voltage, $\mathrm{V}_{\mathrm{DD}}$ (see Note 2) |  | 4.75 | 5 | 5.25 | V |
| Digital ground voltage with respect to ANLG GND, DGTL GND |  |  | 0 |  | V |
| Reference input voltage, $\mathrm{V}_{\text {ref(ext) }}$ ( (see Note 2) |  | 2 |  | 4 | V |
| High-level input voltage, $\mathrm{V}_{\text {IH }}$ |  | 2 |  | $V_{D D}+0.3$ | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ (see Note 3) |  | -0.3 |  | 0.8 | V |
| Load resistance at OUT + and/or OUT -, $\mathrm{R}_{\mathrm{L}}$ |  | 300 |  |  | $\Omega$ |
| Load capacitance at OUT + and/or OUT - , $\mathrm{C}_{\mathrm{L}}$ |  |  |  | 100 | pF |
| MSTR CLK frequency (see Note 4) |  | 0.075 | 5 | 10.368 | MHz |
| Analog input amplifier common mode input voltage (see Note 5) |  |  |  | $\pm 1.5$ | V |
| A/D or D/A conversion rate |  |  |  | 19.2 | kHz |
| Conversion rate |  | 1 |  | 20 | kHz |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC32040I, TLC320411, TLC320421 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC32040C, TLC32041C, TLC32042C | 0 |  | 70 |  |

NOTES: 2. Voltages at analog inputs and outputs, REF, $V_{C C+}$, and $V_{C C-}$, are with respect to the ANLG GND terminal. Voltages at digital inputs and outputs and $V_{D D}$ are with respect to the DGTL GND terminal.
3. The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels and temperature only.
4. The bandpass and low-pass switched-capacitor filter response specifications apply only when the switched-capacitor clock frequency is 288 kHz . For switched-capacitor filter clocks at trequencies other than 288 kHz , the filter response is shifted by the ratio of switched-capacitor filter clock frequency to 288 kHz .
5. This range applies when ( $I N+-I N-$ ) or ( $A \cup X I N+-A U X I N-)$ equals $\pm 6 \mathrm{~V}$.
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V} \mathbf{C C}+=5 \mathrm{~V}$, VCC - $=-5 \mathrm{~V}, \mathrm{VDD}=5 \mathrm{~V}$ (unless otherwise noted)
total device, MSTR CLK frequency $=\mathbf{5 . 1 8 4} \mathbf{M H z}$, outputs not loaded

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{I}^{\text {OH }}=-300 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{I}_{\mathrm{OL}}=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| ${ }^{\prime} \mathrm{CC}+$ Supply current from $\mathrm{V}_{\mathrm{CC}}+$ |  | TLC3204-C |  |  |  | 35 | mA |
|  |  | TLC3204-1 |  |  |  | 40 |  |
| ${ }^{\text {I CC - }}$ | Supply current from VCC - | TLC3204-C |  |  |  | -35 | mA |
|  |  | TLC3204-1 |  |  |  | -40 |  |
| IDD | Supply current from V ${ }_{\text {DD }}$ |  | ${ }^{\text {m MSTR CLK }}$ = 5.184 MHz |  |  | 7 | mA |
| $V_{\text {ref }}$ | Internal reference output voltage |  |  | 3 |  | 3.3 | V |
| $\alpha$ Vref | Temperature coefficient of internal reference voltage |  |  |  | 100 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| $r_{0}$ | Output resistance at REF |  |  |  | 100 |  | k $\Omega$ |

receive amplifier input

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\text {t }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | A/D converter offset error (filters bypassed) |  |  | 25 | 65 | mV |
|  | A/D converter offset error (filters in) |  |  | 25 | 65 | mV |
| CMRR | Common-mode rejection ratio at $\mathrm{IN}+, \mathrm{IN}$-, or AUX $\mathbb{I N}+$, AUX $\mathbb{I N}$ - | See Note 6 |  | 55 |  | dB |
| r | Input resistance at $\operatorname{IN}+, \operatorname{IN}-$ <br> or AUX IN +, AUX IN - , REF |  |  | 100 |  | k $\Omega$ |

## transmit filter output

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\text {¢ }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {OO }} \quad \begin{aligned} & \text { Output offset voltage at OUT + or OUT - } \\ & \text { (single-ended relative to ANLG GND) }\end{aligned}$ |  |  | 15 | 75 | mV |
| VOM Maximum peak output voltage swing across <br> $R_{\text {L }}$ at OUT + or OUT - (single-ended) | $\begin{gathered} R_{L} \geq 300 \Omega \\ \text { Offset voltage }=0 \end{gathered}$ | $\pm 3$ |  |  | V |
| $\begin{array}{ll}\text { VOM } & \begin{array}{l}\text { Maximum peak output voltage swing between } \\ \text { OUT + and OUT - (differential output) }\end{array}\end{array}$ | $R_{L} \geq 600 \Omega$ | $\pm 6$ |  |  | V |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTE 6: The test condition is a $0-\mathrm{dBm}, 1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate.

## TLC32040I, TLC32040C, TLC32041I, TLC32041C, TLC320421, TLC32042C ANALOG INTERFACE CIRCUITS

electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}^{-}=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
system distortion specifications, SCF clock frequency $=\mathbf{2 8 8} \mathbf{~ k H z}$

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT <br> dB |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Attenuation of second harmonic of A/D input signal | single-ended | $V_{\text {in }}=-0.1 \mathrm{~dB}$ to -24 dB referred to $\mathrm{V}_{\text {ref }}$, See Note 7 | 70 |  |  |  |
|  | differential |  | 62 | 70 |  |  |
| Attenuation of third and higher harmonics of $A / D$ input signal | single-ended | $V_{\text {in }}=-0.1 \mathrm{~dB}$ to -24 dB referred to $\mathrm{V}_{\text {ref }}$, See Note 7 |  | 65 |  | dB |
|  | differential |  | 57 | 65 |  |  |
| Attenuation of second harmonic of D/A input signal | single-ended | $V_{\text {in }}=-0 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref, }}$, <br> See Note 7 |  | 70 |  | dB |
|  | differential |  | 62 | 70 |  |  |
| Attenuation of third and higher harmonics of $D / A$ input signal | single-ended | $V_{\text {in }}=-0 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 65 |  | dB |
|  | differential |  | 57 | 65 |  |  |

A/D channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS (see Note 7) | $A_{v}=1^{\ddagger}$ |  | $A_{V}=2^{\ddagger}$ |  | $A_{v}=4^{\ddagger}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX | MIN | MAX |  |
| A/D channel signal-to-distortion ratio | $V_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 58 |  | $>58$ § |  | $>58{ }^{\text {§ }}$ |  | dB |
|  | $V_{\text {in }}=--12 \mathrm{~dB}$ to -6 dB | 58 |  | 58 |  | $>58$ § |  |  |
|  | $\mathrm{V}_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 56 |  | 58 |  | 58 |  |  |
|  | $\mathrm{V}_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 50 |  | 56 |  | 58 |  |  |
|  | $\mathrm{V}_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 44 |  | 50 |  | 56 |  |  |
|  | $\mathrm{V}_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 38 |  | 44 |  | 50 |  |  |
|  | $\mathrm{V}_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 32 |  | 38 |  | 44 |  |  |
|  | $\mathrm{V}_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 26 |  | 32 |  | 38 |  |  |
|  | $V_{\text {in }}=-54 \mathrm{~dB}$ to -48 dB | 20 |  | 26 |  | 32 |  |  |

D/A channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS (see Note 7) | MIN MAX | UNIT |
| :---: | :---: | :---: | :---: |
| D/A channel signal-to-distortion ratio | $\mathrm{V}_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 58 | dB |
|  | $\mathrm{V}_{\text {in }}=-12 \mathrm{~dB}$ to -6 dB | 58 |  |
|  | $V_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 56 |  |
|  | $V_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 50 |  |
|  | $\mathrm{V}_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 44 |  |
|  | $\mathrm{V}_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 38 |  |
|  | $\mathrm{V}_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 32 |  |
|  | $\mathrm{V}_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 26 |  |
|  | $V_{\text {in }}=-54 \mathrm{~dB}$ to -48 dB | 20 |  |

gain and dynamic range

| PARAMETER | TEST CONDITIONS | MIN | TYP $\boldsymbol{T}$ |
| :--- | :---: | :---: | :---: |
| Absolute transmit gain tracking error while transmitting <br> into $600 \Omega$ | -48 dB to 0 dB signal range, <br> See Note 8 | UNIT |  |
| Absolute receive gain tracking error | -48 dB to 0 dB signal range, | $\pm 0.05 \pm 0.15$ | dB |

[^17]NOTES: 7. The test condition is a $1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate ( 0 dB relative to $\mathrm{V}_{\text {ref }}$ ). The load impedance for the

TLC32040I, TLC32040C, TLC32041I, TLC32041C,
TLC32042I, TLC32042C
ANALOG INTERFACE CIRCUITS
power supply rejection and crosstalk attenuation

| PARAMETER |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{C C}+$ or $V_{C C}$ - supply voltage rejection ratio, receive channel | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at DR (ADC output) | 30 |  | dB |
|  | $\mathrm{f}=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| $V_{C C}+$ or $V_{C C}$ - supply voltage rejection ratio, transmit channel (single-ended) | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at OUT + | 30 |  | dB |
|  | $\mathrm{f}=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| Crosstalk attenuation, transmit-to-receive (single-ended) |  |  | 80 |  | dB |

delay distortion, SCF clock frequency $=288 \mathrm{kHz} \pm 2 \%$, input (IN $+-\mathrm{IN}-$ ) is $\pm 3-\mathrm{V}$ sinewave
Please refer to filter response graphs for delay distortion specifications.
TLC32040 and TLC32041 bandpass filter transfer function (see curves), SCF clock
frequency $=288 \mathrm{kHz} \pm 2 \%$, input ( $\mathrm{IN}+-\mathrm{IN}-$ ) is a $\pm 3-\mathrm{V}$ sinewave (see Note 9)

| PARAMETER | TEST CONDITIONS |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Filter Gain (see Note 10) | Input signal reference is 0 dB | $f=100 \mathrm{~Hz}$ |  | -42 | dB |
|  |  | $\mathrm{f}=170 \mathrm{~Hz}$ |  | -25 |  |
|  |  | $300 \mathrm{~Hz} \leq \mathrm{f} \leq 3.4 \mathrm{kHz}$ | -0.5 | 0.5 |  |
|  |  | $\mathrm{f}=4 \mathrm{kHz}$ |  | -16 |  |
|  |  | $\mathrm{f} \geq 4.6 \mathrm{kHz}$ |  | -58 |  |

TLC32042 bandpass filter transfer function (see curves), SCF clock frequency $=\mathbf{2 8 8} \mathbf{~ k H z} \pm 2 \%$, input (IN + - IN -) is a $\pm 3-\mathrm{V}$ sinewave (see Note 9)

| PARAMETER | TEST CONDITIONS |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Filter Gain (see Note 10) | Input signal reference is 0 dB | $\mathrm{f}=100 \mathrm{~Hz}$ |  | -27 | dB |
|  |  | $f=170 \mathrm{~Hz}$ |  | -2 |  |
|  |  | $300 \mathrm{~Hz} \leq \mathrm{f} \leq 3.4 \mathrm{kHz}$ | -0.5 | 0.5 |  |
|  |  | $f=4 \mathrm{kHz}$ |  | -16 |  |
|  |  | $f \geq 4.6 \mathrm{kHz}$ |  | -58 |  |

low-pass filter transfer function, SCF clock frequency $=288 \mathbf{k H z} \pm \mathbf{2 \%}$ (see Note 9)

| PARAMETER | TEST CONDITIONS |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Filter Gain (see Note 10) | Output signal reference is 0 dB | $\mathrm{f} \leq 3.4 \mathrm{kHz}$ | -0.5 | 0.5 | dB |
|  |  | $\mathrm{f}=3.6 \mathrm{kHz}$ |  | -4 |  |
|  |  | $\mathrm{f}=4 \mathrm{kHz}$ |  | -30 |  |
|  |  | $\mathrm{f} \geq 4.4 \mathrm{kHz}$ |  | -58 |  |

serial port

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ |
| :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{IOH}=-300 \mu \mathrm{~A}$ | 2.4 |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{IOL}=2 \mathrm{~mA}$ |  |
| $\mathrm{I}_{\mathrm{I}}$ | Input current |  | ONIT |
| $\mathrm{C}_{1}$ | Input capacitance |  | V |
| $\mathrm{C}_{\mathrm{O}}$ | Output capacitance |  | V |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 9. The above filter specifications are for a switched-capacitor filter clock range of $288 \mathrm{kHz} \pm 2 \%$. For switched-capacitor filter clocks at frequencies other than $288 \mathrm{kHz} \pm 2 \%$, the filter response is shifted by the ratio of switched-capacitor filter clock frequency to 288 kHz .
10. The filter gain outside of th.e passband is measured with respect to the gain at 1 kHz . The filter gain within the passband is measured with respect to the average gain within the passband. The passbands are 300 to 3400 Hz and 0 to 3400 Hz for the bandpass and lowpass filters respectively.
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{C}} \mathrm{C}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$
noise (measurement includes low-pass and bandpass switched-capacitor filters)

| PARAMETER |  | TEST CONDITIONS | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Transmit noise | single-ended | DX input $=00000000000000$, constant input code | 200 |  | $\mu \mathrm{V} \mathrm{rms}$ |
|  | differential |  | 300 | 500 | $\mu \mathrm{V}$ rms |
|  |  |  | 20 |  | dBrnc0 |
| Receive noise (see Note 11) |  | Inputs grounded, gain $=1$ | 300 | 475 | $\mu \mathrm{V}$ rms |
|  |  | 20 |  | dBrncO |

## timing requirements

serial port recommended input signals

| PARAMETER | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {C }}$ (MCLK) Master clock cycle time | 95 |  | ns |
| $\mathrm{tr}_{\mathrm{r}}$ (MCLK) Master clock rise time |  | 10 | ns |
| $\mathrm{t}_{\mathrm{f}}(\mathrm{MCLK})$ Master clock fall time |  | 10 | ns |
| Master clock duty cycle | 42\% | 58\% |  |
| $\overline{\text { RESET pulse duration (see Note 12) }}$ | 800 |  | ns |
| $\mathrm{t}_{\text {Su }}(\mathrm{DX}) \quad \mathrm{DX}$ setup time before SCLK $\downarrow$ | 20 |  | ns |
| th(DX) DX hold time after SCLK $\downarrow$ | $\mathrm{t}_{\mathrm{c}(\text { (SCLK)/4 }}$ |  | ns |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 11. This noise is referred to the input with a buffer gain of one. If the buffer gain is two or four, the noise figure will be correspondingly reduced. The noise is computed by statistically evaluating the digital output of the A/D converter.
12. $\bar{R} E S E T$ pulse duration is the amount of time that the reset pin is held below 0.8 V after the power supplies have reached their recommended values.

# TLC32040I, TLC32040C, TLC32041I, TLC32041C, TLC32042I, TLC32042C ANALOG INTERFACE CIRCUITS 

## correction results

Table 4 below shows the optimum p values and the corresponding correction results for $8000-\mathrm{Hz}$ and $9600-\mathrm{Hz}$ sampling rates.

TABLE 4

|  | ERROR (dB) | ERROR (dB) |
| :---: | :---: | :---: |
| $\mathbf{f}(\mathbf{H z})$ | $\mathbf{f}_{\mathbf{s}}=\mathbf{8 0 0 0} \mathbf{~ H z}$ <br> $\mathbf{p} \mathbf{1}=-0.14813$ <br> $\mathbf{p 2}=0.9888$ | $\mathbf{f}_{\mathbf{s}}=\mathbf{9 6 0 0} \mathbf{~ H z}$ <br> $\mathbf{p} \mathbf{1}=-0.1307$ <br> $\mathbf{p 2}=0.9951$ |
| 300 | -0.099 | -0.043 |
| 600 | -0.089 | -0.043 |
| 900 | -0.054 | 0 |
| 1200 | -0.002 | 0 |
| 1500 | 0.041 | 0 |
| 1800 | 0.079 | 0.043 |
| 2100 | 0.100 | 0.043 |
| 2400 | 0.091 | 0.043 |
| 2700 | -0.043 | 0 |
| 3000 | -0.102 | -0.043 |

## TMS320 software requirements

The digital correction filter equation can be written in state variable form as follows:

$$
Y=k 1 Y+k 2 U
$$

where $k 1$ equals $p 1$ (from the preceding page), $k 2$ equals ( $1-\mathrm{p} 1$ ) p 2 (from the preceding page), $Y$ is the filter state, and $U$ is the next I/O sample. The coefficients $k 1$ and $k 2$ must be represented as 16 -bit integers. The SACH instruction (with the proper shift) will yield the correct result. With the assumption that the TMS320 processor page pointer and memory configuration are properly initialized, the equation can be executed in seven instructions or seven cycles with the following program:

```
ZAC
LT K2
MPY U
LTA K1
MPY Y
APAC
SACH (dma), (shift)
```


# TLC32040I, TLC32040C, TLC320411, TLC32041C, <br> TLC32042I, TLC32042C ANALOG INTERFACE CIRCUITS 

## $\sin \mathrm{x} / \mathrm{x}$ correction section

The AIC does not have $\sin \mathrm{x} / \mathrm{x}$ correction circuitry after the digital-to-analog converter. Sin $\mathrm{x} / \mathrm{x}$ correction can be accomplished easily and efficiently in digital signal processor (DSP) software. Excellent correction accuracy can be achieved to a band edge of 3000 Hz by using a first-order digital correction filter. The results, which are shown below, are typical of the numerical correction accuracy that can be achieved for sample rates of interest. The filter requires only seven instruction cycles per sample on the TMS320 DSPs. With a 200 -ns instruction cycle, nine instructions per sample represents an overhead factor of $1.4 \%$ and $1.7 \%$ for sampling rates of 8000 Hz and 9600 Hz , respectively. This correction will add a slight amount of group delay at the upper edge of the $300-3000-\mathrm{Hz}$ band.

## $\sin \mathbf{x} / \mathbf{x}$ roll-off for a zero-order hold function

The $\sin \mathrm{x} / \mathrm{x}$ roll-off for the AIC DAC zero-order hold function at a band-edge frequency of 3000 Hz for the various sampling rates is shown in the table below.

TABLE 3. $\sin x / x$ ROLL-OFF

| $f_{s}(H z)$ | $20 \log \frac{\sin \pi f / f_{s}}{\pi f / f_{s}}$ <br> $(f=3000 \mathrm{~Hz})$ <br> $(\mathbf{d B})$ |
| ---: | :---: |
| 7200 | -2.64 |
| 8000 | -2.11 |
| 9600 | -1.44 |
| 14400 | -0.63 |
| 19200 | -0.35 |

Note that the actual AIC $\sin x / x$ roll-off will be slightly less than the above figures, because the AIC has less than a $100 \%$ duty cycle hold interval.

## correction filter

To compensate for the $\sin x / x$ roll-off of the AIC, a first-order correction filter shown below, is recommended.


The difference equation for this correction filter is:
$y_{i}+1=p 2(1-p 1)\left(u_{i}+1\right)+p 1 y_{i}$
where the constant p1 determines the pole locations.
The resulting squared magnitude transfer function is:

$$
|H(f)|^{2}=\frac{p 22(1-p 1)^{2}}{1-2 p 1 \cos \left(2 \pi f / f_{s}\right)+p 1^{2}}
$$

TLC32040I, TLC32040C, TLC32041I, TLC32041C,
TLC32042I, TLC32042C
ANALOG INTERFACE CIRCUITS
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (continued)
serial port - AIC output signals

| PARAMETER |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{C}}$ (SCLK) | Shift clock (SCLK) cycle time | 380 |  | ns |
| $\mathrm{t}_{\text {f(SCLK) }}$ | Shift clock (SCLK) fall time |  | 50 | ns |
| $\mathrm{tr}_{\text {( }}$ SCLK) | Shift clock (SCLK) rise time |  | 50 | ns |
|  | Shift clock (SCLK) duty cycle | 45 | 55 | \% |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { FSR/FSX }} \downarrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FH})$ | Delay from SCLK $\uparrow$ to $\overline{\mathrm{FSR} / \mathrm{FSX}} \uparrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{DR})$ | DR valid after SCLK $\uparrow$ |  | 90 | ns |
| $t_{\text {dw }}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \downarrow$ in word mode |  | 90 | ns |
| $t_{d w}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \uparrow$ in word mode |  | 90 | ns |
| $\mathrm{tf}_{\mathrm{f}}$ EODX) | $\overline{\text { EODX }}$ fall time |  | 15 | ns |
| $\mathrm{t}_{\mathrm{f}}(\mathrm{EODR})$ | $\overline{\text { EODR }}$ fall time |  | 15 | ns |
| $\mathrm{t}_{\mathrm{db}}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \downarrow$ in byte mode |  | 100 | ns |
| $t_{d b}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \uparrow$ in byte mode |  | 100 | ns |

TABLE 2. GAIN CONTROL TABLE
(ANALOG INPUT SIGNAL REQUIRED FOR FULL-SCALE A/D CONVERSION)

| INPUT CONFIGURATIONS | CONTROL REGISTER BITS |  | ANALOG INPUT ${ }^{\dagger}$ | A/D CONVERSION RESULT |
| :---: | :---: | :---: | :---: | :---: |
|  | d6 | d7 |  |  |
| $\begin{aligned} & \text { Differential configuration } \\ & \begin{aligned} \text { Analog input } & =\mathbb{I N +}-\mathbb{N}- \\ & =A \cup X I N+-A \cup X I N- \end{aligned} \end{aligned}$ | 1 | 1 | $\pm 6 \mathrm{~V}$ | full-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |
| $\begin{aligned} & \text { Single-ended configuration } \\ & \begin{aligned} \text { Analog input } & =I N+- \text { ANLG GND } \\ & =A U X I N+- \text { ANLG GND } \end{aligned} \end{aligned}$ | 1 | 1 | $\pm 3 \mathrm{~V}$ | half-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |

$\dagger$ In this example, $V_{\text {ref }}$ is assumed to be 3 V . In order to minimize distortion, it is recommended that the analog input not exceed 0.1 dB below full scale.

$R_{f b}=R$ for $d 6=1, d 7=1$
$d 6=0, d 7=0$
$R_{f b}=2 R$ for $d 6=1, d 7=0$
$R_{f b}=4 R$ for $d 6=0, d 7=1$
FIGURE 1. IN + AND IN - GAIN CONTROL CIRCUITRY

$R_{f b}=R$ for $d 6=1, d 7=1$
$d 6=0, d 7=0$
$R_{f b}=2 R$ for $d 6=1, d 7=0$
$R_{f b}=4 R$ for $d 6=0, d 7=1$
FIGURE 2. AUX IN + AND AUX IN GAIN CONTROL CIRCUITRY
byte-mode timing

figure 3. SERIAL PORT timing

## TLC32040I, TLC32040C, TLC32041I, TLC32041C,

TLC32042I, TLC32042C
ANALOG INTERFACE CIRCUITS


FIGURE 4. TMS32010-TLC32040/TLC32041/TLC32042 INTERFACE CIRCUIT
in instruction timing

out instruction timing


FIGURE 5. TMS32010-TLC32040/TLC32041/TLC32042 INTERFACE TIMING

## TYPICAL CHARACTERISTICS



NOTES: A. Maximum relative delay ( 0 Hz to 600 Hz ) $=125 \mu \mathrm{~s}$.
B. Maximum relative delay $(600 \mathrm{~Hz}$ to 3000 Hz$)= \pm 50 \mu \mathrm{~s}$.
C. Absolute delay $(600 \mathrm{~Hz}$ to 3000 Hz$)=700 \mu \mathrm{~s}$.
D. Test conditions are $V_{C C}+V_{C C-}$, and $V_{D D}$ within recommended operating conditions, SCF clock $f=288 \mathrm{kHz} \pm 2 \%$, input $= \pm 3-\mathrm{V}$ sinewave, and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

FIGURE 6

## TYPICAL CHARACTERISTICS



NOTES: A. Maximum relative delay $(200 \mathrm{~Hz}$ to 600 Hz$)=3350 \mu \mathrm{~s}$.
B. Maximum relative delay $(600 \mathrm{~Hz}$ to 3000 Hz$)= \pm 50 \mu \mathrm{~s}$.
C. Absolute delay $(600 \mathrm{~Hz}$ to 3000 Hz$)=1230 \mu \mathrm{~s}$
D. Test conditions are $V_{C C}+V_{C C-}$, and $V_{D D}$ within recommended operating conditions, SCF clock $f=288 \mathrm{kHz} \pm 2 \%$, input $= \pm 3-\mathrm{V}$ sinewave, and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

FIGURE 7

## TLC32040I, TLC32040C, TLC32041I, TLC32041C, <br> TLC32042I, TLC32042C <br> ANALOG INTERFACE CIRCUITS

## TYPICAL CHARACTERISTICS

TLC32042
RECEIVE CHANNEL FILTER


NOTES: A. Maximum relative delay $(200 \mathrm{~Hz}$ to 600 Hz$)-3350 \mu \mathrm{~s}$.
B. Maximum relative delay $(600 \mathrm{~Hz}$ to 3000 Hz$)= \pm 50 \mu \mathrm{~s}$.
C. Absolute delay $(600 \mathrm{~Hz}$ to 3000 Hz$)=1080 \mu \mathrm{~s}$.
D. Test conditions are $V_{C C}+, V_{C C-}$, and $V_{D D}$ within recommended operating conditions, SCF clock $f=288 \mathrm{kHz} \pm 2 \%$, input $= \pm 3-\mathrm{V}$ sinewave, and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

FIGURE 8

TLC32040I, TLC32040C, TLC32041I, TLC32041C,
TLC32042I, TLC32042C
ANALOG INTERFACE CIRCUITS

TYPICAL CHARACTERISTICS

## A/D SIGNAL-TO-DISTORTION RATIO vs <br> INPUT SIGNAL



FIGURE 9

D/A CONVERTER SIGNAL-TO-DISTORTION RATIO vS
INPUT SIGNAL


FIGURE 11

A/D GAIN TRACKING
(GAIN RELATIVE TO GAIN
AT 0 dB INPUT SIGNAL)


FIGURE 10

D/A GAIN TRACKING
vs
(GAIN RELATIVE TO GAIN AT 0 dB INPUT SIGNAL)


FIGURE 12

NOTE: Test conditions are $V_{C C}+, V_{C C-}$, and $V_{D D}$ within recommended operating conditions set clock $f=288 \mathrm{kHz} \pm 2 \%$, and $T_{A}=25^{\circ} \mathrm{C}$.

# TLC32040I, TLC32040C, TLC320411, TLC32041C, <br> TLC32042I, TLC32042C ANALOG INTERFACE CIRCUITS 

## TYPICAL CHARACTERISTICS

## ATTENUATION OF SECOND HARMONIC OF A/D INPUT <br> vs

INPUT SIGNAL


FIGURE 13

ATTENUATION OF SECOND HARMONIC OF D/A INPUT vs
INPUT SIGNAL


FIGURE 15

ATTENUATION OF THIRD HARMONIC OF A/D INPUT vs
INPUT SIGNAL


FIGURE 14

ATTENUATION OF THIRD HARMONIC OF D/A INPUT vs
INPUT SIGNAL


FIGURE 16

NOTE: Test conditions are $V_{C C}+V_{C C-}$, and $V_{D D}$ within recommended operating conditions set clock $f=288 \mathrm{kHz} \pm 2 \%$, and $T_{A}=25{ }^{\circ} \mathrm{C}$.

TLC32040I, TLC32040C, TLC32041I, TLC32041C, TLC32042I, TLC32042C andiog interface circuits

TYPICAL APPLICATION INFORMATION


FIGURE 17. AIC INTERFACE TO THE TMS32020/C25 SHOWING DECOUPLING CAPACITORS AND SCHOTTKY DIODE ${ }^{\dagger}$


FOR: $V_{C C}=12 \mathrm{~V}, \mathrm{R}=7200 \Omega$
$V_{C C}=10 \mathrm{~V}, \mathrm{R}=5600 \Omega$
$V_{C C}=5 \mathrm{~V}, \mathrm{R}=1600 \Omega$
FIGURE 18. EXTERNAL REFERENCE CIRCUIT FOR TLC32041

[^18]- Advanced LinCMOS ${ }^{\text {m }}$ Silicon-Gate Process Technology
- 14-Bit Dynamic Range ADC and DAC
- 16-Bit Dynamic Range Input with Programmable Gain
- Variable ADC and DAC Sampling Rate Up to 19,200 Samples per Second
- Switched-Capacitor Antialiasing Input Filter and Output-Reconstruction Filter
- Serial Port for Direct Interface to TMS320C17, TMS32020, TMS320C25, and TMS320C30 Digital Processors
- Synchronous or Asynchronous ADC and DAC Conversion Rates with Programmable Incremental ADC and DAC Conversion Timing Adjustments
- Serial Port Interface to SN74299 Serial-toParallel Shift Register for Parallel Interface to TMS32010, TMS320C15, or Other Digital Processors
- Internal Reference for Normal Operation and External Purposes, or Can Be Overridden by External Reference


## description

The TLC32044 is a complete analog-to-digital and digital-to-analog input/output system on a single monolithic CMOS chip. This device integrates a bandpass switched-capacitor antialiasing input filter, a 14-bit-resolution A/D converter, four microprocessor-compatible serial port modes, a 14-bit-resolution D/A converter, and a low-pass switched-capacitor outputreconstruction filter. The device offers numerous combinations of Master Clock input frequencies and conversion/sampling rates, which can be changed via digital processor control.

N PACKAGE
(TOP VIEW)


NU -- Nonusable; no external connection should be made to these pins. See Table 2.

Typical applications for this IC include speech encryption for digital transmission, speech recognition/storage systems, speech synthesis, modems (7.2-, $8-, 9.6-14.4-$, and $19.2-\mathrm{kHz}$ sampling rate), analog interface for digital signal processors (DSPs), industrial process control, biomedical instrumentation, acoustical signal processing, spectral analysis, data acquisition, and instrumentation recorders. Four serial modes, which allow direct interface to the TMS320C17, TMS32020, TMS320C25, and TMS320C30 digital signal

## description (continued)

processors, are provided. Also, when the transmit and receive sections of the Analog Interface Circuit (AIC) are operating synchronously, it will interface to two SN74299 serial-to-parallel shift registers. These serial-to-parallel shift registers can then interface in parallel to the TMS32010, TMS320C15, other digital signal processors, or external FIFO circuitry. Output data pulses are emitted to inform the processor that data transmission is complete or to allow the DSP to differentiate between two transmitted bytes. A flexible control scheme is provided so that the functions of the IC can be selected and adjusted coincidentally with signal processing via software control.
The antialiasing input filter comprises eighth-order and fourth-order C.C-type (Chebyshev/elliptic transitional) low-pass and high-pass filters, respectively. The input filter is implemented in switched-capacitor technology and is preceded by a continuous time filter to eliminate any possibility of aliasing caused by sampled data filtering. When only low-pass filtering is desired, the high-pass filter can be switched out of the signal path. A selectable, auxiliary, differential analog input is provided for applications where more than one analog input is required.
The $A / D$ and D/A architectures ensure no missing codes and monotonic operation. An internal voltage reference is provided to ease the design task and to provide complete control over the performance of the IC. The internal voltage reference is brought out to a pin and is available to the designer. Separate analog and digital voltage supplies and grounds are provided to minimize noise and ensure a wide dynamic range. Also, the analog circuit path contains only differential circuitry to keep noise to an absolute minimum. The only exception is the DAC sample-and-hold, which utilizes pseudo-differential circuitry.
The output-reconstruction filter is an eighth-order CC-type (Chebyshev/elliptic transitional low-pass filter) followed by a second-order ( $\sin x) / x$ correction filter) and is implemented in switched-capacitor technology. This filter is followed by a continuous-time filter to eliminate images of the digitally encoded signal. The on-board $(\sin x) / x$ correction filter can be switched out of the signal path using digital signal processor control, if desired.

The TLC32O441 is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TLC32044C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS

functional block diagram


## PRINCIPLES OF OPERATION

## analog input

Two sets of analog inputs are provided. Normally, the $\operatorname{IN}+$ and $\mathbb{I N}$ - input set is used; however, the auxiliary input set, AUX IN + and AUX IN - , can be used if a second input is required. Each input set can be operated in either differential or single-ended modes, since sufficient common-mode range and rejection are provided. The gain for the $\mathbb{I N}+, \mathbb{I N}-, A \cup X I N+$, and $A U X I N$ - inputs can be programmed to be either 1, 2, or 4 (see Table 2). Either input circuit can be selected via software control. It is important to note that a wide dynamic range is assured by the differential internal analog architecture and by the separate analog and digital voltage supplies and grounds.

## A/D bandpass filter, A/D bandpass filter clocking, and A/D conversion timing

The A/D high-pass filter can be selected or bypassed via software control. The frequency response of this filter is presented in the following pages. This response results when the switched-capacitor filter clock frequency is 288 kHz and the A/D sample rate is 8 kHz . Several possible options can be used to attain a $288-\mathrm{kHz}$ switched-capacitor filter clock. When the filter clock frequency is not 288 kHz , the low-pass filter transfer function is frequency-scaled by the ratio of the actual clock frequency to 288 kHz . The ripple bandwidth and 3 -dB low-frequency roll-off points of the high-pass section are 150 and 100 Hz , respectively. However, the high-pass section low-frequency roll-off is frequency-scaled by the ratio of the A/D sample rate to 8 kHz .
The Internal Timing Configuration and AIC DX Data Word Format sections of this data sheet indicate the many options for attaining a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock. These sections indicate that the RX Counter A can be programmed to give a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock for several Master Clock input frequencies.

## PRINCIPLES OF OPERATION (continued)

The A/D conversion rate is then attained by frequency-dividing the $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock with the RX Counter B. Thus, unwanted aliasing is prevented because the A/D conversion rate is an integral submultiple of the bandpass switched-capacitor filter sampling rate, and the two rates are synchronously locked.

## A/D converter performance specifications

Fundamental performance specifications for the $A / D$ converter circuitry are presented in the A/D converter operating characteristics section of this data sheet. The realization of the A/D converter circuitry with switched-capacitor techniques provides an inherent sample-and-hold.

## analog output

The analog output circuitry is an analog output power amplifier. Both noninverting and inverting amplifier outputs are brought out of the IC. This amplifier can drive transformer hybrids or low-impedance loads directly in either a differential or single-ended configuration.

## D/A low-pass filter, D/A low-pass filter clocking, and D/A conversion timing

The frequency response of this filter is presented in the following pages. This response results when the low-pass switched-capacitor filter clock frequency is 288 kHz . Like the A/D filter, the transfer function of this filter is frequency-scaled when the clock frequency is not 288 kHz . A continuous-time filter is provided on the output of the $(\sin x) / x$ filter to eliminate the periodic sample data signal information, which occurs at multiples of the $288-\mathrm{kHz}$ switched-capacitor filter clock. The continuous time filter also greatly attenuates any switched-capacitor clock feedthrough.
The D/A conversion rate is attained by frequency-dividing the $288-\mathrm{kHz}$ switched-capacitor filter clock with TX Counter B. Thus, unwanted aliasing is prevented because the D/A conversion rate is an integral submultiple of the switched-capacitor low-pass filter sampling rate, and the two rates are synchronously locked.

## asynchronous versus synchronous operation

If the transmit section of the AIC (low-pass filter and DAC) and receive section (bandpass filter and ADC) are operated asynchronously, the low-pass and bandpass filter clocks are independently generated from the Master Clock signal. Also, the D/A and A/D conversion rates are independently determined. If the transmit and receive sections are operated synchronously, the low-pass filter clock drives both low-pass and bandpass filters. In synchronous operation, the A/D conversion timing is derived from, and is equal to, the D/A conversion timing. (See description of the WORD/ $\overline{B Y T E}$ pin in the Pin Functional Description Section.)

## D/A converter performance specifications

Fundamental performance specifications for the D/A converter circuitry are presented in the D/A converter operating characteristics section of the data sheet. The D/A converter has a sample-and-hold that is realized with a switched-capacitor ladder.

## system frequency response correction

( $\operatorname{Sin} x$ )/x correction for the D/A converter's zero-order sample-and-hold output can be provided by an onboard second-order $(\sin x) / x$ correction filter. This $(\sin x) / x$ correction filter can be inserted into or deleted from the signal path by digital signal processor control. When inserted, the $(\sin x) / x$ correction filter follows the switched-capacitor low-pass filter. When the TB register (see Internal Timing Configuration section) equals 36 , the correction results of Figures 11 and 12 will be obtained.

## PRINCIPLES OF OPERATION (continued)

$(\operatorname{Sin} x) / x$ correction can also be accomplished by deleting the on-board second-order correction filter and performing the $(\sin x) / x$ correction in digital signal processor software. The system frequency response can be corrected via DSP software to $\pm 0.1 \mathrm{~dB}$ accuracy to a band-edge of 3000 Hz for all sampling rates. This correction is accomplished with a first-order digital correction filter, which requires only seven TMS320 instruction cycles. With a 200-ns instruction cycle, seven instructions represent an overhead factor of only $1.1 \%$ and $1.3 \%$ for sampling rates of 8 and 9.6 kHz , respectively (see the $(\sin x) / x$ Correction Section for more details).

## serial port

The serial port has four possible modes that are described in detail in the Functional Pin Description Section. These modes are briefly described below and in the Functional Description for Pin 13, WORD/ $\overline{\text { BYTE }}$.

1. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS320C17.
2. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS32020, TMS320C25, and the TMS320C30.
3. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS320C17.
4. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS32020, TMS320C25, TMS320C30, or two SN74299 serial-to-parallel shift registers, which can then interface in parallel to the TMS32010, TMS320C15, to any other digital signal processor, or to external FIFO circuitry.

## operation of TLC32044 with internal voltage reference

The internal reference of the TLC32044 eliminates the need for an external voltage reference and provides overall circuit cost reduction. Thus, the internal reference eases the design task and provides complete control over the performance of the IC. The internal reference is brought out to a pin and is available to the designer. To keep the amount of noise on the reference signal to a minimum, an external capacitor may be connected between REF and ANLG GND.

## operation of TLC32044 with external voltage reference

The REF pin may be driven from an external reference circuit if so desired. This external circuit must be capable of supplying $250 \mu \mathrm{~A}$ and must be adequately protected from noise such as crosstalk from the analog input.

## reset

A reset function is provided to initiate serial communications between the AIC and DSP and to allow fast, cost-effective testing during manufacturing. The reset function will initialize all AIC registers, including the control register. After a negative-going pulse on the $\overline{\operatorname{RESET}}$ pin, the AIC will be initialized. This initialization allows normal serial port communications activity to occur between AIC and DSP (see AIC DX Data Word Format section).

## TLC32044I, TLC32044C <br> VOICE-BAND ANALOG INTERFACE CIRCUITS

## PRINCIPLES OF OPERATION (continued)

## loopback

This feature allows the user to test the circuit remotely. In loopback, the OUT + and OUT - pins are internally connected to the $I N+$ and $I N$ - pins. Thus, the DAC bits ( d 15 to d 2 ), which are transmitted to the DX pin, can be compared with the ADC bits (d15 to d2), which are received from the DR pin. An ideal comparison would be that the bits on the DR pin equal the bits on the DX pin. However, in practice there will be some difference in these bits due to the ADC and DAC output offsets.

The loopback feature is implemented with digital signal processor control by transmitting the appropriate serial port bit to the control register (see AIC Data Word Format section).

| NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| ANLG GND | 17,18 |  | Analog ground return for all internal analog circuits. Not internally connected to DGTL GND. |
| AUX IN + | 24 | 1 | Noninverting auxiliary analog input stage. This input can be switched into the bandpass filter and A/D converter path via software control. If the appropriate bit in the Control register is a 1 , the auxiliary inputs will replace the $I N+$ and $I N$ - inputs. If the bit is a 0 , the $I N+$ and $I N$ - inputs will be used (see the AIC DX Data Word Format section). |
| AUX IN - | 23 | 1 | Inverting auxiliary analog input (see the above AUX IN + pin description). |
| DGTL GND | 9 |  | Digital ground for all internal logic circuits. Not internally connected to ANLG GND. |
| DR | 5 | 0 | This pin is used to transmit the ADC output bits from the AIC to the TMS320 serial port. This transmission of bits from the AIC to the TMS320 serial port is synchronized with the SHIFT CLK signal. |
| DX | 12 | 1 | This pin is used to receive the DAC input bits and timing and control information from the TMS320. This serial transmission from the TMS320 serial port to the AIC is synchronized with the SHIFT CLK signal. |
| $\overline{\text { EODR }}$ | 3 | 0 | (See the WORD/ $\overline{\text { BYTE }}$ pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of $A / D$ information have been transmitted from the AIC to the TMS320 serial port. This signal can be used to interrupt a microprocessor upon completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or external FIFO RAM, and to facilitate parallel data bus communications between the AIC and the serial-to-parallel shift registers. During the byte-mode timing, this signal goes low after the first byte has been transmitted from the AIC to the TMS320 serial port and is kept low until the second byte has been transmitted. The TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |

## TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS

| PIN NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| $\overline{\text { EODX }}$ | 11 | 0 | (See the WORD/ $\overline{B Y T E}$ pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of D/A converter and control or register information have been transmitted from the TMS320 serial port to the AIC. This signal can be used to interrupt a microprocessor upon the completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or an external FIFO RAM, and to facilitate parallel data-bus communications between the AIC and the serial-to-parallel shift registers. During the bytemode timing, this signal goes low after the first byte has been transmitted from the TMS 320 serial port to the AIC and is kept low until the second byte has been transmitted. The TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |
| $\overline{\mathrm{FSR}}$ | 4 | 0 | In the serial transmission modes, which are described in the WORD/ $\overline{\mathrm{BYTE}}$ pin description, the $\overline{\mathrm{FSR}}$ pin is held low during bit transmission. When the $\overline{F S R}$ pin goes low, the TMS320 serial port will begin receiving bits from the AIC via the DR pin of the AIC. The most significant DR bit will be present on the DR pin before $\overline{F S R}$ goes low. (See Serial Port Timing and Internal Timing Configuration Diagrams.) |
| $\overline{\text { FSX }}$ | 14 | 0 | When this pin goes low, the TMS320 serial port will begin transmitting bits to the AIC via the DX pin of the AIC. In all serial transmission modes, which are described in the WORD/ $\overline{B Y T E}$ pin description, the $\overline{\mathrm{FSX}}$ pin is held low during bit transmission (see Serial Port Timing and Internal Timing Configuration Diagrams). |
| IN + | 26 | 1 | Noninverting input to analog input amplifier stage |
| IN - | 25 | 1 | Inverting input to analog input amplifier stage |
| MSTR CLK | 6 | 1 | The Master Clock signal is used to derive all the key logic signals of the AIC, such as the Shift Clock, the switched-capacitor filter clocks, and the $A / D$ and $D / A$ timing signals. The Internal Timing Configuration diagram shows how these key signals are derived. The frequencies of these key signals are synchronous submultiples of the Master Clock frequency to eliminate unwanted aliasing when the sampled analog signals are transferred between the switched-capacitor filters and the A/D and D/A converters (see the Internal Timing Configuration). |
| OUT + | 22 | 0 | Noninverting output of analog output power amplifier. Can drive transformer hybrids or high-impedance loads directly in either a differential or a single-ended configuration. |
| OUT - | 21 | 0 | Inverting output of analog output power amplifier. Functionally identical with and complementary to OUT +. |
| REF | 8 | 1/0 | The internal voltage reference is brought out on this pin. An external voltage reference can also be applied to this pin. |
| $\overline{\text { RESET }}$ | 2 | 1 | A reset function is provided to initialize the TA, TA', TB, RA, RA', RB, and control registers. This reset function initiates serial communications between the AIC and DSP. The reset function will initialize all AIC registers including the control register. After a negative-going pulse on the RESET pin, the AIC registers will be initialized to provide an $8-\mathrm{kHz}$ data conversion rate for a $5.184-\mathrm{MHz}$ master clock input signal. The conversion rate adjust registers, TA' and RA', will be reset to 1 . The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section). $d 9=1, d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1$ <br> This initialization allows normal serial-port communication to occur between AIC and DSP. |
| SHIFT CLK | 10 | 0 | The Shift Clock signal is obtained by dividing the Master Clock signal frequency by four. This signal is used to clock the serial data transfers of the AIC, described in the WORD/ $\overline{B Y T E}$ pin description below (see the Serial Port Timing and Internal Timing Configuration diagram). |
| $\mathrm{V}_{\text {DD }}$ | 7 |  | Digital supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $\mathrm{V}_{\mathrm{CC}+}$ | 20 |  | Positive analog supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $\mathrm{V}_{\mathrm{CC}}$ - | 19 |  | Negative analog supply voltage -5V $\pm 5 \%$ |


| $$ | 1/0 | DESCRIPTION |
| :---: | :---: | :---: |
| WORD/ $\overline{\text { BYTE }} 13$ | 1 | This pin, in conjunction with a bit in the CONTROL register, is used to establish one of four serial modes. These four serial modes are described below. <br> AIC transmit and receive sections are operated asynchronously. <br> The following description applies when the AIC is configured to have asynchronous transmit and receive sections. If the appropriate data bit in the Control register is a 0 (see the AIC DX Data Word Format), the transmit and receive sections will be asynchronous. |

L Serial port directly interfaces with the serial port of the TMS320C17 and communicates in two 8 -bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams).

1. The $\overline{F S} \bar{X}$ or $\overline{F S R}$ pin is brought low.
2. One 8-bit byte is transmitted or one 8 -bit byte is received.
3. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought low.
4. The $\overline{F S X}$ or $\overline{F S R}$ pin emits a positive frame-sync pulse that is four Shift Clock cycles wide.
5. One 8-bit byte is transmitted or one 8-bit byte is received.
6. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought high.
7. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought high.

H Serial port directly interfaces with the serial ports of the TMS32020, TMS320C25, and TMS320C30, and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought low.
2. One 16 -bit word is transmitted or one 16 -bit word is received.
3. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin is brought high.
4. The $\overline{E O D X}$ or $\overline{E O D R}$ pin emits a low-going pulse.

AIC transmit and receive sections are operated synchronously.
If the appropriate data bit in the Control register is a 1 , the transmit and receive sections will be configured to be synchronous. In this case, the bandpass switched-capacitor filter and the A/D conversion timing will be derived from the TX Counter A, TX Counter B, and TA, TA', and TB registers, rather than the RX Counter $A, R X$ Counter B, and RA, RA', and RB registers. In this case, the AIC $\overline{F S X}$ and $\overline{\mathrm{FSR}}$ timing will be identical during primary data communication; however, $\overline{\mathrm{FSR}}$ will not be asserted during secondary data communication since there is no new A/D conversion result. The synchronous operation sequences are as follows (see Serial Port Timing diagrams).

L Serial port directly interfaces with the serial port of the TMS320C17 and communicates in two 8 -bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{F S X}$ and $\overline{\mathrm{FSR}}$ pins are brought low.
2. One 8-bit byte is transmitted and one 8-bit byte is received.
3. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought low.
4. The $\overline{\mathrm{FSX}}$ and $\overline{\mathrm{FSR}}$ pins emit positive frame-sync pulses that are four Shift Clock cycles wide.
5. One 8-bit byte is transmitted and one 8 -bit byte is received.
6. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought high.
7. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high.

H Serial port directly interfaces with the serial ports of the TMS32020, TMS320C25, and TMS320C30, and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{\mathrm{FSX}}$ and $\overline{\mathrm{FSF}}$ pins are brought low.
2. One 16 -bit word is transmitted and one 16 -bit word is received.
3. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high.
4. The $\overline{E O D X}$ or $\overline{E O D R}$ pins emit low-going pulses.

Since the transmit and receive sections of the AIC are now synchronous, the AIC serial port, with additional NOR and AND gates, will interface to two SN74299 serial-to-parallel shift registers. Interfacing the AIC to the SN74299 shift register allows the AIC to interface to an external FIFO RAM and facilitates parallel, data bus communications between the AIC and the digital signal processor. The operation sequence is the same as the above sequence (see Serial Port Timing diagrams).

## INTERNAL TIMING CONFIGURATION



NOTE: Frequency $1,20.736 \mathrm{MHz}$, is used to show how 153.6 kHz (for a commercially available modem split-band filter clock), popular speech and modem sampling signal frequencies, and an internal $288-\mathrm{kHz}$ switched-capacitor filter clock can be derived synchronously and as submultiples of the crystal oscillator frequency. Since these derived frequencies are synchronous submultiples of the crystal frequency, aliasing does not occur as the sampled analog signal passes between the analog converter and switched-capacitor filter stages. Frequency $2,41.472 \mathrm{MHz}$, is used to show that the AIC can work with high-frequency signals, which are used by highspeed digital signal processors.
${ }^{\dagger}$ Split-band filtering can alternatively be performed after the analog input function via software in the TMS320.
$\ddagger$ These control bits are described in the AIC DX Data Word Format section.

## explanation of internal timing configuration

All of the internal timing of the AIC is derived from the high-frequency clock signal that drives the Master Clock input pin. The Shift Clock signal, which strobes the serial port data between the AIC and DSP, is derived by dividing the Master Clock input signal frequency by four.
Low-pass:

SCF Clock Frequency
(D/A or A/D Path)

Conversion Frequency $=$

Master Clock Frequency
$2 \times$ Contents of Counter $A$
SCF Clock Frequency (D/A or A/D Path)
Contents of Counter B

High-pass:
SCF Clock Frequency (A/D Path)

A/D Conversion Frequency

Shift Clock Frequency $=$
$\frac{\text { Master Clock Frequency }}{4}$

TX Counter A and TX Counter B, which are driven by the Master Clock signal, determine the D/A conversion timing. Similarly, RX Counter A and RX Counter B determine the A/D conversion timing. In order for the low-pass switched-capacitor filter in the D/A path to meet its transfer function specifications, the frequency of its clock input must be 288 kHz . If the clock frequency is not 288 kHz , the filter transfer function frequencies are frequency-scaled by the ratios of the clock frequency to 288 kHz . Thus, to obtain the specified filter response, the combination of Master Clock frequency and TX Counter A and RX Counter A values must yield a $288-\mathrm{kHz}$ switched-capacitor clock signal. This $288-\mathrm{kHz}$ clock signal can then be divided by the TX Counter $B$ to establish the D/A conversion timing.
The transfer function of the bandpass switched-capacitor filter in the A/D path is a composite of its highpass and low-pass section transfer functions. The high-frequency roll-off of the low-pass section will meet the bandpass filter transfer function specification when the low-pass section SCF is 288 kHz . Otherwise, the high-frequency roll-off will be frequency-scaled by the ratio of the high-pass section's SCF clock to 288 kHz . The low-frequency roll-off of the high-pass section will meet the bandpass filter transfer function specification when the $A / D$ conversion rate is 8 kHz . Otherwise, the low-frequency roll-off of the highpass section will be frequency-scaled by the ratio of the $A / D$ conversion rate to 8 kHz .

TX Counter $A$ and TX Counter $B$ are reloaded every D/A conversion period, while RX Counter A and RX Counter $B$ are reloaded every $A / D$ conversion period. The TX Counter $B$ and RX Counter $B$ are loaded with the values in the TB and RB Registers, respectively. Via software control, the TX Counter A can be loaded with either the TA Register, the TA Register less the TA' Register, or the TA Register plus the TA' Register. By selecting the TA Register less the TA' Register option, the upcoming conversion timing will occur earlier by an amount of time that equals TA' times the signal period of the Master Clock. By selecting the TA Register plus the TA' Register option, the upcoming conversion timing will occur later by an amount of time that equals TA' times the signal period of the Master Clock. Thus, the D/A conversion timing can be advanced or retarded. An identical ability to alter the A/D conversion timing is provided. In this case, however, the RX Counter A can be programmed via software control with the RA Register, the RA Register less the RA' Register, or the RA Register plus the RA' Register.

The ability to advance or retard conversion timing is particularly useful for modem applications. This feature allows controlled changes in the $A / D$ and $D / A$ conversion timing. This feature can be used to enhance signal-to-noise performance, to perform frequency-tracking functions, and to generate nonstandard modem frequencies.

## TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS

If the transmit and receive sections are configured to be synchronous (see WORD/ $\overline{B Y T E}$ pin description), then both the low-pass and bandpass switched-capacitor filter clocks are derived from TX Counter A. Also, both the $D / A$ and $A / D$ conversion timing are derived from the TX Counter $A$ and TX Counter B. When the transmit and receive sections are configured to be synchronous, the RX Counter $A, R X$ Counter B, RA Register, RA' Register, and RB Registers are not used.

## AIC DR or DX word bit pattern

A/D or D/A MSB,


AIC DX data word format section


NOTE: Setting the two least significant bits to 1 in the normal transmission of DAC information (Primary Communications) to the AIC will initiate Secondary Communications upon completion of the Primary Communications.
Upon completion of the Primary Communication, $\overline{\text { FSX }}$ will remain high for four SHIFT CLOCK cycles and will then go low and initiate the Secondary Communication. The timing specifications for the Primary and Secondary Communications are identical. In this manner, the Secondary Communication, if initiated, is interleaved between successive Primary Communications. This interleaving prevents the Secondary Communication from interfering with the Primary Communications and DAC timing, thus preventing the AIC from skipping a DAC output. It is important to note that in the synchronous mode, $\overline{F S R}$ will not be asserted during Secondary Communications.

## secondary DX serial communication protocol



## reset function

A reset function is provided to initiate serial communications between the AIC and DSP. The reset function will initialize all AIC registers, including the control register. After power has been applied to the AIC, a negative-going pulse on the $\overline{\text { RESET }}$ pin will initialize the $A I C$ registers to provide an $8-k H z A / D$ and D/A conversion rate for a 5.184 MHz master clock input signal. The AIC, excepting the CONTROL register, will be initialized as follows (see AIC DX Data Word Format section):

| REGISTER | INITIALIZED <br> REGISTER <br> VALUE (HEX) |
| :---: | :---: |
| TA | 9 |
| TA | 1 |
| TB | 24 |
| RA | 9 |
| RA | 1 |
| RB | 24 |

The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section):

$$
d 9=1, d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1
$$

This initialization allows normal serial port communications to occur between AIC and DSP. If the transmit and receive sections are configured to operate synchronously and the user wishes to program different conversion rates, only the TA, TA', and TB register need to be programmed, since both transmit and receive timing are synchronously derived from these registers (see the Pin Descriptions and AIC DX Word Format sections).

The circuit shown below will provide a reset on power-up when power is applied in the sequence given under Power-Up Sequence. The circuit depends on the power supplies' reaching their recommended values a minimum of 800 ns before the capacitor charges to 0.8 V above DGTL GND.

> TLC32044


## power-up sequence

To ensure proper operation of the AIC, and as a safeguard against latch-up, it is recommmended that Schottky diodes with forward voltages less than or equal to 0.4 V be connected from $\mathrm{V}_{\mathrm{CC}}$ - to ANLG GND and from $V_{C C}$ - to DGTL GND (see Figure 21). In the absence of such diodes, power should be applied in the following sequence: ANLG GND and DGTL GND, $V_{C C}-$, then $V_{C C}+$ and $V_{D D}$. Also, no input signal should be applied until after power-up.

## AIC responses to improper conditions

The AIC has provisions for responding to improper conditions. These improper conditions and the response of the AIC to these conditions are presented in Table 1 below.

## AIC register constraints

The following constraints are placed on the contents of the AIC registers:

1. TA register must be $>1$.
2. TA' register can be either positive, negative, or zero.
3. RA register must be $>1$.
4. RA' register can be either positive, negative, or zero.
5. (TA register $\pm T A^{\prime}$ register) must be $>1$.
6. (RA register $\pm$ RA' register) must be $>1$.
7. TB register must be $>1$.

TABLE 1. AIC RESPONSES TO IMPROPER CONDITIONS

| IMPROPER CONDITION | AIC RESPONSE |
| :---: | :---: |
| $\begin{aligned} & \text { TA register }+ \text { TA' register }=0 \text { or } 1 \\ & \text { TA register }-\mathrm{TA}^{\prime} \text { register }=0 \text { or } 1 \end{aligned}$ | Reprogram TX Counter A with TA register value |
| TA register + TA' register $<0$ | MODULO 64 arithmetic is used to ensure that a positive value is loaded into the TX Counter $A$, i.e., TA register + TA' register +40 HEX is loaded into TX Counter A |
| $\begin{aligned} & \text { RA register }+ \text { RA' register }=0 \text { or } 1 \\ & \text { RA register }- \text { RA' register }=0 \text { or } 1 \end{aligned}$ | Reprogram RX Counter A with RA register value |
| RA register + RA' register $=0$ or 1 | MODULO 64 arithmetic is used to ensure that a positive value is loaded into RX Counter $A$, i.e., RA register + RA' register +40 HEX is loaded into RX Counter A |
| $\begin{aligned} & \text { TA register }=0 \text { or } 1 \\ & \text { RA register }=0 \text { or } 1 \end{aligned}$ | AIC is shut down |
| TB register $=0$ or 1 | Reprogram TB register with 24 HEX |
| RB register $=0$ or 1 | Reprogram RB register with 24 HEX |
| AIC and DSP cannot communicate | Hold last DAC output |

## improper operation due to conversion times being too close together

If the difference between two successive D/A conversion frame syncs is less that $1 / 19.2 \mathrm{kHz}$, the AIC operates improperly. In this situation, the second D/A conversion frame sync occurs too quickly and there is not enough time for the ongoing conversion to be completed. This situation can occur if the $A$ and $B$ registers are improperly programmed or if the $A+A^{\prime}$ register or $A-A^{\prime}$ register result is too small. When incrementally adjusting the conversion period via the $A+A^{\prime}$ register options, the designer should be very careful not to violate this requirement (see diagram below).


## TLC32044I, TLC32044C

VOICE-BAND ANALOG INTERFACE CIRCUITS

## asynchronous operation - more than one receive frame sync occurring between two transmit frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. The command to use the incremental conversion period adjust option is sent to the AIC during a $\overline{\mathrm{FSX}}$ frame sync. The ongoing conversion period is then adjusted. However, either Receive Conversion Period A or B may be adjusted. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. Therefore, if there is sufficient time between t 1 and t 2 , the receive conversion period adjustment will be performed during Receive Conversion Period A. Otherwise, the adjustment will be performed during Receive Conversion Period B. The adjustment command only adjusts one transmit conversion period and one receive conversion period. To adjust another pair of transmit and receive conversion periods, another command must be issued during a subsequent $\overline{\mathrm{FSX}}$ frame (see figure below).

asynchronous operation - more than one transmit frame sync occurring between two receive frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. The command to use the incremental conversion period adjust options is sent to the AIC during a $\overline{\mathrm{FSX}}$ frame sync. The ongoing transmit conversion period is then adjusted. However, three possibilities exist for the receive conversion period adjustment in the diagram as shown in the figure below. If the adjustment command is issued during Transmit Conversion Period A, Receive Conversion Period A will be adjusted if there is sufficient time between t1 and t 2 . Or, if there is not sufficient time between t 1 and t 2 , Receive Conversion Period B will be adjusted. Or, the receive portion of an adjustment command may be ignored if the adjustment command is sent during a receive conversion period, which is already being or will be adjusted due to a prior adjustment command. For example, if adjustment commands are issued during Transmit Conversion Periods A, B, and $C$, the first two commands may cause Receive Conversion Periods $A$ and $B$ to be adjusted, while the third receive adjustment command is ignored. The third adjustment command is ignored since it was issued during Receive Conversion Period B, which already will be adjusted via the Transmit Conversion Period B adjustment command.


## TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS

asynchronous operation - more than one set of primary and secondary DX serial communication occurring between two receive frame sync (see AIC DX Data Word Format section)

The TA, TA', TB, and control register information that is transmitted in the secondary communications is always accepted and is applied during the ongoing transmit conversion period. If there is sufficient time between $t 1$ and $t 2$, the TA, RA', and RB register information, which is sent during Transmit Conversion Period A, will be applied to Receive Conversion Period A. Otherwise, this information will be applied during Receive Conversion Period B. If RA, RA', and RB register information has already been received and is being applied during an ongoing conversion period, any subsequent RA, RA', or RB information that is received during this receive conversion period will be disregarded (see diagram below).


## test modes ${ }^{\dagger}$

The following paragraph provides information that allows the TLC32044 to be operated in special test modes. These test modes are used by Texas Instruments to facilitate testing of the device during manufacturing. They are not intended to be used in real applications, however, they allow the filters in the $A / D$ and $D / A$ paths to be used without using the $A / D$ and $D / A$ converters.

In normal operation, the nonusable (NU) pins are left unconnected. These NU pins are used by the factory to speed up testing of the TLC32044 Analog Interface Circuit (AIC). When the device is used in normal (non-test-mode) operation, the NU pin (pin 1) has an internal pull-down to -5 V . Externally connecting 0 V or 5 V to pin 1 puts the device in test-mode operation. Selecting one of the possible test modes is accomplished by placing a particular voltage on certain pins. A description of these modes is provided in Table 2 and Figures 1 and 2.

TABLE 2. LIST OF TEST MODES

| TEST PINS | D/A PATH TEST (PIN 1 to 5 V ) | A/D PATH TEST (PIN 1 to 0) |
| :---: | :---: | :---: |
|  | TEST FUNCTION | TEST FUNCTION |
| 5 | The low-pass switched-capacitor filter clock is brought out to pin 5 . This clock signal is normally internal. | The bandpass switched-capacitor filter clock is brought out to pin 5 . This clock signal is normally internal. |
| 11 | No change from normal operation. The EODX signal is brought out to pin 11. | The pulse that initiates the A/D conversion is brought out here. This signal is normally internal. |
| 3 | The pulse that initiates the D/A conversion is brought out here. | No change from normal operation. The EODR signal is brought out. |
| 27 and 28 | There are no test output signals provided on these pins. | The outputs of the A/D path low-pass or bandpass filter (depending upon control bit d2 - see AIC DX Data Word Format section) are brought out to these pins. If the high-pass section is inserted, the output will have a $(\sin x) / x$ droop. The slope of the droop will be determined by the ADC sampling frequency, which is the high-pass section clock frequency (see diagram of bandpass or low-pass filter test for receive section). These outputs will drive small ( $30-\mathrm{pF}$ ) loads. |
| 15 and 16 | D/A PATH LOW-PASS FILTER TEST; PIN 13 (WORD/BYTE) to -5 V |  |
|  | TEST FUNCTION |  |
|  | The inputs of the D/A path low-pass filter are brought out to pins 15 and 16 . The D/A input to this filter is removed. If the $(\sin x) / x$ correction filter is inserted, the OUT + and OUT - signals will have a flat response (see Figure 2). The common-mode range of these inputs must not exceed $\pm 0.5 \mathrm{~V}$. |  |

t In the test mode, the AIC responds to the setting of Pin 13 to -5 V , as if Pin 13 were set to 0 V . Thus, the byte mode is selected for communicating between DSP and AIC. Either of the path tests (D/A or A/D) can be performed simultaneously with the D/A low-pass filter test. In this situation, Pin 13 must be connected to -5 V , which initiates byte-mode communications.


FIGURE 1. BANDPASS OR LOW-PASS FILTER TEST FOR RECEIVER SECTION


FIGURE 2. LOW-PASS FILTER TEST FOR TRANSMIT SECTION

[^19]
## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ (see Note 1 ) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 15 V
Supply voltage, VDD . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to 15 V
Output voltage, $\mathrm{V}_{\mathrm{O}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 15 V
Input voltage, $\mathrm{V}_{\mathrm{I}}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 15 V
Digital ground voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to 15 V
Operating free-air temperature range: TLC320441 . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC32044C . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: N package . . . . . . . . . . $260^{\circ} \mathrm{C}$

NOTE 1: Voltage values for maximum ratings are with respect to $\mathrm{VCC}-$.
recommended operating conditions

| PARAMETER |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\text {CC }}+$ (see Note 2 ) |  | 4.75 | 5 | 5.25 | V |
| Supply voltage, VCC - (see Note 2) |  | -4.75 | -5 | -5.25 | V |
| Digital supply voltage, VDD (see Note 2) |  | 4.75 | 5 | 5.25 | V |
| Digital ground voltage with respect to ANLG GND, DGTL GND |  |  | 0 |  | V |
| Reference input voltage, $\mathrm{V}_{\text {reffext }}$ (see Note 2) |  | 2 |  | 4 | V |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$ |  | 2 |  | $V_{D D}+0.3$ | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ (see Note 3) |  | -0.3 |  | 0.8 | V |
| Load resistance at OUT + and/or OUT - , R $\mathrm{L}_{\text {L }}$ |  | 300 |  |  | $\Omega$ |
| Load capacitance at OUT + and/or OUT - , C $C_{L}$ |  |  |  | 100 | pF |
| MSTR CLK frequency (see Note 4) |  | 0.075 | 5 | 10.368 | MHz |
| Analog input amplifier common mode input voltage (see Note 5) |  |  |  | $\pm 1.5$ | V |
| A/D or D/A conversion rate |  |  |  | 19.2 | kHz |
| Conversion rate |  |  |  | 20 | kHz |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC320441 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC32044C | 0 |  | 70 |  |

NOTES: 2. Voltages at analog inputs and outputs, REF, $V_{C C}$, and $V_{C C-}$, are with respect to the ANLG GND terminal. Voltages at digital inputs and outputs and VDD are with respect to the DGTL GND terminal.
3. The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels and temperature only.
4. The bandpass switched-capacitor filter (SCF) specifications apply only when the low-pass section SCF clock is 288 kHz and the high-pass section SCF clock is 8 kHz . If the low-pass SCF clock is shifted from 288 kHz , the low-pass roll-off frequency will shift by the ratio of the low-pass SCF clock to 288 kHz . If the high-pass SCF clock is shifted from 8 kHz , the high-pass roll-off frequency will shift by the ratio of the high-pass SCF clock to 8 kHz . Similarly, the low-pass switched-capacitor filter (SCF) specifications apply only when the SCF clock is 288 kHz . If the SCF clock is shifted from 288 kHz , the low-pass roll-off frequency will shift by the ratio of the SCF clock to 288 kHz .
5. This range applies when ( $I N+-\mathbb{I}-$ ) or $(A \cup X I N+-A \cup X I N-)$ equals $\pm 6 \mathrm{~V}$.

TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, VCC- $=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
total device, MSTR CLK frequency $=5.184 \mathrm{MHz}$, outputs not loaded

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\text {¢ }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}} \mathrm{H}$ | High-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{I}^{\text {OH }}=-300 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ L | Low-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{l}^{\mathrm{OL}}=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| ${ }^{\text {I C C }}+$ Supply current from $\mathrm{V}_{\mathrm{CC}}+$ |  | TLC320441 |  |  |  | 40 | mA |
|  |  | TLC32044C |  |  |  | 35 |  |
| 'CC - Supply current from $\mathrm{V}_{\text {CC }}$ - |  | TLC320441 |  |  |  | -40 | mA |
|  |  | TLC32044C |  |  |  | -35 |  |
| IDD S | Supply current from $\mathrm{V}_{\text {DD }}$ |  | ${ }^{\text {f }}$ MSTR CLK $=5.184 \mathrm{MHz}$ |  |  | 7 | mA |
| $\mathrm{V}_{\text {ref }}$ Internal reference output voltage | Internal reference output voltage |  |  | 3 |  | 3.3 | V |
| $\alpha$ Vref ${ }^{\text {in }}$ | Temperature coefficient of internal reference voltage |  |  |  | 250 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| ro | Output resistance at REF |  |  |  | 100 |  | k $\Omega$ |

receive amplifier input

| PARAMETER | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| A/D converter offset error (filters in) |  | 10 | 70 | mV |
| CMRR <br> Common-mode rejection ratio at $\operatorname{IN}+, I N-$, or AUX IN + , AUX $\mathbb{I N}$ - | See Note 6 | 55 |  | dB |
| $\begin{array}{ll} \text { rI } & \text { Input resistance at } \mathbb{I N}+, \mathbb{N}- \\ \text { or } A \cup X \mathbb{N}+, A \cup X I N-, R E F \end{array}$ |  | 100 |  | k $\Omega$ |

transmit filter output

| PARAMETER | TEST CONDITIONS | MIN TYP $\dagger$ MAX | UNIT |  |
| :--- | :--- | :---: | :---: | :---: |
| $V_{\text {OO }}$ | Output offset voltage at OUT + or OUT - <br> (single-ended relative to ANLG GND) |  | 15 | 80 |
| $V_{\text {OM }}$ | Maximum peak output voltage swing across <br> $R_{L}$ at OUT + or OUT - (single-ended) | $R_{L} \geq 300 \Omega$, <br> Offset voltage $=0$ | $\pm 3$ | V |
| $V_{\text {OM }}$ | Maximum peak output voltage swing between <br> OUT + and OUT - (differential output) | $R_{\mathrm{L}} \geq 600 \Omega$ | $\pm 6$ | V |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTE 6: The test condition is a $0-\mathrm{dBm}, 1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate.

## TLC32044I, TLC32044C

VOICE-BAND ANALOG INTERFACE CIRCUITS
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{C}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
system distortion specifications, SCF clock frequency $=288 \mathrm{kHz}$

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Attenuation of second harmonic of A/D input signal | single-ended | $\mathrm{V}_{\mathrm{in}}=-0.1 \mathrm{~dB}$ to -24 dB referred to $\mathrm{V}_{\text {ref }}$, <br> See Note 7 | 70 |  |  | dB |
|  | differential |  | 62 | 70 |  |  |
| Attenuation of third and higher harmonics of $A / D$ input signal | single-ended | $V_{\text {in }}=-0.1 \mathrm{~dB}$ to -24 dB referred to $\mathrm{V}_{\text {ref }}$, <br> See Note 7 |  | 65 |  | dB |
|  | differential |  | 57 | 65 |  |  |
| Attenuation of second harmonic of D/A input signal | single-ended | $V_{\text {in }}=-0 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 70 |  | dB |
|  | differential |  | 62 | 70 |  |  |
| Attenuation of third and higher harmonics of $D / A$ input signal | single-ended | $V_{\text {in }}=-0 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 65 |  | B |
|  | differential |  | 57 | 65 |  |  |

## A/D channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS <br> (see Note 7) | $A_{v}=1^{\ddagger}$ |  | $A_{V}=2^{\ddagger}$ |  | $A_{V}=4^{\ddagger}$ |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | MAX | MIN | MAX | MIN | MAX |  |
| A/D channel signal-to-distortion ratio | $\mathrm{V}_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 58 |  | $>58{ }^{\text {§ }}$ |  | $>58{ }^{\text {§ }}$ |  | dB |
|  | $\mathrm{V}_{\text {in }}=-12 \mathrm{~dB}$ to -6 dB | 58 |  | 58 |  | $>58{ }^{\text {§ }}$ |  |  |
|  | $\mathrm{V}_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 56 |  | 58 |  | 58 |  |  |
|  | $\mathrm{V}_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 50 |  | 56 |  | 58 |  |  |
|  | $\mathrm{V}_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 44 |  | 50 |  | 56 |  |  |
|  | $\mathrm{V}_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 38 |  | 44 |  | 50 |  |  |
|  | $\mathrm{V}_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 32 |  | 38 |  | 44 |  |  |
|  | $\mathrm{V}_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 26 |  | 32 |  | 38 |  |  |
|  | $\mathrm{V}_{\text {in }}=-54 \mathrm{~dB}$ to -48 dB | 20 |  | 26 |  | 32 |  |  |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
$\ddagger A_{V}$ is the programmable gain of the input amplifier.
$\S$ A value $>60$ is over range and signal clipping occurs.
D/A channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS (see Note 7) | MIN MAX | UNIT |
| :---: | :---: | :---: | :---: |
| D/A channel signal-to-distortion ratio | $V_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 58 | dB |
|  | $V_{\text {in }}=-12 \mathrm{~dB}$ to -6 dB | 58 |  |
|  | $V_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 56 |  |
|  | $V_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 50 |  |
|  | $V_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 44 |  |
|  | $V_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 38 |  |
|  | $V_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 32 |  |
|  | $V_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 26 |  |
|  | $\mathrm{V}_{\mathrm{in}}=-54 \mathrm{~dB}-48 \mathrm{~dB}$ | 20 |  |

NOTE 7: The test condition is a $1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate ( 0 dB relative to $\mathrm{V}_{\text {ref }}$ ). The load impedance for the DAC is $600 \Omega$.
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{C}} \mathrm{C}+=5 \mathrm{~V}$, VCC $-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted) (Continued)
gain and dynamic range

| PARAMETER | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ MAX | UNIT |
| :--- | :---: | ---: | :---: |
| Absolute transmit gain tracking error while transmitting <br> into $600 \Omega$ | -48 dB to 0 dB signal range, <br> See Note 8 | $\pm 0.05 \pm 0.15$ | dB |
| Absolute receive gain tracking error | -48 dB to 0 dB signal range, <br> See Note 8 | $\pm 0.05 \pm 0.15$ | dB |

power supply rejection and crosstalk attenuation

| PARAMETER |  | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}+$ or $\mathrm{V}_{\mathrm{CC}}$ - supply voltage rejection ratio, receive channel | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at DR (ADC output) | 30 |  | dB |
|  | $\mathrm{f}=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| $\mathrm{V}_{\mathrm{CC}}+$ or $\mathrm{V}_{\mathrm{CC}}$ - supply voltage rejection ratio, transmit channel (single-ended) | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at OUT + | 30 |  | dB |
|  | $f=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| Crosstalk attenuation, transmit-to-receive (single-ended) |  |  | 80 |  | dB |

${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTE 8: Gain tracking is relative to the absolute gain at 1 kHz and $0 \mathrm{~dB}\left(0 \mathrm{~dB}\right.$ relative to $\mathrm{V}_{\text {ref }}$ ).

## TLC32044I, TLC32044C <br> VOICE-BAND ANALOG INTERFACE CIRCUITS

## delay distortion

bandpass filter transfer function, SCF $\mathrm{f}_{\text {clock }}=\mathbf{2 8 8} \mathbf{k H z}$, input ( $\mathrm{IN}+-\mathrm{IN}-$ ) is a $\pm \mathbf{~} \mathbf{- V}$ sinewave ${ }^{\dagger}$ (see Note 9)

| PARAMETER | TEST CONDITION | FREQUENCY RANGE | ADJUSTMENT ADDEND ${ }^{\ddagger}$ | MIN | TYP§ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Filter gain | Input signal reference is 0 dB | $\mathrm{f} \leq 50 \mathrm{~Hz}$ | $\mathrm{K1} \times 0 \mathrm{~dB}$ | -33 | -29 | -25 | dB |
|  |  | $\mathrm{f}=100 \mathrm{~Hz}$ | K1 $\times-0.26 \mathrm{~dB}$ | -4 | -2 | -1 |  |
|  |  | $f=150 \mathrm{~Hz}$ to 3100 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.25 | 0 | 0.25 |  |
|  |  | $f=3100 \mathrm{~Hz}$ to 3300 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.3 | 0 | 0.3 |  |
|  |  | $f=3300 \mathrm{~Hz}$ to 3650 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.5 | 0 | 0.5 |  |
|  |  | $f=3800 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.3 \mathrm{~dB}$ | -5 | -3 | -1 |  |
|  |  | $\mathrm{f}=4000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.7 \mathrm{~dB}$ | -20 | -17 | -16 |  |
|  |  | $\mathrm{f} \geq 4400 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 3.2 \mathrm{~dB}$ |  |  | -40 |  |
|  |  | $\mathrm{f} \geq 5000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ |  |  | -65 |  |

low-pass filter transfer function, SCF f clock $=\mathbf{2 8 8} \mathbf{~ k H z}$ (see Note 9)

| PARAMETER | TEST CONDITION | FREQUENCY RANGE | ADJUSTMENT ADDEND ${ }^{\ddagger}$ | MIN | TYP§ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Filter gain | Input signal reference is 0 dB | $f=0 \mathrm{~Hz}$ to 3100 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.25 | 0 | 0.25 | dB |
|  |  | $\mathrm{f}=3100 \mathrm{~Hz}$ to 3300 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.3 | 0 | 0.3 |  |
|  |  | $\mathrm{f}=3300 \mathrm{~Hz}$ to 3650 Hz | K1 $\times 0 \mathrm{~dB}$ | -0.5 | 0 | 0.5 |  |
|  |  | $\mathrm{f}=3800 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.3 \mathrm{~dB}$ | -5 | -3 | -1 |  |
|  |  | $\mathrm{f}=4000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.7 \mathrm{~dB}$ | -20 | $-17$ | -16 |  |
|  |  | $\mathrm{f} \geq 4400 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 3.2 \mathrm{~dB}$ |  |  | -40 |  |
|  |  | $\mathrm{f} \geq 5000 \mathrm{~Hz}$ | K1 $\times 0 \mathrm{~dB}$ |  |  | -65 |  |

## serial port

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\text {§ }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{I}^{\mathrm{OH}}=-300 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{l}_{\mathrm{OL}}=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| 1 | Input current |  |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  |  | 15 |  | pF |
| $\mathrm{C}_{0}$ | Output capacitance |  |  | 15 |  | pF |

${ }^{\dagger}$ See filter curves in typical characteristics.
$\ddagger$ The MIN, TYP, and MAX specifications are given for a $288-\mathrm{kHz}$ SCF clock frequency. A slight error in the $288-\mathrm{kHz}$ SCF may result from inaccuracies in the MSTR CLK frequency, resulting from crystal frequency tolerances. If this frequency error is less than $0.25 \%$, the ADJUSTMENT ADDEND should be added to the MIN, TYP, and MAX specifications, where K1 = $100 \cdot[(\mathrm{SCF}$ frequency $-288 \mathrm{kHz}) /$ 288 kHz ]. For errors greater than $0.25 \%$, see Note 10.
$\S$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
NOTES: 9. The filter gain outside of the passband is measured with respect to the gain at 1 kHz . The filter gain within the passband is measured with respect to the average gain within the passband. The passbands are 150 to 3600 Hz and 0 to 3600 Hz for the bandpass and low-pass filters respectively.
10. For switched-capacitor filter clocks at frequencies other than 288 kHz , the filter response is shifted by the ratio of switchedcapacitor filter clock frequency to 288 kHz .

TLC32044I, TLC32044C VOICE-BAND ANALOG INTERFACE CIRCUITS

> operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$
noise (measurement includes low-pass and bandpass switched-capacitor filters)

| PARAMETER |  | TEST CONDITIONS | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Transmit noise | with $(\sin x) / \mathrm{x}$ | DX input $=00000000000000$, constant input code |  | 550 | $\mu \mathrm{V}$ rms |
|  | without $(\sin x) / \mathrm{x}$ |  | 325 | 425 | $\mu \mathrm{V}$ rms |
|  |  |  | 18 |  | dBrncO |
| Receive noise (see Note 11) |  | Inputs grounded, gain $=1$ | 300 | 500 | $\mu \mathrm{V}$ rms |
|  |  | 18 |  | dBrncO |

## timing requirements

serial port recommended input signals

| PARAMETER |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{c}}$ (MCLK) | Master clock cycle time | 95 |  | ns |
| $\mathrm{tr}_{\mathbf{r} \text { (MCLK) }}$ | Master clock rise time |  | 10 | ns |
| $\mathrm{t}_{\mathrm{f}}(\mathrm{MCLK}$ ) | Master clock fall time |  | 10 | ns |
|  | Master clock duty cycle | 25\% | 75\% |  |
|  | RESET pulse duration (see Note 12) | 800 |  | ns |
| $t_{\text {su }}(\mathrm{DX})$ | DX setup time before SCLK $\downarrow$ | 20 |  | ns |
| th( $D X$ ) | DX hold time after SCLK $\downarrow$ | $\mathrm{t}_{\mathrm{c}(\mathrm{SCLK}) / 4}$ |  | ns |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 11. The noise is computed by statistically evaluating the digital output of the A/D converter.
12. $\overline{\text { RESET pulse duration is the amount of time that the reset pin is held below } 0.8 \mathrm{~V} \text { after the power supplies have reached }}$ their recommended values.
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{C}} \mathrm{C}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (continued)
serial port - AIC output signals

| PARAMETER |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| ${ }^{\text {t }}$ (SCLK) | Shift clock (SCLK) cycle time | 380 |  | ns |
| $t_{\text {f }}$ (SCLK) | Shift clock (SCLK) fall time |  | 50 | ns |
| $\mathrm{t}_{\text {r }}$ SCLK) | Shift clock (SCLK) rise time |  | 50 | ns |
|  | Shift clock (SCLK) duty cycle | 45 | 55 | \% |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FL})$ | Delay from SCLK $\uparrow$ to $\overline{\mathrm{FSR} / \mathrm{FSX}} \downarrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FH})$ | Delay from SCLK $\uparrow$ to $\overline{\mathrm{FSR} / \mathrm{FSX}} \uparrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{DR})$ | DR valid after SCLK $\uparrow$ |  | 90 | ns |
| $t_{\text {dw }}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\dagger$ to $\overline{E O D X} / \overline{\text { EODR }} \downarrow$ in word mode |  | 90 | ns |
| $\mathrm{t}_{\mathrm{dw}}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX } / \overline{E O D R} ~} \uparrow$ in word mode |  | 90 | ns |
| $\mathrm{t}_{\text {f(EODX) }}$ | $\overline{\text { EODX }}$ fall time |  | 15 | ns |
| $\mathrm{t}_{\mathrm{f} \text { (EODR) }}$ | $\overline{\text { EODR fall time }}$ |  | 15 | ns |
| $\mathrm{t}_{\mathrm{db}}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \downarrow$ in byte mode |  | 100 | ns |
| $\mathrm{t}_{\mathrm{db}}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \uparrow$ in byte mode |  | 100 | ns |

TABLE 2. GAIN CONTROL TABLE
(ANALOG INPUT SIGNAL REQUIRED FOR FULL-SCALE A/D CONVERSION)

| INPUT CONFIGURATIONS | CONTROL REGISTER BITS |  | ANALOG INPUT ${ }^{\dagger}$ | A/D CONVERSION RESULT |
| :---: | :---: | :---: | :---: | :---: |
|  | d6 | d7 |  |  |
| Differential configuration$\begin{aligned} \text { Analog input } & =\mathbb{I N +}+\mathbb{I N}- \\ & =A \cup X I N+-A \cup X I N- \end{aligned}$ | 1 | 1 | $\pm 6 \mathrm{~V}$ | full-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |
| Single-ended configuration$\begin{aligned} \text { Analog input } & =\mathrm{IN}+- \text { ANLG GND } \\ & =\text { AUX } \operatorname{IN}+- \text { ANLG GND } \end{aligned}$ | 1 | 1 | $\pm 3 \mathrm{~V}$ | half-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |

I In this example, $V_{\text {ref }}$ is assumed to be 3 V . In order to minimize distortion, it is recommended that the analog input not exceed 0.1 dB below full scale.


FIGURE 3. IN + AND IN - GAIN CONTROL CIRCUITRY

$R_{f b}=R$ for $d \sigma=1, d 7=1$
$d 6=0, d 7=0$
$R_{f b}=2 R$ for $d 6=1, d 7=0$
$R_{f b}=4 R$ for $d 6=0, d 7=1$
FIGURE 4. AUX IN + AND AUX IN GAIN CONTROL CIRCUITRY

## $(\sin x) / x$ correction section

If the designer does not wish to use the on-board second-order $(\sin x) / x$ correction filter, correction can be accomplished in digital signal processor (DSP) software. ( $\operatorname{Sin} x$ )/x correction can be accomplished easily and efficiently in digital signal processor (DSP) software. Excellent correction accuracy can be achieved to a band edge of 3000 Hz by using a first-order digital correction filter. The results, which are shown below, are typical of the numerical correction accuracy that can be achieved for sample rates of interest. The filter requires only seven instruction cycles per sample on the TMS320 DSPs. With a 200-ns instruction cycle, nine instructions per sample represents an overhead factor of $1.4 \%$ and $1.7 \%$ for sampling rates of 8000 Hz and 9600 Hz , respectively. This correction will add a slight amount of group delay at the upper edge of the $300-3000-\mathrm{Hz}$ band.
$(\sin x) / x$ roll-off for a zero-order hold function
The $(\sin x) / x$ roll-off for the AIC DAC zero-order hold function at a band-edge frequency of 3000 Hz for the various sampling rates is shown in the table below.

TABLE 3. $(\sin \mathbf{x}) / \mathbf{x}$ ROLL-OFF

| $\mathbf{f}_{\mathbf{S}}(\mathrm{Hz})$ | $20 \log \frac{\sin \pi \mathbf{f} / \mathbf{f}_{\mathbf{S}}}{\pi \mathbf{f} / \mathbf{f}_{\mathbf{s}}}$ <br> $(\mathbf{f}=\mathbf{3 0 0 0 ~ H z )}$ <br> $(\mathrm{dB})$ |
| ---: | :---: |
| 7200 | -2.64 |
| 8000 | -2.11 |
| 9600 | -1.44 |
| 14400 | -0.63 |
| 19200 | -0.35 |

Note that the actual AIC $(\sin x) / x$ roll-off will be slightly less than the above figures, because the AIC has less than a $100 \%$ duty cycle hold interval.

## correction filter

To compensate for the $(\sin x) / x$ roll-off of the AIC, a first-order correction filter shown below, is recommended.


The difference equation for this correction filter is:
$y_{i}+1=p 2(1-p 1)\left(u_{i}+1\right)+p 1 y_{i}$
where the constant p1 determines the pole locations.
The resulting squared magnitude transfer function is:

$$
|H(f)|^{2}=\frac{p 2^{2}(1-p 1)^{2}}{1-2 p 1 \cos \left(2 \pi f / f_{S}\right)+p 1^{2}}
$$

## correction results

Table 4 below shows the optimum p values and the corresponding correction results for $8000-\mathrm{Hz}$ and $9600-\mathrm{Hz}$ sampling rates.

TABLE 4

|  | ERROR (dB) <br> $\mathbf{f}(\mathbf{H z})$$\mathbf{f}_{\mathbf{S}}=\mathbf{8 0 0 0} \mathbf{~ H z}$ <br> $\mathbf{p} 1=-\mathbf{0 . 1 4 8 1 3}$ <br> $\mathbf{p 2}=0.9888$ | ERROR (dB) <br> $\mathbf{f}_{\mathbf{s}}=\mathbf{9 6 0 0} \mathbf{~ H z}$ <br> $\mathbf{p} 1=-\mathbf{0 . 1 3 0 7}$ <br> $\mathbf{p 2}=0.9951$ |
| :---: | :--- | :--- |
| 300 | -0.099 | -0.043 |
| 600 | -0.089 | -0.043 |
| 900 | -0.054 | 0 |
| 1200 | -0.002 | 0 |
| 1500 | 0.041 | 0 |
| 1800 | 0.079 | 0.043 |
| 2100 | 0.100 | 0.043 |
| 2400 | 0.091 | 0.043 |
| 2700 | -0.043 | 0 |
| 3000 | -0.102 | -0.043 |

## TMS320 software requirements

The digital correction filter equation can be written in state variable form as follows:

$$
Y=k 1 Y+k 2 U
$$

where $k 1$ equals $p 1$ (from the preceding page), $k 2$ equals ( $1-\mathrm{p} 1$ ) p2 (from the preceding page), Y is the filter state, and $U$ is the next I/O sample. The coefficients $k 1$ and $k 2$ must be represented as 16 -bit integers. The SACH instruction (with the proper shift) will yield the correct result. With the assumption that the TMS320 processor page pointer and memory configuration are properly initialized, the equation can be executed in seven instructions or seven cycles with the following program:

```
ZAC
LT K2
MPY U
LTA K1
MPY Y
APAC
SACH (dma), (shift)
```

byte-mode timing

word-mode timing


FIGURE 5. SERIAL PORT TIMING


FIGURE 6. TMS32010/TMS320C15-TLC32044 INTERFACE CIRCUIT
in instruction timing

out instruction timing


FIGURE 7. TMS32010/TMS320C15-TLC32044 INTERFACE TIMING

## TYPICAL CHARACTERISTICS



Normalized Frequency $-\mathrm{kHz} \times \frac{\text { SCF Clock Frequency }}{288 \mathrm{kHz}}$
FIGURE 8

AIC RECEIVE-CHANNEL BANDPASS FILTER


FIGURE 10

AIC TRANSMIT AND RECEIVE LOW-PASS FILTER


FIGURE 9
AIC RECEIVE-CHANNEL HIGH-PASS FILTER


Normalized Frequency-kHz $\times \frac{A / D \text { Conversion Rate }}{8 \mathrm{k} \text { samples } / \mathrm{s}}$
FIGURE 11

TYPICAL CHARACTERISTICS


FIGURE 12
(SIN X)/X CORRECTION FILTER


Normalized Frequency $-\mathrm{kHz} \times \frac{\text { SCF Clock Frequency }}{288 \mathrm{kHz}}$
FIGURE 14

AIC (SIN X)/X CORRECTION FILTER


Normalized Frequency $-\mathrm{kHz} \times \frac{\text { SCF Clock Frequency }}{288 \mathrm{kHz}}$
FIGURE 13
A/D SIGNAL-TO-DISTORTION RATIO VS
input signal


FIGURE 15

## TYPICAL CHARACTERISTICS

A/D GAIN TRACKING
(GAIN RELATIVE TO GAIN AT O dB INPUT SIGNAL)


FIGURE 16

D/A CONVERTER SIGNAL-TO-DISTORTION RATIO
INPUT SIGNAL LEVEL


FIGURE 17

## TYPICAL CHARACTERISTICS



FIGURE 18

A/D SECOND HARMONIC DISTORTION
VS
INPUT SIGNAL


FIGURE 19

D/A SECOND HARMONIC DISTORTION
vs
INPUT SIGNAL


FIGURE 20

## TYPICAL CHARACTERISTICS



FIGURE 21

D/A THIRD HARMONIC DISTORTION
vs
INPUT SIGNAL


FIGURE 22

## TLC32044I, TLC32044C

VOICE-BAND ANALOG INTERFACE CIRCUITS

TYPICAL APPLICATION INFORMATION

$\mathrm{C}=0.2 \mu \mathrm{~F}$, CERAMIC
FIGURE 23. AIC INTERFACE TO THE TMS32020/C25 SHOWING DECOUPLING CAPACITORS AND SCHOTTKY DIODE ${ }^{\dagger}$


FOR: $V_{C C}=12 \mathrm{~V}, \mathrm{R}=7200 \Omega$
$V_{C C}=10 \mathrm{~V}, \mathrm{R}=5600 \Omega$
$V_{C C}=5 \mathrm{~V}, \mathrm{R}=1600 \Omega$
FIGURE 24. EXTERNAL REFERENCE CIRCUIT FOR TLC32044
${ }^{\dagger}$ Thomson Serniconductors

- Advanced LinCMOS ${ }^{\text {™ }}$ Silicon-Gate Process Technology
- 14-Bit Dynamic Range ADC and DAC
- 16-Bit Dynamic Range Input with Programmable Gain
- Variable ADC and DAC Sampling Rate Up to 19,200 Samples per Second
- Switched-Capacitor Antialiasing Input Filter and Output-Reconstruction Filter
- Serial Port for Direct Interface to TMS320C17, TMS32020, TMS320C25, and TMS320C30 Digital Processors
- Synchronous or Asynchronous ADC and DAC Conversion Rates with Programmable Incremental ADC and DAC Conversion Timing Adjustments
- Serial Port Interface to SN74299 Serial-toParallel Shift Register for Parallel Interface to TMS32010, TMS320C15, or Other Digital Processors
- Internal Reference for Normal Operation and External Purposes, or Can Be Overridden by External Reference


## description

The TLC32045 is a complete analog-to-digital and digital-to-analog input/output system on a single monolithic CMOS chip. This device integrates a bandpass switched-capacitor antialiasing input filter, a 14-bit-resolution A/D converter, four microprocessor-compatible serial port modes, a 14-bit-resolution D/A converter, and a low-pass switched-capacitor outputreconstruction filter. The device offers numerous combinations of Master Clock input frequencies and conversion/sampling rates, which can be changed via digital processor control.

N PACKAGE
(TOP VIEW)


FN PACKAGE (TOP VIEW)


NU - Nonusable; no external connection should be made to these pins. See Table 2.

Typical applications for this IC include speech encryption for digital transmission, speech recognition/storage systems, speech synthesis, modems (7.2-, $8-, 9.6-14.4-$, and $19.2-\mathrm{kHz}$ sampling rate), analog interface for digital signal processors (DSPs), industrial process control, biomedical instrumentation, acoustical signal processing, spectral analysis, data acquisition, and instrumentation recorders. Four serial modes, which allow direct interface to the TMS320C17, TMS32020, TMS320C25, and TMS320C30 digital signal

## description (continued)

processors, are provided. Also, when the transmit and receive sections of the Analog Interface Circuit (AIC) are operating synchronously, it will interface to two SN74299 serial-to-parallel shift registers. These serial-to-parallel shift registers can then interface in parallel to the TMS32010, TMS320C15, other digital signal processors, or external FIFO circuitry. Output data pulses are emitted to inform the processor that data transmission is complete or to allow the DSP to differentiate between two transmitted bytes. A flexible control scheme is provided so that the functions of the IC can be selected and adjusted coincidentally with signal processing via software control.

The antialiasing input filter comprises eighth-order and fourth-order CC-type (Chebyshev/elliptic transitional) low-pass and high-pass filters, respectively. The input filter is implemented in switched-capacitor technology and is preceded by a continuous time filter to eliminate any possibility of aliasing caused by sampled data filtering. When only low-pass filtering is desired, the high-pass filter can be switched out of the signal path. A selectable, auxiliary, differential analog input is provided for applications where more than one analog input is required.

The A/D and D/A converters each have 14 bits of resolution with 9 bits of integral linearity specified over any 9 -bit range. The $A / D$ and $D / A$ architectures ensure no missing codes and monotonic operation. An internal voltage reference is provided to ease the design task and to provide complete control over the performance of the IC. The internal voltage reference is brought out to a pin and is available to the designer. Separate analog and digital voltage supplies and grounds are provided to minimize noise and ensure a wide dynamic range. Also, the analog circuit path contains only differential circuitry to keep noise to an absolute minimum. The only exception is the DAC sample-and-hold, which utilizes pseudo-differential circuitry.

The output-reconstruction filter is an eighth-order CC-type (Chebyshev/elliptic transitional low-pass filter) followed by a second-order $(\sin x) / x$ correction filter) and is implemented in switched-capacitor technology. This filter is followed by a continuous-time filter to eliminate images of the digitally encoded signal. The on-board $(\sin x) / x$ correction filter can be switched out of the signal path using digital signal processor control, if desired.

The TLC32045I is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$, and the TLC32045C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram



## PRINCIPLES OF OPERATION

## analog input

Two sets of analog inputs are provided. Normally, the IN + and IN - input set is used; however, the auxiliary input set, AUX IN + and AUX IN - , can be used if a second input is required. Each input set can be operated in either differential or single-ended modes, since sufficient common-mode range and rejection are provided. The gain for the $\mathbb{I N}+, \mathbb{I N}-, A \cup X I N+$, and $A U X I N-i n p u t s$ can be programmed to be either 1,2 , or 4 (see Table 2). Either input circuit can be selected via software control. It is important to note that a wide dynamic range is assured by the differential internal analog architecture and by the separate analog and digital voltage supplies and grounds.

## A/D bandpass filter, A/D bandpass filter clocking, and A/D conversion timing

The A/D high-pass filter can be selected or bypassed via software control. The frequency response of this filter is presented in the following pages. This response results when the switched-capacitor filter clock frequency is 288 kHz and the A/D sample rate is 8 kHz . Severa! possible options can be used to attain a $288-\mathrm{kHz}$ switched-capacitor filter clock. When the filter clock frequency is not 288 kHz , the low-pass filter transfer function is frequency-scaled by the ratio of the actual clock frequency to 288 kHz . The ripple bandwidth and 3-dB low-frequency roll-off points of the high-pass section are 150 and 100 Hz , respectively. However, the high-pass section low-frequency roll-off is frequency-scaled by the ratio of the A/D sample rate to 8 kHz .

The Internal Timing Configuration and AIC DX Data Word Format sections of this data sheet indicate the many options for attaining a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock. These sections indicate that the RX Counter A can be programmed to give a $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock for several Master Clock input frequencies.

## PRINCIPLES OF OPERATION (continued)

The A/D conversion rate is then attained by frequency-dividing the $288-\mathrm{kHz}$ bandpass switched-capacitor filter clock with the RX Counter B. Thus, unwanted aliasing is prevented because the A/D conversion rate is an integral submultiple of the bandpass switched-capacitor filter sampling rate, and the two rates are synchronously locked.

## A/D converter performance specifications

Fundamental performance specifications for the $A / D$ converter circuitry are presented in the $A / D$ converter operating characteristics section of this data sheet. The realization of the A/D converter circuitry with switched-capacitor techniques provides an inherent sample-and-hold.

## analog output

The analog output circuitry is an analog output power amplifier. Both noninverting and inverting amplifier outputs are brought out of the IC. This amplifier can drive transformer hybrids or low-impedance loads directly in either a differential or single-ended configuration.

## D/A low-pass filter, D/A low-pass filter clocking, and D/A conversion timing

The frequency response of this filter is presented in the following pages. This response results when the low-pass switched-capacitor filter clock frequency is 288 kHz . Like the $A / D$ filter, the transfer function of this filter is frequency-scaled when the clock frequency is not 288 kHz . A continuous-time filter is provided on the output of the $(\sin x) / x$ filter to eliminate the periodic sample data signal information, which occurs at multiples of the $288-\mathrm{kHz}$ switched-capacitor filter clock. The continuous time filter also greatly attenuates any switched-capacitor clock feedthrough.
The $\mathrm{D} / \mathrm{A}$ conversion rate is attained by frequency-dividing the $288-\mathrm{kHz}$ switched-capacitor filter clock with TX Counter $B$. Thus, unwanted aliasing is prevented because the D/A conversion rate is an integral submultiple of the switched-capacitor low-pass filter sampling rate, and the two rates are synchronously locked.

## asynchronous versus synchronous operation

If the transmit section of the AIC (low-pass filter and DAC) and receive section (bandpass filter and ADC) are operated asynchronously, the low-pass and bandpass filter clocks are independently generated from the Master Clock signal. Also, the D/A and A/D conversion rates are independently determined. If the transmit and receive sections are operated synchronously, the low-pass filter clock drives both low-pass and bandpass filters. In synchronous operation, the A/D conversion timing is derived from, and is equal to, the D/A conversion timing. (See description of the WORD/ $\overline{\text { BYTE }}$ pin in the Pin Functional Description Section.)

## D/A converter performance specifications

Fundamental performance specifications for the D/A converter circuitry are presented in the D/A converter operating characteristics section of the data sheet. The D/A converter has a sample-and-hold that is realized with a switched-capacitor ladder.

## system frequency response correction

$(\operatorname{Sin} x) / x$ correction for the D/A converter's zero-order sample-and-hold output can be provided by an onboard second-order $(\sin x) / x$ correction filter. This $(\sin x) / x$ correction filter can be inserted into or deleted from the signal path by digital signal processor control. When inserted, the $(\sin x) / x$ correction filter follows the switched-capacitor low-pass filter. When the TB register (see Internal Timing Configuration section) equals 36, the correction results of Figures 11 and 12 will be obtained.

## TLC32045I, TLC32045C VOICE-BAND ANALOG INTERFACE CIRCUITS

## PRINCIPLES OF OPERATION (continued)

( $\operatorname{Sin} x$ )/x correction can also be accomplished by deleting the on-board second-order correction filter and performing the $(\sin x) / x$ correction in digital signal processor software. The system frequency response can be corrected via DSP software to $\pm 0.1 \mathrm{~dB}$ accuracy to a band-edge of 3000 Hz for all sampling rates. This correction is accomplished with a first-order digital correction filter, which requires only seven TMS320 instruction cycles. With a 200-ns instruction cycle, seven instructions represent an overhead factor of only $1.1 \%$ and $1.3 \%$ for sampling rates of 8 and 9.6 kHz , respectively (see the $(\sin x) / x$ Correction Section for more details).

## serial port

The serial port has four possible modes that are described in detail in the Functional Pin Description Section. These modes are briefly described below and in the Functional Description for Pin 13, WORD/BYTE.

1. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS320C17.
2. The transmit and receive sections are operated asynchronously, and the serial port interfaces directly with the TMS32020, TMS320C25, and the TMS320C30.
3. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS320C17.
4. The transmit and receive sections are operated synchronously, and the serial port interfaces directly with the TMS32020, TMS320C25, TMS320C30, or two SN74299 serial-to-parallel shift registers, which can then interface in parallel to the TMS32010, TMS320C15, to any other digital signal processor, or to external FIFO circuitry.

## operation of TLC32045 with internal voltage reference

The internal reference of the TLC32045 eliminates the need for an external voltage reference and provides overall circuit cost reduction. Thus, the internal reference eases the design task and provides complete control over the performance of the IC. The internal reference is brought out to a pin and is available to the designer. To keep the amount of noise on the reference signal to a minimum, an external capacitor may be connected between REF and ANLG GND.

## operation of TLC32045 with external voltage reference

The REF pin may be driven from an external reference circuit if so desired. This external circuit must be capable of supplying $250 \mu \mathrm{~A}$ and must be adequately protected from noise such as crosstalk from the analog input.

## reset

A reset function is provided to initiate serial communications between the AIC and DSP and to allow fast, cost-effective testing during manufacturing. The reset function will initialize all AIC registers, including the control register. After a negative-going pulse on the $\overline{\operatorname{RESET}}$ pin, the AIC will be initialized. This initialization allows normal serial port communications activity to occur between AIC and DSP (see AIC DX Data Word Format section).

## PRINCIPLES OF OPERATION (Continued)

## loopback

This feature allows the user to test the circuit remotely. In loopback, the OUT + and OUT - pins are internally connected to the $I N+$ and $I N$ - pins. Thus, the DAC bits ( $d 15$ to $d 2$ ), which are transmitted to the DX pin, can be compared with the ADC bits (d15 to d2), which are received from the DR pin. An ideal comparison would be that the bits on the DR pin equal the bits on the DX pin. However, in practice there will be some difference in these bits due to the ADC and DAC output offsets.

The loopback feature is implemented with digital signal processor control by transmitting the appropriate serial port bit to the control register (see AIC Data Word Format section).

| NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| ANLG GND | 17,18 |  | Analog ground return for all internal analog circuits. Not internally connected to DGTL GND. |
| AUX $\operatorname{IN}+$ | 24 | 1 | Noninverting auxiliary analog input stage. This input can be switched into the bandpass filter and A/D converter path via software control. If the appropriate bit in the Control register is a 1 , the auxiliary inputs will replace the $I N+$ and $I N$ - inputs. If the bit is a 0 , the $I N+$ and $I N$ - inputs will be used (see the AIC DX Data Word Format section). |
| AUX IN - | 23 | 1 | Inverting auxiliary analog input (see the above AUX IN + pin description). |
| DGTL GND | 9 |  | Digital ground for all internal logic circuits. Not internally connected to ANLG GND. |
| DR | 5 | 0 | This pin is used to transmit the ADC output bits from the AIC to the TMS320 serial port. This transmission of bits from the AIC to the TMS320 serial port is synchronized with the SHIFT CLK signal. |
| DX | 12 | 1 | This pin is used to receive the DAC input bits and timing and control information from the TMS320. This serial transmission from the TMS320 serial port to the AIC is synchronized with the SHIFT CLK signal. |
| $\overline{\text { EODR }}$ | 3 | 0 | (See the WORD/BYTE pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of $A / D$ information have been transmitted from the AIC to the TMS320 serial port. This signal can be used to interrupt a microprocessor upon completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or external FIFO RAM, and to facilitate parallel data bus communications between the AIC and the serial-to-parallel shift registers. During the byte-mode timing, this signal goes low after the first byte has been transmitted from the AIC to the TMS320 serial port and is kept low until the second byte has been transmitted. The TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |

## TLC32045I, TLC32045C VOICE-BAND ANALOG INTERFACE CIRCUITS

| PIN <br> NAME | NO. | 1/0 | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| EODX | 11 | 0 | (See the WORD/ $\overline{\text { BYTE }}$ pin description and the Serial Port Timing Diagram.) During the word-mode timing, this signal is a low-going pulse that occurs immediately after the 16 bits of $D / A$ converter and control or register information have been transmitted from the TMS320 serial port to the AIC. This signal can be used to interrupt a microprocessor upon the completion of serial communications. Also, this signal can be used to strobe and enable external serial-to-parallel shift registers, latches, or an external FIFO RAM, and to facilitate parallel data-bus communications between the AIC and the serial-to-parallel shift registers. During the bytemode timing, this signal goes low after the first byte has been transmitted from the TMS320 serial port to the AIC and is kept low until the second byte has been transmitted. The TMS320C17 can use this low-going signal to differentiate between the two bytes as to which is first and which is second. |
| $\overline{\text { FSR }}$ | 4 | 0 | In the serial transmission modes, which are described in the WORD/ $\overline{B Y T E}$ pin description, the $\overline{F S R}$ pin is held low during bit transmission. When the $\overline{F S R}$ pin goes low, the TMS320 serial port will begin receiving bits from the AIC via the DR pin of the AIC. The most significant DR bit will be present on the DR pin before $\overline{\mathrm{FSR}}$ goes low. (See Serial Port Timing and Internal Timing Configuration Diagrams.) |
| $\overline{\text { FSX }}$ | 14 | 0 | When this pin goes low, the TMS320 serial port will begin transmitting bits to the AIC via the DX pin of the AIC. In all serial transmission modes, which are described in the WORD/ $\overline{B Y T E}$ pin description, the $\overline{\mathrm{FSX}}$ pin is held low during bit transmission (see Serial Port Timing and Internal Timing Configuration Diagrams). |
| IN + | 26 | 1 | Noninverting input to aralog input amplifier stage |
| IN - | 25 | 1 | Inverting input to analog input amplifier stage |
| MSTR CLK | 6 | 1 | The Master Clock signal is used to derive alt the key logic signals of the AIC, such as the Shift Clock, the switched-capacitor filter clocks, and the A/D and D/A timing signals. The Internal Timing Configuration diagram shows how these key signals are derived. The frequencies of these key signals are synchronous submultiples of the Master Clock frequency to eliminate unwanted aliasing when the sampled analog signals are transferred between the switched-capacitor filters and the A/D and D/A converters (see the Internal Timing Configuration). |
| OUT + | 22 | 0 | Noninverting output of analog output power amplifier. Can drive transformer hybrids or high-impedance loads directly in either a differential or a single-ended configuration. |
| OUT - | 21 | 0 | Inverting output of analog output power amplifier. Functionally identical with and complementary to OUT + . |
| REF | 8 | 1/0 | The internal voltage reference is brought out on this pin. An external voltage reference can also be applied to this pin. |
| RESET | 2 | 1 | A reset function is provided to initialize the TA, TA', TB, RA, RA', RB, and control registers. This reset function initiates serial communications between the AIC and DSP. The reset function will initialize all AIC registers including the control register. After a negative-going pulse on the $\overline{\operatorname{RESET}}$ pin, the AIC registers will be initialized to provide an $8-\mathrm{kHz}$ data conversion rate for a $5.184-\mathrm{MHz}$ master clock input signal. The conversion rate adjust registers, TA' and RA', will be reset to 1 . The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section). $d 9=1, d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1$ <br> This initialization allows normal serial-port communication to occur between AIC and DSP. |
| SHIFT CLK | 10 | 0 | The Shift Clock signal is obtained by dividing the Master Clock signal frequency by four. This signal is used to clock the serial data transfers of the AIC, described in the WORD/ $\overline{B Y T E}$ pin description below (see the Serial Port Timing and Internal Timing Configuration diagram). |
| $V_{\text {DD }}$ | 7 |  | Digital supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $V_{\text {CC }+}$ | 20 |  | Positive analog supply voltage, $5 \mathrm{~V} \pm 5 \%$ |
| $\mathrm{V}_{\mathrm{CC}}$ - | 19 |  | Negative analog supply voltage -5V $\pm 5 \%$ |


| PIN <br> NAME NO. |  | I/O | DESCRIPTION |
| :---: | :---: | :---: | :--- |
| WORD/BYTE 13 | 1 | This pin, in conjunction with a bit in the CONTROL register, is used to establish one of four serial <br> modes. These four serial modes are described below. <br> AIC transmit and receive sections are operated asynchronous/y. <br> The following description applies when the AIC is configured to have asynchronous transmit and receive sections. <br> If the appropriate data bit in the Control register is a 0 (see the AIC DX Data Word Format), the transmit and <br> receive sections will be asynchronous. |  |

$L$ Serial port directly interfaces with the serial port of the TMS320C17 and communicates in two 8 -bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams).

1. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin is brought low.
2. One 8 -bit byte is transmitted or one 8 -bit byte is received.
3. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought low.
4. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin emits a positive frame-sync pulse that is four Shift Clock cycles wide.
5. One 8 -bit byte is transmitted or one 8 -bit byte is received.
6. The $\overline{E O D X}$ or $\overline{E O D R}$ pin is brought high.
7. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought high.

H Serial port directly interfaces with the serial ports of the TMS32020, TMS320C25, and TMS320C30, and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{\mathrm{FSX}}$ or $\overline{\mathrm{FSR}}$ pin is brought low.
2. One 16-bit word is transmitted or one 16-bit word is received.
3. The $\overline{F S X}$ or $\overline{F S R}$ pin is brought high.
4. The $\overline{E O D X}$ or $\overline{E O D R}$ pin emits a low-going pulse.

AIC transmit and receive sections are operated synchronously.
If the appropriate data bit in the Control register is a 1 , the transmit and receive sections will be configured to be synchronous. In this case, the bandpass switched-capacitor filter and the A/D conversion timing will be derived from the TX Counter A, TX Counter B, and TA, TA', and TB registers, rather than the RX Counter $A, R X$ Counter B, and RA, RA', and RB registers. In this case, the AIC $\overline{F S X}$ and $\overline{F S R}$ timing will be identical during primary data communication; however, $\overline{F S R}$ will not be asserted during secondary data communication since there is no new A/D conversion result. The synchronous operation sequences are as follows (see Serial Port Timing diagrams).

L Serial port directly interfaces with the serial port of the TMS320C17 and communicates in two 8 -bit bytes. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought low.
2. One 8-bit byte is transmitted and one 8-bit byte is received.
3. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought low.
4. The $\overline{\mathrm{FSX}}$ and $\overline{\mathrm{FSR}}$ pins emit positive frame-sync pulses that are four Shift Clock cycles wide.
5. One 8-bit byte is transmitted and one 8-bit byte is received.
6. The $\overline{E O D X}$ and $\overline{E O D R}$ pins are brought high.
7. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high.

H Serial port directly interfaces with the serial ports of the TMS32020, TMS320C25, and TMS320C30, and communicates in one 16 -bit word. The operation sequence is as follows (see Serial Port Timing diagrams):

1. The $\overline{F S X}$ and $\overline{\operatorname{FSR}}$ pins are brought low.
2. One 16 -bit word is transmitted and one 16 -bit word is received.
3. The $\overline{F S X}$ and $\overline{F S R}$ pins are brought high.
4. The $\overline{E O D X}$ or $\overline{E O D R}$ pins emit low-going pulses.

Since the transmit and receive sections of the AIC are now synchronous, the AIC serial port, with additional NOR and AND gates, will interface to two SN74299 serial-to-parallel shift registers. Interfacing the AIC to the SN74299 shift register allows the AIC to interface to an external FIFO RAM and facilitates parallel, data bus communications between the AIC and the digital signal processor. The operation sequence is the same as the above sequence (see Serial Port Timing diagrams).

## INTERNAL TIMING CONFIGURATION



NOTE: Frequency $1,20.736 \mathrm{MHz}$, is used to show how 153.6 kHz (for a commercially available modem split-band filter clock), popular speech and modem sampling signal frequencies, and an internal $288-\mathrm{kHz}$ switched-capacitor filter clock can be derived synchronously and as submultiples of the crystal oscillator frequency. Since these derived frequencies are synchronous submultiples of the crystal frequency, aliasing does not occur as the sampled analog signal passes between the analog converter and switched-capacitor filter stages. Frequency $2,41.472 \mathrm{MHz}$, is used to show that the AIC can work with high-frequency signals, which are used by highspeed digital signal processors.
${ }^{\dagger}$ Split-band filtering can alternatively be performed after the analog input function via software in the TMS320.
${ }^{\ddagger}$ These control bits are described in the AIC DX Data Word Format section.
explanation of internal timing configuration
All of the internal timing of the AIC is derived from the high-frequency clock signal that drives the Master Clock input pin. The Shift Clock signal, which strobes the serial port data between the AIC and DSP, is derived by dividing the Master Clock input signal frequency by four.
Low-pass:

| SCF Clock Frequency <br> (D/A or A/D Path) | $\frac{\text { Master Clock Frequency }}{2 \times \text { Contents of Counter } A}$ |
| :--- | :---: |
| Conversion Frequency $=$ | $\frac{\text { SCF Clock Frequency (D/A or A/D Path) }}{\text { Contents of Counter B }}$ |

High-pass:

SCF Clock Frequency
(A/D Path)
Shift Clock Frequency $=$

A/D Conversion Frequency
$\frac{\text { Master Clock Frequency }}{4}$

TX Counter A and TX Counter B, which are driven by the Master Clock signal, determine the D/A conversion timing. Similarly, RX Counter A and RX Counter B determine the A/D conversion timing. In order for the low-pass switched-capacitor filter in the D/A path to meet its transfer function specifications, the frequency of its clock input must be 288 kHz . If the clock frequency is not 288 kHz , the filter transfer function frequencies are frequency-scaled by the ratios of the clock frequency to 288 kHz . Thus, to obtain the specified filter response, the combination of Master Clock frequency and TX Counter A and RX Counter A values must yield a $288-\mathrm{kHz}$ switched-capacitor clock signal. This $288-\mathrm{kHz}$ clock signal can then be divided by the TX Counter $B$ to establish the D/A conversion timing.
The transfer function of the bandpass switched-capacitor filter in the A/D path is a composite of its highpass and low-pass section transfer functions. The high-frequency roll-off of the low-pass section will meet the bandpass filter transfer function specification when the low-pass section SCF is 288 kHz . Otherwise, the high-frequency roll-off will be frequency-scaled by the ratio of the high-pass section's SCF clock to 288 kHz . The low-frequency roll-off of the high-pass section will meet the bandpass filter transfer function specification when the A/D conversion rate is 8 kHz . Otherwise, the low-frequency roll-off of the highpass section will be frequency-scaled by the ratio of the $A / D$ conversion rate to 8 kHz .
TX Counter $A$ and TX Counter $B$ are reloaded every D/A conversion period, while RX Counter $A$ and RX Counter $B$ are reloaded every $A / D$ conversion period. The TX Counter $B$ and $R X$ Counter $B$ are loaded with the values in the TB and RB Registers, respectively. Via software control, the TX Counter A can be loaded with either the TA Register, the TA Register less the TA' Register, or the TA Register plus the TA' Register. By selecting the TA Register less the TA' Register option, the upcoming conversion timing will occur earlier by an amount of time that equals TA' times the signal period of the Master Clock. By selecting the TA Register plus the TA' Register option, the upcoming conversion timing will occur later by an amount of time that equals TA' times the signal period of the Master Clock. Thus, the D/A conversion timing can be advanced or retarded. An identical ability to alter the A/D conversion timing is provided. In this case, however, the RX Counter A can be programmed via software control with the RA Register, the RA Register less the RA' Register, or the RA Register plus the RA' Register.
The ability to advance or retard conversion timing is particularly useful for modem applications. This feature allows controlled changes in the $A / D$ and $D / A$ conversion timing. This feature can be used to enhance signal-to-noise performance, to perform frequency-tracking functions, and to generate nonstandard modem frequencies.

If the transmit and receive sections are configured to be synchronous (see WORD/ $\overline{B Y T E}$ pin description), then both the low-pass and bandpass switched-capacitor filter clocks are derived from TX Counter A. Also, both the D/A and A/D conversion timing are derived from the TX Counter $A$ and TX Counter B. When the transmit and receive sections are configured to be synchronous, the RX Counter A, RX Counter B, RA Register, RA' Register, and RB Registers are not used.

## AIC DR or DX word bit pattern

A/D or D/A MSB,
1st bit sent

| D 15 | D14 | 1st bit sent of 2nd byte | A/D or D/A LSB |  |  |  |  |  |  |  |  |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

AIC DX data word format section


NOTE: Setting the two least significant bits to 1 in the normal transmission of DAC information (Primary Communications) to the AIC will initiate Secondary Communications upon completion of the Primary Communications.

Upon completion of the Primary Communication, $\overline{\mathrm{FSX}}$ will remain high for four SHIFT CLOCK cycles and will then go low and initiate the Secondary Communication. The timing specifications for the Primary and Secondary Communications are identical. In this manner, the Secondary Communication, if initiated, is interleaved between successive Primary Communications. This interleaving prevents the Secondary Communication from interfering with the Primary Communications and DAC timing, thus preventing the AIC from skipping a DAC output. It is important to note that in the synchronous mode, $\overline{\mathrm{FSR}}$ will not be asserted during Secondary Communications.

## secondary DX serial communication protocol



## reset function

A reset function is provided to initiate serial communications between the AIC and DSP. The reset function will initialize all AIC registers, including the control register. After power has been applied to the AIC, a negative-going pulse on the $\overline{\operatorname{RESET}}$ pin will initialize the AIC registers to provide an $8-\mathrm{kHz} \mathrm{A} / \mathrm{D}$ and $\mathrm{D} / \mathrm{A}$ conversion rate for a 5.184 MHz master clock input signal. The AIC, excepting the CONTROL register, will be initialized as follows (see AIC DX Data Word Format section):

| REGISTER | INITIALIZED <br> REGISTER <br> VALUE (HEX) |
| :--- | :---: |
| TA |  |
| TA' | 9 |
| TB | 24 |
| RA | 9 |
| RA | 1 |
| RB | 24 |

The CONTROL register bits will be reset as follows (see AIC DX Data Word Format section):

$$
d 9=1, d 7=1, d 6=1, d 5=1, d 4=0, d 3=0, d 2=1
$$

This initialization allows normal serial port communications to occur between AIC and DSP. If the transmit and receive sections are configured to operate synchronously and the user wishes to program different conversion rates, only the TA, TA', and TB register need to be programmed, since both transmit and receive timing are synchronously derived from these registers (see the Pin Descriptions and AIC DX Word Format sections).

The circuit shown below will provide a reset on power-up when power is applied in the sequence given under Power-Up Sequence. The circuit depends on the power supplies' reaching their recommended values a minimum of 800 ns before the capacitor charges to 0.8 V above DGTL GND.

TLC32045


## power-up sequence

To ensure proper operation of the AIC, and as a safeguard against latch-up, it is recommmended that Schottky diodes with forward voltages less than or equal to 0.4 V be connected from VCC - to ANLG GND and from VCC - to DGTL GND (see Figure 21). In the absence of such diodes, power should be applied in the following sequence: ANLG GND and DGTL GND, VCC - , then VCC + and VDD. Also, no input signal should be applied until after power-up.

## AIC responses to improper conditions

The AIC has provisions for responding to improper conditions. These improper conditions and the response of the AIC to these conditions are presented in Table 1 below.

## AIC register constraints

The following constraints are placed on the contents of the AIC registers:

1. TA register must be $>1$.
2. TA' register can be either positive, negative, or zero.
3. RA register must be $>1$.
4. RA' register can be either positive, negative, or zero.
5. (TA register $\pm$ TA' register) must be $>1$.
6. (RA register $\pm$ RA' register) must be $>1$.
7. TB register must be $>1$.

TABLE 1. AIC RESPONSES TO IMPROPER CONDITIONS

| IMPROPER CONDITION | AIC RESPONSE |
| :---: | :---: |
| $\begin{aligned} & \text { TA register }+ \text { TA' register }=0 \text { or } 1 \\ & \text { TA register }- \text { TA' register }=0 \text { or } 1 \end{aligned}$ | Reprogram TX Counter A with TA register value |
| TA register + TA' register $<0$ | MODULO 64 arithmetic is used to ensure that a positive value is loaded into the TX Counter $A$, i.e., TA register + TA' register +40 HEX is loaded into TX Counter A |
| $\begin{aligned} & \text { RA register }+ \text { RA' register }=0 \text { or } 1 \\ & \text { RA register }-R A^{\prime} \text { register }=0 \text { or } 1 \end{aligned}$ | Reprogram RX Counter A with RA register value |
| RA register + RA' register $=0$ or 1 | MODULO 64 arithmetic is used to ensure that a positive value is loaded into RX Counter $A$, i.e., RA register + RA' register +40 HEX is loaded into RX Counter A |
| $\begin{aligned} & \text { TA register }=0 \text { or } 1 \\ & \text { RA register }=0 \text { or } 1 \end{aligned}$ | AIC is shut down |
| TB register $=0$ or 1 | Reprogram TB register with 24 HEX |
| RB register $=0$ or 1 | Reprogram RB register with 24 HEX |
| AIC and DSP cannot communicate | Hold last DAC output |

## improper operation due to conversion times being too close together

If the difference between two successive D/A conversion frame syncs is less that $1 / 19.2 \mathrm{kHz}$, the AIC operates improperly. In this situation, the second D/A conversion frame sync occurs too quickly and there is not enough time for the ongoing conversion to be completed. This situation can occur if the A and B registers are improperly programmed or if the $A+A^{\prime}$ register or $A-A^{\prime}$ register result is too small. When incrementally adjusting the conversion period via the $A+A^{\prime}$ register options, the designer should be very careful not to violate this requirement (see diagram below).


## TLC32045I, TLC32045C <br> VOICE-BAND ANALOG INTERFACE CIRCUITS

asynchronous operation - more than one receive frame sync occurring between two transmit frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. The command to use the incremental conversion period adjust option is sent to the AIC during a $\overline{\mathrm{FSX}}$ frame sync. The ongoing conversion period is then adjusted. However, either Receive Conversion Period A or B may be adjusted. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. Therefore, if there is sufficient time between t 1 and t 2 , the receive conversion period adjustment will be performed during Receive Conversion Period A. Otherwise, the adjustment will be performed during Receive Conversion Period B. The adjustment command only adjusts one transmit conversion period and one receive conversion period. To adjust another pair of transmit and receive conversion periods, another command must be issued during a subsequent $\overline{\mathrm{FSX}}$ frame (see figure below).

asynchronous operation - more than one transmit frame sync occurring between two receive frame syncs

When incrementally adjusting the conversion period via the $A+A^{\prime}$ or $A-A^{\prime}$ register options, a specific protocol is followed. For both transmit and receive conversion periods, the incremental conversion period adjustment is performed near the end of the conversion period. The command to use the incremental conversion period adjust options is sent to the AIC during a $\overline{\text { FSX }}$ frame sync. The ongoing transmit conversion period is then adjusted. However, three possibilities exist for the receive conversion period adjustment in the diagram as shown in the figure below. If the adjustment command is issued during Transmit Conversion Period A, Receive Conversion Period A will be adjusted if there is sufficient time between t 1 and t 2 . Or, if there is not sufficient time between t 1 and t 2 , Receive Conversion Period B will be adjusted. Or, the receive portion of an adjustment command may be ignored if the adjustment command is sent during a receive conversion period, which is already being or will be adjusted due to a prior adjustment command. For example, if adjustment commands are issued during Transmit Conversion Periods A, B, and C, the first two commands may cause Receive Conversion Periods $A$ and $B$ to be adjusted, while the third receive adjustment command is ignored. The third adjustment command is ignored since it was issued during Receive Conversion Period B, which already will be adjusted via the Transmit Conversion Period B adjustment command.

asynchronous operation - more than one set of primary and secondary DX serial communication occurring between two receive frame sync (see AIC DX Data Word Format section)

The TA, TA', TB, and control register information that is transmitted in the secondary communications is always accepted and is applied during the ongoing transmit conversion period. If there is sufficient time between $t 1$ and $t 2$, the TA, RA', and RB register information, which is sent during Transmit Conversion Period A, will be applied to Receive Conversion Period A. Otherwise, this information will be applied during Receive Conversion Period B. If RA, RA', and RB register information has already been received and is being applied during an ongoing conversion period, any subsequent RA, RA', or RB information that is received during this receive conversion period will be disregarded (see diagram below).


## test modes ${ }^{\dagger}$

The following paragraph provides information that allows the TLC32045 to be operated in special test modes. These test modes are used by Texas Instruments to facilitate testing of the device during manufacturing. They are not intended to be used in real applications, however, they allow the filters in the $A / D$ and $D / A$ paths to be used without using the $A / D$ and $D / A$ converters.

In normal operation, the nonusable (NU) pins are left unconnected. These NU pins are used by the factory to speed up testing of the TLC32045 Analog Interface Circuit (AIC). When the device is used in normal (non-test mode) operation, the NU pin (pin 1) has an internal pull-down to -5 V . Externally connecting 0 V or 5 V to pin 1 puts the device in test-mode operation. Selecting one of the possible test or NU modes is accomplished by placing a particular voltage on certain pins. A description of these modes is provided in Table 2 and Figures 1 and 2.

TABLE 2. LIST OF TEST MODES

| TEST PINS | D/A PATH TEST (PIN 1 to 5 V ) | A/D PATH TEST (PIN 1 to 0) |
| :---: | :---: | :---: |
|  | TEST FUNCTION | TEST FUNCTION |
| 5 | The low-pass switched-capacitor filter clock is brought out to pin 5 . This clock signal is normally internal. | The bandpass switched-capacitor filter clock is brought out to pin 5 . This clock signal is normally internal. |
| 11 | No change from normal operation. The $\overline{E O D X}$ signal is brought out to pin 11. | The pulse that initiates the A/D conversion is brought out here. This signal is normally internal. |
| 3 | The pulse that initiates the D/A conversion is brought out here. | No change from normal operation. The EODR signal is brought out. |
| 27 and 28 | There are no test output signals provided on these pins. | The outputs of the A/D path low-pass or bandpass filter (depending upon control bit d2 - see AIC DX Data Word Format section) are brought out to these pins. If the high-pass section is inserted, the output will have a $(\sin x) / x$ droop. The slope of the droop will be determined by the ADC sampling frequency, which is the high-pass section clock frequency (see diagram of bandpass or low-pass filter test for receive section). These outputs will drive small (30-pF) loads. |
| 15 and 16 | D/A PATH LOW-PASS FILTER TEST; PIN 13 (WORD/BYTE) to -5 V |  |
|  | TEST FUNCTION |  |
|  | The inputs of the D/A path low-pass filter are brought out to pins 15 and 16. The D/A input to this filter is removed. If the $(\sin x) / x$ correction filter is inserted, the OUT + and OUT - signals will have a flat response (see Figure 2 ). The common-mode range of these inputs must not exceed $\pm 0.5 \mathrm{~V}$. |  |

$\dagger$ In the test mode, the AIC responds to the setting of Pin 13 to -5 V , as if Pin 13 were set to 0 V . Thus, the byte mode is selected for communicating between DSP and AIC. Either of the path tests (D/A or A/D) can be performed simultaneously with the D/A low-pass filter test. In this situation, Pin 13 must be connected to -5 V , which initiates byte-mode communications.


FIGURE 1. BANDPASS OR LOW-PASS FILTER TEST FOR RECEIVER SECTION


FIGURE 2. LOW-PASS FILTER TEST FOR TRANSMIT SECTION

[^20]
# absolute maximum ratings over operating free-air temperature range (unless otherwise noted) 

```
Supply voltage, VCC + (see Note 1)
                                -0.3V to 15V
    Supply voltage, VDD . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to 15 V
    Output voltage, \mp@subsup{V}{O}{}
    -0.3V to 15V
    Input voltage, V।
    -0.3V to 15V
    Digital ground voltage . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to 15 V
    Operating free-air temperature range: TLC320451 . . . . . . . . . . . . . . . . . . . . - 40 % C to 85 % C
    TLC32045C . . . . . . . . . . . . . . . . . . . . . . . 0 0
    Storage temperature range
    -40}\mp@subsup{}{}{\circ}\textrm{C}\mathrm{ to }12\mp@subsup{5}{}{\circ}\textrm{C
    Case temperature for 10 seconds: FN package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 260 % C
    Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: N package . . . . . . . . . 260 % C
```

NOTE 1: Voltage values for maximum ratings are with respect to VCC - .
recommended operating conditions

| PARAMETER |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}+$ (see Note 2) |  | 4.75 | 5 | 5.25 | V |
| Supply voltage, $\mathrm{V}_{\text {CC }}$ - (see Note 2) |  | -4.75 | -5 | -5.25 | V |
| Digital supply voltage, VDD (see Note 2) |  | 4.75 | 5 | 5.25 | V |
| Digital ground voitage with respect to ANLG GND, DGTL GND |  |  | 0 |  | V |
| Reference input voltage, $\mathrm{V}_{\text {reffext }}$ (see Note 2) |  | 2 |  | 4 | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ |  | 2 |  | $V_{D D}+0.3$ | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ (see Note 3) |  | -0.3 |  | 0.8 | V |
| Load resistance at OUT + and/or OUT - , R $\mathrm{L}_{\mathrm{L}}$ |  | 300 |  |  | $\Omega$ |
| Load capacitance at OUT + and/or OUT -, C $\mathrm{C}_{L}$ |  |  |  | 100 | pF |
| MSTR CLK frequency (see Note 4) |  | 0.075 | 5 | 10.368 | MHz |
| Analog input amplifier common mode input voltage (see Note 5) |  |  |  | $\pm 1.5$ | V |
| A/D or D/A conversion rate |  |  |  | 19.2 | kHz |
| Conversion rate |  | 1 |  | 20 | kHz |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC320451 | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC32045C | 0 |  | 70 |  |

NOTES: 2. Voltages at analog inputs and outputs, REF, $\mathrm{V}_{\mathrm{CC}}{ }_{+}$, and $\mathrm{V}_{\mathrm{CC}}{ }_{-}$, are with respect to the ANLG GND terminal. Voltages at digital inputs and outputs and $V_{D D}$ are with respect to the DGTL GND terminal.
3. The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels and temperature only.
4. The bandpass switched-capacitor filter (SCF) specifications apply only when the low-pass section SCF clock is 288 kHz and the high-pass section SCF clock is 8 kHz . If the low-pass SCF clock is shifted from 288 kHz , the low-pass roll-off frequency will shift by the ratio of the low-pass SCF clock to 288 kHz . If the high-pass SCF clock is shifted from 8 kHz , the high-pass roll-off frequency will shift by the ratio of the high-pass SCF clock to 8 kHz . Similarly, the low-pass switched-capacitor filter (SCF) specifications apply only when the SCF clock is 288 kHz . If the SCF clock is shifted from 288 kHz , the low-pass roll-off frequency will shift by the ratio of the SCF clock to 288 kHz .
5. This range applies when ( $I N+-I N-$ ) or ( $A \cup X I N+-A \cup X I N-)$ equals $\pm 6 \mathrm{~V}$.

TLC32045I, TLC32045C vOICE-BAND ANALOG INTERFACE CIRCUITS
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
total device, MSTR CLK frequency $=5.184 \mathrm{MHz}$, outputs not loaded

| PARAMETER |  |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{I}^{\mathrm{OH}}=-300 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{VOL}^{\text {O }}$ | Low-level output voltage |  | $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}, \mathrm{I}^{\mathrm{OL}}=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| ${ }^{1} \mathrm{CC}+$ Supply current from $\mathrm{V}_{\mathrm{CC}}+$ |  | TLC320451 |  |  |  | 45 | mA |
|  |  | TLC32045C |  |  |  | 40 |  |
| ICC - Supply current from $\mathrm{V}_{\text {CC }}$ - |  | TLC32045I |  |  |  | -45 | mA |
|  |  | TLC32045C |  |  |  | -40 |  |
| IDD | Supply current from VDD |  | $\mathrm{f}_{\text {MSTR }}$ CLK $=5.184 \mathrm{MHz}$ |  |  | 7 | mA |
| $V_{\text {ref }}$ | Internal reference output voltage |  |  | 2.9 |  | 3.4 | V |
| $\alpha$ Vref | Temperature coefficient of internal reference voltage |  |  |  | 250 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| $\mathrm{r}_{0}$ | Output resistance at REF |  |  |  | 100 |  | k $\Omega$ |

receive amplifier input

| PARAMETER | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| A/D converter offset error (filters in) |  | 10 | 75 | mV |
| CMRR <br> Common-mode rejection ratio at $\operatorname{IN}+, \operatorname{IN}$-, or AUX IN +, AUX IN - | See Note 6 | 55 |  | dB |
| $\begin{array}{ll} \hline r_{1} & \text { Input resistance at } \mathbb{I N}+, \mathbb{I N}- \\ \text { or AUX } \mathbb{I N}+, \text { AUX } \mathbb{I N}-, \text { REF } \end{array}$ |  | 100 |  | k $\Omega$ |

transmit filter output

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ |
| :--- | :--- | :---: | :---: | :---: |
| $V_{\text {OO }}$ | Output offset voltage at OUT + or OUT - <br> (single-ended relative to ANLG GND) | $R_{L} \geq 300 \Omega$, <br> Offset voltage $=0$ | 15 | 80 |
| $V_{\text {OM }}$ | Maximum peak output voltage swing across <br> $R_{L}$ at OUT + or OUT - (single-ended) | $R_{L} \geq 600 \Omega$ | $\pm 3$ |  |
| $V_{\text {OM }}$ | Maximum peak output voltage swing between <br> OUT + and OUT - (differential output) |  | V |  |

${ }^{\dagger}$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTE 6: The test condition is a $0-\mathrm{dBm}, 1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate.
electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}+=5 \mathrm{~V}$, VCC $-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
system distortion specifications, SCF clock frequency $=\mathbf{2 8 8} \mathbf{~ k H z}$

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Attenuation of second harmonic of A/D input signal | single-ended | $V_{\text {in }}=-0.1 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 70 |  | dB |
|  | differential |  | 55 | 70 |  |  |
| Attenuation of third and higher harmonics of $A / D$ input signal | single-ended | $V_{\text {in }}=-0.1 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 65 |  | dB |
|  | differential |  | 55 | 65 |  |  |
| Attenuation of second harmonic of D/A input signal | single-ended | $V_{\text {in }}=-0 d B$ to $-24 d B$ referred to $V_{\text {ref }}$, <br> See Note 7 |  | 70 |  | dB |
|  | differential |  | 55 | 70 |  |  |
| Attenuation of third and higher harmonics of D/A input signal | single-ended | $V_{\text {in }}=-0 \mathrm{~dB}$ to -24 dB referred to $V_{\text {ref }}$, See Note 7 |  | 65 |  | dB |
|  | differential |  | 55 | 65 |  |  |

## A/D channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS (see Note 7) | $A_{v}=1^{\ddagger}$ | $A_{V}=2^{\ddagger}$ | $A_{V}=4^{\ddagger}$ | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN MAX | MIN MAX | MIN MAX |  |
| A/D channel signal-to-distortion ratio | $V_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 55 | >55§ | $>55^{\text {§ }}$ | dB |
|  | $\mathrm{V}_{\text {in }}=-12 \mathrm{~dB}$ to -6 dB | 55 | 55 | $>55^{\text {§ }}$ |  |
|  | $V_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 53 | 55 | 55 |  |
|  | $V_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 47 | 53 | 55 |  |
|  | $V_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 41 | 47 | 53 |  |
|  | $V_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 35 | 41 | 47 |  |
|  | $V_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 29 | 35 | 41 |  |
|  | $V_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 23 | 29 | 35 |  |
|  | $V_{\text {in }}=-54 \mathrm{~dB}$ to -48 dB | 17 | 23 | 29 |  |

## D/A channel signal-to-distortion ratio

| PARAMETER | TEST CONDITIONS (see Note 7) | MIN MAX | UNIT |
| :---: | :---: | :---: | :---: |
| D/A channel signal-to-distortion ratio | $V_{\text {in }}=-6 \mathrm{~dB}$ to -0.1 dB | 55 | dB |
|  | $V_{\text {in }}=-12 \mathrm{~dB}$ to -6 dB | 55 |  |
|  | $V_{\text {in }}=-18 \mathrm{~dB}$ to -12 dB | 53 |  |
|  | $V_{\text {in }}=-24 \mathrm{~dB}$ to -18 dB | 47 |  |
|  | $V_{\text {in }}=-30 \mathrm{~dB}$ to -24 dB | 41 |  |
|  | $V_{\text {in }}=-36 \mathrm{~dB}$ to -30 dB | 35 |  |
|  | $V_{\text {in }}=-42 \mathrm{~dB}$ to -36 dB | 29 |  |
|  | $V_{\text {in }}=-48 \mathrm{~dB}$ to -42 dB | 23 |  |
|  | $\mathrm{V}_{\text {in }}=-54 \mathrm{~dB}$ to -48 dB | 17 |  |

[^21]electrical characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{C}} \mathrm{C}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (unless otherwise noted)
gain and dynamic range

| PARAMETER | TEST CONDITIONS | MIN TYP ${ }^{\dagger}$ MAX | UNIT |
| :---: | :---: | :---: | :---: |
| Absolute transmit gain tracking error while transmitting into $600 \Omega$ | -42 dB to 0 dB signal range, See Note 8 | $\pm 0.05 \pm 0.15$ | dB |
| Absolute receive gain tracking error | -42 dB to 0 dB signal range, See Note 8 | $\pm 0.05 \pm 0.15$ | dB |

power supply rejection and crosstalk attenuation

| PARAMETER |  | TEST CONDITIONS | MIN TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}+$ or $\mathrm{V}_{\mathrm{CC}}$ - supply voltage rejection ratio, receive channel | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at DR (ADC output) | 30 |  | dB |
|  | $\mathrm{f}=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| $\mathrm{V}_{\mathrm{CC}}+$ or $\mathrm{V}_{\mathrm{CC}}$ - supply voltage rejection ratio, transmit channel (single-ended) | $f=0$ to 30 kHz | Idle channel, supply signal at 200 mV p-p measured at OUT + | 30 |  | dB |
|  | $\mathrm{f}=30 \mathrm{kHz}$ to 50 kHz |  | 45 |  |  |
| Crosstalk attenuation, transmit-to-receive (single-ended) |  |  | 75 |  | dB |

[^22]
## TLC32045I, TLC32045C <br> VOICE-BAND ANALOG INTERFACE CIRCUITS

## delay distortion

bandpass filter transfer function, SCF $\mathrm{f}_{\text {clock }}=288 \mathrm{kHz} \operatorname{IN}+-\mathbb{I N}-$ is a $\pm 3 \mathrm{~V}$ sinewave ${ }^{\dagger}$ (see Note 9)

| PARAMETER | TEST CONDITION | FREQUENCY RANGE | ADJUSTMENT ADDEND ${ }^{\ddagger}$ | MIN | TYP§ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gain relative to gain at 1 kHz (except passband ripple specification) | Input signal <br> reference is 0 dB (see Note 9) | $\mathrm{f} \leq 50 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -33 | -29 | -25 | dB |
|  |  | $\mathrm{f}=100 \mathrm{~Hz}$ | K1 $\times-0.26 \mathrm{~dB}$ | -4 | -2 | -1 |  |
|  |  | $\mathrm{f}=150 \mathrm{~Hz}$ to 3100 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.25 | 0 | 0.25 |  |
|  |  | $\mathrm{f}=3100 \mathrm{~Hz}$ to 3300 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.3 | 0 | 0.3 |  |
|  |  | $f=3300 \mathrm{~Hz}$ to 3650 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.5 | 0 | 0.5 |  |
|  |  | $\mathrm{f}=3800 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.3 \mathrm{~dB}$ | -5 | -3 | -1 |  |
|  |  | $\mathrm{f}=4000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.7 \mathrm{~dB}$ | -20 | -17 | -16 |  |
|  |  | $\mathrm{f} \geq 4400 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 3.2 \mathrm{~dB}$ |  |  | -40 |  |
|  |  | $\mathrm{f} \geq 5000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ |  |  | -65 |  |

low-pass filter transfer function (see curves), SCF $\boldsymbol{f}_{\text {clock }}=\mathbf{2 8 8} \mathbf{~ k H z}$ (see Note 9)

| PARAMETER | TEST CONDITION | FREQUENCY RANGE | ADJUSTMENT ADDEND ${ }^{\ddagger}$ | MIN | TYP§ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gain relative to gain at 1 kHz (except passband ripple specification) | Input signal reference is 0 dB (see Note 9) | $\mathrm{f}=0 \mathrm{~Hz}$ to 3100 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.25 | 0 | 0.25 | dB |
|  |  | $f=3100 \mathrm{~Hz}$ to 3300 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.3 | 0 | 0.3 |  |
|  |  | $f=3300 \mathrm{~Hz}$ to 3650 Hz | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ | -0.5 | 0 | 0.5 |  |
|  |  | $f=3800 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.3 \mathrm{~dB}$ | -5 | -3 | -1 |  |
|  |  | $\mathrm{f}=4000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 2.7 \mathrm{~dB}$ | -20 | -17 | -16 |  |
|  |  | $\mathrm{f} \geq 4400 \mathrm{~Hz}$ | $\mathrm{K1} \times 3.2 \mathrm{~dB}$ |  |  | -40 |  |
|  |  | $\mathrm{f} \geq 5000 \mathrm{~Hz}$ | $\mathrm{K} 1 \times 0 \mathrm{~dB}$ |  |  | -65 |  |

## serial port

| PARAMETER |  | TEST CONDITIONS | MIN | TYP§ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{I}^{\mathrm{OH}}=-300 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\text {OL }}$ | Low-level output voltage | $1 \mathrm{OL}=2 \mathrm{~mA}$ |  |  | 0.4 | V |
| 1 | Input current |  |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  |  | 15 |  | pF |
| $\mathrm{C}_{0}$ | Output capacitance |  |  | 15 |  | pF |

${ }^{\dagger}$ See filter curves in typical characteristics.
$\ddagger$ The MIN, TYP, and MAX specifications are given for a $288-\mathrm{kHz}$ SCF clock frequency. A slight error in the $288-\mathrm{kHz}$ SCF may result from inaccuracies in the MSTR CLK frequency, resulting from crystal frequency tolerances. If this frequency error is less than $0.25 \%$, the ADJUSTMENT ADDEND should be added to the MIN, TYP, and MAX specifications, where K1 = $100 \cdot$ [(SCF frequency -288 kHz )/ 288 kHz ]. For errors greater than $0.25 \%$, see Note 10.
§ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
NOTES: 9. The filter gain outside of the passband is measured with respect to the gain at 1 kHz . The filter gain within the passband is measured with respect to the average gain within the passband. The passbands are 150 to 3600 Hz and 0 to 3600 Hz for the bandpass and low-pass filters respectively.
10. For switched-capacitor filter clocks at frequencies other than 288 kHz , the filter response is shifted by the ratio of switchedcapacitor filter clock frequency to 288 kHz .

TLC32045I, TLC32045C VOICE-BAND ANALOG INTERFACE CIRCUITS
operating characteristics over recommended operating free-air temperature range, $\mathrm{VCC}+=5 \mathrm{~V}$, $\mathrm{VCC}_{\mathrm{C}}=-5 \mathrm{~V}, \mathrm{VDD}_{\mathrm{D}}=5 \mathrm{~V}$
noise (measurement includes low-pass and bandpass switched-capacitor filters)

| PARAMETER |  | TEST CONDITIONS | TYP ${ }^{\dagger}$ MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Transmit noise | with $(\sin x) / \mathrm{x}$ correction | DX input $=00000000000000$, constant irput code | 600 | $\mu \mathrm{V}$ rms |
|  |  |  | 450 | $\mu \mathrm{V}$ rms |
|  | without $(\sin x) / \mathrm{x}$ correction |  | 24 | dBrnc0 |
| Receive noise (see Note 11) |  | Inputs grounded, gain $=1$ | 530 | $\mu \mathrm{V}$ rms |
|  |  | 24 | dBrnc0 |

## timing requirements

serial port recommended input signals

| PARAMETER |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{c}}$ (MCLK) | Master clock cycle time | 95 |  | ns |
| tr (MCLK) | Master clock rise time |  | 10 | ns |
| $\mathrm{t}_{\mathrm{f}}$ (MCLK) | Master clock fall time |  | 10 | ns |
|  | Master clock duty cycle | 25\% | 75\% |  |
|  | $\overline{\text { RESET }}$ pulse duration (see Note 12) | 800 |  | ns |
| $\mathrm{t}_{\text {su }}(\mathrm{DX})$ | DX setup time before SCLK $\downarrow$ | 20 |  | ns |
| $\left.\mathrm{th}_{\text {( }} \mathrm{DX}\right)$ | DX hold time after SCLK $\downarrow$ | $\mathrm{t}_{\mathrm{c}(\text { (SCLK }) / 4}$ |  | ns |

[^23]
## TLC32045I, TLC32045C VOICE-BAND ANALOG INTERFACE CIRCUITS

operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{C}} \mathrm{C}+=5 \mathrm{~V}$, $\mathrm{V}_{\mathrm{CC}}-=-5 \mathrm{~V}, \mathrm{~V}_{\mathrm{DD}}=5 \mathrm{~V}$ (continued)
serial port - AIC output signals

| PARAMETER |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{C}}$ (SCLK) | Shift clock (SCLK) cycle time | 380 |  | ns |
| $\mathrm{t}_{\mathrm{f} \text { (SCLK) }}$ | Shift clock (SCLK) fall time |  | 50 | ns |
| $\mathrm{tr}_{\mathrm{r}}$ SCLK) | Shift clock (SCLK) rise time |  | 50 | ns |
|  | Shift clock (SCLK) duty cycle | 45 | 55 | \% |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FL})$ | Delay from SCLK $\uparrow$ to $\overline{\mathrm{FSR} / \mathrm{FSX}} \downarrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{FH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { FSR/FSX }} \uparrow$ |  | 90 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{CH}-\mathrm{DR})$ | DR valid after SCLK $\uparrow$ |  | 90 | ns |
| $t_{d w}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \downarrow$ in word mode |  | 90 | ns |
| $t_{d w}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \uparrow$ in word mode |  | 90 | ns |
| $\mathrm{t}_{\mathrm{f} \text { (EODX) }}$ | $\overline{\text { EODX }}$ fall time |  | 15 | ns |
| $\mathrm{t}_{\mathrm{f}}$ (EODR) | $\overline{\text { EODR }}$ fall time |  | 15 | ns |
| $\mathrm{t}_{\mathrm{db}}(\mathrm{CH}-\mathrm{EL})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \downarrow$ in byte mode |  | 100 | ns |
| $\mathrm{t}_{\mathrm{db}}(\mathrm{CH}-\mathrm{EH})$ | Delay from SCLK $\uparrow$ to $\overline{\text { EODX }} / \overline{\text { EODR }} \uparrow$ in byte mode |  | 100 | ns |

TABLE 2. GAIN CONTROL TABLE
(ANALOG INPUT SIGNAL REQUIRED FOR FULL-SCALE A/D CONVERSION)

| INPUT CONFIGURATIONS | CONTROL REGISTER BITS |  | ANALOG INPUT ${ }^{\dagger}$ | A/D CONVERSION RESULT |
| :---: | :---: | :---: | :---: | :---: |
|  | d6 | d7 |  |  |
| Differential configuration$\begin{aligned} \text { Analog input } & =\mathbb{I N +}-\mathbb{I N -} \\ & =A \cup X I N+-A \cup X I N- \end{aligned}$ | 1 | 1 | $\pm 6 \mathrm{~V}$ | full-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |
| $\begin{aligned} & \text { Single-ended configuration } \\ & \begin{aligned} \text { Analog input } & =I N+- \text { ANLG GND } \\ & =A U X I N+- \text { ANLG GND } \end{aligned} \end{aligned}$ | 1 | 1 | $\pm 3 \mathrm{~V}$ | half-scale |
|  | 0 | 0 |  |  |
|  | 1 | 0 | $\pm 3 \mathrm{~V}$ | full-scale |
|  | 0 | 1 | $\pm 1.5 \mathrm{~V}$ | full-scale |

${ }^{\dagger}$ In this example, $\mathrm{V}_{\text {ref }}$ is assumed to be 3 V . In order to minimize distortion, it is recommended that the analog input not exceed 0.1 dB below full scale.

$R_{f b}=R$ for $d 6=1, d 7=1$ $d 6=0, d 7=0$
$R_{f b}=2 R$ for $d 6=1, d 7=0$
$R_{f b}=4 R$ for $d 6=0, d 7=1$
FIGURE 3. IN + AND IN - GAIN
CONTROL CIRCUITRY

$R_{f b}=R$ for $d 6=1, d 7=1$
$d 6=0, d 7=0$
$R_{f b}=2 R$ for $d 6=1, d 7=0$
$R_{f b}=4 R$ for $d 6=0, d 7=1$
FIGURE 4. AUX IN + AND AUX IN GAIN CONTROL CIRCUITRY

## $(\sin x) / x$ correction section

If the designer does not wish to use the on-board second-order $(\sin x) / x$ correction filter, correction can be accomplished in digital signal processor (DSP) software. ( $\operatorname{Sin} x$ )/x correction can be accomplished easily and efficiently in digital signal processor (DSP) software. Excellent correction accuracy can be achieved to a band edge of 3000 Hz by using a first-order digital correction filter. The results, which are shown below, are typical of the numerical correction accuracy that can be achieved for sample rates of interest. The filter requires only seven instruction cycles per sample on the TMS320 DSPs. With a 200-ns instruction cycle, nine instructions per sample represents an overhead factor of $1.4 \%$ and $1.7 \%$ for sampling rates of 8000 Hz and 9600 Hz , respectively. This correction will add a slight amount of group delay at the upper edge of the $300-3000-\mathrm{Hz}$ band.

## $(\sin \mathbf{x}) / \mathbf{x}$ roll-off for a zero-order hold function

The $(\sin x) / x$ roll-off for the AIC DAC zero-order hold function at a band-edge frequency of 3000 Hz for the various sampling rates is shown in the table below.

TABLE 3. $(\sin x) / x$ ROLL-OFF

| $\mathbf{f}_{\mathbf{S}}(\mathrm{Hz})$ | $20 \log \frac{\sin \pi \mathbf{f} / \mathbf{f}_{\mathbf{S}}}{\pi \mathbf{f} / \mathbf{f}_{\mathbf{S}}}$ <br> $(\mathbf{f}=3000 \mathrm{~Hz})$ <br> $(\mathbf{d B})$ |
| ---: | :---: |
| 7200 | -2.64 |
| 8000 | -2.11 |
| 9600 | -1.44 |
| 14400 | -0.63 |
| 19200 | -0.35 |

Note that the actual AIC $(\sin x) / x$ roll-off will be slightly less than the above figures, because the AIC has less than a $100 \%$ duty cycle hold interval.

## correction filter

To compensate for the $(\sin x) / x$ roll-off of the AIC, a first-order correction filter shown below, is recommended.


The difference equation for this correction filter is:
$y_{i}+1=p 2(1-p 1)\left(u_{i}+1\right)+p 1 y_{i}$
where the constant p1 determines the pole locations.
The resulting squared magnitude transfer function is:

$$
|H(f)|^{2}=\frac{p 2^{2}(1-p 1)^{2}}{1-2 p 1 \cos \left(2 \pi f / f_{s}\right)+p 1^{2}}
$$

## TLC32045I, TLC32045C <br> VOICE-BAND ANALOG INTERFACE CIRCUITS

## correction results

Table 4 below shows the optimum p values and the corresponding correction results for $8000-\mathrm{Hz}$ and $9600-\mathrm{Hz}$ sampling rates.

TABLE 4

|  | ERROR $(\mathbf{d B})$ <br> $\mathbf{f}(\mathbf{H z})$ <br>  <br>  <br>  <br> $\mathbf{f}_{\mathbf{s}}=\mathbf{8 0 0 0} \mathbf{~ H z}$ <br> $\mathbf{p} \mathbf{1}=-\mathbf{0 . 1 4 8 1 3}$ <br> $\mathbf{p} 2=0.9888$ | ERROR $(\mathbf{d B})$ <br> $\mathbf{f}_{\mathbf{s}}=\mathbf{9 6 0 0} \mathbf{~ H z}$ <br> $\mathbf{p 1}=-\mathbf{0 . 1 3 0 7}$ <br> $\mathbf{p 2}=0.9951$ |
| :---: | :---: | :---: |
| 300 | -0.099 | -0.043 |
| 600 | -0.089 | -0.043 |
| 900 | -0.054 | 0 |
| 1200 | -0.002 | 0 |
| 1500 | 0.041 | 0 |
| 1800 | 0.079 | 0.043 |
| 2100 | 0.100 | 0.043 |
| 2400 | 0.091 | 0.043 |
| 2700 | -0.043 | 0 |
| 3000 | -0.102 | -0.043 |

## TMS320 software requirements

The digital correction filter equation can be written in state variable form as follows:

$$
Y=k 1 Y+k 2 U
$$

where $k 1$ equals $p 1$ (from the preceding page), $k 2$ equals ( $1-\mathrm{p} 1$ ) p2 (from the preceding page), $Y$ is the filter state, and $U$ is the next I/O sample. The coefficients $k 1$ and $k 2$ must be represented as 16 -bit integers. The SACH instruction (with the proper shift) will yield the correct result. With the assumption that the TMS320 processor page pointer and memory configuration are properly initialized, the equation can be executed in seven instructions or seven cycles with the following program:

```
ZAC
LT K2
MPY U
LTA K1
MPY Y
APAC
SACH (dma), (shift)
```

TLC32045I, TLC32045C VOICE-BAND ANALOG INTERFACE CIRCUITS
byte-mode timing


FIGURE 5. SERIAL PORT TIMING

TLC32045I, TLC32045C
VOICE-BAND ANALOG INTERFACE CIRCUITS


FIGURE 6. TMS32010/TMS320C15-TLC32045 INTERFACE CIRCUIT
in instruction timing

out instruction timing


FIGURE 7. TMS32010/TMS320C15-TLC32045 INTERFACE TIMING

## TYPICAL CHARACTERISTICS

AIC TRANSMIT AND RECEIVE LOW-PASS FILTER


Normalized Frequency $-\mathrm{kHz} \times \frac{\text { SCF Clock Frequency }}{288 \mathrm{kHz}}$
FIGURE 8


AIC TRANSMIT AND RECEIVE LOW-PASS FILTER


FIGURE 9

AIC RECEIVE CHANNEL HIGH-PASS FILTER


FIGURE 11

TYPICAL CHARACTERISTICS

AIC RECEIVE CHANNEL BANDPASS FILTER


FIGURE 12
(SIN X)/X CORRECTION FILTER


Normalized Frequency $-\mathrm{kHz} \times \frac{\text { SCF Clock Frequency }}{288 \mathrm{kHz}}$
FIGURE 14

AIC (SIN X)/X CORRECTION FILTER


FIGURE 13

## A/D SIGNAL-TO-DISTORTION RATIO vs

INPUT SIGNAL


FIGURE 15

## TYPICAL CHARACTERISTICS

> A/D GAIN TRACKING


FIGURE 16

D/A CONVERTER SIGNAL-TO-DISTORTION RATIO
vs
INPUT SIGNAL LEVEL


FIGURE 17

## TLC32045I, TLC32045C

VOICE-BAND ANALOG INTERFACE CIRCUITS

## TYPICAL CHARACTERISTICS



FIGURE 18

A/D SECOND HARMONIC DISTORTION
vs
INPUT SIGNAL


FIGURE 19

D/A SECOND HARMONIC DISTORTION
vs
INPUT SIGNAL


FIGURE 20

TYPICAL CHARACTERISTICS


FIGURE 21


FIGURE 22

TYPICAL APPLICATION INFORMATION


FIGURE 23. AIC INTERFACE TO THE TMS32020/C25 SHOWING DECOUPLING CAPACITORS AND SCHOTTKY DIODE ${ }^{\dagger}$


FOR: $\quad V_{C C}=12 \mathrm{~V}, \mathrm{R}=7200 \Omega$ $V_{C C}=10 \mathrm{~V}, \mathrm{R}=5600 \Omega$ $V_{C C}=5 \mathrm{~V}, \mathrm{R}=1600 \Omega$

FIGURE 24. EXTERNAL REFERENCE CIRCUIT FOR TLC32045
${ }^{\dagger}$ Thomson Semiconductors

# General Information 

## Product Previews

sмə!ィәдд ¥onpoid $\omega$

## - Advanced LinCMOS ${ }^{\text {™ }}$ Silicon-Gate Technology

- Easy Microprocessor Interface
- On-Chip Data Latches
- Digital Inputs are TTL-Compatible with $\mathbf{1 0 . 8}$-V to $\mathbf{1 5 . 7 5 - V}$ Power Supply
- Monotonic Over the Entire A/D Conversion Range
- Designed to be Interchangeable with Analog Devices AD7628
- Fast Control Signaling for Digital Signal Processor Applications Including Interface with TMS320

| KEY PERFORMANCE SPECIFICATIONS |  |
| :--- | :---: |
| Resolution | 8 bits |
| Linearity Error | $1 / 2 \mathrm{LSB}$ |
| Power Dissipation at $V_{D D}=15 \mathrm{~V}$ | 15 mW |
| Settling Time at $V_{D D}=5 \mathrm{~V}$ | 100 ns |
| Propagation Delay at $V_{D D}=5 \mathrm{~V}$ | 80 ns |

## description

The AD7628 is a dual 8 -bit digital-to-analog converter designed with separate on-chip data latches and featuring excellent DAC-to-DAC matching. Data is transferred to either of the two DAC data latches via a common 8-bit input port. Control input DACA/DACB determines which DAC is loaded. The "load" cycle of the AD7628 is similar to the "write" cycle of a random-access memory, allowing easy interface to most popular microprocessor busses and output ports. Segmenting the high-order bits minimizes glitches during changes in the most significant bits, where glitch impulse is typically the strongest.

The AD7628 operates from a $10.8-\mathrm{V}$ to 15.75 V power supply and is TTL-compatible over this range. Power dissipation is less than 15 mW . Excellent 2- or 4-quadrant multiplying makes the AD7628 a sound choice for many microprocessor-controlled gain-setting and signal-control applications.

The AD7628B is characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The AD7628K is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

AVAILABLE OPTIONS

| SYMBOLIZATION |  | OPERATING <br> TEMPERATURE |
| :---: | :---: | :---: |
| DEVICE | PACKAGE <br> SUFFIX |  |
| AD7628B | $\mathrm{FN}, \mathrm{N}$ | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7628K | $\mathrm{FN}, \mathrm{N}$ | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |

Advanced LinCMOS is a trademark of Texas Instruments Incorporated.

N PACKAGE
(TOP VIEW)


AD7628
Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING
digital-to-analog converter
functional block diagram

operating sequence


## AD7628 <br> Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VDD (to AGND or DGND) ..... -0.3 V to 17 V
Voltage between AGND and DGND ..... $\pm V_{D D}$
Input voltage, $\mathrm{V}_{1}$ (to $\operatorname{DGND}$ ) $-0.3 \vee$ to $V_{D D}+0.3 \vee$
Reference voltage, $\mathrm{V}_{\text {refA }}$ or $\mathrm{V}_{\text {refB }}$ (to $A G N D$ ) ..... $\pm 25 \mathrm{~V}$
Feedback voltage, $V_{\text {RFBA }}$ or $V_{\text {RFBB }}$ (to AGND) ..... $\pm 25 \mathrm{~V}$
Output voltage, $\mathrm{V}_{\mathrm{OA}}$ or $\mathrm{V}_{\mathrm{OB}}$ (to AGND) ..... $\pm 25 \mathrm{~V}$
Peak input current ..... $10 \mu \mathrm{~A}$
Operating free-air temperature range: AD7628B ..... $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
AD7628K ..... $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range ..... $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package ..... $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: N package ..... $260^{\circ} \mathrm{C}$

## recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ |  | 10.8 |  | 15.75 | V |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ or $\mathrm{V}_{\text {ref }}$ |  | $\pm 10$ |  |  | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ |  | 2.4 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 | V |
| $\overline{\mathrm{CS}}$ setup time, $\mathrm{t}_{\text {sul }}(\mathrm{CS}$ ) |  | 50 |  |  | ns |
| $\overline{\text { CS }}$ hold time, th(CS) |  | 0 |  |  | ns |
| DAC select setup time, $\mathrm{t}_{\text {su }}(\mathrm{DAC})$ |  | 50 |  |  | ns |
| DAC select hold time, $\mathrm{th}^{\text {(DAC }}$ ) |  | 10 |  |  | ns |
| Data bus input setup time $\mathrm{t}_{\text {su }}(\mathrm{D})$ |  | 25 |  |  | ns |
| Data bus input hold time th ( D ) |  | 0 |  |  | ns |
| Pulse duration, $\overline{\mathrm{WR}}$ low, $\mathrm{t}_{\text {w }}$ (WR) |  | 50 |  |  | ns |
| perating free-air temperature, | AD7628B | -25 |  | 85 | C |
| Operating free-air temperature, $T_{\text {A }}$ | AD7628K | 0 |  | 70 |  |

## AD7628

## Advanced LinCMOS ${ }^{\text {Tw }}$ DUAL 8-BIT MULTIPLYING digital-TO-ANALOG CONVERTER

electrical characteristics over recommended ranges of operating free-air temperature and VDD $\mathrm{V}_{\text {ref }}=\mathrm{V}_{\text {refB }}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{OA}}$ and VOB at 0 V (unless otherwise noted)


## AD7628 <br> Advanced LinCMOS ${ }^{T w}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

| PARAMETER |  | TEST CONDITIONS |  | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Linearity error |  |  |  |  | $\pm 1 / 2$ | LSB |
| Setting time (to 1/2 LSB) |  | See Note 1 |  |  | 100 | ns |
| Gain error |  | See Note 2 | Full Range |  | $\pm 3$ | LSB |
|  |  | $25^{\circ} \mathrm{C}$ |  | $\pm 2$ |  |
| AC feedthrough | REFA to OUTA |  | See Note 3 | Full Range |  | -65 | dB |
|  | REFB to OUTB | $25^{\circ} \mathrm{C}$ |  |  | -70 |  |  |
| Temperature coefficient of gain |  |  |  |  | 0.0035 | \%FSR $/{ }^{\circ} \mathrm{C}$ |  |
| Propagation delay (from digital input to 90\% of final analog output current) |  | See Note 4 |  |  | 80 | ns |  |
| Channel-to-channel isolation | REFA to OUTB | See Note 5 | $25^{\circ} \mathrm{C}$ |  | 80 | dB |  |
|  | REFB to OUTA | See Note 6 | $25^{\circ} \mathrm{C}$ |  | 80 |  |  |
| Digital-to-analog glitch impulse area |  | Measured for code transition from 00000000 to 11111111 ,$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | 440 | $\mathrm{nV} \cdot \mathrm{s}$ |  |
| Digital crosstalk glitch impulse area |  | Measured for code transition from 00000000 to 11111111 ,$T_{A}=25^{\circ} \mathrm{C}$ |  |  | 60 | $\mathrm{nV} \cdot \mathrm{s}$ |  |
| Harmonic distortion |  | $\mathrm{V}_{\mathrm{i}}=6 \mathrm{~V}, \mathrm{f}=1 \mathrm{kHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | -85 | dB |  |

NOTES: 1. OUTA, OUTB load $=100 \Omega, C_{e x t}=13 \mathrm{pF} ; \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at 0 V ; DBO-DB7 at 0 V to $\mathrm{V}_{D D}$ or $\mathrm{V}_{D D}$ to 0 V .
2. Gain error is measured using an internal feedback resistor. Nominal Full Scale Range (FSR) $=\mathrm{V}_{\text {ref }}-1$ LSB. Both DAC latches are loaded with 11111111.
3. $V_{\text {ref }}=20 \mathrm{~V}$ peak-to-peak, $10-\mathrm{kHz}$ sine wave.
4. $V_{\text {refA }}=V_{\text {refB }}=10 \mathrm{~V}$; OUTA/OUTB load $=100 \Omega, C_{e x t}=13 \mathrm{pF} ; \overline{\mathrm{WR}}$ and $\overline{\mathrm{CS}}$ at $0 \mathrm{~V} ; \mathrm{DBO}-\mathrm{DB7}$ at 0 V to $\mathrm{V}_{\mathrm{DD}}$ or $\mathrm{V}_{\mathrm{DD}}$ to 0 V .
5. $V_{\text {ref }}=20 \mathrm{~V}$ peak-to-peak, $10-\mathrm{kHz}$ sine wave; $\mathrm{V}_{\text {refB }}=0$.
6. $V_{\text {ref }}=20 \mathrm{~V}$ peak-to-peak, $10-\mathrm{kHz}$ sine wave; $V_{\text {refA }}=0$.

## principles of operation

The AD7628 contains two identical 8-bit multiplying D/A converters, DACA and DACB. Each DAC consists of an inverted R-2R ladder, analog switches, and input data latches. Binary-weighted currents are switched between DAC output and AGND, thus maintaining a constant current in each ladder leg independent of the switch state. Most applications require only the addition of an external operational amplifier and voltage reference. A simplified D/A circuit for DACA with all digital inputs low is shown in Figure 1.

Figure 2 shows the DACA equivalent circuit. A similar equivalent circuit can be drawn for DACB. Both DACs share the analog ground pin 1 (AGND). With all digital inputs high, the entire reference current flows to OUTA. A small leakage current (I lkg) flows across internal junctions, and as with most semiconductor devices, doubles every $10^{\circ} \mathrm{C} . \mathrm{C}_{0}$ is due to the parallel combination of the NMOS switches and has a value that depends on the number of switches connected to the output. The range of $\mathrm{C}_{\mathrm{o}}$ is 25 pF to 60 pF maximum. The equivalent output resistance $r_{0}$ varies with the input code from $0.8 R$ to $3 R$ where $R$ is the nominal value of the ladder resistor in the R-2R network.

Interfacing the AD7628 to a microprocessor is accomplished via the data bus, $\overline{\mathrm{CS}}, \overline{\mathrm{WR}}$, and $\overline{\mathrm{DACA}} / \mathrm{DACB}$ control signals. When $\overline{C S}$ and $\overline{W R}$ are both low, the AD7628 analog output, specified by the $\overline{D A C A} / D A C B$ control line, responds to the activity on the DBO-DB7 data bus inputs. In this mode, the input latches are transparent and input data directly affects the analog output. When either the $\overline{\mathrm{CS}}$ signal or $\overline{\mathrm{WR}}$ signal goes high, the data on the DBO-DB7 inputs is latched until the $\overline{C S}$ and $\overline{W R}$ signals go low again. When $\overline{\mathrm{CS}}$ is high, the data inputs are disabled, regardless of the state of the $\overline{\mathrm{WR}}$ signal.

The digital inputs of the AD7628 provide TTL compatibility when operated from a supply voltage of 10.8 V to 15.75 V . Power dissipation is a low 10 mW within this range.


FIGURE 1. SIMPLIFIED FUNCTIONAL CIRCUIT FOR DACA


Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

## TYPICAL APPLICATION DATA

The AD7628 is capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2-quadrant and 4-quadrant multiplication are shown in Figures 3 and 4. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.


NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table for recommended values. Make gain adjustment with digital input of 255.
2. C 1 and C 2 phase compensation capacitors ( 10 pF to 15 pF ) are required when using high-speed amplifiers to prevent ringing or oscillation.

FIGURE 3. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)

## AD7628 <br> Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 8-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTER

TYPICAL APPLICATION DATA


NOTES: 1. R1, R2, R3, and R4 are used only if gain adjustment is required. See table in Figure 3 for recommended values. Adjust R1 for $\mathrm{V}_{\mathrm{OA}}=0 \mathrm{~V}$ with code 10000000 in DACA latch. Adjust R 3 for $\mathrm{V}_{\mathrm{OB}}=0 \mathrm{~V}$ with 10000000 in DACB latch.
2. Matching and tracking are essential for resistor pairs R6, R7, R9, and R10.
3. C1 and C2 phase compensation capacitors ( 10 pF to 15 pF ) may be required if A1 and A3 are high-speed amplifiers.

FIGURE 4. BIPOLAR OPERATION (4-QUADRANT OPERATION)

TABLE 1. UNIPOLAR BINARY CODE

| DAC LATCH CONTENTS <br> MSB LSB | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $-V_{i}(255 / 256)$ |
| 10000001 | $-V_{i}(129 / 256)$ |
| 10000000 | $-V_{i}(128 / 256)=-V_{i} / 2$ |
| 01111111 | $-V_{i}(127 / 256)$ |
| 00000001 | $-V_{i}(1 / 256)$ |
| 00000000 | $-V_{i}(0 / 256)=0$ |

${ }^{\dagger} 1 \mathrm{LSB}=(2-8) \mathrm{V}_{\mathrm{i}}$

TABLE 2. BIPOLAR (OFFSET BINARY) CODE

| DAC LATCH CONTENTS <br> MSB <br> LSB | ANALOG OUTPUT |
| :---: | :---: |
| 11111111 | $V_{i}(127 / 128)$ |
| 10000001 | $V_{i}(1 / 128)$ |
| 10000000 | 0 V |
| 01111111 | $-V_{i}(1 / 128)$ |
| 00000001 | $-V_{i}(127 / 128)$ |
| 00000000 | $-V_{i}(128 / 128)$ |

[^24]
## TYPICAL APPLICATION DATA

microprocessor interface information


NOTE: $\quad A=$ decoded address for AD7628 DACA.
$A+1=$ decoded address for AD7628 DACB.
FIGURE 5. AD7628 - INTEL 8051 INTERFACE


NOTE: $\quad A=$ decoded address for AD7628 DACA.
$A+1=$ decoded address for AD7628 DACB.
FIGURE 6. AD7628 - 6800 INTERFACE

## TYPICAL APPLICATION DATA

## voltage-mode operation

The AD7628 current-multiplying D/A converter can be operated in a voltage mode. In the voltage mode, a fixed voltage is placed on the current output pin. The analog output voltage is then available at the reference voltage pin. An example of a current-multiplying D/A converter operating in voltage mode is shown in Figure 7. The relationship between the fixed input voltage and the analog output voltage is given by the following equation:

$$
\text { Analog output voltage }=\text { fixed input voltage }(D / 256)
$$

where $D=$ the digital input. In voltage-mode operation, the AD7628 meets the following specification:

| LINEARITY ERROR | TEST CONDITIONS | MIN | TYP |
| :---: | :---: | :---: | :---: |
| Analog output voltage for REFA, B | $\mathrm{V}_{\mathrm{DD}}=12 \mathrm{~V}$, OUTA or OUTB $=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ | UNIT |  |



Figure 7. CURRENT-MULTIPLYing d/A CONVERTER OPERATING IN VOLTAGE MODE

## - 6-Bit Resolution

- 0.8\% Linearity
- Maximum Conversion Rate . . . 25 MHz Typ 20 MHz Min
- Analog Input Voltage Range . . .
$V_{C C}$ to $V_{C C}-2 \mathrm{~V}$
- Analog Input Dynamic Range . . . 1 V
- TTL Digital I/O Level
- Low Power Consumption . . . 200 mW Typ
- 5-V Single-Supply Operation
- Interchangeable with Fujitsu MB40576


## description

The TL5501 is a low-power ultra-high-speed video-band analog-to-digital converter that uses the Advanced Low-Power Schottky (ALS) process. It utilizes the full-parallel comparison (flash method) for high-speed conversion. It converts wide-band analog signals (such as a video signal) to a digital signal at a sampling rate of dc to 25 MHz . Because of such high-speed capability, the TL5501 is suitable for digital video applications such as digital TV, video processing with a computer, or radar signal processing.

The TL5501 is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram



## equivalents of analog input circuit



NOTE A: $C_{i}$ - nonlinear emitter-follower junction capacitance
$R_{i}$ - linear resistance model for input current transition caused by comparator switching. $V_{\mathbf{I}}<V_{\text {refB }}$ : Infinite; CLK high: Infinite.
$V_{\text {refB }}$ - voltage at REFB terminal
Ibias - constant input bias current
D - Base-collector junction diode of emitter-follower transistor
equivalent of digital input circuit

function table

| STEP | ANALOG INPUT VOLTAGE ${ }^{\dagger}$ | DIGITAL OUTPUT CODE |
| :---: | :---: | :---: |
| 0 | 3.992 V | L L L L L |
| 1 | 4.008 V | L L L L H |
| ! | ! | ! |
| 31 | 4.488 V | L H H H H H |
| 32 | 4.508 V | H L L L L L |
| 33 | 4.520 V | $H L L L$ |
| 1 | 1 | i |
| 62 | 4.984 V | H H H H H L |
| 63 | 5.000 V | $\mathrm{H} \mathrm{H} \boldsymbol{H} \mathrm{H} \boldsymbol{H} \mathrm{H}$ |

$\dagger$ These values are based on the assumption that $V_{\text {refB }}$ and $V_{\text {refT }}$ have been adjusted so that the voltage at the transition from digital 0 to $1\left(\mathrm{~V}_{\mathrm{ZT}}\right)$ is 4.000 V and the transition to full scale $\left(\mathrm{V}_{\mathrm{FT}}\right)$ is $4.992 \mathrm{~V} .1 \mathrm{LSB}=16 \mathrm{mV}$.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage range, ANLG VCC | . 5 V to 7 V |
| :---: | :---: |
| Supply voltage range, DGTL VCC | 0.5 V to 7 V |
| Input voltage range at digital input, $\mathrm{V}_{1}$ | -0.5 V to 7 V |
| Input voltage range at analog input, $V$ | -0.5 V to ANLG VCC +0.5 V |
| Analog reference voltage range, $\mathrm{V}_{\text {ref }}$ | -0.5 V to ANLG $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$ |
| Storage temperature range | $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Operating free-air temperature range | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Lead temperature 1,6 mm (1/16 inch) | $260^{\circ} \mathrm{C}$ |

recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, ANLG $\mathrm{V}_{\mathrm{CC}}$ | 4.75 | 5 | 5.25 | V |
| Supply voltage, DGTL $\mathrm{V}_{\text {CC }}$ | 4.75 | 5 | 5.25 | V |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$ | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| Input voltage at analog input, $\mathrm{V}_{1}$ (see Note 1) | 4 |  | 5 | V |
| Analog reference voltage (top side), $\mathrm{V}_{\text {reft }}$ (see Note 1) | 4 | 5 | 5.1 | V |
| Analog reference voltage (bottom side), $\mathrm{V}_{\text {ref }}$ (see Note 1) | 3 | 4 | 4.1 | V |
| High-level output current, 1 OH |  |  | -400 | $\mu \mathrm{A}$ |
| Low-level output current, IOL |  |  | 4 | mA |
| Clock pulse duration, high-level or low-level, $\mathrm{t}_{\mathrm{w}}$ | 25 |  |  | ns |
| Operating free-air temperature, $\mathrm{T}_{\text {A }}$ | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTE 1: $\mathrm{V}_{\text {refB }}<\mathrm{V}_{\mathrm{I}}<\mathrm{V}_{\text {reft }}, \mathrm{V}_{\text {refT }}-\mathrm{V}_{\text {refB }}=1 \mathrm{~V} \pm 0.1 \mathrm{~V}$.

## TL5501

6-BIT ANALOG-TO-DIGITAL CONVERTER
electrical characteristics over operating supply voltage range, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Analog input current | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  |  | 75 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{1}=4 \mathrm{~V}$ |  |  | 73 |  |
| 1 IH | Digital high-level input current | $\mathrm{V}_{1}=2.7 \mathrm{~V}$ |  | 0 | 20 | $\mu \mathrm{A}$ |
| ILL | Digital low-level input current | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  | -40 | -400 | $\mu \mathrm{A}$ |
| 4 | Digital input current | $\mathrm{V}_{1}=7 \mathrm{~V}$ |  |  | 100 | $\mu \mathrm{A}$ |
| $I_{\text {refB }}$ | Reference current | $\mathrm{V}_{\text {refB }}=4 \mathrm{~V}$ |  | -4 | -7.2 | mA |
| Ireft | Reference current | $\mathrm{V}_{\text {reft }}=5 \mathrm{~V}$ |  | 4 | 7.2 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | $\mathrm{I}^{\mathrm{OH}}=-400 \mu \mathrm{~A}$ | 2.7 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\mathrm{l} \mathrm{OL}=1.6 \mathrm{~mA}$ |  |  | 0.4 | V |
| $\mathrm{r}_{\mathrm{i}}$ | Analog input resistance |  | 100 |  |  | k $\Omega$ |
| $\mathrm{C}_{\mathrm{i}}$ | Analog input capacitance |  |  | 35 | 65 | pF |
| ICC | Supply current |  |  | 40 | 60 | mA |

operating characteristics over operating supply voltage range, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | MIN | TYP ${ }^{\text {t }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Linearity error |  |  |  | $\pm 0.8$ | \%FSR |
| ${ }^{\text {fax }}$ | Maximum conversion rate |  | 20 | 25 |  | MHz |
| $t_{d}$ | Digital output delay time | See Figure 3 |  | 15 | 30 | ns |

timing diagram


## TYPICAL CHARACTERISTICS

IDEAL CONVERSION CHARACTERISTICS


FIGURE 1


FIGURE 2
NOTE 2: This curve is based on the assumption that $V_{\text {refB }}$ and $V_{\text {refT }}$ have been adjusted so that the voltage at the transition from digital 0 to $1\left(\mathrm{~V}_{\mathrm{ZT}}\right)$ is 4.000 V and the transition to full scale $\left(\mathrm{V}_{\mathrm{FT}}\right)$ is $4.992 \mathrm{~V} .1 \mathrm{LSB}=16 \mathrm{mV}$.

## PARAMETER MEASUREMENT INFORMATION



FIGURE 3. LOAD CIRCUIT

- 6-Bit Resolution
- $\pm 0.8 \%$ Linearity
- Maximum Conversion Rate . . . $30 \mathbf{M H z}$ Typ 20 MHz Min
- Analog Output Voltage Range . . . VCC to VCC -1 V
- TTL Digital Input Voltage
- Low Power Consumption . . . 200 mW Typ
- 5-V Single-Supply Operation
- Interchangeable with Fujitsu MB40776


## description

The TL5601 is a low-power ultra-high-speed video digital-to-analog converter that uses the Advanced LowPower Schottky (ALS) process. It converts digital signals to analog signals at a sampling rate of dc to 20 MHz . Because of such high-speed capability, the TL5601 is suitable for digital video applications such as digital television, video processing with a computer, and radar signal processing.
The TL5601C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
functional block diagram


FIJNCTION TABLE

| STEP | DIGITAL |  |  |  |  |  | INPUTS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |  |
|  | D5 | D4 | D3 | D2 | D1 | D0 | VOLTAGE |
| O | L | L | L | L | L | L | 3.992 V |
| 1 | L | L | L | L | L | H | 4.008 V |
| I |  |  |  |  |  |  | I |
| 31 | L | H | H | H | H | H | 4.488 V |
| 32 | H | L | L | L | L | L | 4.504 V |
| 33 | H | L | L | L | L | H | 4.520 V |
| I |  |  |  |  |  |  | I |
| 62 | H | H | H | H | H | L | 4.984 V |
| 63 | H | H | H | H | H | H | 5.000 V |

[^25]
## TL5601 6-BIT DIGITAL-TO-ANALOG CONVERTER

schematics of equivalent input and output circuits

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage range, ANLG VCC, DGTL VCC
-0.5 V to 7 V
Digital input voltage range, $\mathrm{V}_{1}$
-0.5 V to 7 V
Analog reference voltage range, $\mathrm{V}_{\text {ref. }}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 3.8 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$
Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16$ inch) from case for 10 seconds
$260^{\circ} \mathrm{C}$
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $V_{C C}$ Supply voltage | 4.75 | 5 | 5.25 | V |
| $\mathrm{V}_{\text {ref }}$ Analog reference voltage (see Note 1) | 3.8 | 4 | 4.2 | V |
| $\mathrm{V}_{1 \mathrm{H}} \quad$ High-level input voltage | 2 |  |  | V |
| $\mathrm{V}_{\text {IL }} \quad$ Low-level input voltage |  |  | 0.8 | V |
| $\mathrm{t}_{\mathrm{w}} \quad$ Pulse duration, CLK high or low | 25 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ Setup time, data before CLK $\uparrow$ | 12.5 |  |  | ns |
| th Hold time, data after CLK $\uparrow$ | 12.5 |  |  | ns |
| $\mathrm{C}_{\text {comp }}$ Phase compensation capacitance (see Note 2) | 1 |  |  | $\mu \mathrm{F}$ |
| $\mathrm{T}_{\mathrm{A}}$ Operating free-air temperature | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 1. $V_{\text {ref }}$ must be within 1.2 V of $\mathrm{V}_{\mathrm{CC}}$.
2. This capacitor should be connected between comp and GND.
electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| II Input current at maximum input voltage | $\mathrm{V}_{1}=7 \mathrm{~V}$ |  | 0 | 100 | $\mu \mathrm{A}$ |
| $I_{\text {IH }}$ High-level input current | $V_{1}=2.7 \mathrm{~V}$ |  | 0 | 20 | $\mu \mathrm{A}$ |
| IIL Low-level input current | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  | -40 | -400 | $\mu \mathrm{A}$ |
| Iref Input reference current | $\mathrm{V}_{\text {ref }}=4 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |
| $V_{\text {FS }}$ Full-scale analog output voltage | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=3.976 \mathrm{~V}$, | $\mathrm{V}_{\mathrm{CC}}-15$ | $\mathrm{V}_{\text {CC }}$ | $\mathrm{V}_{C C}+15$ | mV |
| $\mathrm{V}_{\text {ZS }}$ Zero-scale analog output voltage | $\mathrm{I}_{0}=0$ (no load) | 3.932 | 3.992 | 4.052 | V |
| $r_{0}$ Output resistance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 70 | 80 | 90 | $\Omega$ |
| ICC Supply current | $V_{\text {ref }}=4.05 \mathrm{~V}$ |  | 48 | 65 | mA |

operating characteristics over recommended ranges of supply voltage and operating free-air temperature

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $E_{L} \quad$ Linearity error |  |  |  | $\pm 0.8$ | \%FSR |
| $f_{\text {max }}$ Maximum conversion rate |  | 20 | 30 |  | MHz |

${ }^{\dagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

PARAMETER MEASUREMENT INFORMATION


FIGURE 1. VOLTAGE WAVEFORMS

TYPICAL CHARACTERISTICS


FIGURE 2. IDEAL CONVERSION CHARACTERISTICS


FIGURE 3. END-POINT LINEARITY ERROR

- 8-Bit Resolution
- $\pm 0.2 \%$ Linearity
- Maximum Conversion Rate . . . $30 \mathbf{M H z}$ Typ


## 20 MHz Min

- Analog Output Voltage Range . . . VCC to VCC - 1 V
- TTL Digital Input Voltage
- 5-V Single-Supply Operation
- Low Power Consumption . . . 250 mW Typ
- Interchangeable with Fujitsu MB40778

N PACKAGE
(TOP VIEW)


## description

The TL5602 is a low-power ultra-high-speed video digital-to-analog converter that uses the Advanced LowPower Schottky (ALS) process. It converts digital signals to analog signals at a sampling rate of dc to 20 MHz . Because of such high-speed capability, the TL5602 is suitable for digital video applications such as digital television, video processing with a computer, and radar signal processing.
The TL5602C is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
functional block diagram


FUNCTION TABLE

| STEP | DIGITAL INPUTS |  |  |  |  |  |  |  | OUTPUT VOLTAGE ${ }^{\dagger}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | DO |  |
| 0 | L | L | L | L | L | L | L | L | 3.980 V |
| 1 | L | L | L | L | L | L | L | L | 3.984 V |
| 1 |  |  |  |  |  |  |  |  | i |
| 127 | L | H | H | H | H | H | H | H | 4.488 V |
| 128 | H | L | L | L | L | L | L | L | 4.492 V |
| 129 | H | L | L | L | L | L | L | H | 4.496 V |
| 1 |  |  |  |  |  |  |  |  | 1 |
| 254 | H | H | H | H | H | H | H | L | 4.996 V |
| 255 | H | H | H | H | H | H | H | H | 5.000 V |

${ }^{\dagger}$ For $V_{C C}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=3.976 \mathrm{~V}$
schematics of equivalent input and output circuits
EQUIVALENT OF EACH DIGITAL INPUT
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

> Supply voltage range, ANLG VCC, DGTL VCC
> -0.5 V to 7 V
> Digital input voltage range, $\mathrm{V}_{\mathrm{l}}$
> -0.5 V to 7 V
> Analog reference voltage range, $\mathrm{V}_{\text {ref }}$ 3.8 V to $\mathrm{V}_{\mathrm{CC}}+0.5 \mathrm{~V}$
> Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
> Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
> Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds
> $260^{\circ} \mathrm{C}$
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CC }} \quad$ Supply voltage | 4.75 | 5 | 5.25 | V |
| $\mathrm{V}_{\text {ref }}$ Analog reference voltage (see Note 1) | 3.8 | 4 | 4.2 | V |
| $\mathrm{V}_{\text {IH }} \quad$ High-level input voltage | 2 |  |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ Low-level input voltage |  |  | 0.8 | V |
| $t_{w} \quad$ Pulse duration, CLK high or low | 25 |  |  | ns |
| $\mathrm{t}_{\text {su }}$ Setup time, data before CLK $\uparrow$ | 12.5 |  |  | ns |
| th Hold time, data after CLK $\uparrow$ | 12.5 |  |  | ns |
| $\mathrm{C}_{\text {comp }}$ Phase compensation capacitance (see Note 2) | 1 |  |  | $\mu \mathrm{F}$ |
| $\mathrm{T}_{\mathrm{A}}$ Operating free-air temperature | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 1. $V_{C C}-V_{\text {ref }} \leq 1.2 \mathrm{~V}$
2. This capacitor should be connected between COMP and GND.
electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| I/ Input current at maximum input voltage | $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{1}=7 \mathrm{~V}$ |  | 0 | 100 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{IH}}$ High-level input current | $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{1}=2.7 \mathrm{~V}$ |  | 0 | 20 | $\mu \mathrm{A}$ |
| IIL Low-level input current | $\mathrm{V}_{\mathrm{CC}}=5.25 \mathrm{~V}, \mathrm{~V}_{1}=0.4 \mathrm{~V}$ |  | -40 | -400 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {ref }}$ Input reference current | $V_{\text {ref }}=4 \mathrm{~V}$ |  |  | 10 | $\mu \mathrm{A}$ |
| $V_{\text {FS }}$ Full-scale analog output voltage | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=3.976 \mathrm{~V}$, | $\mathrm{V}_{\text {CC }}-15$ | $\mathrm{V}_{\text {CC }}$ | $\mathrm{V}_{\mathrm{CC}}+15$ | mV |
| $\mathrm{V}_{\text {ZS }}$ Zero-scale analog output voltage | $\mathrm{I}_{\mathrm{O}}=0$ (no load) | 3.919 | 3.980 | 4.042 | V |
| $r_{0}$ Output resistance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 70 | 80 | 90 | $\Omega$ |
| ICC Supply current | $\mathrm{V}_{\text {ref }}=4.05 \mathrm{~V}$ |  | 50 | 75 | mA |

${ }^{\dagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=4 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
operating characteristics over recommended ranges of supply voltage and operating free-air temperature

| PARAMETER | TEST CONDITIONS | MIN | TYP |
| :--- | :---: | :---: | :---: |
| $\mathrm{E}_{\mathrm{L}}$ Linearity error |  | MAX | UNIT |
| $\mathrm{f}_{\max }$ Maximum conversion rate |  | $\pm 0.2$ | $\%$ FSR |

## PARAMETER MEASUREMENT INFORMATION


figure 1. voltage waveforms

TYPICAL CHARACTERISTICS


FIGURE 2. IDEAL CONVERSION CHARACTERISTICS


FIGURE 3. END-POINT LINEARITY ERROR

- LinCMOS ${ }^{\text {M }}$ Technology
- 8-Bit Resolution A/D Converter
- Microprocessor Peripheral or Stand-Alone Operation
- On-Chip 12-Channel Analog Multiplexer
- Built-In Self-Test Mode
- Software-Controllable Sample and Hold
- Total Unadjusted Error . . . $\pm 0.5$ LSB Max
- Direct Replacement for Motorola MC145041
- On-Board System Clock
- End-Of-Conversion (EOC) Output
- Pinout and Control Signals Compatible with TLC540 and TLC1540 Family of 10-Bit A/D Converters

TYPICAL PERFORMANCE

| Channel Acquisition/Sample Time | $1.6 \mu \mathrm{~s}$ |
| :--- | :---: |
| Conversion Time | $20 \mu \mathrm{~s}$ |
| Samples per Second | $25 \times 10^{3}$ |
| Power Dissipation | 10 mW |

## description

The TLC542 is a LinCMOS ${ }^{\text {M }}$ A/D peripheral built around an 8-bit switched-capacitor successiveapproximation A/D converter. The device is designed for serial interface to a microprocessor or peripheral via a 3-state output with three inputs (including I/O Clock, Chip Select ( $\overline{\mathrm{CS}}$ ), and Address Input). The TLC542 allows high-speed data transfers and sample rates of up to 40,000 samples per second. In addition to the high-speed converter and versatile control logic, an on-chip 12 -channel analog multiplexer can sample any one of 11 inputs or an internal "self-test" voltage, and the sample-and-hold is started under microprocessor control. At the end of conversion, the End-Of-Conversion (EOC) output pin goes high to indicate that conversion is complete. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The converter incorporated in the TLC542 features differential high-impedance reference inputs that facilitate ratiometric conversion, scaling, and isolation of analog circuitry from logic and supply noises. A switchedcapacitor design allows low-error ( $\pm 0.5 \mathrm{LSB}$ ) conversion in $20 \mu$ s over the full operating temperature range.

The TLC542 is available in both the N and FN plastic packages. The TLC542M is characterized for operation from $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$, and the TLC542l is characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

TLC542M, TLC542I
LinCMOS ${ }^{\text {T }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 11 INPUTS
functional block diagram


## operating sequence



NOTES:

1. The conversion cycle, which requires 36 internal system clock periods, is initiated on the 8 th falling edge of the $1 / O$ Clock after $\overline{\mathrm{CS}}$ goes low for the channel whose address exists in memory at that time. If $\overline{\mathrm{CS}}$ is kept low during conversion, the $\mathrm{I} / \mathrm{O}$ Clock must remain low for at least 36 system clock cycles to allow conversion to be completed.
2. To minimize errors caused by noise at the chip select input, the internal circuitry waits for two rising edges and one falling edge of the internal system clock after $\overline{\mathrm{CS}} \downarrow$ before responding to control input signals. The $\overline{\mathrm{CS}}$ setup time is given by the $\mathrm{t}_{\text {Su }}(\mathrm{CS})$ specifications. Therefore, no attempt should be made to clock-in an address until the minimum chip select setup time has elapsed.

## TLC542M, TLC542I

LinCMOS ${ }^{\text {T }} 8$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS

## WITH SERIAL CONTROL AND 11 INPUTS

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 3) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 6.5 V
Input voltage range (any input) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$
Output voltage range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$
Peak input current range (any input) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 20 \mathrm{~mA}$
Peak total input current (all inputs) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 30 \mathrm{~mA}$
Operating free-air temperature: TLC542M . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
TLC5421 . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: N package . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
NOTE 3: All voltage values are with respect to digital ground with REF - and GND wired together (unless otherwise noted).
recommended operating conditions, $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.5 V

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | 4.75 | 5 | 5.5 | V |
| Positive reference voltage, $\mathrm{V}_{\text {REF }}+$ (see Note 4) |  | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF }}$ - (see Note 4) |  | 0.1 | 0 | 2.5 | V |
| Differential reference voltage, $\mathrm{V}_{\text {REF }}+-\mathrm{V}_{\text {REF }}$ - (see Note 4) |  | 1 | $\mathrm{V}_{\text {CC }}$ | $V_{C C}+0.2$ | V |
| Analog input voltage (see Note 4) |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level control input voltage, $\mathrm{V}_{\text {IH }}$ |  | 2 |  |  | V |
| Low-level control input voltage, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 | V |
| Setup time, address bits at data input before I/O CLK $\uparrow, \mathrm{t}_{\text {Su }}(\mathrm{A})$ |  | 400 |  |  | ns |
| Hold time, address bits after I/O CLK $\uparrow, \mathrm{th}(\mathrm{A})$ |  | 0 |  |  | ns |
| Hold time, $\overline{\mathrm{CS}}$ low after 8 th l/O CLK $\downarrow$, h (CS) |  | 0 |  |  | ns |
| Setup time, $\overline{\mathrm{CS}}$ low before clocking in first address bit, $\mathrm{t}_{\text {Su( }}$ (CS) (see Note 2) |  | 1.4 |  |  | $\mu \mathrm{s}$ |
| $\overline{\mathrm{CS}}$ high during conversion, $\mathrm{t}_{\mathrm{WH}}$ (CS) |  | 17 |  |  | $\mu \mathrm{s}$ |
| Input/Output clock frequency, f CLK(1/O) |  | 0 |  | 1.1 | MHz |
| Input/Output clock high, $\mathrm{t}_{\mathrm{wH}}(1 / \mathrm{O})$ |  | 404 |  |  | ns |
| Input/Output clock low, ${ }_{\text {wL }}$ (1/O) |  | 404 |  |  | ns |
| 1/O Clock transition time (see Note 5) | ${ }^{\text {f }}$ CLK $(1 / \mathrm{O}) \leq 525 \mathrm{kHz}$ |  |  | 100 | ns |
|  | ${ }^{\mathrm{f}} \mathrm{CLK}(\mathrm{I} / \mathrm{O})>525 \mathrm{kHz}$ |  |  | 40 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC542M | -55 |  | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC5421 | -40 |  | 85 |  |

NOTES: 2. To minimize errors caused by noise at the chip select input, the internal circuitry waits for two rising edges and one falling edge of the internal system clock after $\overline{C S} \downarrow$ before responding to control input signals. The $\overline{C S}$ setup time is given by the $t_{\text {Su }}(C S)$ specifications. Therefore, no attempt should be made to clock-in an address until the minimum chip select setup time has elapsed.
4. Analog input voltages greater than that applied to REF + convert as all ones (11111111), while input voltages less than that applied to REF - convert as all zeros (00000000). For proper operation, REF + must be at least 1 V higher than REF - . Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 V .
5. This is the time required for the clock input signal to fall from $V_{I H}$ min to $V_{I L}$ max or to rise from $V_{I L} \max$ to $V_{I H}$ min. In the vicinity of normal room temperature, the devices function with input clock transition time as slow as $2 \mu s$ for remote data acquisition applications where the sensor and the A/D converter are placed several feet away from the controlling microprocessor.

## TLC542M, TLC542I <br> LinCMOS 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 11 INPUTS

electrical characteristics over recommended operating temperature range,
$\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{REF}}+=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{f} C L K(\mathrm{I} / \mathrm{O})=1.1 \mathrm{MHz}$

| PARAMETER | TEST CONDITIONS |  | MIN | TYP $\dagger$ | MAX |
| :--- | :--- | ---: | ---: | :---: | :---: |

$\dagger$ All typical values are at $T_{A}=25^{\circ} \mathrm{C}$.
operating characteristics over recommended operating free-air temperature range, $\mathrm{VCC}=\mathrm{V}_{\mathrm{REF}}+=4.75 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{fCLK}(\mathrm{I} / \mathrm{O})=1 \mathrm{MHz}$

|  | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Linearity error (see Note 7) |  |  | $\pm 0.5$ | LSB |
|  | Zero error (see Note 8) | See Note 6 |  | $\pm 0.5$ | LSB |
|  | Full-scale error (see Note 8) | See Note 6 |  | $\pm 0.5$ | LSB |
|  | Total unadjusted error (see Note 9) |  |  | $\pm 0.5$ | LSB |
|  | Self-test output code | Input A11 address = 1011, See Note 10 | $\begin{gathered} 01111101 \\ (125) \end{gathered}$ | 10000011 $(131)$ |  |
| ${ }^{\text {t }}$ conv | Conversion time | See operating sequence |  | 20 | $\mu \mathrm{s}$ |
| tcycle | Total access and conversion cycle time | See operating sequence |  | 40 | $\mu \mathrm{s}$ |
| tacq | Channel acquisition time (sample cycle) | See operating sequence |  | 16 | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\mathrm{v}}$ | Time output data remains valid after I/O CLK $\downarrow$ | See Figure 5 | 10 |  | ns |
| $t_{d}(I O-D A T A)$ | Delay time, 1/O CLK $\downarrow$ to data output valid | See Figure 5 |  | 400 | ns |
| $\mathrm{t}_{\mathrm{d}}(10-E O C)$ | Delay time, 8th I/O CLK $\downarrow$ to EOC $\downarrow$ | See Figure 6 |  | 500 | ns |
| $\mathrm{t}_{\mathrm{d}}($ EOC-DATA) | Delay time, EOC $\uparrow$ to data out (MSB) | See Figure 7 |  | 400 | ns |
| ${ }^{\text {P }} \mathrm{PZH}, \mathrm{tPZL}$ | Delay time, $\overline{\mathrm{CS}} \downarrow$ to data out (MSB) | See Figure 2 |  | 3.4 | $\mu \mathrm{s}$ |
| ${ }^{\text {tPHZ }}$, tPLZ | Delay time, $\overline{\mathrm{CS}} \uparrow$ to data out | See Figure 2 |  | 150 | ns |
| tr(EOC) | Rise time | See Figure 7 |  | 100 | ns |
| $\mathrm{t}_{\text {f }}(\mathrm{EOC})$ | Fall time | See Figure 6 |  | 100 | ns |
| $\mathrm{tr}_{\text {( }}$ (bus) | Data bus rise time | See Figure 5 |  | 300 | ns |
| $t_{f}$ (bus) | Data bus fall time | See Figure 5 |  | 300 | ns |

NOTES: 6. Analog input voltages greater than that applied to REF + convert to all ones (11111111), while input voltages less than that applied to REF - convert to all zeros ( 00000000 ). For proper operation, REF + must be at least 1 V higher than REF-. Also, the total unadjusted error may increase as this differential reference voltage falls below 4.75 V .
7. Linearity error is the maximum deviation from the best straight line through the $A / D$ transfer characteristics.
8. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
9. Total unadjusted error is the sum of linearity, zero, and full-scale errors.
10. Both the input address and the output codes are expressed in positive logic. The A11 analog input signal is internally generated and is used for test purposes.

## TLC542M, TLC542I

LinCMOS ${ }^{\text {™ }}$ 8-BIT ANALOG-TO-DIGITAL PERIPHERALS
WITH SERIAL CONTROL AND 11 INPUTS

## PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT FOR $t_{d}, t_{r}$ AND $t_{f}$

NOTE A: $C_{L}=50 \mathrm{pF}$.


> LOAD CIRCUIT FOR tpZH AND tpHZ


> LOAD CIRCUIT FOR tPZL AND tPLZ


FIGURE 2


FIGURE 3


FIGURE 4

PARAMETER MEASUREMENT INFORMATION


FIGURE 5


FIGURE 6


FIGURE 7

## principles of operation

The TLC542 is a complete data acquisition system on a single chip. The device includes such functions as analog multiplexer, sample-and-hold, 8 -bit A/D converter, data and control registers, and control logic. Three control inputs (I/O clock, chip select ( $\overline{\mathrm{CS}}$ ), and address) are included for flexibility and access speed. These control inputs and a TTL-compatible 3 -state output are intended for serial communications with a microprocessor or microcomputer. With judicious interface timing, the TLC542 can complete a conversion in $20 \mu \mathrm{~s}$, while complete input-conversion-output cycles can be repeated every $40 \mu \mathrm{~s}$. Furthermore, this fast conversion can be executed on any of 11 inputs or its built-in "self-test" and in any order desired by the controlling processor.
When $\overline{C S}$ is high, the Data Output pin is in a 3 -state condition and the Address Input and I/O Clock pins are disabled. When additional TLC542 devices are used, this feature allows each of these pins, with the exception of the $\overline{\mathrm{CS}} \mathrm{pin}$, to share a control logic point with their counterpart pins on additional $\mathrm{A} / \mathrm{D}$ devices. Thus, this feature minimizes the control logic pins required when using multiple $A / D$ devices.
The control sequence is designed to minimize the time and effort required to initiate conversion and to obtain the conversion result. A normal control sequence is as follows:

1. $\overline{\mathrm{CS}}$ is brought low. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for two rising edges and then a falling edge of the internal system clock before recognizing the low $\overline{\mathrm{CS}}$ transition. The MSB of the result of the previous conversion automatically appears on the Data Out pin.
2. On the first four rising edges of the $1 / O$ Clock, a new positive-logic multiplexer address is shifted in, with the MSB of this address shifted first. The negative edges of these four I/O clock pulses shift out the second, third, fourth, and fifth most significant bits of the result of the previous conversion. The onchip sample-and-hold begins sampling the newly addressed analog input after the fourth falling edge of the I/O Clock. The sampling operation basically involves charging the internal capacitors to the level of the analog input voltage.
3. Three clock cycles are applied to the I/O pin, and the sixth, seventh, and eighth conversion bits are shifted out on the negative edges of these clock cycles.
4. The final eighth clock cycle is applied to the I/O Clock pin. The falling edge of this clock cycle completes the analog sampling process and initiates the hold function. Conversion is then performed during the next $20 \mu \mathrm{~s}$. After this final I/O Clock cycle, $\overline{\mathrm{CS}}$ must go high or the I/O Clock must remain low for at least $20 \mu$ s to allow for the conversion function.
$\overline{\mathrm{CS}}$ can be kept low during periods of multiple conversion. If $\overline{\mathrm{CS}}$ is taken high, it must remain high until the end of the conversion. Otherwise, a valid falling edge of $\overline{\mathrm{CS}}$ causes a reset condition, which aborts the conversion process.
A new conversion may be started and the ongoing conversion simultaneously aborted by performing steps 1 through 4 before the $20-\mu \mathrm{s}$ conversion time has elapsed. Such action yields the conversion result of the previous conversion and not the ongoing conversion.
The End-Of-Conversion (EOC) output goes low on the negative edge of the eighth I/O Clock. The subsequent low-to-high transition of EOC indicates the A/D conversion is complete and the conversion result is ready for transfer.

# TLC543M, TLC543I, TLC544M, TLC544I 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 5 INPUTS <br> D2799, SEPTEMBER 1986 

- LinCMOS ${ }^{\text {m }}$ Technology
- 8-Bit Resolution A/D Converter
- On-Chip 6-Channel Analog Multiplexer
- Built-In Self-Test Mode
- Software-Controllable Sample-and-Hold
- Total Unadjusted Error . . . $\pm 0.5$ LSB Max
- End-of-Conversion Output
- Conversion Time . . . $17 \mu \mathrm{~s}$ Max
- Internal System Clock . . . 4 MHz Typ
- Low Power Consumption . . . 6 mW Typ
- Minimum Sample Rates:

TLC543 . . . 45,500 c/s
TLC544 . . . 40,000 c/s


## description

The TLC543 and TLC544 are LinCMOS ${ }^{\text {Tm }}$ A/D peripherals built around an 8-bit switched-capacitor, successive-approximation A/D converter. They are designed for serial interface to a microprocessor or peripheral via a 3 -state output with up to four control lines including I/O Clock, Chip Select ( $\overline{\mathrm{CS}}$ ), Address Input, and End-of-Conversion (EOC) output. A $4-\mathrm{MHz}$ on-chip system clock and simultaneous read/write operations permit high-speed data transfer and minimum sample rates of 45,500 cycles per second for the TLC543 and 40,000 cycles per second for the TLC544. In addition to the high-speed converter and versatile control logic, an on-chip 6-channel analog multiplexer can be used to sample any one of five inputs or an internal "self-test" voltage, and a sample-and-hold can operate automatically or under processor control.

The converters incorporated in the TLC543 and TLC544 feature differential high-impedance reference inputs that permit ratiometric conversion, scaling, and isolation of analog circuitry from logic and supply noise.
A totally switched-capacitor design allows low-error ( $\pm 0.5 \mathrm{LSB}$ ) conversion in 17 microseconds maximum for the TLC543 and the TLC544 over the full operating temperature range. The TLC543M and TLC544M are characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC543I and TLC544I are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## TLC543M, TLC543I, TLC544M, TLC544I 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 5 INPUTS

functional block diagram

operating sequence


NOTES: A. The conversion cycle, which requires 36 internal system clock periods, is initiated on the 8 th falling edge of the $\mathrm{I} / \mathrm{O}$ Clock after $\overline{\mathrm{CS}}$ goes low for the channel whose address exists in memory at that time. If $\overline{\mathrm{CS}}$ is kept low during conversion, the $1 / O$ clock must remain low for at least 36 system clock cycles to allow conversion to complete.
B. The most significant bit (MSB) is automatically placed on the DATA OUT bus after $\overline{\mathrm{CS}}$ is brought low. The remaining seven bits (A6-AO) are clocked out on the first seven falling edges of the I/O Clock.
C. To minimize errors caused by noise at the $\overline{\mathrm{CS}}$ input, the internal circuitry waits for three internal system clock cycles ( $1.4 \mu \mathrm{~s}$ at 2 MHz ) after a chip select transition before responding to control input signals. Therefore, no attempt should be made to clock-in address data until the minimum chip-select setup time has elapsed.

## TLC543M, TLC543I, TLC544M, TLC544I 8-BIT ANALOG-TO-DIGITAL PERIPHERALS WITH SERIAL CONTROL AND 5 INPUTS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VCC (see Note 1) ..... 6.5 V
Input voltage range (any input) ..... -0.3 V to $\mathrm{VCC}+0.3 \mathrm{~V}$
Peak input current (any input) ..... $\pm 10 \mathrm{~mA}$
Peak total input current (all inputs) ..... $\pm 30 \mathrm{~mA}$
Operating free-air temperature range TLC543M, TLC544M $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
$-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage temperature range $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from case for 10 seconds: $D$ or N package ..... $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from case for 60 seconds: J package ..... $300^{\circ} \mathrm{C}$

NOTE 1: All voltages are with respect to ground (GND pin) with REF - and GND wired together (unless otherwise noted).
recommended operating conditions

|  |  | TLC543 |  |  | TLC544 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | NOM | MAX | MIN | NOM | MAX |  |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | 3 | 5 | 6 | 3 | 5 | 6 | V |
| Positive reference voltage, $\mathrm{V}_{\text {REF }+ \text { ( }}$ | Note 2) | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | 2.5 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.1$ | V |
| Negative reference voltage, $\mathrm{V}_{\text {REF - }}$ ( s | ee Note 2) | -0.1 | 0 | 2.5 | 0.1 | 0 | 2.5 | V |
| Differential reference voltage, $\mathrm{V}_{\text {REF + }}$ | - VREF - (see Note 2) | 1 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.2$ | 1 | $\mathrm{V}_{\mathrm{CC}}$ | $\mathrm{V}_{\mathrm{CC}}+0.2$ | V |
| Analog input voltage (see Note 2) |  | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | 0 |  | $\mathrm{V}_{\mathrm{CC}}$ | V |
| High-level control input voltage, $\mathrm{V}_{\text {IH }}$ | or $\mathrm{V}_{\mathrm{CC}}=4.75$ to 5.5 V ) | 2 |  |  | 2 |  |  | V |
| Low-level control input voltage, $\mathrm{V}_{\text {IL }}$ (for | r $\mathrm{V}_{\mathrm{CC}}=4.75$ to 5.5 V ) |  |  | 0.8 |  |  | 0.8 | V |
| Input/Output clock frequency, fCLK(I/O) (for $\mathrm{V}_{\mathrm{CC}}=4.75$ to 5.5 V ) |  | 0 |  | 2.048 | 0 |  | 1.1 | MHz |
| System clock frequency, ${ }^{\text {f }}$ CLK(I/O) (f | $\mathrm{V}_{\mathrm{CC}}=4.75$ to 5.5 V ) |  |  | 4 |  |  | 2.1 | MHz |
| Input/Output clock high, $\mathrm{t}_{\mathrm{w}} \mathrm{H}(1 / \mathrm{O})$ |  | 200 |  |  | 404 |  |  | ns |
| Input/Output clock low, $\mathrm{t}_{\mathrm{wL}}(1 / \mathrm{O})$ |  | 200 |  |  | 404 |  |  | ns |
| 1/O clock transition time (see Note 3) | ${ }^{\text {f }}$ CLK(I/O) $<1.1 \mathrm{MHz}$ |  |  | 100 |  |  | 100 | ns |
|  | ${ }^{\text {f }}$ CLK $(1 / \mathrm{O})>1.1 \mathrm{MHz}$ |  |  | 40 |  |  |  | ns |
| Duration of $\overline{\mathrm{CS}}$ input high state during | conversion, $\mathrm{t}_{\mathrm{WH}}$ (CS) | 17 |  |  | 17 |  |  | $\mu \mathrm{S}$ |
| Setup time, address bits at data input before I/O CLOCK $\uparrow$, $\mathrm{t}_{\mathrm{su}}(\mathrm{A})$ |  | 200 |  |  | 400 |  |  | ns |
| Hold time, address bits after I/O CLOC | $K \uparrow, t_{h}(A)$ | 0 |  |  | 0 |  |  | ns |
| Setup time, $\overline{\mathrm{CS}}$ low before clocking in $\mathrm{t}_{\text {su(CS) }}$ (see Note 4) | first address bits, | 1.4 |  |  | 1.4 |  |  | $\mu \mathrm{S}$ |
| Operating free-air temperature $T_{A}$ | TLC543M, TLC544M | -55 |  | 125 | -55 |  | 125 |  |
| Operating free-air tem | TLC543I, TLC544I | -40 |  | 85 | -40 |  | 85 | ${ }^{\circ}$ |

NOTES: 2. Analog input voltages greater than that applied to REF + convert to all ones (11111111), and input voltages less than that applied to REF - convert to all zeros (00000000). For proper operation, REF + voltage must be at least 1 V higher than REF voltage. Also, adjusted errors may increase as this differential reference voltage falls below 4.75 V.
3. This is the time required for the clock input signal to fall from $V_{I H} \min$ to $V_{I L} \max$ or to rise from $V_{I L} \max$ to $V_{I H} m i n$. In the vicinity of normal room temperature, the devices function with input clock transitions as slow as $2 \mu \mathrm{~s}$ for remote data acquisition applications in which the sensor and the A/D converter are placed several feet away from the controlling microprocessor.
4. To minimize errors caused by noise at the Chip Select input, the internal circuitry waits for three system clock cycles $(1.4 \mu \mathrm{~s}$ at 2 MHz ) after a chip select falling edge is detected before responding to control input signals. Therefore, no attempt should be made to clock-in address data until the minimum chip select setup time has elapsed.
electrical characteristics over recommended operating temperature range,
$V_{C C}=V_{R E F}+=4.75 \mathrm{~V}$ to 5.5 V (unless otherwise noted), $\mathrm{f} C L K(I / O)=2.048 \mathrm{MHz}$ for TLC543 or $\mathrm{fCLK}(\mathrm{I} / \mathrm{O})=1.1 \mathrm{MHz}$ for TLC544

| PARAMETER |  |  |  | TEST CONDITIONS |  | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage, Data out, EOC |  |  | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ | ${ }^{\mathrm{I}} \mathrm{OH}=-360 \mu \mathrm{~A}$ | 2.4 |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage |  | Data out | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{IOL}=3.2 \mathrm{~mA}$ |  |  | 0.4 | V |
|  |  |  | EOC | $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}_{\mathrm{OL}}=1.6 \mathrm{~mA}$ |  |  | 0.4 |  |
| IOZ | Off-state (high-impedance state) output current |  |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$, | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  |  | 10 | $\mu \mathrm{A}$ |
|  |  |  |  | $V_{0}=0$, | $\overline{\mathrm{CS}}$ at $\mathrm{V}_{\mathrm{CC}}$ |  |  | -10 |  |
| $\mathrm{IIH}^{\text {H }}$ | High-level input current |  |  | $\mathrm{V}_{1}=\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ |  |  | 0.005 | 2.5 | $\mu \mathrm{A}$ |
| IIL | Low-level input current |  |  | $\mathrm{V}_{1}=0$ |  |  | -0.005 | -2.5 | $\mu \mathrm{A}$ |
| ${ }^{\text {ICC }}$ | Operating supply current |  |  | $\overline{\mathrm{CS}}$ at 0 V |  |  | 1.2 | 2 | mA |
| 1 lkg | Selected channel leakage current |  |  | Selected channel at $V_{C C}$, <br> Unselected channel at 0 V | See Figure 1 |  | 0.4 | 1 | $\mu \mathrm{A}$ |
|  |  |  |  | Selected channel at 0 V , <br> Unselected channel at $\mathrm{V}_{\mathrm{CC}}$ |  |  | -0.4 | -1 |  |
| IREF | Reference current |  |  | $\mathrm{V}_{\text {REF }+}=\mathrm{V}_{\text {CC, }}$, $\overline{\mathrm{CS}}$ at 0 V |  |  | 0.1 | 1 | mA |
| $C_{i}$ | Input capacitance | Anal | inputs |  |  |  | 7 | 55 | pF |
|  |  | Cont | inputs |  |  |  | 5 | 15 |  |

${ }^{\dagger}$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

PARAMETER MEASUREMENT INFORMATION

figure 1. SELECTED CHANNEL LEAKAGE CURRENT
operating characteristics over recommended operating free-air temperature range, $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{REF}}+=4.75$ to 5.5 V ,
$\mathrm{fCLK}(1 / \mathrm{O})=2.048 \mathrm{MHz}$ for $\mathrm{TLC543}$ or 1.1 MHz for TLC544

| PARAMETER |  | TEST CONDITIONS | TLC543 |  |  | TLC544 |  |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
|  | Linearity error (see Note 5) |  |  |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
|  | Zero error (see Note 6) |  |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
|  | Full-scale error (see Note 6) |  |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
|  | Total unadjusted error (see Note 7) |  |  |  | $\pm 0.5$ |  |  | $\pm 0.5$ | LSB |
|  | Self-test output code | Input A5 address $=10110$, See Note 8 | $\begin{gathered} 01111101 \\ (125) \end{gathered}$ |  | $\begin{array}{r} 10000011 \\ (131) \end{array}$ | $\begin{gathered} 01111101 \\ (125) \\ \hline \end{gathered}$ |  | $\begin{gathered} 10000011 \\ (131) \end{gathered}$ |  |
| t conv | Conversion time | See Operating Sequence |  | 8 | 17 |  | 12 | 17 | $\mu \mathrm{S}$ |
| $\mathrm{ta}_{\mathrm{a}+\mathrm{c}}$ | Total access and conversion time | See Operating Sequence |  | 12 | 22 |  | 19 | 25 | $\mu \mathrm{s}$ |
| $\mathrm{tacq}^{\text {a }}$ | Channel acquisition time (sample cycle) | See Operating Sequence |  |  | 4 |  |  | 4 | I/O <br> clock <br> cycles |
| $\mathrm{t}_{\mathrm{v}}$ | Time output data remains valid after I/O clock $\downarrow$ |  | 10 |  |  | 10 |  |  | ns |
| $\mathrm{t}_{\mathrm{d}}$ | Delay time, 1/O clock $\downarrow$ to data output valid |  |  |  | 300 |  |  | 400 | ns |
| $t_{\text {en }}$ | Output enable time | See Figure 2 |  |  | 1.4 |  |  | 1.4 | ns |
| $\mathrm{t}_{\text {dis }}$ | Output disable time |  |  |  | 150 |  |  | 150 | ns |
| $\mathrm{t}_{\mathrm{r}}$ (bus) | Data bus and EOC rise time |  |  |  | 300 |  |  | 300 | ns |
| $\mathrm{t}_{\mathrm{f} \text { (bus) }}$ | Data bus and EOC fall time |  |  |  | 300 |  |  | 300 | ns |
| ${ }^{\text {tPHL }}$ (EOC) | Propagation delay, 8th I/O clock $\downarrow$ to EOC |  |  |  | 400 |  |  | 400 | ns |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{EOC})$ | Delay time, EOC to DATA OUT (MSB) (see Note 9) |  | -1 |  |  | -1 |  |  | $\mu \mathrm{S}$ |

NOTES: 5. Linearity error is the maximum deviation from the best straight line through the $A / D$ transfer characteristics,
6. Zero error is the difference between the output of an ideal and an actual A/D converter for zero input voltage; full-scale error is that same difference for fullscale input voltage
7. Total unadjusted error comprises linearity, zero, and full-scale errors.
8. Both the input address and the output codes are expressed in positive logic. The A5 analog input signal is internally generated and is used for test purposes.
9. The EOC signal is output after 40 internal clock cycles, while the data is available after 36 internal clock cycles. Thus, the delay time, EOC to DATA OUT, is a negative value equal to four internal system clock cycles less internal propagation delays.

## PARAMETER MEASUREMENT INFORMATION




VOLTAGE WAVEFORMS FOR EOC TIMING

NOTES: A. $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ for TLC543 and 100 pF for TLC544.
B. $t_{\text {en }}=t_{P Z H}$ or $t_{P Z L}, t_{\text {dis }}=t_{\text {PHZ }}$ or $t_{\text {PLZ }}$.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

FIGURE 2. OPERATING CHARACTERISTICS

## PRINCIPLES OF OPERATION

## introduction

TLC543 and TLC544 are each complete data acquisition systems on a single chip. They include the functions of analog multiplexer, sample-and-hold, 8-bit A/D converter, data and control registers, and control logic. Flexible serial communication is achieved with a microprocessor or microcomputer using a TTL-compatible 3-state Data Out and four control lines - Chip Select ( $\overline{\mathrm{CS}}$ ), I/O Clock, Address Input, and End of Conversion (EOC) output.

To maximize access speed, the device simultaneously writes the previous conversion result, reads a new multiplexer address, and acquires the analog signal. This is followed by the A/D conversion, whose end is signalled by the EOC output going high. These total access and conversion cycles are completed in a minimum of $22 \mu \mathrm{~s}$ for the TLC543 and $25 \mu \mathrm{~s}$ for the TLC544. Conversion can take place, in any order, on the five analog inputs or the built-in self-test system.
The system clock, which drives the control logic and the switched-capacitor successive-approximation A/D converter, is internal to the device and typically runs at a frequency of 4 MHz . This internal system clock runs independently, and there are no required phase or frequency relationships with other signals.

## digital interface

The I/O clock controls the acquisition of the analog signal as well as all serial data communications between the TLC543 or TLC544 and the host processor. From the host, this I/O clock consists of a burst of eight pulses separated by the conversion time. Timing may be achieved by Chip Select ( $\overline{\mathrm{CS}}$ ) synchronously gating a continuous I/O clock or directly from the host with $\overline{\mathrm{CS}}$ held low continuously.
With $\overline{\mathrm{CS}}$ high, Data Out is in a high-impedance condition with the Address input and I/O Clock input disabled. This feature allows the interface pins, with the exception of $\overline{\mathrm{CS}}$ and EOC, to share a common bus with additional TLC543 or TLC544 devices or other members of the TLC543/544 family of devices.

## typical operating sequence

Consider an access and conversion sequence where $\overline{\mathrm{CS}}$ is being used: $\overline{\mathrm{CS}}$ is brought low and recognized after the time out of the noise-rejection circuitry. The MSB of the result of the previous conversion appears at Data Out, whose 3-state output is enabled. The MSB of the new multiplexer address should be present at the Address Input to conform with the setup time, $t_{s u}(A)$, requirements before the first rising edge of the I/O clock. The multiplexer address is shifted in on the first three rising edges of the I/O clock.
The first seven falling edges of I/O CLOCK shift out the remaining seven bits of the previous conversion on DATA OUT. The eighth I/O clock falling edge returns the MSB to the Data Out. Optimum serial transfer takes place with the bit streams being read on the rising edges of the I/O clock for the respective devices and the Data Out and Address In lines.

At the fourth falling edge of the I/O clock, the on-chip sample-and-hold begins to acquire the newly addressed analog input and continues until the eighth (and final) falling edge. A hold function is initiated by the eighth I/O clock pulse falling edge. To start the conversion at a specific point in time (or lengthen the acquisition time), the host processor may leave the eighth I/O clock pulse in the high state until the moment at which the analog signal must be sampled. After bringing the eighth I/O pulse low, the A/D function is performed in the next 36 internal system clock cycles.
In applications where $\overline{\mathrm{CS}}$ is held low continuously, the bursts of eight I/O clock pulses should be timed to be at least $t_{\text {conv }}$ apart.

## $\overline{\mathrm{CS}}$ input

To minimize bus contention caused by noise enabling the 3 -state Data Out, when the $\overline{\mathrm{CS}}$ input is brought low, the device waits for two rising edges and a falling edge of the internal system clock before recognizing the $\overline{\mathrm{CS}}$ transition. Hence, the setup time $\mathrm{t}_{\mathrm{Su}}(\mathrm{CS})$ should be observed when using the $\overline{\mathrm{CS}}$ input. This also applies to a $\overline{\mathrm{CS}}$ high-to-low transition, except for disabling DATA OUT, which goes into a high-impedance state immediately within the $t_{\text {dis }}$ specification (see Figure 3). If this interruption of $\overline{\mathrm{CS}}$ in the low state is less than 1.5 internal system clock cycles, and hence not recognized, DATA OUT will be immediately enabled with the return of $\overline{\mathrm{CS}}$ to the low state. DATA OUT becomes enabled after a $\overline{\mathrm{CS}}$ high-to-low transition in time $t_{e n}$ (equivalent to $t_{\text {su( }}(\mathrm{CS})$ for this device).
$\overline{\mathrm{CS}}$ can be brought high during a conversion without affecting the ongoing conversion but must remain high until the end of conversion. Otherwise, a $\overline{C S}$ falling edge causes a reset condition that aborts the conversion in progress. When a new access cycle starts, the previous conversion result is output.
A new conversion may be restarted by toggling $\overline{\mathrm{CS}}$ high-to-low at least $\mathrm{t}_{\text {su }}(\mathrm{CS})$ before the eighth falling edge of the I/O clock. The ongoing access cycle is aborted. Again, when a new access cycle starts, the previous conversion result is output.

## end of conversion output (EOC)

EOC goes low at propagation delay time, tPHL(EOC), after the 8 th falling edge of the I/O clock and goes high when conversion is complete. At this time, the MSB is available at Data Out; however, if $\overline{\mathrm{CS}}$ is high, it is necessary to bring $\overline{\mathrm{CS}}$ low and wait for the $\overline{\mathrm{CS}}$ recognition time before Data Out is available, since Data Out is in a high-impedance state when $\overline{C S}$ is high. Delay time, $\mathrm{t}_{\mathrm{d}}(\mathrm{EOC})$, of EOC to Data Out is a negative value of 4 internal system clock cycles less internal propagation delay because the EOC signal is output after 40 internal system clock cycles, whereas conversion is complete with data available after 36 cycles.

## TLC1225A, TLC1225B <br> SELF-CALIBRATING 12-BIT-PLUS-SIGN UNIPOLAR OR BIPOLAR ANALOG-TO-DIGITAL CONVERTERS <br> D2982, FEBRUARY 1987-REVISED JANUARY 1989

- Advanced LinCMOS ${ }^{\text {TM }}$ Technology
- Self-Calibration Eliminates Expensive Trimming at Factory and Offset Adjustment in the Field
- 12-Bit Plus Sign Bipolar or 12-Bit Unipolar
- $\pm 1 / 2$ and $\pm 1$ LSB Linearity Error in Unipolar Configuration
- $10 \mu \mathrm{~s}$ Conversion Time (clock $=2.6 \mathrm{MHz}$ )
- Compatible with All Microprocessors
- True Differential Analog Voltage Inputs
- 0 to 5 V Analog Voltage Range with Single 5-V Supply (Unipolar Configuration)
- -5 V to 5 V Analog Voltage Range with $\pm 5-\mathrm{V}$ Supplies (Bipolar Configuration)
- Low Power . . . 25 mW Maximum


## description

The TLC1225A and TLC1225B converters are manufactured with Texas Instruments highly efficient Advanced LinCMOS ${ }^{\text {TM }}$ technology. Either of the TLC1225A or TLC1225B CMOS analog-to-digital converters can be operated as a unipolar or bipolar converter. A unipolar input( 0 to 5 V ) can be accommodated with a single $5-\mathrm{V}$ supply; a bipolar input ( -5 V to 5 V ) requires the addition of a $5-\mathrm{V}$ negative supply. Conversion is performed via the successive-approximation method. The TLC1225A and TLC1225B output the converted data in a parallel word and interfaces directly to a 16-bit data bus. Negative numbers are given in the two's complement data format. All digital signals are fully TTL and CMOS compatible.

These converters utilize a self-calibration technique by which seven of the internal capacitors in the capacitive ladder of the A/D conversion circuitry can be automatically calibrated. The internal capacitors are calibrated during a nonconversion, capacitor-calibrate cycle in which all seven of the internal capacitors are calibrated at the same time. A conversion requires only $10 \mu \mathrm{~s}(2.6 \mathrm{MHz}$ clock) after the nonconversion, capacitorcalibrating cycle has been completed. The calibration or conversion cycle may be initiated at any time by issuing the proper command word to the data bus. The self-calibrating technique eliminates the need for expensive trimming of thin-film resistors at the factory and provide excellent performance at low cost.

The TLC1225AM and TLC1225BM are characterized for operation over the full military temperature range of $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$. The TLC1225AI and TLC1225BI are characterized for operation from $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.
functional block diagram


## operation description

## calibration of comparator offset

The following actions are performed to calibrate the comparator offset:

1. The $\operatorname{IN}+$ and $\operatorname{IN}$ - inputs are internally shorted together in order that the comparator input is zero. A course comparator offset calibration is performed by storing the offset voltages of the interconnecting comparator stages on the coupling capacitors that connect these stages. Refer to Figure 1. The storage of offset voltages is accomplished by closing all switches and then opening switches $A$ and $A^{\prime}$, then switches $B$ and $B^{\prime}$, and then $C$ and $C^{\prime}$. This process continues until all interconnecting stages of the comparator are calibrated. After this action, some of the comparator offset still remains uncalibrated.


FIGURE 1
2. An A/D conversion is done on the remaining offset with the 8 -bit calibration DACs and 8 -bit SAR and the result is stored in the RAM.

## capacitor calibration of the ADC's capacitive ladder

The following actions are performed to calibrate capacitors in the 13-bit DACs that comprise the ADC's capacitive ladder:

1. The $\mathbb{I N}+$ and $\mathbb{I N}$ - inputs are internally disconnected from the 13 -bit capacitive DACs.
2. The most significant bit (MSB) capacitor is tied to REF, while the rest of the ladder capacitors are tied to GND. The A/D conversion result for the remaining comparator offset, obtained in Step 2 above, is retrieved from the RAM and is input to the 8 -bit DACs.
3. Step 1 of the Calibration of Comparator Offset sequence is performed. The 8 -bit DAC input is returned to zero and the remaining comparator offset is then subtracted. Thus, the comparator offset is completely corrected.
4. Now the MSB capacitor is tied to GND, while the rest of the ladder capacitors, $C_{x}$, are tied to REF. An MSB capacitor voltage error (see Figure 2) on the comparator output will occur if the MSB capacitor does not equal the sum of the other capacitors in the capacitive ladder. This error voltage is converted to an 8-bit word from which a capacitor error is computed and stored in the RAM.
5. The capacitor voltage error for the next most significant capacitor is calibrated by keeping the MSB capacitor grounded and then performing the above Steps 1-4 while using the next most significant capacitor in lieu of the MSB capacitor. The seven most significant capacitors can be calibrated in this manner.

# TLC1225A, TLC1225B <br> SELF-CALIBRATING 12-BIT-PLUS-SIGN UNIPOLAR OR BIPOLAR <br> ANALOG-TO-DIGITAL CONVERTERS 



FIGURE 2

## analog-to-digital conversion

The following steps are performed in the analog-to-digital conversion process:

1. Step 1 of the Calibration of Comparator Offset Sequence is performed. The A/D conversion result for the remaining comparator offset, which was obtained in Step 2 of the Calibration of Comparator Offset, is retrieved from the RAM and is input to the 8-bit DACs. Thus the comparator offset is completely corrected.
2. $\mathrm{IN}+$ and IN - are sampled onto the 13-bit capacitive ladders.
3. The 13-bit analog-to-digital conversion is performed. As the successive-approximation conversion proceeds successively through the seven most significant capacitors, the error for each of these capacitors is recovered from the RAM and accumulated in a register. This register controls the 8 -bit DACs so the total accumulated error for these capacitors is subtracted out during the conversion process.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage (ANLG $V_{C C}+$ and DGTL $V_{C C}$ ) (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . 15 V
Supply voltage, ANLG VCC- . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 15 V
Control and Clock input voltage range -0.3 V to +15 V
Analog input (IN+, IN-) voltage range,

$$
V_{1+} \text { and } V_{1}-\ldots . . . . . . . . . . . . . . . . . . . . . . .
$$

Reference voltage range, Vref . . . . . . . . . . . . . . . . . . . . . . . . . . . . . - 0.3 V to ANLG $\mathrm{V}_{\mathrm{CC}}++0.3 \mathrm{~V}$
Pin 7 voltage range, VOS . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to ANLG VCC+ +0.3 V
Output voltage range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to DGTL VCC +0.3 V
Input current (per pin) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 5 \mathrm{~mA}$
Input current (per package) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $\pm 20 \mathrm{~mA}$
Operating free-air temperature range:
TLC1225AM, TL1225BM . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
TLC1225AI, TLC1225BI . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}$ ( $1 / 16 \mathrm{inch}$ ) from the case for 60 seconds: J package . . . . . . . . . . . . . $300^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from the case for 10 seconds: N package . . . . . . . . . . . $260^{\circ} \mathrm{C}$
NOTE 1: All analog voltages are referred to ANLG GND and all digital voltages are referred to DGTL GND.
recommended operating conditions

|  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage | ANLG VCC + | 4.5 | 6 | V |
|  | ANLG $\mathrm{V}_{\text {CC }}$ - | -5.5 | ANLG GND |  |
|  | DGTL VCC | 4.5 | 6 |  |
| High-level input voltage, $\mathrm{V}_{\mathbb{I H}}$, all digital inputs except CLK IN ( $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V ) |  | 2 |  | V |
| Low-level input voltage, VIL, all digital inputs except CLK IN ( $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to 5.25 V ) |  |  | 0.8 | V |
| Analog input voltage, $\mathrm{V}_{1+}, \mathrm{V}_{1-}$ | Bipolar range | ANLG V ${ }_{\text {CC }}-0.05$ | ANLG $\mathrm{V}_{\text {CC }}++0.05$ | V |
|  | Unipolar range | ANLG GND - 0.05 | ANLG $\mathrm{V}_{\text {CC }}++0.05$ |  |
| Pin 7 (TIE HIGH) |  | 2 |  | V |
| Clock input frequency, flock |  | 0.3 | 2.6 | MHz |
| Clock duty cycle |  | 40\% | 60\% |  |
| Pulse duration, $\overline{C S}$ and $\overline{W R}$ both low, $\mathrm{t}_{\mathrm{w}}(\overline{\mathrm{CS}} \cdot \overline{\mathrm{WR}})$ |  | 50 |  | ns |
| Setup time before $\overline{\mathrm{Wr}} \uparrow$ or $\overline{\mathrm{CS}} \uparrow, \mathrm{t}_{\text {su }}$ |  |  | 50 | ns |
| Hold time after $\overline{\mathrm{WR}} \uparrow$ or $\overline{\mathrm{CS}} \uparrow$, th |  |  | 50 | ns |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC1225AM, TLC1225BM | -55 | 125 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC1225AI, TLC1225BI | -40 | 85 |  |

electrical characteristics over recommended operating free-air temperature range, ANLG VCC $+=$ DGTL $V_{C C}=V_{\text {ref }}=5 \mathrm{~V}$, ANLG $V_{C C}-=-5 \mathrm{~V}$ (for bipolar input range), ANLG VCC - = ANLG GND (for unipolar input range) (unless otherwise noted) (see Note 2)

|  | PARAMETER | TEST CON | TIONS | MIN MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $1 \mathrm{O}=-1.8 \mathrm{~mA}$ | 2.4 | V |
|  |  |  | $\mathrm{I}^{\mathrm{O}}=-50 \mu \mathrm{~A}$ | 4.5 |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | DGTL $\mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V}$, | $\mathrm{I}^{\mathrm{O}}=8 \mathrm{~mA}$ | 0.4 | V |
| $\mathrm{V}_{\mathrm{T}+}$ | Clock positive-going threshold voltage |  |  | $2.7 \quad 3.5$ | V |
| $\mathrm{V}_{\text {T- }}$ | Clock negative-going threshold voltage |  |  | 1.42 .1 | V |
|  |  | $\mathrm{V}_{\mathrm{T}+}$ min $-\mathrm{V}_{\mathrm{T}-\max }$ |  | 0.6 |  |
|  |  | $V_{T+}+\max -V_{T}$ - min |  | 2.1 |  |
| ${ }^{\text {ref }}$ | Input resistance, REF terminal |  |  | $1 \quad 10$ | $\mathrm{M} \Omega$ |
| IIH | High-level input current | $V_{1}=5 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
| IIL | Low-level input current | $V_{1}=0$ |  | -1 | $\mu \mathrm{A}$ |
|  | High-impedance-state | $\mathrm{V}_{\mathrm{O}}=0$ |  | -3 |  |
| 'OZ | output leakage current | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V}$ |  | 3 |  |
| 10 | Output current | $\mathrm{V}_{\mathrm{O}}=0$ |  | -6 | mA |
|  | Output current | $\mathrm{V}_{\mathrm{O}}=5 \mathrm{~V}$ |  | 8 |  |
| DGTL ICC | Supply current from DGTL $\mathrm{V}_{\text {CC }}$ | ${ }^{\text {clk }}$ = 2.6 MHz , | $\overline{\mathrm{CS}}$ high | 3 | mA |
| ANLG ICC+ | Supply current from ANLG $\mathrm{V}_{\mathrm{CC}}+$ | $\mathrm{f}_{\text {clk }}=2.6 \mathrm{MHz}$, | $\overline{\mathrm{CS}}$ high | 3 | mA |
| ANLG ${ }^{\text {I CC- }}$ | Supply current from ANLG $\mathrm{V}_{\text {CC }}$ - | $\mathrm{f}_{\text {clk }}=2.6 \mathrm{MHz}$, | $\overline{\mathrm{CS}}$ high | -3 | mA |

NOTE 2: Bipolar input range is defined as: $\mathrm{V}_{1+}=-5.05 \mathrm{~V}$ to $5.05 \mathrm{~V}, \mathrm{~V}_{1-}=-5.05 \mathrm{~V}$ to 5.05 V , and $\left|\mathrm{V}_{1+}-\mathrm{V}_{1-}\right| \leq 5.05 \mathrm{~V}$. The unipolar input voltage range is defined as: $\mathrm{V}_{1+}=-0.05 \mathrm{~V}$ to $5.05 \mathrm{~V}, \mathrm{~V}_{1-}=-0.05 \mathrm{~V}$ to 5.05 V , and $\left|\mathrm{V}_{1+}-\mathrm{V}_{1-}\right| \leq 5.05 \mathrm{~V}$.
operating characteristics over recommended operating free-air temperature range, ANLG VCC $+=$ DGTL $V_{C C}=V_{\text {ref }}=5 \mathrm{~V}$, ANLG VCC $-=-5 \mathrm{~V}$ (for bipolar input range), ANLG VCC - = ANLG GND (for unipolar input range), fclock $=2.6 \mathrm{MHz}$ (unless otherwise noted) (see Note 2)


NOTES: 2. Bipolar input range is defined as: $\mathrm{V}_{1+}=-5.05 \mathrm{~V}$ to $5.05 \mathrm{~V}, \mathrm{~V}_{1-}=-5.05 \mathrm{~V}$ to 5.05 V , and $\mid \mathrm{V}_{1+}-\mathrm{V}_{1-} \leq 5.05 \mathrm{~V}$. The unipolar input voltage range is defined as: $\mathrm{V}_{1+}=-0.05 \mathrm{~V}$ to $5.05 \mathrm{~V}, \mathrm{~V}_{1-}=-0.05 \mathrm{~V}$ to 5.05 V , and $\left|\mathrm{V}_{1+}-\mathrm{V}_{1-}\right| \leq 5.05 \mathrm{~V}$.
3. See the Positive and Negative Full-Scale Adjustment section, Unipolar Inputs.
4. See the Positive and Negative Full-Scale Adjustment section, Bipolar Inputs.



FIGURE 4. LOAD CIRCUITS AND WAVEFORMS

## power-up calibration sequence

## PRINCIPLES OF OPERATION

Power-Up calibration is not automatic and calibration is initiated by writing control words to the six least significant bits of the data bus. If addressed or initiated, conversion can begin after the first clock cycle. However, full A/D conversion accuracy is not established until after internal capacitor calibration.

## conversion start sequence

The writing of the conversion command word to the six least significant bits of the data bus, when either $\overline{\mathrm{CS}}$ or $\overline{W R}$ goes high, initiates the conversion sequence.
analog sampling sequence
Sampling of the input signal occurs during clock cycles 3 thru 10 of the conversion sequence.
completed A/D conversion
When INT goes low, conversion is complete and the $A / D$ result can be read. A new conversion can begin immediately. The $A / D$ conversion is complete at the end of clock cycle 27 of the conversion sequence.
aborting a conversion in process and beginning a new conversion
If a conversion is initiated while a conversion sequence is in process, the ongoing conversion will be aborted and a new conversion sequence will begin.

## reading the conversion result

When both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ go low, all 13 bits of conversion data are output to the I/O bus. The format of the output is extended sign with 2's complement, right justified data. For both unipolar and bipolar cases, the sign bit D12 is low if $\mathrm{V}_{1}+-\mathrm{V}_{1}$ - is positive and high if $\mathrm{V}_{1}+-\mathrm{V}_{1}$ - is negative.

## general

reset INT
When reading the conversion data, the falling edge of the first low-going combination of $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ will reset $\overline{\mathbb{N T}}$. The falling edge of the low-going combination of $\overline{\mathrm{CS}}$ and $\overline{\mathrm{WR}}$ will also reset $\overline{\mathrm{NT}}$.

## ready out

For high-speed microprocessors, READY OUT allows the TLC1225 to insert a wait state in the microprocessor's read or write cycle.

## reference voltage ( $V_{\text {ref }}$ )

This voltage defines the range for $\left|V_{1+}-V_{1-}\right|$. When $\left|V_{1+}-V_{1-}\right|$ equals $V_{\text {ref, }}$ the highest conversion data value results. When $\left|\mathrm{V}_{\mathrm{I}}+-\mathrm{V}_{1-}\right|$ equals 0 , the conversion data value is zero. Thus, for a given input, the conversion data changes ratiometrically with changes in $\mathrm{V}_{\text {ref }}$.
TIE HIGH
This pin is a digital input and should be tied high.

## calibration and conversion considerations

Calibration of the internal capacitor and $A / D$ conversion are two separate actions. Each action is independently initiated. A calibration command that calibrates all seven internal capacitors is normally issued before conversion. A conversion command then initiates the A/D conversion. Subsequent conversions can be performed by issuing additional conversion commands. The calibration and conversion commands are totally independent from one another and can be initiated in any order. Calibration and conversion commands require 105 and 27 clock cycles, respectively.

The calibrate and conversion commands are initiated by writing control words on the six least significant bits of the data bus. These control words are written into the IC when either $\overline{\mathrm{CS}}$ or $\overline{\mathrm{WR}}$ goes high. The initiation of these commands is illustrated in the Timing Diagram. The bit patterns for the commands are shown in Table 1.

TABLE 1. CONVERSION COMMANDS

| COMMAND | $\overline{\mathbf{C S}}+\overline{\text { WR }}$ | DI5 | DI4 | DI3 | DI2 | DI1 | DIO | REQUIRED NUMBER <br> OF CLOCK CYCLES |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | H | L | X | X | X | L | 27 |

tCalibration is lost when clock is stopped.

## analog inputs

## differential inputs provide common-mode rejection

The differential inputs reduce common-mode noise. Common-mode noise is noise common to both $\operatorname{IN}+$ and $\mathbb{N}$ - inputs, such as $60-\mathrm{Hz}$ noise. There is no time interval between the sampling of the $\mathbb{N}+$ and $\mathbb{N}$ - so these inputs are truly differential. Thus, no conversion errors result from a time interval between the sampling of the $\mathrm{IN}+$ and N - inputs.

## input bypass capacitors

Input bypass capacitors may be used for noise filtering. However, the charge on these bypass capacitors will be depleted during the input sampling sequence when the internal sampling capacitors are charged. Note that the charging of the bypass capacitors through the differential source resistances must keep pace with the charge depletion of the bypass capacitors during the input sampling sequence. Higher source resistances reduce the amount of charging current for the bypass capacitors. Also, note that fast, successive conversion

## TLC1225A, TLC1225B <br> SELF-CALIBRATING 12-BIT-PLUS-SIGN UNIPOLAR OR BIPOLAR ANALOG-TO-DIGITAL CONVERTERS


#### Abstract

will have the greatest charge depletion effect on the bypass capacitors. Therefore, the above phenomenon becomes more significant as source resistances and the converssion rate (i.e., higher clock frequency and conversion initiation rate) increase.


In addition, if the above phenomenon prevents the bypass capacitors from fully charging between conversions, voltage drops across the source resistances will result due to the ongoing bypass capacitor charging currents. The voltage drops will cause a conversion error. Also, the voltage drops increase with higher $\left|V_{1}+-V_{1}\right|$ values, higher source resistances, and lower charge on the bypass capacitors (i.e., faster conversion rate).

For low-source-resistance applications ( $\mathrm{R}_{\text {source }}<100 \Omega$ ), a $0.001-\mu \mathrm{F}$ bypass capacitor at the inputs will prevent pickup due to the series lead inductance of a long wire. A $100-\Omega$ resistor can be placed between the capacitor and the output of an operational amplifier to isolate the capacitor from the operational amplifier.

## input leads

The input leads should be kept as short as possible, since the coupling of noise and digital clock signals to the inputs can cause errors.

## power supply considerations

Noise spikes on the VCC lines can cause conversion error. Low-inductance tantalum capacitors ( $>1 \mu \mathrm{~F}$ ) with short leads should be used to bypass ANLG VCC and DGTL VCC. A separate regulator for the TLC1225A or TLC1225B and other analog circuitry will greatly reduce digital noise on the supply line.

## positive and negative full-scale adjustment

## unipolar inputs

Apply a differential input voltage that is 0.5 LSB below the desired analog full-scale voltage (VFS) and adjust the magnitude of the REF input so that the output code is just changing from 0111111111110 to 0111111111111 . If this transition is desired for a different input voltage, the reference voltage can be adjusted accordingly.

## bipolar inputs

First, follow the procedure for the unipolar case.
Second, apply a differential input voltage so that the digital output code is just changing from 1000000000001 to 1000000000000 . Call this actual differential voltage V X . The ideal differential voltage for this transition is:

$$
\begin{equation*}
-V_{F S}+\frac{V_{F S}}{8192} \tag{1}
\end{equation*}
$$

The difference between the actual and ideal differential voltages is:

$$
\begin{equation*}
\text { Delta }=V_{X}-\left(-V_{F S}+\frac{V_{F S}}{8192}\right) \tag{2}
\end{equation*}
$$

Then apply a differential input voltage of:

$$
\begin{equation*}
V_{X}-\frac{\text { Delta }}{2} \tag{3}
\end{equation*}
$$

and adjust $V_{\text {ref }}$ so the digital output code is just changing from 1000000000001 to 1000000000000 . This procedure produces positive and negative full-scale transitions with symmetrical minimum error.

TYPICAL APPLICATIONS


FIGURE 5. TRANSFER CHARACTERISTIC


NOTES: A. The analog input must have some current return path to ANALOG GND.
B. Bypass capacitor leads must be as short as possible.

FIGURE 6. ANALOG CONSIDERATIONS

TYPICAL APPLICATIONS (Continued)


FIGURE 7. INPUT PROTECTION


NOTES: A. $V_{1-}=0.15 \times$ ANLG $V_{C C}+$
B. $15 \%$ of ANALOG $V_{C C} \leq V_{X D R} \leq 85 \%$ of ANALOG $V_{C C}$

FIGURE 8. OPERATING WITH RATIOMETRIC TRANSDUCERS

- 8-Bit Resolution
- 0.2\% Linearity
- Maximum Conversion Rate . . . 25 MHz Typ 20 MHz Min
- Analog Input Voltage Range . . .
$V_{C C}$ to $V_{C C}-2 V$
- Analog Input Dynamic Range . . . 2 V to 5 V
- TTL Digital I/O Level
- Low Power Consumption . . . 200 mW Typ
- 5-V Single-Supply Operation
- Interchangeable with Fujitsu MB40578

N PACKAGE
(TOP VIEW)


## description

The TLC5502 is a low-power ultra-high-speed video-band analog-to-digital converter that uses the LinEPIC ${ }^{\text {Tm }} 1-\mu \mathrm{m}$ CMOS process. It utilizes the full-parallel comparison (flash method) for high-speed conversion. It converts wide-band analog signals (such as a video signal) to a digital signal at a sampling rate of dc to 30 MHz . Because of such high-speed capability, the TL5502 is suitable for digital video applications such as digital TV, video processing with a computer, or radar signal processing.
The TL5502 is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

## functional block diagram



LinEPIC is a trademark of Texas Instruments Incorporated.

## TLC5502

## 8-BIT ANALOG-TO-DIGITAL CONVERTER

equivalents of analog input circuit

equivalent of digital input circuit


## FUNCTION TABLE


$\dagger$ These values are based on the assumption that $V_{\text {refB }}$ and
$V_{\text {refT }}$ have been adjusted so that the voltage at the
transition from digital 0 to $1\left(V_{\mathrm{ZT}}\right)$ is 2.964 V and the
transition to full scale $\left(\mathrm{V}_{\mathrm{FT}}\right)$ is $4.996 \mathrm{~V} .1 \mathrm{LSB}=8 \mathrm{mV}$.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage range, ANLG VDD | -0.5 V to 7 V |
| :---: | :---: |
| Supply voltage range, DGTL VDD | -0.5 V to 7 V |
| Input voltage range at digital input, $\mathrm{V}_{1}$ | -0.5 V to 7 V |
| Input voltage range at analog input, $\mathrm{V}_{1}$ | -0.5 V to ANLG $\mathrm{V}_{D D}+0.5 \mathrm{~V}$ |
| Analog reference voltage range, $\mathrm{V}_{\text {ref }}$ | -0.5 V to ANLG $\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ |
| Operating free-air temperature range | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Storage temperature range | $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
|  | $260^{\circ} \mathrm{C}$ |

## recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, ANLG $\mathrm{V}_{\mathrm{DD}}$ | 4.75 | 5 | 5.25 | V |
| Supply voltage, DGTL V ${ }_{\text {DD }}$ | 4.75 | 5 | 5.25 | V |
| High-level input voltage, $\mathrm{V}_{1 \mathrm{H}}$ | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| Input voltage at analog input, $\mathrm{V}_{\text {I }}$ | 0 |  | 5 | V |
| Analog reference voltage (top side), $\mathrm{V}_{\text {reft }}$ | 3 |  | ANLG <br> GND | V |
| Analog reference voltage (bottom side), $V_{\text {refB }}$ | ANLG GND |  | 3 | V |
| Differential reference voltage, $\mathrm{V}_{\text {refT }}-\mathrm{V}_{\text {ref }} \mathrm{B}$ | 2 |  | 5 | V |
| High-level output current, $\mathrm{I}^{\mathrm{OH}}$ |  |  | -400 | $\mu \mathrm{A}$ |
| Low-level output current, IOL |  |  | 4 | mA |
| Clock pulse duration, high-level or low-level, $\mathrm{t}_{\mathrm{w}}$ | 25 |  |  | ns |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

## TLC5502

## 8-BIT ANALOG-TO-DIGITAL CONVERTER

electrical characteristics over operating supply voltage range, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{OH}}$ High-level output voltage | ${ }^{1} \mathrm{OH}=-400 \mu \mathrm{~A}$ | 2.4 |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ Low-level output voltage | $\mathrm{I}_{\mathrm{OL}}=4 \mathrm{~mA}$ |  | 0.4 | V |
| II Analog input current | $\mathrm{V}_{1}=4 \mathrm{~V}$ |  | 15 | $\mu \mathrm{A}$ |
| $\mathrm{IIH}_{\mathrm{H}}$ Digital high-level input current | $\mathrm{V}_{1}=5 \mathrm{~V}$ |  | 1 | $\mu \mathrm{A}$ |
| IIL Digital low-level input current | $V_{1}=0$ |  | -1 | $\mu \mathrm{A}$ |
| II Digital input current | $\mathrm{V}_{1}=7 \mathrm{~V}$ |  | 100 | $\mu \mathrm{A}$ |
| IrefB Reference current | $\mathrm{V}_{\text {refB }}=3 \mathrm{~V}$ | $-10$ |  | mA |
| IrefT Reference current | $\mathrm{V}_{\text {reft }}=5 \mathrm{~V}$ | -10 |  | mA |
| $\mathrm{r}_{\mathrm{i}} \quad$ Analog input resistance |  | 1 |  | $\mathrm{M} \Omega$ |
| $\mathrm{C}_{\mathrm{i}} \quad$ Analog input capacitance |  | 50 | 75 | pF |
| ICC Supply current |  | 40 | 60 | mA |

operating characteristics over operating supply voltage range, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $E_{L}$ | Linearity error |  |  |  | $\pm 0.2$ | \%FSR |
| $f_{\text {max }}$ | Maximum conversion rate |  | 20 | 30 |  | MHz |
| $\mathrm{t}_{\mathrm{d}}$ | Digital output delay time | See Figure 3 |  | 15 | 30 | ns |

timing diagram


## TYPICAL CHARACTERISTICS

IDEAL CONVERSION CHARACTERISTICS


FIGURE 1


FIGURE 2
NOTE 2: This curve is based on the assumption that $V_{\text {refB }}$ and $V_{\text {refT }}$ have been adjusted so that the voltage at the transition from digital 0 to $1\left(\mathrm{~V}_{\mathrm{ZT}}\right)$ is 4.000 V and the transition to full scale ( $\mathrm{V}_{\mathrm{FT}}$ ) is 4.992 V . $1 \mathrm{LSB}=16 \mathrm{mV}$.

## 8-BIT ANALOG-TO-DIGITAL CONVERTER

## PARAMETER MEASUREMENT INFORMATION



FIGURE 3. LOAD CIRCUIT

- 8-Bit Resolution
- $\pm 0.2 \%$ Linearity
- Maximum Conversion Rate . . . 30 MHz Typ 20 MHz Min
- Analog Output Voltage Range of $V_{C C}$ to $V_{C C}-1$ V
- TTL Digital Input Voltage
- 5-V Single Power Supply Operation
- Low Power Consumption . . . 80 mW Typical
- Interchangeable with Fujitsu MB40778


## description

The TLC5602 is a low-power ultra-high speed video digital-to-analog converter that uses the LinEPIC ${ }^{\text {mM }} 1-\mu \mathrm{m}$ CMOS process. The TL5602 converts digital signals to analog signals at a sampling rate of dc to 20 MHz . Because of highspeed operation, the TLC5602 is suitable for digital video applications such as digital television, video processing with a computer, and radar-signal processing.

The TLC5602 is characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.
$N$
dUAL-IN-LINE PACKAGE
(TOP VIEW)


FUNCTION TABLE

| STEP | DIGITAL INPUTS |  |  |  |  |  |  |  | OUTPUT VOLTAGE ${ }^{\dagger}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | D7 | D6 | D5 | D4 | D3 | D2 | D1 | DO |  |
| 0 | L | L | L | L | L | L | L | L | 3.980 V |
| 1 | L | L | L | L | L | L | L | H | 3.984 V |
| , |  |  |  | ! |  |  |  |  | i |
| 127 | L | H | H | H | H | H | H | H | 4.488 V |
| 128 | H | L | L | L | L | L | L | L | 4.492 V |
| 129 | H | L | L | L | L | L | L | H | 4.496 V |
| ! |  |  |  | ! |  |  |  |  | $!$ |
| 254 | H | H | H | H | H | H | H | L | 4.996 V |
| 255 | H | H | H | H | H | H | H | H | 5.000 V |

${ }^{\dagger}$ For $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=3.976 \mathrm{~V}$.

## functional block diagram



[^26]
## TLC5602 <br> LinEPIC ${ }^{T M}$ 8-BIT DIGITAL-TO-ANALOG CONVERTER

schematic of digital input and analog output

${ }^{\dagger}$ ANLG GND and DGTL GND are not connected internally and should be tied together as close to the device as possible.
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage range, ANLG VDD, DGTL VDD
-0.5 V to 7 V
Digital input voltage range, $\mathrm{V}_{1}$ -0.5 V to 7 V

Operating free-air temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}\left(1 / 16\right.$ inch) from case for 10 seconds . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
recommended operating conditions

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ | 4.75 | 5 | 5.25 | V |
| Analog reference voltage, $\mathrm{V}_{\text {ref }}$ (see Note 1) | 3.8 | 4 | 4.2 | V |
| High-level input voltage, $\mathrm{V}_{\text {IH }}$ | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  | 0.8 | V |
| Pulse duration, CLK high or low, $\mathrm{t}_{\mathrm{w}}$ | 25 |  |  | ns |
| Setup time, data high before CLK $\uparrow$, $\mathrm{t}_{\text {su }}$ | 12.5 |  |  | ns |
| Hold time, data high after CLK $\uparrow$, th | 12.5 |  |  | ns |
| Phase compensation capacitance, $\mathrm{C}_{\text {comp }}$ (see Note 2) | 1 |  |  | $\mu \mathrm{F}$ |
| Operating free-air temperature, $T_{A}$ | 0 |  | 70 | ${ }^{\circ} \mathrm{C}$ |

NOTES: 1. $V_{\text {ref }}$ should be greater than or equal to $V_{D D}-1.2 \mathrm{~V}$.
2. The phase compensation capacitor should be connected between COMP and ANLG GND.
electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\dagger}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $I_{\text {IH }}$ High-level input current | $\mathrm{V}_{\mathrm{DD}}=5.25 \mathrm{~V}, \mathrm{~V}_{1}=2.7 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
| IIL Low-level input current | $V_{\text {DD }}=5.25 \mathrm{~V}, \mathrm{~V}_{1}=0.4 \mathrm{~V}$ |  |  | -1 | $\mu \mathrm{A}$ |
| Iref Input reference current | $\mathrm{V}_{\text {ref }}=4 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
| VFS Full-scale analog output voltage | $\mathrm{V}_{\text {DD }}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=4 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{DD}}-15$ | $V_{\text {DD }}$ | $V_{D D}+15$ | mV |
| $\mathrm{V}_{\text {ZS }} \quad$ Zero-scale analog output voltage |  | 3.919 | 3.98 | 4.042 | V |
| $r_{0}$ Output resistance | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 60 |  | 100 | $\Omega$ |
| $\mathrm{C}_{\mathrm{i}} \quad$ Input capacitance | $\mathrm{f}_{\text {clock }}=1 \mathrm{MHz}, \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 15 |  |  | pF |
| IDD Supply current | $\mathrm{V}_{\text {ref }}=4.05 \mathrm{~V}$ |  | 16 | 25 | mA |

operating characteristics over recommended ranges of supply voltage and operating free-air temperature

|  | PARAMETER | TEST CONDITIONS | MIN | TYP ${ }^{\text { }}$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $E_{L}$ | Linearity error, best-straight-line |  |  |  | $\pm 0.2 \%$ |  |
| $E_{D}$ | Linearity error, differential |  |  |  | $\pm 0.1 \%$ |  |
| $\mathrm{G}_{\text {diff }}$ | Differential gain | NTSC 40 IRE modulated ramp,$f_{\text {clock }}=14.3 \mathrm{MHz}$ |  |  | 2\% |  |
| $\phi_{\text {diff }}$ | Differential phase |  |  | $2^{\circ}$ |  |  |
| $t_{\text {pd }}$ | Propagation delay, CLK to analog output | $C_{L}=10 \mathrm{pF}$ |  | 25 | 1 | ns |
| $\mathrm{t}_{\mathrm{s}}$ | Settling time to within $1 / 2$ LSB | $C_{L}=10 \mathrm{pF}$ |  | 30 |  | ns |

${ }^{\dagger}$ All typical values are at $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.


FIGURE 1. Voltage waveforms

## TYPICAL CHARACTERISTICS

IDEAL CONVERSION CHARACTERISTICS


FIGURE 2


FIGURE 3

- Advanced LinCMOS ${ }^{\text {™ }}$ Silicon-Gate Technology
- Monotonic Over the Entire A/D Conversion Range
- Fast Settling Time
- CMOS/TTL Compatible
- Four-Quadrant Multiplication
- Designed to be Interchangeable with Analog Devices AD7533, AD7520, and PMI PM-7533

| KEY PERFORMANCE <br> SPECIFICATIONS |  |
| :--- | :--- |
| Resolution | 10 Bits |
| Linearity Error | $1 / 2 \mathrm{LSB}$ |
| Power Dissipation | 30 mW |
| Settling Time | 150 ns |

## description

The TLC7533 and AD7533 are Advanced LinCMOS ${ }^{\text {™ }} 10$-bit digital-to-analog converters featuring two- and four-quadrant multiplication.

The TLC7533 and AD7533 are functionally equivalent to the AD7520 and have the same pinout. Texas Instruments advanced thin-film-on-monolithic-CMOS fabrication process provides 10 -bit linearity without laser trimming.

The TLC7533 and AD7533 feature TTL or CMOS compatibility with low input leakage currents from $5-\mathrm{V}$ to $15-\mathrm{V}$ power supplies. Output scaling is provided by an internal feedback resistor and an external operational amplifier. Either positive or negative reference voltages can be used.
The TLC7533C and AD75331 are characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$. The TLC7533L and AD7533C are characterized for operation from $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$.

TLC7533 . . . D OR N PACKAGE
AD7533 . . . N PACKAGE
(TOP VIEW)


NC - No internal connections
AVAILABLE OPTIONS

| SYMBOLIZATION ${ }^{\dagger}$ |  | OPERATING |
| :---: | :---: | :---: |
| DEVICE | PACKAGE <br> SUFFIX | TEMPERATURE <br> RANGE |
| TLC7533C | D, FN, N | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| TLC75331 | D, FN, N | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7533C | $\mathrm{FN}, \mathrm{N}$ | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| AD7533L | $\mathrm{FN}, \mathrm{N}$ | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |

t In many instances, these ICs may have both TLC7533 and AD7533 labeling on the package.

## TLC7533, AD7533 <br> Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 10-BIT MULTIPLYING DIGITAL-TO-ANALOG CONVERTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)
Supply voltage, VDD (see Note 1) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to 17 V
Digital input voltage, $\mathrm{V}_{1}$. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . -0.3 to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$
Output voltage at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, OUT1 and OUT2 ......................................... $\pm 25 \mathrm{~V}$

Reference voltage, $\mathrm{V}_{\text {ref . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . }}$. 25 V
Operating free-air temperature range: TLC75331, AD7533C . . . . . . . . . . . . . . . . . . $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
TLC7533C, AD7533L . . . . . . . . . . . . . . . . . . . . $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$
Storage temperature range . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$
Case temperature for 10 seconds: FN package. . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . $260^{\circ} \mathrm{C}$
Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds: D or N package . . . . . . . $260^{\circ} \mathrm{C}$

NOTE 1: All voltage values are with respect to the network ground terminal.
recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{DD}}$ |  | 5 |  | 16.5 | V |
| Reference voltage, $\mathrm{V}_{\text {ref }}$ |  |  | $\pm 10$ |  | V |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ |  | 2.4 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.8 | V |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ | TLC75331, AD7533C | -25 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | TLC7533C, AD7533L | 0 |  | 70 |  |

electrical characteristics over recommended operating temperature range, $\mathrm{V} D \mathrm{DD}=15 \mathrm{~V}$, $\mathrm{V}_{\text {ref }}= \pm 10 \mathrm{~V}$. OUT1 and OUT2 at 0 V (unless otherwise noted)

| PARAMETER |  |  | TEST CONDITIONS |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| l 1 lkg | Input leakage current |  | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $\mathrm{r}_{\mathrm{i}}$ | Input resistance, REF (see Note 2) |  |  |  | 5 | 20 | k ת |
| lolkg | Output leakage current | OUT1 | Digital inputs at $\mathrm{V}_{\text {IL }}$ | Full range |  | $\pm 200$ | nA |
|  |  |  |  | $25^{\circ} \mathrm{C}$ |  | $\pm 50$ |  |
|  |  | OUT2 | Digital inputs at $\mathrm{V}_{\mathrm{IH}}$ | Full range |  | $\pm 200$ |  |
|  |  |  |  | $25^{\circ} \mathrm{C}$ |  | $\pm 50$ |  |
| $k_{\text {svs }}$ Supply voltage sensitivity <br> $\Delta A V / \Delta V_{D D}$ (see Note 3) |  |  | $V_{D D}=14 \mathrm{~V} \text { to } 17 \mathrm{~V},$ <br> Digital inputs at $V_{I H}$ or $V_{I L}$ | Full range |  | 0.008 | \%/\% |
|  |  |  | $25^{\circ} \mathrm{C}$ |  | 0.005 |  |
| ${ }^{\prime}$ DD | Supply current |  |  |  |  |  | 2 | mA |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  | $\mathrm{V}_{1}=0$ or $\mathrm{V}_{\mathrm{DD}}$ |  |  | 5 | pF |
| $\mathrm{C}_{0}$ | Output capacitance | OUT1 | Digital inputs at $\mathrm{V}_{1 \mathrm{H}}$ |  |  | 100 | pF |
|  |  | OUT2 |  |  |  | 35 |  |
|  |  | OUT1 | Digital inputs at $\mathrm{V}_{\text {IL }}$ |  |  | 35 |  |
|  |  | OUT2 |  |  |  | 100 |  |

NOTES: 2. Temperature coefficient is approximately $-300 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.
3. $A V$ is the ratio of the $D / A$ external operational amplifier output voltage to the REF input voltage when using the internal feedback resistor.
operating characteristics over recommended operating free-air temperature range, VDD $=15 \mathrm{~V}$, $\mathrm{V}_{\text {ref }}=10 \mathrm{~V}$, OUT1 and OUT2 at 0 V (unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Relative accuracy | See Note 4 |  |  | $\pm 0.05$ | \%FSR |
| Gain error | Digital inputs $=\mathrm{V}_{1 \mathrm{H}}$, See Notes 4 and 5 | Full range |  | $\pm 1.5$ | \%FS |
|  |  | $25^{\circ} \mathrm{C}$ |  | $\pm 1.4$ |  |
| Output current settling time | To $\pm 0.05 \%$ FSR, $R_{L}=100 \Omega$ <br> Digital inputs changing from $V_{I H}$ to $V_{I L}$, or $V_{\text {IL }}$ to $V_{I H}$ |  |  | 150 | ns |
| Feedthrough error | Digital inputs at $\mathrm{V}_{\mathrm{IL}}$, <br> $V_{\text {ref }}= \pm 10 \mathrm{~V}$ sine wave at 100 kHz |  |  | $\pm 0.1$ | \%FSR |

NOTES 4. Practical Full Scale Range (FSR) $=V_{\text {ref }}-1$ LSB.
5. Gain error is measured using an internal feedback resistor, Full Scale (FS) $=V_{\text {ref }}(1023 / 1024)$. Maximum gain change from $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ to minimum or maximum temperature is $\pm 0.1 \%$ FSR.

## PRINCIPLES OF OPERATION

The TLC7533 and AD7533 are 10-bit multiplying D/A converters consisting of an inverted R-2R ladder and analog switches. Binary-weighted currents are switched between the OUT1 and OUT2 bus lines by NMOS current switches. The on-state resistances of these switches are binarily scaled so that the voltage drop across every switch is the same. The OUT1 and OUT2 bus lines should be maintained at the same potential so that the current in each ladder leg remains constant and is independent of the switch state. Most applications require only the addition of an external operational amplifier and a voltage reference.

The equivalent circuit for all digital inputs low is shown in Figure 1. With all of the digital inputs low, the entire reference current, $I_{r e f}$, is switched to OUT2 as shown in Figure 2. The current source $I_{\text {ref }} / 1024$ represents the constant current flowing through the termination resistor of the R-2R ladder; while the current source $l_{\mathrm{kgg}}$ represents leakage currents to the substrate. The output capacitances, $\mathrm{C}_{\mathrm{O}}(1)$ and $\mathrm{C}_{\mathrm{O}}(2)$, are due to the capacitance of the NMOS current switches and vary with the switch state. With all digital inputs low, all of the current switches and the entire resistor ladder are switched to the OUT2 bus line. The capacitance appearing at OUT2 is a maximum of 100 pF ; at OUT1 there is a maximum of 35 pF . With all digital inputs high, all of the current switches are switched to OUT1, and 100 pF maximum appears at OUT1. A maximum of 35 pF appears at OUT2 as shown in Figure 3.


FIGURE 1. SIMPLIFIED D/A CIRCUIT - ALL DIGITAL INPUTS LOW


FIGURE 2. D/A EQUIVALENT CIRCUIT ALL DIGITAL INPUTS LOW


FIGURE 3. D/A EQUIVALENT CIRCUIT ALL DIGITAL INPUTS HIGH

## TYPICAL APPLICATION DATA

The TLC7533 and AD7533 are capable of performing 2-quadrant or full 4-quadrant multiplication. Circuit configurations for 2-quadrant or 4 -quadrant multiplication are shown in Figures 4 and 5. Input coding for unipolar and bipolar operation are summarized in Tables 1 and 2, respectively.


FIGURE 4. UNIPOLAR OPERATION (2-QUADRANT MULTIPLICATION)


FIGURE 5. BIPOLAR OPERATION (4-QUADRANT OPERATION)
NOTES: 6. $R_{A}$ and $R_{B}$ are used only if gain adjustment is required.
7. $C_{1}$ (10-33 pF) may be required for phase compensation when using high-speed op-amps.

TABLE 1. UNIPOLAR BINARY CODE

| DAC DIGITAL INPUT <br> MSB $\quad$ LSB $^{\dagger}$ | ANALOG OUTPUT |
| :--- | :--- |
| 1111111111 | $-V_{1}(1023 / 1024)$ |
| 1000000001 | $-V_{1}(513 / 1024)$ |
| 1000000000 | $-V_{1}(512 / 1024)=-V_{\text {ref }^{\prime} / 2}$ |
| 0111111111 | $-V_{1}(511 / 1024)$ |
| 0000000001 | $-V_{1}(1 / 1024)$ |
| 0000000000 | $-V_{1}(0 / 1024)=0$ |

[^27]TABLE 2. BIPOLAR (OFFSET BINARY) CODE

| DAC DIGITAL INPUT <br> MSB $\quad$ LSB <br> $\ddagger$ | ANALOG OUTPUT |
| :--- | :--- |
| 1111111111 | $+V_{1}(511 / 512)$ |
| 1000000001 | $+V_{1}(1 / 512)$ |
| 1000000000 | 0 |
| 0111111111 | $-V_{1}(1 / 512)$ |
| 0000000001 | $-V_{1}(511 / 512)$ |
| 0000000000 | $-V_{1}(512 / 512)=-V_{1}$ |

Advanced LinCMOS ${ }^{\text {TM }}$ DUAL 10-BIT MULTIPLYING

## TYPICAL APPLICATION DATA

The TLC7533 and AD7533 may be used in voltage output operation as shown in Figure 6. In this configuration, the input voltage is applied to the OUT1 terminal and the output voltage is taken from the REF terminal. The output voltage varies with the digital input code according to the equation shown. The output should be buffered to prevent loading errors due to the high output resistance of this circuit (typically $10 \mathrm{k} \Omega$ ). The input voltage should not exceed 1.5 V to ensure nonlinearity errors less than 1 LSB.


FIGURE 6. VOLTAGE OUTPUT OPERATION

By connecting the DAC in the feedback of an op-amp as shown in Figure 7, the circuit behaves as a programmable gain amplifier with the transfer function:

$$
v_{O}=-V_{I}\left(\frac{1024}{D}\right)
$$

where $D=$ Digital Input Code (expressed as a decimal number)


| GAIN TABLE |  |
| ---: | :--- |
| $\mathbf{D}$ | $\mathbf{V}_{\mathbf{0}} / \mathbf{V}_{\mathbf{1}}$ |
| 1023 | -1.00097 |
| 512 | -2 |
| 256 | -4 |
| 128 | -8 |
| 2 | -512 |
| 1 | -1024 |
| 0 | open loop |

FIGURE 7. PROGRAMMABLE GAIN AMPLIFIER

## TYPICAL APPLICATION DATA

The programmable function generator shown in Figure 8 produces both square and triangular wave output at a frequency determined by the digital input code. The digital input of the digitally programmable limit detector shown in Figure 9 determines the trip point of the PASS/FAIL output. For a digital input of 00000 00000, the threshold is 0 V , for 1111111111 , the threshold is -V ref.


FIGURE 8. PROGRAMMABLE FUNCTION GENERATOR


FIGURE 9. PROGRAMMABLE LIMIT DETECTOR

TYPICAL APPLICATION DATA


FIGURE 10. MODIFIED SCALE-FACTOR AND OFFSET


FIGURE 11. 10-BIT AND SIGN MULTIPLYING D/A

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## Contents

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Electrical characteristics presented in this data book, unless otherwise noted, apply for the circuit type(s) listed in the page heading regardless of package. The availability of a circuit function in a particular package is shown in the "Available Options" table on each data sheet and is usually denoted by an alphabetical reference above the pin-connection diagram(s). These alphabetical references refer to mechanical outline drawings shown in this section.

Factory orders for circuits described in this data book should include a four-part type number as explained in the following example.


Circuits are shipped in one of the carriers below. Unless a specific method of shipment is specified by the customer (with possible additional costs), circuits will be shipped in the most practical carrier.

Small Outline (D, DW)
Dual-In-Line (J, JD, N, P)

- Slide Magazines
-A-Channel Plastic Tubing
-Sectioned Cardboard Box
- Individual Cardboard Box

Chip Carriers (FK, FN)
-Anti-Static Plastic Tubing

## D008, D014, and D016 plastic "small outline" packages

Each of these "small outline" packages consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.


## MECHANICAL DATA

DW016, DW020, DW024, and DW028 plastic "small outline" packages
Each of these "small outline" packages consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.

${ }^{\dagger}$ The 28 -pin package drawing is presently classified as Advance Information.
NOTES: A. Leads are within $0,25(0.010)$ radius of true position at maximum material dimension.
B. Body dimensions do not include mold flash or protrusion.
C. Mold flash or protrusion shall not exceed 0,15 (0.006).
D. Lead tips to be planar within $\pm 0,051(0.002)$ exclusive of solder.

## FKO20 and FK028 ceramic chip carrier packages

Each of these hermetically sealed chip carrier packages has a three-layer ceramic base with a metal lid and braze seal. The packages are intended for surface mounting on solder lands on 1,27 (0.050-inch) centers. Terminals require no additional cleaning or processing when used in soldered assembly.

FK package terminal assignments conform to JEDEC Standards 1 and 2.


FNO20, FN028, FNO44, FN068, and FN084 plastic chip carrier packages
Each of these chip carrier packages consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound withstands soldering temperatures with no deformation, and circuit performance characteristics remain stable when the devices are operated in high-humidity conditions. The packages are intended for surface mounting on solder lands on 1,27 (0.050) centers. Leads require no additional cleaning or processing when used in soldered assembly.

FN020, FN028, FN044, FN068, and FN084
(28-terminal package used for illustration)


| NO. OF TERMINALS | A |  | B |  | c |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX | MIN | MAX |
| 20 | 9,78 | 10.03 | 8,89 | 9,04 | 7.87 | 8,38 |
|  | (0.385) | (0.395) | (0.350) | (0.356) | (0.310) | (0.330) |
| 28 | 12,32 | 12.57 | 11.43 | 11,58 | 10.41 | 10.92 |
|  | (0.485) | (0.495) | (0.450) | (0.456) | (0.410) | (0.430) |
| 44 | 17,40 | 17.65 | 16,51 | 16,66 | 15.49 | 16,00 |
|  | (0.685) | (0.695) | (0.650) | (0.656) | (0.610) | (0.630) |
| 68 | 25,02 | 25,27 | 24,13 | 24,33 | 23,11 | 23.62 |
|  | (0.985) | (0.995) | (0.950) | (0.956) | (0.910) | (0.930) |
| 84 | 30,10 | 30,35 | 29.21 | 29.41 | 27.69 | 28.70 |
|  | (1.185) | (1.195) | (1.150) | (1.158) | (1.090) | (1.130) |



ALL LINEAR DIMENSIONS ARE IN MILLIMETERS AND PARENTHETICALLY IN INCHES

NOTES: A. Centerline of center pin each side is within $0,10(0.004)$ of package centerline as determined by dimension $B$.
B. Location of each pin is within $0,127(0.005)$ of true position with respect to center pin on each side.
C. The lead contact points are planar within $0,10(0.004)$.

## J014 ceramic dual-in-line package

This hermetically sealed dual-in-line package consists of a ceramic base, ceramic cap, and a lead frame. Hermetic sealing is accomplished with glass. The package is intended for insertion in mounting-hole rows on $7,62(0.300)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Tin-plated ('bbight-dipped'") leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above the seating plane.

## MECHANICAL DATA

## J018 ceramic dual-in-line package

This hermetically sealed dual-in-line package consists of a ceramic base, ceramic cap, and a lead frame. Hermetic sealing is accomplished with glass. The package is intended for insertion in mounting-hole rows on $7,62(0.300)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Tin-plated ("bright-dipped") leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above the seating plane.

## J020 ceramic dual-in-line package

This hermetically sealed dual-in-line package consists of a ceramic base, ceramic cap, and a lead frame. Hermetic sealing is accomplished with glass. The package is intended for insertion in mounting-hole rows on 7,62 ( 0.300 ) centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Tin-plated ('bright-dipped'") leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above the seating plane.

## J028 ceramic dual-in-line package

This hermetically sealed dual-in-line package consists of a ceramic base, ceramic cap, and a lead frame. Hermetic sealing is accomplished with glass. The package is intended for insertion in mounting-hole rows on $15,24(0.600)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Tin-plated ('"bright-dipped') leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0,51 ( 0.020 ) above the seating plane.

## JD024 and JD028 ceramic side-braze dual-in-line packages

Each of these hermetically sealed dual-in-line packages consists of a ceramic base, metal can, and sidebrazed tin-plated leads. These packages are intended for insertion in mounting-hole rows on 15,14 (0.600) centers. Leads require no additional cleaning or processing when used in soldered assembly.

JD024 and JD028


|  | PINS (N) | 24 |
| :--- | :---: | :---: |
| DIM |  | 28 |
| A +0.51 $(+0.020)$ | 15.24 | 15.24 |
| $-0.25(-0.010)$ | $10.600)$ | $10.600)$ |
| B (MAX) | 31.8 | 36.8 |
|  | $(1.250)$ | $(1.450)$ |
| C (NOM) | 15.0 | 15.0 |
|  | $(0.590)$ | $10.590)$ |

ALL LINEAR DIMENSIONS ARE IN MILLIMETERS AND PARENTHETICALLY IN INCHES

NOTE A: Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.

## N014 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on $7,62(0.300)$ centers (see Note A). Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0,51(0.020) above seating plane.

## N016 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on $7,62(0.300)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0.25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above seating plane.

## MECHANICAL DATA

## N018 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on $7,62(0.300)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above seating plane.

## NO20 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on 7,62 (0.300) centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0,51(0.020) above seating plane.

## NO22 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on $10,16(0.400)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0,51 (0.020) above seating plane.

## N028 plastic dual-in-line package

This dual-in-line package consists of a circuit mounted on a lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on $15,24(0.600)$ centers. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least 0,51 ( 0.020 ) above seating plane.

## P008 dual-in-line plastic package

This package consists of a circuit mounted on an 8-pin lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high-humidity conditions. The package is intended for insertion in mounting-hole rows on 7,62 ( 0.300 ) centers (See Note A). Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Solder-plated leads require no additional cleaning or processing when used in soldered assembly.


NOTES: A. Each pin centerline is located within $0,25(0.010)$ of its true longitudinal position.
B. This dimension does not apply for solder-dipped leads.
C. When solder-dipped leads are specified, dipped area of the lead extends from the lead tip to at least $0,51(0.020)$ above seating plane.

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[^0]:    ${ }^{\dagger}$ Analog/digital inputs can be used either as digital logic inputs or inputs for analog to digital conversion. For example: The TLC532/3A
    can have 11 analog inputs, 5 analog inputs, and 6 digital inputs, or any combination in between.
    $\ddagger$ Includes access time
    §Differential input

[^1]:    ${ }^{\dagger}$ Analog/digital inputs can be used either as digital logic inputs or inputs for analog to digital conversion. For example: The TLC532/3A can have 11 analog inputs, 5 analog inputs, and 6 digital inputs, or any combination in between.
    $\ddagger$ Includes access time
    §Differential input

[^2]:    $\dagger$ The TLC32040 and TLC32041 have two differential inputs for the 14 -bit A/D and a serial port input for the 14 -bit D/A. The $A / D$ conversion accuracy for this device is measured in terms of signal-to-quantization distortion and also in LSB over certain converter ranges. The package types are $F N$ and $N$. Please refer to the data sheet.

[^3]:    $\dagger 1 \mathrm{LSB}=(2-8) \mathrm{V}_{\mathrm{i}}$

[^4]:    $H=$ high level, $L=$ low level
    $\uparrow=$ low-to-high transition

[^5]:    ${ }^{\dagger}$ All parameters are measured under open-loop conditions with zero common-mode input voltage.
    $\ddagger$ All typical values are at $V_{C C}=5 \mathrm{~V}, T_{A}=25^{\circ} \mathrm{C}$.

[^6]:    § All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
    NOTES: 5. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.
    6. The most significant-bit-first data is output directly from the comparator and therefore requires additional delay to allow for comparator response time. Least-significant-bit-first data applies only to ADC0832.

[^7]:    ${ }^{\dagger}$ All parameters are measured under open-loop conditions with zero common-mode input voltage (unless otherwise specified).
    $\ddagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=\mathrm{V}+=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

[^8]:    $H=$ high level, $L=$ low level
    $\uparrow=$ low-to-high transition

[^9]:    ${ }^{\dagger}{ }^{T} y$ pical values are at $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

[^10]:    ${ }^{\dagger}$ Typical values for all except supply voltage sensitivity are at $\mathrm{V}_{\mathrm{CC}}=3 \mathrm{~V}$.
    NOTES: 6. Refer to the operating sequence diagram.
    7. For clock frequencies other than $640 \mathrm{kHz}, \mathrm{t}_{\mathrm{d}(\mathrm{EOC})}$ maximum is 8 clock periods plus $2 \mu \mathrm{~s}$.
    8. Supply voltage sensitivity relates to the ability of an analog-to-digital converter to maintain accuracy as the supply voltage varies. The supply and $\mathrm{V}_{\text {ref }}+$ are varied together and the change in accuracy is measured with respect to full-scale.
    9. Linearity error is the maximum deviation from a straight line through the end points of the A/D transfer characteristic.
    10. Zero error is the difference between 00000000 and the converted output for zero input voltage; full-scale error is the difference between 11111111 and the converted output for full-scale input voltage.
    11. Total unadjusted error is the maximum sum of linearity error, zero error, and full-scale error.

[^11]:    *This step is the voltage at pin 2 with respect to analog ground.

[^12]:    ${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    $\ddagger$ These parameters are linear functions of $\mathrm{V}_{\mathrm{C}} 1$.

[^13]:    $H=$ High-level, $L=$ Low-level, $X=$ Irrelevant
    $\downarrow=$ High-to-low transition, $\uparrow=$ Low-to-high transition
    ${ }^{\dagger}$ For proper operation, Reset must be low for at least three clock cycles.

[^14]:    ${ }^{\dagger}$ With supply voltages at or near 2 V , the analog switch on-state resistance becomes very nonlinear. It is recommended that only digital signals be transmitted at these low supply voltages.

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[^16]:    ${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.

[^17]:    ${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    ${ }^{\ddagger} A_{V}$ is the programmable gain of the input amplifier.
    ${ }^{\S}$ A value $>58$ is overrange and signal clipping occurs. DAC is $600 \Omega$.
    8. Gain tracking is relative to the absolute gain at 1 kHz and $0 \mathrm{~dB}\left(0\right.$ db relative to $\left.V_{\text {ref }}\right)$

[^18]:    ${ }^{\dagger}$ Thomson Semiconductors

[^19]:    ${ }^{\dagger}$ All analog signal paths have differential architecture and hence have positive and negative components.

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[^21]:    $\dagger_{\text {All typical values are at }} \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    $\ddagger A_{V}$ is the programmable gain of the input amplifier.
    § A value $>55$ is over range and signal clipping occurs.
    NOTE 7: The test condition is a $1-\mathrm{kHz}$ input signal with an $8-\mathrm{kHz}$ conversion rate ( 0 dB relative to $\mathrm{V}_{\text {ref }}$ ). The load impedance for the DAC is $600 \Omega$.

[^22]:    ${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    NOTE: 8. Gain tracking is relative to the absolute gain at 1 kHz and $0 \mathrm{~dB}\left(0 \mathrm{~dB}\right.$ relative to $\left.\mathrm{V}_{\text {ref }}\right)$.

[^23]:    ${ }^{\dagger}$ All typical values are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
    NOTES: 11. The noise is computed by statistically evaluating the digital output of the A/D converter.
    12. RESET pulse duration is the amount of time that the reset pin is held below 0.8 V after the power supplies have reached their recommended values.

[^24]:    $\ddagger 1 \mathrm{LSB}=(2-7) \mathrm{V}_{\mathrm{i}}$

[^25]:    ${ }^{\dagger}$ For $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~V}_{\text {ref }}=3.976 \mathrm{~V}$

[^26]:    LinEPIC is a trademark of Texas Instruments Incorporated.

[^27]:    $\dagger_{1} L S B=(2-10) V_{1}$
    $\ddagger 1$ LSB $=(2-9) V_{1}$

